

**TPS65950**  
**Integrated Power Management/Audio Codec**  
**Silicon Revision 1.2**

**Data Manual**



PRODUCTION DATA information is current as of publication date.  
Products conform to specifications per the terms of the Texas  
Instruments standard warranty. Production processing does not  
necessarily include testing of all parameters.

Literature Number: SWCS032E  
October 2008–Revised January 2011

## Contents

|          |   |           |
|----------|---|-----------|
| <b>1</b> | <b>Introduction</b>                           | <b>11</b> |
| 1.1      | Features                                      | 12        |
| 1.2      | TPS65950 Block Diagram                        | 13        |
| <b>2</b> | <b>Terminal Description</b>                   | <b>14</b> |
| 2.1      | Corner Balls                                  | 14        |
| 2.2      | Ball Characteristics                          | 15        |
| 2.3      | Signal Description                            | 20        |
| <b>3</b> | <b>Electrical Characteristics</b>             | <b>27</b> |
| 3.1      | Absolute Maximum Ratings                      | 27        |
| 3.2      | Minimum Voltages and Associated Currents      | 27        |
| 3.3      | Recommended Operating Conditions              | 28        |
| 3.4      | Digital I/O Electrical Characteristics        | 28        |
| <b>4</b> | <b>Power Module</b>                           | <b>32</b> |
| 4.1      | Power Providers                               | 34        |
| 4.1.1    | VDD1 dc-dc Regulator                          | 35        |
| 4.1.1.1  | VDD1 dc-dc Regulator Characteristics          | 35        |
| 4.1.1.2  | External Components and Application Schematic | 36        |
| 4.1.2    | VDD2 dc-dc Regulator                          | 38        |
| 4.1.2.1  | VDD2 dc-dc Regulator Characteristics          | 38        |
| 4.1.2.2  | External Components and Application Schematic | 39        |
| 4.1.3    | VIO dc-dc Regulator                           | 41        |
| 4.1.3.1  | VIO dc-dc Regulator Characteristics           | 41        |
| 4.1.3.2  | External Components and Application Schematic | 42        |
| 4.1.4    | VDAC LDO Regulator                            | 44        |
| 4.1.5    | VPLL1 LDO Regulator                           | 45        |
| 4.1.6    | VPLL2 LDO Regulator                           | 46        |
| 4.1.7    | VMMC1 LDO Regulator                           | 47        |
| 4.1.8    | VMMC2 LDO Regulator                           | 48        |
| 4.1.9    | VSIM LDO Regulator                            | 49        |
| 4.1.10   | VAUX1 LDO Regulator                           | 50        |
| 4.1.11   | VAUX2 LDO Regulator                           | 51        |
| 4.1.12   | VAUX3 LDO Regulator                           | 52        |
| 4.1.13   | VAUX4 LDO Regulator                           | 53        |
| 4.1.14   | Internal LDOs                                 | 54        |
| 4.1.15   | CP  | 54        |
| 4.1.16   | USB LDO Short-Circuit Protection Scheme       | 55        |
| 4.2      | Power References                              | 55        |
| 4.3      | Power Control                                 | 56        |
| 4.3.1    | Backup Battery Charger                        | 56        |
| 4.3.2    | Battery Monitoring and Threshold Detection    | 56        |
| 4.3.2.1  | Power On/Power Off and Backup Conditions      | 56        |
| 4.3.3    | VRRTC LDO Regulator                           | 57        |
| 4.4      | Power Consumption                             | 58        |
| 4.5      | Power Management                              | 59        |
| 4.5.1    | Boot Modes                                    | 59        |
| 4.5.2    | Process Modes                                 | 59        |

|          |  |                    |
|----------|--|--------------------|
| 4.5.2.1  | C027.0 Mode .....  | <a href="#">59</a> |
| 4.5.2.2  | C021.M Mode .....  | <a href="#">59</a> |
| 4.5.3    | Power-On Sequence .....                                    | <a href="#">59</a> |
| 4.5.3.1  | Timings Before Sequence_Start .....                        | <a href="#">59</a> |
| 4.5.3.2  | OMAP2 Power-On Sequence .....                              | <a href="#">60</a> |
| 4.5.3.3  | OMAP3 Power-On Sequence .....                              | <a href="#">61</a> |
| 4.5.3.4  | Power On in Slave_C021_Generic Mode .....                  | <a href="#">63</a> |
| 4.5.4    | Power-Off Sequence .....                                   | <a href="#">63</a> |
| 4.5.4.1  | Power-Off Sequence in Master Modes .....                   | <a href="#">63</a> |
| <b>5</b> | <b>Real-Time Clock and Embedded Power Controller .....</b> | <a href="#">65</a> |
| 5.1      | RTC .....  | <a href="#">65</a> |
| 5.1.1    | Backup Battery .....                                       | <a href="#">65</a> |
| 5.2      | EPC .....  | <a href="#">65</a> |
| <b>6</b> | <b>Audio/Voice Module .....</b>                            | <a href="#">66</a> |
| 6.1      | Audio/Voice Downlink (RX) Module .....                     | <a href="#">67</a> |
| 6.1.1    | Earphone Output .....                                      | <a href="#">67</a> |
| 6.1.1.1  | Earphone Output Characteristics .....                      | <a href="#">67</a> |
| 6.1.1.2  | External Components and Application Schematic .....        | <a href="#">68</a> |
| 6.1.2    | 8-Ω Stereo Hands-Free .....                                | <a href="#">68</a> |
| 6.1.2.1  | 8-Ω Stereo Hands-Free Output Characteristics .....         | <a href="#">68</a> |
| 6.1.2.2  | External Components and Application Schematic .....        | <a href="#">69</a> |
| 6.1.3    | Headset .....  | <a href="#">70</a> |
| 6.1.3.1  | Headset Output Characteristics .....                       | <a href="#">70</a> |
| 6.1.3.2  | External Components and Application Schematic .....        | <a href="#">72</a> |
| 6.1.4    | Headset Pop-Noise Attenuation .....                        | <a href="#">75</a> |
| 6.1.5    | Predriver for External Class-D Amplifier .....             | <a href="#">76</a> |
| 6.1.5.1  | Predriver Output Characteristics .....                     | <a href="#">76</a> |
| 6.1.5.2  | External Components and Application Schematic .....        | <a href="#">77</a> |
| 6.1.6    | Vibrator H-Bridge .....                                    | <a href="#">78</a> |
| 6.1.6.1  | Vibrator H-Bridge Output Characteristics .....             | <a href="#">78</a> |
| 6.1.6.2  | External Components and Application Schematic .....        | <a href="#">78</a> |
| 6.1.7    | Carkit Output .....  | <a href="#">79</a> |
| 6.1.8    | Digital Audio Filter Module .....                          | <a href="#">80</a> |
| 6.1.9    | Digital Voice Filter Module .....                          | <a href="#">80</a> |
| 6.1.9.1  | Voice Downlink Filter (Sampling Frequency at 8 kHz) .....  | <a href="#">81</a> |
| 6.1.9.2  | Voice Downlink Filter (Sampling Frequency at 16 kHz) ..... | <a href="#">82</a> |
| 6.1.10   | Boost Stage .....  | <a href="#">82</a> |
| 6.2      | Audio/Voice Uplink (TX) Module .....                       | <a href="#">84</a> |
| 6.2.1    | Microphone Bias Module .....                               | <a href="#">84</a> |
| 6.2.1.1  | Analog Microphone Bias Module Characteristics .....        | <a href="#">85</a> |
| 6.2.1.2  | External Components and Application Schematic .....        | <a href="#">86</a> |
| 6.2.1.3  | Digital Microphone Bias Module Characteristics .....       | <a href="#">87</a> |
| 6.2.1.4  | Silicon Microphone Characteristics .....                   | <a href="#">89</a> |
| 6.2.2    | Stereo Differential Input .....                            | <a href="#">90</a> |
| 6.2.3    | Headset Differential Input .....                           | <a href="#">90</a> |
| 6.2.4    | FM Radio/Auxiliary Stereo Input .....                      | <a href="#">91</a> |
| 6.2.4.1  | External Components .....                                  | <a href="#">91</a> |
| 6.2.5    | PDM Interface for Digital Microphones .....                | <a href="#">91</a> |

|           |   |                     |
|-----------|---|---------------------|
| 6.2.6     | Uplink Characteristics .....  | <a href="#">92</a>  |
| 6.2.7     | Microphone Amplification Stage .....                                  | <a href="#">93</a>  |
| 6.2.8     | Carkit Input .....  | <a href="#">93</a>  |
| 6.2.9     | Digital Audio Filter Module .....                                     | <a href="#">94</a>  |
| 6.2.10    | Digital Voice Filter Module .....                                     | <a href="#">95</a>  |
| 6.2.10.1  | Voice Uplink Filter (Sampling Frequency at 8 kHz) .....               | <a href="#">95</a>  |
| 6.2.10.2  | Voice Uplink Filter (Sampling Frequency at 16 kHz) .....              | <a href="#">97</a>  |
| <b>7</b>  | <b>USB HS 2.0 OTG Transceiver .....</b>                               | <a href="#">99</a>  |
| 7.1       | USB Features .....  | <a href="#">99</a>  |
| 7.2       | USB Transceiver .....   | <a href="#">100</a> |
| 7.2.1     | MCPC Carkit Port Timing .....   | <a href="#">102</a> |
| 7.2.2     | USB-CEA Carkit Port Timing .....                                      | <a href="#">103</a> |
| 7.2.3     | HS USB Port Timing .....  | <a href="#">105</a> |
| 7.2.4     | PHY Electrical Characteristics .....                                  | <a href="#">106</a> |
| 7.2.4.1   | 5-V Tolerance .....   | <a href="#">106</a> |
| 7.2.4.2   | LS/FS Single-Ended Receivers .....                                    | <a href="#">106</a> |
| 7.2.4.3   | LS/FS Differential Receiver .....                                     | <a href="#">107</a> |
| 7.2.4.4   | LS/FS Differential Transmitter .....                                  | <a href="#">107</a> |
| 7.2.4.5   | HS Differential Receiver .....  | <a href="#">108</a> |
| 7.2.4.6   | HS Differential Transmitter .....                                     | <a href="#">108</a> |
| 7.2.4.7   | CEA/MCPC/UART Driver .....  | <a href="#">109</a> |
| 7.2.4.8   | Pullup/Pulldown Resistors .....                                       | <a href="#">110</a> |
| 7.2.4.9   | PHY DPLL Electrical Characteristics .....                             | <a href="#">110</a> |
| 7.2.4.10  | PHY Power Consumption .....   | <a href="#">111</a> |
| 7.2.5     | OTG Electrical Characteristics .....                                  | <a href="#">111</a> |
| 7.2.5.1   | OTG VBUS Electrical .....   | <a href="#">112</a> |
| 7.2.5.2   | OTG ID Electrical .....   | <a href="#">112</a> |
| <b>8</b>  | <b>Battery Interface .....</b>  | <a href="#">114</a> |
| 8.1       | General Description .....   | <a href="#">114</a> |
| 8.1.1     | Battery Charger Interface Overview .....                              | <a href="#">114</a> |
| 8.1.2     | Battery Backup Overview .....   | <a href="#">114</a> |
| 8.2       | Typical Application Schematics .....                                  | <a href="#">114</a> |
| 8.2.1     | Functional Configurations .....                                       | <a href="#">114</a> |
| 8.2.2     | In-Rush Current Limitation Schematic .....                            | <a href="#">115</a> |
| 8.2.3     | Configuration With BCI Not Used .....                                 | <a href="#">116</a> |
| 8.3       | Electrical Characteristics .....                                      | <a href="#">118</a> |
| 8.3.1     | Main Charge .....   | <a href="#">118</a> |
| 8.3.2     | Precharge .....   | <a href="#">121</a> |
| 8.3.3     | Constant Voltage Mode .....   | <a href="#">122</a> |
| 8.4       | Charge Sequence Timing Diagram .....                                  | <a href="#">124</a> |
| 8.5       | CEA Charger Type .....  | <a href="#">124</a> |
| <b>9</b>  | <b>MADC .....</b>   | <a href="#">126</a> |
| 9.1       | General Description .....   | <a href="#">126</a> |
| 9.2       | Main Electrical Characteristics .....                                 | <a href="#">126</a> |
| 9.3       | Channel Voltage Input Range .....                                     | <a href="#">127</a> |
| 9.3.1     | Sequence Conversion Time (Real-Time or Nonaborted Asynchronous) ..... | <a href="#">127</a> |
| <b>10</b> | <b>LED Drivers .....</b>  | <a href="#">129</a> |

|           |  |                     |
|-----------|--|---------------------|
| 10.1      | General Description .....                                      | <a href="#">129</a> |
| <b>11</b> | <b>Keyboard .....</b>  | <a href="#">130</a> |
| 11.1      | Keyboard Connection .....                                      | <a href="#">130</a> |
| <b>12</b> | <b>Clock Specifications .....</b>                              | <a href="#">131</a> |
| 12.1      | Features .....   | <a href="#">131</a> |
| 12.2      | Input Clock Specifications .....                               | <a href="#">132</a> |
| 12.2.1    | Clock Source Requirements .....                                | <a href="#">132</a> |
| 12.2.2    | High-Frequency Input Clock .....                               | <a href="#">132</a> |
| 12.2.3    | 32-kHz Input Clock .....                                       | <a href="#">135</a> |
| 12.2.3.1  | External Crystal Description .....                             | <a href="#">136</a> |
| 12.2.3.2  | External Clock Description .....                               | <a href="#">138</a> |
| 12.3      | Output Clock Specifications .....                              | <a href="#">140</a> |
| 12.3.1    | 32KCLKOUT Output Clock .....                                   | <a href="#">140</a> |
| 12.3.2    | HFCLKOUT Output Clock .....                                    | <a href="#">142</a> |
| 12.3.3    | Output Clock Stabilization Time .....                          | <a href="#">143</a> |
| <b>13</b> | <b>Timing Requirements and Switching Characteristics .....</b> | <a href="#">144</a> |
| 13.1      | Timing Parameters .....  | <a href="#">144</a> |
| 13.2      | Target Frequencies .....                                       | <a href="#">144</a> |
| 13.3      | I <sup>2</sup> C Timing .....                                  | <a href="#">145</a> |
| 13.4      | Audio Interface: TDM/I2S Protocol .....                        | <a href="#">146</a> |
| 13.4.1    | I2S Right- and Left-Justified Data Format .....                | <a href="#">146</a> |
| 13.4.2    | TDM Data Format .....  | <a href="#">148</a> |
| 13.5      | Voice/Bluetooth PCM Interfaces .....                           | <a href="#">149</a> |
| 13.6      | JTAG Interfaces .....  | <a href="#">151</a> |
| <b>14</b> | <b>Debouncing Time .....</b>                                   | <a href="#">153</a> |
| <b>15</b> | <b>External Components .....</b>                               | <a href="#">155</a> |
| <b>16</b> | <b>TPS65950 Package .....</b>                                  | <a href="#">160</a> |
| 16.1      | TPS65950 Standard Package Symbols .....                        | <a href="#">160</a> |
| 16.2      | Package Thermal Resistance Characteristics .....               | <a href="#">160</a> |
| 16.3      | Mechanical Data .....  | <a href="#">161</a> |
| 16.4      | ESD Specifications .....                                       | <a href="#">162</a> |
| <b>17</b> | <b>Glossary .....</b>  | <a href="#">163</a> |

## List of Figures

|      |  |                    |
|------|--|--------------------|
| 1-1  | TPS65950 Block Diagram.....  | <a href="#">13</a> |
| 2-1  | PBGA Bottom View .....   | <a href="#">14</a> |
| 4-1  | Power Provider Block Diagram .....   | <a href="#">33</a> |
| 4-2  | VDD1 dc-dc Regulator Efficiency .....  | <a href="#">36</a> |
| 4-3  | VDD1 dc-dc Application Schematic.....  | <a href="#">37</a> |
| 4-4  | VDD2 dc-dc Regulator Efficiency .....  | <a href="#">39</a> |
| 4-5  | VDD2 dc-dc Application Schematic.....  | <a href="#">40</a> |
| 4-6  | VIO dc-dc Regulator Efficiency in Active Mode .....  | <a href="#">42</a> |
| 4-7  | VIO dc-dc Application Schematic .....  | <a href="#">43</a> |
| 4-8  | Timings Before Sequence Start .....  | <a href="#">60</a> |
| 4-9  | Timings—OMAP2 Power-On Sequence .....  | <a href="#">61</a> |
| 4-10 | Timings—OMAP3 Power-On Sequence .....  | <a href="#">62</a> |
| 4-11 | Timings—Power On in Slave_C021_Generic Model .....   | <a href="#">63</a> |
| 4-12 | Power-Off Sequence in Master Modes .....   | <a href="#">64</a> |
| 6-1  | Audio/Voice Module Block Diagram .....   | <a href="#">67</a> |
| 6-2  | Earphone Amplifier.....  | <a href="#">67</a> |
| 6-3  | Earphone Speaker .....   | <a href="#">68</a> |
| 6-4  | 8- $\Omega$ Stereo Hands-Free Amplifiers .....   | <a href="#">68</a> |
| 6-5  | 8- $\Omega$ Stereo Hands-Free .....  | <a href="#">70</a> |
| 6-6  | Headset Amplifier .....  | <a href="#">70</a> |
| 6-7  | Headset 4-Wire Stereo Jack Without an External FET.....                                    | <a href="#">72</a> |
| 6-8  | Headset 4-Wire Stereo Jack With an External FET .....                                      | <a href="#">73</a> |
| 6-9  | Headset 5-Wire Stereo Jack .....   | <a href="#">74</a> |
| 6-10 | Headset 4-Wire Stereo Jack Optimized .....   | <a href="#">75</a> |
| 6-11 | Headset Pop-Noise Cancellation Diagram.....  | <a href="#">76</a> |
| 6-12 | Predriver for External Class D .....   | <a href="#">77</a> |
| 6-13 | Vibrator H-Bridge .....  | <a href="#">79</a> |
| 6-14 | Carkit Output Downlink Path Characteristics .....  | <a href="#">79</a> |
| 6-15 | Digital Audio Filter Downlink Path Characteristics .....                                   | <a href="#">80</a> |
| 6-16 | Digital Voice Filter Downlink Path Characteristics .....                                   | <a href="#">80</a> |
| 6-17 | Voice Downlink Frequency Response With $F_S = 8$ kHz.....                                  | <a href="#">81</a> |
| 6-18 | Voice Downlink Frequency Response With $F_S = 16$ kHz .....                                | <a href="#">82</a> |
| 6-19 | Analog and Digital Microphone Multiplexing .....   | <a href="#">85</a> |
| 6-20 | Analog Microphone Pseudodifferential .....   | <a href="#">87</a> |
| 6-21 | Analog Microphone Differential .....   | <a href="#">87</a> |
| 6-22 | Digital Microphone Bias Module Block Diagram .....   | <a href="#">88</a> |
| 6-23 | Digital Microphone Bias Module Timing Diagram.....   | <a href="#">89</a> |
| 6-24 | Silicon Microphone Module .....  | <a href="#">90</a> |
| 6-25 | Audio Auxiliary Input .....  | <a href="#">91</a> |
| 6-26 | Example of PDM Interface Circuitry .....   | <a href="#">92</a> |
| 6-27 | Uplink Amplifier .....   | <a href="#">93</a> |
| 6-28 | Carkit Input Uplink Path Characteristics .....   | <a href="#">93</a> |
| 6-29 | Digital Audio Filter Uplink Path Characteristics .....                                     | <a href="#">94</a> |
| 6-30 | Digital Audio Filter Uplink Path Characteristics .....                                     | <a href="#">95</a> |
| 6-31 | Voice Uplink Frequency Response With $F_S = 8$ kHz (Frequency Range 0 to 600 Hz) .....     | <a href="#">96</a> |
| 6-32 | Voice Uplink Frequency Response With $F_S = 8$ kHz (Frequency Range 3000 to 3600 Hz) ..... | <a href="#">96</a> |
| 6-33 | Voice Uplink Frequency Response With $F_S = 16$ kHz (Frequency Range 0 to 600 Hz) .....    | <a href="#">97</a> |

|       |   |                     |
|-------|---|---------------------|
| 6-34  | Voice Uplink Frequency Response With $F_S = 16$ kHz (Frequency Range 6200 to 7000 Hz) ..... | <a href="#">97</a>  |
| 7-1   | USB 2.0 PHY Overview .....  | <a href="#">99</a>  |
| 7-2   | USB System Application Schematic.....   | <a href="#">101</a> |
| 7-3   | MCPC UART and Handshake Mode Data Flow .....  | <a href="#">102</a> |
| 7-4   | MCPC UART and Handshake Mode Timings.....   | <a href="#">103</a> |
| 7-5   | USB-CEA Carkit UART Data Flow .....   | <a href="#">104</a> |
| 7-6   | USB-CEA Carkit UART Timing Parameters.....  | <a href="#">105</a> |
| 7-7   | HS USB Interface—Transmit and Receive Modes (ULPI 8-Bit) .....                              | <a href="#">105</a> |
| 8-1   | Typical Application Schematics .....  | <a href="#">115</a> |
| 8-2   | Typical Application Schematic (In-Rush Current Limitation) .....                            | <a href="#">116</a> |
| 8-3   | Typical Application Schematic (BCI Not Used) .....  | <a href="#">117</a> |
| 8-4   | Automatic Charge Sequence Timing Diagram.....   | <a href="#">124</a> |
| 9-1   | Conversion Sequence General Timing Diagram .....  | <a href="#">128</a> |
| 10-1  | LED Driver Block Diagram.....   | <a href="#">129</a> |
| 11-1  | Keyboard Connection .....   | <a href="#">130</a> |
| 12-1  | Clock Overview .....  | <a href="#">131</a> |
| 12-2  | HFCLKIN Clock Distribution .....  | <a href="#">133</a> |
| 12-3  | Example of Wired-OR Clock Request.....  | <a href="#">135</a> |
| 12-4  | HFCLKIN Squared Input Clock .....   | <a href="#">135</a> |
| 12-5  | 32-kHz Oscillator Block Diagram In Master Mode With Crystal .....                           | <a href="#">136</a> |
| 12-6  | 32-kHz Crystal Input.....   | <a href="#">137</a> |
| 12-7  | 32-kHz Oscillator Block Diagram Without Crystal Option 1 .....                              | <a href="#">139</a> |
| 12-8  | 32-kHz Oscillator Block Diagram Without Crystal Option 2 .....                              | <a href="#">139</a> |
| 12-9  | 32-kHz Oscillator in Bypass Mode Block Diagram Without Crystal Option 3 .....               | <a href="#">139</a> |
| 12-10 | 32-kHz Square- or Sine-Wave Input Clock.....  | <a href="#">140</a> |
| 12-11 | 32.768-kHz Clock Output Block Diagram.....  | <a href="#">141</a> |
| 12-12 | 32KCLKOUT Output Clock .....  | <a href="#">142</a> |
| 12-13 | HFCLKOUT Output Clock .....   | <a href="#">142</a> |
| 12-14 | 32KCLKOUT and HFCLKOUT Clock Stabilization Time .....                                       | <a href="#">143</a> |
| 12-15 | HFCLKOUT Behavior .....   | <a href="#">143</a> |
| 13-1  | I <sup>2</sup> C Interface—Transmit and Receive in Slave Mode .....                         | <a href="#">145</a> |
| 13-2  | I2S Interface—I2S Master Mode.....  | <a href="#">147</a> |
| 13-3  | I2S Interface—I2S Slave Mode .....  | <a href="#">147</a> |
| 13-4  | TDM Interface—TDM Master Mode .....   | <a href="#">148</a> |
| 13-5  | Voice/BT PCM Interface—Master Mode (Mode 1) .....   | <a href="#">150</a> |
| 13-6  | Voice PCM Interface—Slave Mode (Mode 1).....  | <a href="#">150</a> |
| 13-7  | JTAG Interface Timing .....   | <a href="#">152</a> |
| 14-1  | Debouncing Sequence Chronogram Example .....  | <a href="#">154</a> |
| 16-1  | Printed Device Reference .....  | <a href="#">160</a> |
| 16-2  | TPS65950 Mechanical Package Top View.....   | <a href="#">161</a> |
| 16-3  | Ball Size.....  | <a href="#">161</a> |

## List of Tables

|      |   |                    |
|------|---|--------------------|
| 2-1  | Ball Characteristics .....  | <a href="#">15</a> |
| 2-2  | Signal Description .....  | <a href="#">20</a> |
| 3-1  | Absolute Maximum Ratings .....  | <a href="#">27</a> |
| 3-2  | VBAT Min Required Per VBAT Ball and Associated Maximum Current .....                  | <a href="#">27</a> |
| 3-3  | Recommended Operating Maximum Ratings .....   | <a href="#">28</a> |
| 3-4  | Digital I/O Electrical Characteristics .....  | <a href="#">29</a> |
| 4-1  | Summary of the Power Providers .....  | <a href="#">34</a> |
| 4-2  | Part Names With Corresponding VDD1 Current Support .....                              | <a href="#">35</a> |
| 4-3  | VDD1 dc-dc Regulator Characteristics .....  | <a href="#">35</a> |
| 4-4  | VDD2 dc-dc Regulator Characteristics .....  | <a href="#">38</a> |
| 4-5  | VIO dc-dc Regulator Characteristics .....   | <a href="#">41</a> |
| 4-6  | VDAC LDO Regulator Characteristics .....  | <a href="#">44</a> |
| 4-7  | VPPLL1 LDO Regulator Characteristics .....  | <a href="#">45</a> |
| 4-8  | VPPLL2 LDO Regulator Characteristics .....  | <a href="#">46</a> |
| 4-9  | VMMC1 LDO Regulator Characteristics .....   | <a href="#">47</a> |
| 4-10 | VMMC2 LDO Regulator Characteristics .....   | <a href="#">48</a> |
| 4-11 | VSIM LDO Regulator Characteristics .....  | <a href="#">49</a> |
| 4-12 | VAUX1 LDO Regulator Characteristics .....   | <a href="#">50</a> |
| 4-13 | VAUX2 LDO Regulator Characteristics .....   | <a href="#">51</a> |
| 4-14 | VAUX3 LDO Regulator Characteristics .....   | <a href="#">52</a> |
| 4-15 | VAUX4 LDO Regulator Characteristics .....   | <a href="#">53</a> |
| 4-16 | Output Load Conditions .....  | <a href="#">54</a> |
| 4-17 | CP Characteristics .....  | <a href="#">54</a> |
| 4-18 | Voltage Reference Characteristics .....   | <a href="#">55</a> |
| 4-19 | Backup Battery Charger Characteristics .....  | <a href="#">56</a> |
| 4-20 | Battery Threshold Levels .....  | <a href="#">56</a> |
| 4-21 | VRRTC LDO Regulator Characteristics .....   | <a href="#">57</a> |
| 4-22 | Power Consumption .....   | <a href="#">58</a> |
| 4-23 | Regulator States Depending on Use Cases .....   | <a href="#">58</a> |
| 4-24 | BOOT Mode Description .....   | <a href="#">59</a> |
| 4-25 | C027.0 Mode Description .....   | <a href="#">59</a> |
| 4-26 | C021.M Mode Description .....   | <a href="#">59</a> |
| 5-1  | System States .....   | <a href="#">65</a> |
| 6-1  | Earphone Amplifier Output Characteristics .....                                       | <a href="#">67</a> |
| 6-2  | 8- $\Omega$ Stereo Hands-Free Output Characteristics .....                            | <a href="#">68</a> |
| 6-3  | Headset Output Characteristics .....  | <a href="#">70</a> |
| 6-4  | Output Characteristics of a Headset 4-Wire Stereo Jack Without an External FET .....  | <a href="#">72</a> |
| 6-5  | Output Characteristics of a Headset 4-Wire Stereo Jack With an External FET .....     | <a href="#">73</a> |
| 6-6  | Output Characteristics of a Headset 5-Wire Stereo Jack .....                          | <a href="#">74</a> |
| 6-7  | Headset Pop-Noise Characteristics .....   | <a href="#">76</a> |
| 6-8  | Predriver Output Characteristics .....  | <a href="#">77</a> |
| 6-9  | Vibrator H-Bridge Output Characteristics .....  | <a href="#">78</a> |
| 6-10 | MCPC and USB-CEA Carkit Audio Downlink Electrical Characteristics .....               | <a href="#">79</a> |
| 6-11 | Digital Audio Filter RX Electrical Characteristics .....                              | <a href="#">80</a> |
| 6-12 | Digital Voice Filter RX Electrical Characteristics With $F_S = 8$ kHz .....           | <a href="#">81</a> |
| 6-13 | Digital Voice Filter RX Electrical Characteristics With $F_S = 16$ kHz .....          | <a href="#">82</a> |
| 6-14 | Boost Electrical Characteristics Versus $F_S$ Frequency ( $F_S \leq 22.05$ kHz) ..... | <a href="#">83</a> |

|       |   |                     |
|-------|---|---------------------|
| 6-15  | Boost Electrical Characteristics Versus $F_S$ Frequency ( $F_S \geq 24$ kHz) .....                                    | <a href="#">83</a>  |
| 6-16  | Analog Microphone Bias Module Characteristics .....   | <a href="#">85</a>  |
| 6-17  | Characteristics of Analog Microphone Bias Module With a Bias Resistor .....   | <a href="#">86</a>  |
| 6-18  | Digital Microphone Bias Module Characteristics .....  | <a href="#">88</a>  |
| 6-19  | Digital Microphone Bias Module Characteristics (2) .....  | <a href="#">88</a>  |
| 6-20  | Silicon Microphone Module Characteristics .....   | <a href="#">90</a>  |
| 6-21  | Uplink Amplifier Characteristics .....  | <a href="#">93</a>  |
| 6-22  | MCPC and USB-CEA Carkit Audio Uplink Electrical Characteristics .....   | <a href="#">94</a>  |
| 6-23  | Digital Audio Filter TX Electrical Characteristics .....  | <a href="#">94</a>  |
| 6-24  | Digital Voice Filter TX Electrical Characteristics With $F_S = 8$ kHz .....   | <a href="#">96</a>  |
| 6-25  | Digital Voice Filter TX Electrical Characteristics With $F_S = 16$ kHz .....  | <a href="#">97</a>  |
| 7-1   | MCPC UART and Handshake Mode Timings .....  | <a href="#">102</a> |
| 7-2   | USB-CEA Carkit Interface Timing Parameters .....  | <a href="#">103</a> |
| 7-3   | USB-CEA Carkit UART Timing Parameters .....   | <a href="#">104</a> |
| 7-4   | HS USB Interface Timing Requirement Parameters .....  | <a href="#">105</a> |
| 7-5   | HS USB Interface Switching Requirement Parameters .....   | <a href="#">105</a> |
| 7-6   | 5V-Tolerant Electrical Summary .....  | <a href="#">106</a> |
| 7-7   | LS/FS Single-Ended Receivers .....  | <a href="#">106</a> |
| 7-8   | LS/FS Differential Receiver .....   | <a href="#">107</a> |
| 7-9   | LS/FS Differential Transmitter .....  | <a href="#">107</a> |
| 7-10  | HS Differential Receiver .....  | <a href="#">108</a> |
| 7-11  | HS Differential Transmitter .....   | <a href="#">109</a> |
| 7-12  | CEA/MCPC/UART Driver .....  | <a href="#">109</a> |
| 7-13  | Pullup/Pulldown Resistors .....   | <a href="#">110</a> |
| 7-14  | PHY DPLL Electrical Characteristics .....   | <a href="#">110</a> |
| 7-15  | PHY Power Consumption .....   | <a href="#">111</a> |
| 7-16  | OTG VBUS Electrical .....   | <a href="#">112</a> |
| 7-17  | OTG ID Electrical .....   | <a href="#">112</a> |
| 8-1   | Main Charge Electrical Characteristics<br>$V_{BAT} = 3.6$ V, $R_S = 0.22$ $\Omega$ , unless otherwise specified ..... | <a href="#">118</a> |
| 8-2   | Precharge Electrical Characteristics<br>$R_S = 0.22$ $\Omega$ , unless otherwise specified .....                      | <a href="#">121</a> |
| 8-3   | CV Mode Electrical Characteristics .....  | <a href="#">123</a> |
| 8-4   | Precharge Detection Characteristics .....   | <a href="#">124</a> |
| 8-5   | Main Charge Current Limit Indication .....  | <a href="#">125</a> |
| 9-1   | Electrical Characteristics .....  | <a href="#">126</a> |
| 9-2   | Analog Input Voltage Range .....  | <a href="#">127</a> |
| 9-3   | Sequence Conversion Timing Characteristics .....  | <a href="#">127</a> |
| 10-1  | Electrical Characteristics .....  | <a href="#">129</a> |
| 12-1  | TPS65950 Input Clock Source Requirements .....  | <a href="#">132</a> |
| 12-2  | HFCLKIN Input Clock Electrical Characteristics .....  | <a href="#">135</a> |
| 12-3  | HFCLKIN Square Input Clock Timing Requirements With Slicer in Bypass .....  | <a href="#">135</a> |
| 12-4  | Crystal Electrical Characteristics .....  | <a href="#">136</a> |
| 12-5  | Base Oscillator Switching Characteristics .....   | <a href="#">137</a> |
| 12-6  | 32-kHz Crystal Input Clock Timing Requirements .....  | <a href="#">137</a> |
| 12-7  | 32-kHz Input Square- or Sine-Wave Clock Source Electrical Characteristics .....                                       | <a href="#">140</a> |
| 12-8  | 32-kHz Square-Wave Input Clock Source Timing Requirements .....   | <a href="#">140</a> |
| 12-9  | 32KCLKOUT Output Clock Electrical Characteristics .....   | <a href="#">141</a> |
| 12-10 | 32KCLKOUT Output Clock Switching Characteristics .....  | <a href="#">141</a> |

|       |   |                     |
|-------|---|---------------------|
| 12-11 | HFCLKOUT Output Clock Electrical Characteristics .....      | <a href="#">142</a> |
| 12-12 | HFCLKOUT Output Clock Switching Characteristics .....       | <a href="#">142</a> |
| 13-1  | Timing Parameters .....                                     | <a href="#">144</a> |
| 13-2  | TPS65950 Interface Target Frequencies .....                 | <a href="#">144</a> |
| 13-3  | I <sup>2</sup> C Interface Timing Requirements .....        | <a href="#">145</a> |
| 13-4  | I <sup>2</sup> C Interface Switching Requirements .....     | <a href="#">146</a> |
| 13-5  | I2S Interface—Timing Requirements.....                      | <a href="#">147</a> |
| 13-6  | I2S Interface—Switching Characteristics .....               | <a href="#">148</a> |
| 13-7  | TDM Interface Master Mode Timing Requirements .....         | <a href="#">148</a> |
| 13-8  | TDM Interface Master Mode Switching Characteristics .....   | <a href="#">149</a> |
| 13-9  | Voice PCM Interface Timing Requirements (Mode 1) .....      | <a href="#">150</a> |
| 13-10 | Voice PCM Interface Switching Characteristics (Mode 1)..... | <a href="#">150</a> |
| 13-11 | JTAG Interface Timing Requirements.....                     | <a href="#">152</a> |
| 13-12 | JTAG Interface Switching Characteristics .....              | <a href="#">152</a> |
| 14-1  | Debouncing Time .....                                       | <a href="#">153</a> |
| 15-1  | TPS65950 External Components.....                           | <a href="#">155</a> |
| 16-1  | TPS65950 Nomenclature Description.....                      | <a href="#">160</a> |
| 16-2  | TPS65950 Thermal Resistance Characteristics .....           | <a href="#">160</a> |

## Integrated Power Management/Audio Codec

Check for Samples: [TPS65950](#)

### 1 Introduction

The TPS65950 device is a highly integrated power-management and audio coder/decoder (codec) integrated circuit (IC) that supports the power and peripheral requirements of the OMAP™ application processors. The device contains power management, an audio codec, a universal serial bus (USB) high-speed (HS) transceiver, an ac/USB charger, light-emitting diode (LED) drivers, an analog-to-digital converter (ADC), a real-time clock (RTC), and embedded power control.

The power portion of the device contains three buck converters, two controllable by a dedicated SmartReflex™ class-3 interface, multiple low-dropout (LDO) regulators, an embedded power controller (EPC) to manage the power-sequencing requirements of OMAP, and an RTC and backup module. The RTC can be powered by a backup battery when the main supply is not present, and the device contains a coin-cell charger to recharge the backup battery as needed.

The USB module provides a HS 2.0 on-the-go (OTG) transceiver suitable for direct connection to the OMAP universal transceiver macrocell interface (UTMI) + low pin interface (ULPI) with an integrated charge pump (CP) and full support for the carkit Consumer Electronics Association (CEA)-936A specification.

The Li-ion battery charger supports charging from ac chargers, USB host devices, USB chargers, or carkits. The type of charger is detected automatically by the device, which provides hardware-controlled linear charging with ac chargers, USB chargers, and carkits, in addition to software-controlled charging for all charger types.

The audio codec in the device includes five digital-to-analog converters (DACs) and two ADCs to provide multiple voice channels and stereo downlink channels that can support all standard audio sample rates through several inter-IC sound (I2S™)/time division multiplexing (TDM) format interfaces. The audio output stages on the device include stereo headset amplifiers, two integrated class-D amplifiers providing stereo differential outputs, predrivers for line outputs, and an earpiece amplifier. The input audio stages include three differential microphone inputs, stereo line inputs, and interface for digital microphones. Automatic and programmable gain control is available with all necessary digital filtering, side-tone functions, and pop-noise reduction.

The device also provides auxiliary modules, including LED drivers, and ADC, keypad interface, and general-purpose inputs/outputs (GPIOs). The LED driver can power two LED circuits to illuminate a panel or provide user indicators. The drivers also provide pulse width modulation (PWM) circuits to control the illumination levels of the LEDs. The ADC monitors signals entering the device, such as supply and charging voltages, and has multiple additional external ADC inputs for system use. The keypad interface implements a built-in scanning algorithm to decode hardware-based key presses and to reduce software use, with multiple additional GPIOs that can be used as interrupts when they are configured as inputs.

This TPS65950 Data Manual describes the electrical and mechanical specifications for the TPS65950. It covers the following topics:

- TPS65950 terminals: Assignment, multiplexing, electrical characteristics, and functional description (see [Section 2, Terminal Description](#))
- Electrical characteristic requirements: Maximum and recommended operating conditions, digital input/output (I/O) characteristics (see [Section 3, Electrical Characteristics](#))
- Power module, including the power provider, power references, power control, power consumption, and power management with the on and off sequences (see [Section 4, Power Module](#))
- RTC and EPC (see [Section 5, Real-Time Clock and Embedded Power Controller](#))
- Audio/voice module with the electrical characteristics and the application schematics for the downlink and uplink paths (see [Section 6, Audio/Voice Module](#))

- Battery charger interface (see [Section 8, Battery Interface](#))
- Various modules: Monitoring analog-to-digital conversion (MADC), LED drivers, and keyboard (see [Section 9, MADC](#), [Section 10, LED Drivers](#), and [Section 11, Keyboard](#))
- Clock specifications: Clock slicer, input and output clocks (see [Section 12, Clock Specifications](#))
- Timing requirements and switching characteristics (ac timings) of the interfaces (see [Section 13, Timing Requirements and Switching Characteristics](#))
- Debouncing time (see [Section 14, Debouncing Time](#))
- External components for the application schematics (see [Section 15, External Components](#))
- Thermal resistance characteristics, device nomenclature, and mechanical data about the available packaging (see [Section 16, TPS65950 Package](#))
- Glossary of acronyms and abbreviations used in this data manual (see [Section 17, Glossary](#))

## 1.1 Features

- Power:
  - Three efficient stepdown converters
    - VDD1: TPS65950A2 with 1.2A and TPS65950A3 with 1.4A (for 1GHz speed)
    - VDD2: 600mA
    - VIO: 700mA
  - 10 external linear LDOs for clocks and peripherals
  - SmartReflex dynamic voltage management
- Audio:
  - Voice codec
  - 15-bit linear codec (8 and 16 kHz)
  - Differential input main and submicrophones
  - Differential headset microphone input
  - Auxiliary/FM input (mono or stereo)
  - Differential 32- $\Omega$  speaker and 16- $\Omega$  headset drivers (external predrivers for class D)
  - 8- $\Omega$  stereo class-D drivers
  - Pulse code modulation (PCM) and TDM interfaces
  - Bluetooth® interface
  - Automatic level control (ALC)
  - Digital and analog mixing
  - 16-bit linear audio stereo DAC (96, 48, 44.1, and 32 kHz, and derivatives)
  - 16-bit linear audio stereo ADC (48, 44.1, and 32 kHz, and derivatives)
  - Digital microphone inputs
  - Carkit
- Charger:
  - Li-ion, Li-on polymer, and cobalt-nickel-manganese charger
  - Supports charging with ac-regulated charger (maximum 7 V), USB host devices, Mobile Computing Promotion Consortium (MCPC) devices, USB chargers, and carkit chargers (maximum 7 V)
  - Backup battery charger
- USB:
  - USB 2.0 OTG-compliant HS transceivers
  - 12-bit ULPI
  - USB power supply (5-V CP for VBUS)
  - CEA-2011: OTG transceiver interface specification
  - CEA-936A: Mini-USB analog carkit interface specification
  - MCPC ME-universal asynchronous receiver/transmitter (UART) GL-006 specification
- Additional features:
  - LED driver circuit for two external LEDs
  - 10-bit MADC with 3 to 8 external inputs
  - RTC and retention modules
  - HS inter-integrated circuit ( $I^2C$ ™) serial control
  - Thermal shutdown and hot-die detection
  - Keypad interface (up to 8 × 8)
  - External vibrator (vibrator) control
  - 19 GPIO devices
  - 0.4-mm pitch, 209 pin, 7 × 7 mm package



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## 1.2 TPS65950 Block Diagram

Figure 1-1 is a block diagram of the TPS65950.

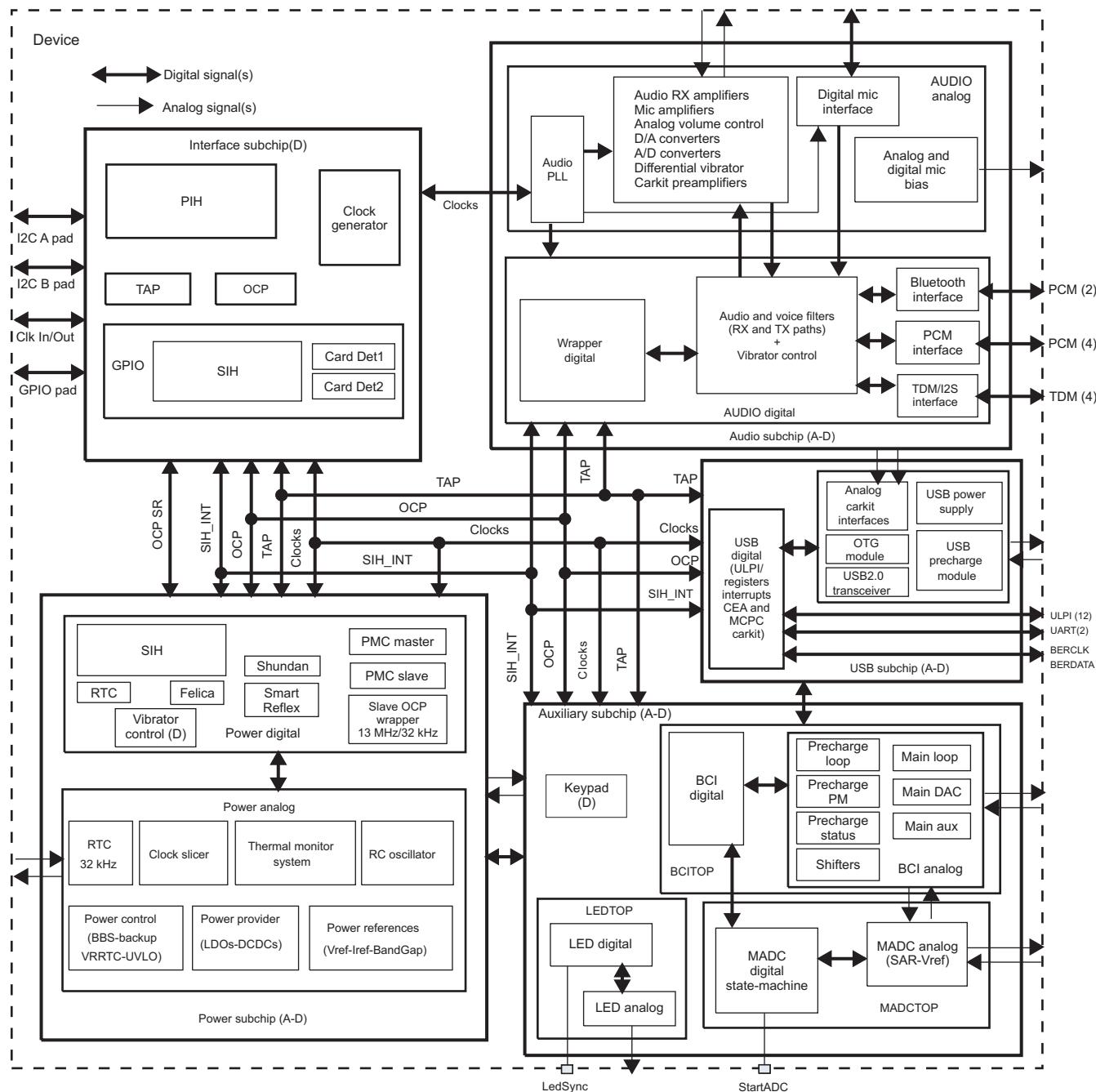
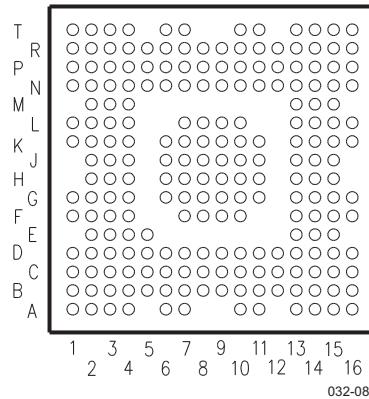


Figure 1-1. TPS65950 Block Diagram

032-003

## 2 Terminal Description

Figure 2-1 shows the ball locations for the 209-ball plastic ball grid array (PBGA) package and is used with Table 2-1 to locate signal names and ball grid numbers.



**Figure 2-1. PBGA Bottom View**

### 2.1 Corner Balls

The four corner balls (see the following list) are not usable for functional pins:

- Test
- TestV1
- Test.RESET
- TestV2

The eight corner adjacent balls are:

- RFID.EN
- UART1.TXD
- JTAG.TDI/BERDATA
- JTAG.CLK/BERCLK
- PCM.VFS
- PCM.VDX
- PCM.VDR
- PCM.VCK

## 2.2 Ball Characteristics

**Table 2-1** describes the terminal characteristics and the signals multiplexed on each pin. The following list describes the column headings in **Table 2-1**:

1. Ball: Ball number(s) associated with each signal(s)
2. Pin Name: Names of all the signals that are multiplexed on each ball
3. A/D: Analog or digital signal
4. Type: Terminal type when a particular signal is multiplexed on the terminal
  - I = Input
  - O = Output
  - OD = Open drain
5. Reference Level: Voltage applied to the I/O cell (see the power module and battery charger interface [BCI] chapters for values).
6. PU/PD: Denotes the presence of an internal pullup or pulldown. Pullups and pulldowns can be enabled or disabled through software.
7. Min = Minimum value
8. Typ = Typical value
9. Max = Maximum value
10. Buffer Strength: Drive strength of the associated output buffer

**Table 2-1. Ball Characteristics**

| Ball[1] | Pin Name[2] | A/D [3] | Type[4] | Reference Level RL[5] | PU[6] (kΩ) |        |        | PD[6] (kΩ) |     |     | Buffer Strength (mA)[10] |
|---------|-------------|---------|---------|-----------------------|------------|--------|--------|------------|-----|-----|--------------------------|
|         |             |         |         |                       | Min[7]     | Typ[8] | Max[9] | Min        | Typ | Max |                          |
| H4      | ADCIN0      | A       | I/O     | VINTANA1.OUT          |            |        |        |            |     |     |                          |
| J3      | ADCIN1      | A       | I/O     | VINTANA1.OUT          |            |        |        |            |     |     |                          |
| G3      | ADCIN2      | A       | I       | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| P5      | VCCS        | A       | I       | VBAT + 0.2            |            |        |        |            |     |     |                          |
| N5      | VAC         | A       | Power   | VACCHARGER            |            |        |        |            |     |     |                          |
| P4      | VBATS       | A       | I       | VBAT                  |            |        |        |            |     |     |                          |
| N4      | PCHGAC      | A       | I       | VACCHARGER            |            |        |        |            |     |     |                          |
| N6      | PCHGUSB     | A       | I       | VBUS                  |            |        |        |            |     |     |                          |
| N2      | VPRECH      | A       | O       | VPRECH                |            |        |        |            |     |     |                          |
| N1      | BCIAUTO     | A       | I       | VPRECH                |            |        |        |            |     |     |                          |
| P6      | ICTLUSB1    | A       | O       | VBUS                  |            |        |        |            |     |     |                          |
| P1      | ICTLUSB2    | A       | O       | VCCS                  |            |        |        |            |     |     |                          |
| N7      | ICTLAC1     | A       | O       | VACCHARGER            |            |        |        |            |     |     |                          |
| P2      | ICTLAC2     | A       | O       | VCCS                  |            |        |        |            |     |     |                          |
| R5      | VBAT        | A       | Power   | VBAT                  |            |        |        |            |     |     |                          |
| P12     | GPIO0/CD1   | D       | I/O     | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 | 8                        |
|         | JTAG.TDO    | D       | I/O     | IO_1P8                |            |        |        |            |     |     | 8                        |
| N12     | GPIO1/CD2   | D       | I/O     | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 | 2                        |
|         | JTAG.TMS    | D       | I       | IO_1P8                |            |        |        |            |     |     |                          |
| L4      | GPIO2       | D       | I/O     | IO_1P8                | 156        | 220    | 450    | 59         | 100 | 144 | 2                        |
|         | Test1       | D       | I/O     | IO_1P8                |            |        |        |            |     |     | 2                        |
| P13     | GPIO15      | D       | I/O     | IO_1P8                | 156        | 220    | 450    | 59         | 100 | 144 | 2                        |
|         | Test2       | D       | I/O     | IO_1P8                |            |        |        |            |     |     | 2                        |
| M4      | GPIO6       | D       | I/O     | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 | 2                        |
|         | PWM0        | D       | O       | IO_1P8                |            |        |        |            |     |     | 4                        |
|         | Test3       | D       | I/O     | IO_1P8                |            |        |        |            |     |     | 2                        |

Table 2-1. Ball Characteristics (continued)

| Ball[1] | Pin Name[2]             | A/D [3] | Type[4]   | Reference Level RL[5] | PU[6] (kΩ) |        |        | PD[6] (kΩ) |     |     | Buffer Strength (mA)[10] |
|---------|-------------------------|---------|-----------|-----------------------|------------|--------|--------|------------|-----|-----|--------------------------|
|         |                         |         |           |                       | Min[7]     | Typ[8] | Max[9] | Min        | Typ | Max |                          |
| N14     | GPIO7                   | D       | I/O       | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 | 2                        |
|         | VIBRA.SYNC              | D       | I         | IO_1P8                |            |        |        |            |     |     |                          |
|         | PWM1                    | D       | O         | IO_1P8                |            |        |        |            |     |     | 4                        |
|         | Test4                   | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 2                        |
| J9      | START.ADC               | D       | I         | IO_1P8                |            |        |        |            |     |     |                          |
| C13     | SYSEN                   | D       | OD/I      | IO_1P8                | 4.7        | 7.35   | 10     |            |     |     | 2                        |
| C6      | CLKEN                   | D       | O         | IO_1P8                |            |        |        |            |     |     | 2                        |
| D7      | CLKEN2                  | D       | O         | IO_1P8                |            |        |        |            |     |     | 2                        |
| G10     | CLKREQ                  | D       | I         | IO_1P8                |            |        |        | 60         | 100 | 146 |                          |
| F10     | INT1                    | D       | O         | IO_1P8                |            |        |        |            |     |     | 2                        |
| F9      | INT2                    | D       | O         | IO_1P8                |            |        |        |            |     |     | 2                        |
| A13     | NRESPWRON               | D       | O         | IO_1P8                |            |        |        |            |     |     | 2                        |
| B13     | NRRESPWARM              | D       | I         | IO_1P8                |            |        |        |            |     |     | 2                        |
| A11     | PWRON                   | D       | I         | VBAT                  |            |        |        |            |     |     |                          |
| B14     | NC                      |         |           |                       |            |        |        |            |     |     |                          |
| P7      | NSLEEP1                 | D       | I         | IO_1P8                |            |        |        |            |     |     |                          |
| G9      | NSLEEP2                 | D       | I         | IO_1P8                |            |        |        |            |     |     |                          |
| D13     | CLK256FS <sup>(1)</sup> | D       | O         | IO_1P8                |            |        |        |            |     |     | 2                        |
| F8      | VMODE1                  | D       | I         | IO_1P8                |            |        |        |            |     |     |                          |
| K11     | BOOT0                   | A/D     | I/O       | VBAT                  |            |        |        |            |     |     |                          |
| J11     | BOOT1                   | A/D     | I/O       | VBAT                  |            |        |        |            |     |     |                          |
| A10     | REGEN                   | D       | OD        | VBAT                  | 5.5        | 8      | 12     |            |     |     | 2                        |
| H8      | MSECURE                 | D       | I         | IO_1P8                |            |        |        |            |     |     |                          |
| N16     | VREF                    | A       | Power     | VREF                  |            |        |        |            |     |     |                          |
| N15     | AGND                    | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| C4      | NC                      |         |           |                       |            |        |        |            |     |     |                          |
|         | I2C.SR.SDA              | D       | I/O       | IO_1P8                | 2.5        |        | 3.4    |            |     |     | 12                       |
| D6      | VMODE2                  | D       | I         | IO_1P8                |            |        |        |            |     |     | 2                        |
|         | I2C.SR.SCL              | D       | I/O       | IO_1P8                | 2.5        |        | 3.4    |            |     |     | 12                       |
| D4      | I2C.CNTL.SDA            | D       | I/O       | IO_1P8                | 2.5        |        | 3.4    |            |     |     | 12                       |
| D5      | I2C.CNTL.SCL            | D       | I         | IO_1P8                | 2.5        |        | 3.4    |            |     |     | 12                       |
| R1      | PCM.VCK                 | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 2                        |
| T2      | PCM.VDR                 | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 2                        |
| T15     | PCM.VDX                 | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 2                        |
| R16     | PCM.VFS                 | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 2                        |
| L3      | I2S.CLK                 | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 2                        |
| K6      | I2S.SYNC                | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 2                        |
| K4      | I2S.DIN                 | D       | I         | IO_1P8                |            |        |        |            |     |     | 2                        |
| K3      | I2S.DOUT                | D       | O         | IO_1P8                |            |        |        |            |     |     | 2                        |
| E2      | MIC.MAIN.P              | A       | I         | MICBIAS1.OUT          |            |        |        |            |     |     |                          |
| F2      | MIC.MAIN.M              | A       | I         | MICBIAS1.OUT          |            |        |        |            |     |     |                          |
| G2      | MIC.SUB.P               | A       | I         | MICBIAS2.OUT          |            |        |        |            |     |     |                          |
|         | DIG.MIC.0               | A       | I         | VMIC1.OUT             |            |        |        |            |     |     |                          |
| H2      | MIC.SUB.M               | A       | I         | MICBIAS2.OUT          |            |        |        |            |     |     |                          |
|         | DIG.MIC.1               | A       | I         | VMIC2.OUT             |            |        |        |            |     |     |                          |
| E3      | HSMIC.P                 | A       | I         | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| F3      | HSMIC.M                 | A       | I         | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| D10     | VBAT.LEFT               | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| D9      | VBAT.LEFT               | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| B9      | IHF.LEFT.P              | A       | O         | VBAT                  |            |        |        |            |     |     |                          |
| B10     | IHF.LEFT.M              | A       | O         | VBAT                  |            |        |        |            |     |     |                          |
| C10     | GND.LEFT                | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| C9      | GND.LEFT                | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| D12     | VBAT.RIGHT              | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |

(1) To avoid reflection on this pin caused by impedance mismatch, a serial resistance (Rs) of 33 Ω must be added.

**Table 2-1. Ball Characteristics (continued)**

| Ball[1]                   | Pin Name[2]                        | A/D [3] | Type[4]     | Reference Level RL[5] | PU[6] (kΩ) |        |        | PD[6] (kΩ) |     |     | Buffer Strength (mA)[10] |
|---------------------------|------------------------------------|---------|-------------|-----------------------|------------|--------|--------|------------|-----|-----|--------------------------|
|                           |                                    |         |             |                       | Min[7]     | Typ[8] | Max[9] | Min        | Typ | Max |                          |
| D11                       | VBAT.RIGHT                         | A       | Power       | VBAT                  |            |        |        |            |     |     |                          |
| B11                       | IHF.RIGHT.P                        | A       | O           | VBAT                  |            |        |        |            |     |     |                          |
| B12                       | IHF.RIGHT.M                        | A       | O           | VBAT                  |            |        |        |            |     |     |                          |
| C12                       | GND.RIGHT                          | A       | Power GND   | GND                   |            |        |        |            |     |     |                          |
| C11                       | GND.RIGHT                          | A       | Power GND   | GND                   |            |        |        |            |     |     |                          |
| A6                        | EAR.P                              | A       | O           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| A7                        | EAR.M                              | A       | O           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| B4                        | HSOL                               | A       | O           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| B7                        | PreDrv.LEFT                        | A       | O           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
|                           | VMID                               | A       | Power       | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| B5                        | HSOR                               | A       | O           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| B8                        | PreDrv.RIGHT                       | A       | O           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
|                           | ADCIN7                             | A       | I           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| F1                        | AUXL                               | A       | I           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| G1                        | AUXR                               | A       | I           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| D1                        | MICBIAS1.OUT                       | A       | Power       | VINTANA2.OUT          |            |        |        |            |     |     |                          |
|                           | VMIC1.OUT                          | A       | Power       | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| D2                        | MICBIAS2.OUT                       | A       | Power       | VINTANA2.OUT          |            |        |        |            |     |     |                          |
|                           | VMIC2.OUT                          | A       | Power       | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| E4                        | VHSMIC.OUT                         | A       | Power       | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| D3                        | MICBIAS.GND                        |         | Power GND   | GND                   |            |        |        |            |     |     |                          |
| J4 / J6 / J7 /<br>J8 / E5 | AVSS1                              | A       | Power GND   | GND                   |            |        |        |            |     |     |                          |
| R10                       | AVSS2                              | A       | Power GND   | GND                   |            |        |        |            |     |     |                          |
| M15                       | AVSS3                              | A       | Power GND   | GND                   |            |        |        |            |     |     |                          |
| C7                        | AVSS4                              | A       | Power GND   | GND                   |            |        |        |            |     |     |                          |
| B1                        | UART1.TXD                          | D       | OD          | External 1.8 to 3.3 V |            |        |        |            |     |     | 2                        |
| D8                        | GPIO8                              | D       | I           | IO_1P8                | 4.7        | 7.4    | 10     | 5.9        | 7   | 8.3 |                          |
|                           | UART1.RXD                          | D       | I           | IO_1P8                |            |        |        |            |     |     |                          |
| N11                       | RTSO/<br>CLK64K.OUT/<br>BERCLK.OUT | D       | OD          | VUSB.3P1              |            |        |        |            |     |     | 2                        |
|                           | ADCIN5                             | A       | I           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| P11                       | CTS/BERDATA.OUT                    | D       | OD/CMOS/I/O | VUSB.3P1              | 4.7        | 7.4    | 10     |            |     |     | 2                        |
|                           | ADCIN3                             | A       | I           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| N8                        | TXAF                               | A       | I           | VUSB.3P1              |            |        |        |            |     |     |                          |
|                           | ADCIN4                             | A       | I           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| N9                        | RXAF                               | A       | O           | VUSB.3P1              |            |        |        |            |     |     |                          |
|                           | ADCIN6                             | A       | I           | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| L10                       | MANU                               | D       | I           | VUSB.3P1              | 162        | 280    | 414    |            |     |     |                          |
| N10                       | 32KCLKOUT                          | D       | O           | IO_1P8                |            |        |        |            |     |     |                          |
| P16                       | 32KXIN                             | A       | I           | IO_1P8                |            |        |        |            |     |     |                          |
| P15                       | 32KXOUT                            | A       | O           | IO_1P8                |            |        |        |            |     |     |                          |
| A14                       | HFCLKIN                            | A       | I           | IO_1P8                |            |        |        |            |     |     |                          |
| R12                       | HFCLKOUT                           | D       | O           | IO_1P8                |            |        |        |            |     |     |                          |
| R8                        | VBUS                               | A       | Power       | VBUS                  |            |        |        |            |     |     |                          |
| T10                       | DP/UART3.RXD                       | A       | I/O         | VBUS                  |            |        |        |            |     |     | 2                        |
| T11                       | DN/UART3.TXD                       | A       | I/O         | VBUS                  |            |        |        |            |     |     | 2                        |
| R11                       | ID                                 | A       | I/O         | VBUS                  |            |        |        |            |     |     | 2                        |
| L15                       | UCLK                               | D       | I           | IO_1P8                |            |        |        |            |     |     | 16                       |
| L14                       | STP                                | D       | I           | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 | 16                       |
|                           | GPIO9                              | D       | I/O         | IO_1P8                |            |        |        |            |     |     | 2                        |
| L13                       | DIR                                | D       | O           | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 | 16                       |
|                           | GPIO10                             | D       | I/O         | IO_1P8                |            |        |        |            |     |     | 2                        |

Table 2-1. Ball Characteristics (continued)

| Ball[1] | Pin Name[2]      | A/D [3] | Type[4]   | Reference Level RL[5] | PU[6] (kΩ) |        |        | PD[6] (kΩ) |     |     | Buffer Strength (mA)[10] |
|---------|------------------|---------|-----------|-----------------------|------------|--------|--------|------------|-----|-----|--------------------------|
|         |                  |         |           |                       | Min[7]     | Typ[8] | Max[9] | Min        | Typ | Max |                          |
| M13     | NXT              | D       | O         | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 | 16                       |
|         | GPIO11           | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 2                        |
| K14     | DATA0            | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 16                       |
|         | UART4.TXD        | D       | I         | IO_1P8                |            |        |        |            |     |     |                          |
| K13     | DATA1            | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 16                       |
|         | UART4.RXD        | D       | O         | IO_1P8                |            |        |        |            |     |     | 2                        |
| J14     | DATA2            | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 16                       |
|         | UART4.RTSI       | D       | I         | IO_1P8                |            |        |        |            |     |     |                          |
| J13     | DATA3            | D       | I/O       | IO_1P8                | 60         | 100    | 140    | 60         | 100 | 140 | 16                       |
|         | UART4.CTSO       | D       | O         | IO_1P8                |            |        |        |            |     |     | 16                       |
|         | GPIO12           | D       | I/O       | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 | 16                       |
| G14     | DATA4            | D       | I/O       | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 | 16                       |
|         | GPIO14           | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 2                        |
| G13     | DATA5            | D       | I/O       | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 | 16                       |
|         | GPIO3            | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 2                        |
| F14     | DATA6            | D       | I/O       | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 | 16                       |
|         | GPIO4            | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 2                        |
| F13     | DATA7            | D       | I/O       | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 | 16                       |
|         | GPIO5            | D       | I/O       | IO_1P8                |            |        |        |            |     |     | 2                        |
| T16     | TEST.RESET       | A/D     | I         | VBAT                  |            |        |        | 30         | 50  | 70  |                          |
| T1      | TESTV1           | A       | I/O       | VBAT                  |            |        |        |            |     |     |                          |
| A16     | TESTV2           | A       | I/O       | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| A1      | TEST             | D       | I         | IO_1P8                |            |        |        | 60         | 100 | 146 |                          |
| A15     | JTAG.TDI/BERDATA | D       | I         | IO_1P8                |            |        |        |            |     |     |                          |
| B16     | JTAG.TCK/BERCLK  | D       | I         | IO_1P8                |            |        |        |            |     |     |                          |
| R7      | CP.IN            | A       | Power     | VBAT/VBUS             |            |        |        |            |     |     |                          |
| T7      | CP.CAPP          | A       | O         | CP.CAPP               |            |        |        |            |     |     |                          |
| T6      | CP.CAPM          | A       | O         | CP.CAPM               |            |        |        |            |     |     |                          |
| R6      | CP.GND           | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| R9      | VBAT.USB         | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| P9      | VUSB.3P1         | A       | Power     | VUSB.3P1              |            |        |        |            |     |     |                          |
| L1      | VAUX12S.IN       | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| M2      | VAUX1.OUT        | A       | Power     | VAUX1.OUT             |            |        |        |            |     |     |                          |
| M3      | VAUX2.OUT        | A       | Power     | VAUX2.OUT             |            |        |        |            |     |     |                          |
| H15     | VPLL13R.IN       | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| K16     | VRTC.OUT         | A       | Power     | VRTC.OUT              |            |        |        |            |     |     |                          |
| H14     | VPLL1.OUT        | A       | Power     | VPLL1.OUT             |            |        |        |            |     |     |                          |
| J15     | VSDI.CSI.OUT     | A       | Power     | VSDI.CSI.OUT          |            |        |        |            |     |     |                          |
| G16     | VAUX3.OUT        | A       | Power     | VAUX3.OUT             |            |        |        |            |     |     |                          |
| B2      | VAUX4.IN         | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| B3      | VAUX4.OUT        | A       | Power     | VAUX4.OUT             |            |        |        |            |     |     |                          |
| C1      | VMMC1.IN         | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| C2      | VMMC1.OUT        | A       | Power     | VMMC1.OUT             |            |        |        |            |     |     |                          |
| A3      | VMMC2.IN         | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| A4      | VMMC2.OUT        | A       | Power     | VMMC2.OUT             |            |        |        |            |     |     |                          |
| K2      | VSIM.OUT         | A       | Power     | VSIM.OUT              |            |        |        |            |     |     |                          |
| P8      | VINTUSB1P5.OUT   | A       | Power     | VINTUSB1P5.OUT        |            |        |        |            |     |     |                          |
| P10     | VINTUSB1P8.OUT   | A       | Power     | VINTUSB1P8.OUT        |            |        |        |            |     |     |                          |
| K1      | VDAC.IN          | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| L2      | VDAC.OUT         | A       | Power     | VDAC.OUT              |            |        |        |            |     |     |                          |
| K15     | VINT.IN          | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| H3      | VINTANA1.OUT     | A       | Power     | VINTANA1.OUT          |            |        |        |            |     |     |                          |

**Table 2-1. Ball Characteristics (continued)**

| Ball[1]                 | Pin Name[2]  | A/D [3] | Type[4]   | Reference Level RL[5] | PU[6] (kΩ) |        |        | PD[6] (kΩ) |     |     | Buffer Strength (mA)[10] |
|-------------------------|--------------|---------|-----------|-----------------------|------------|--------|--------|------------|-----|-----|--------------------------|
|                         |              |         |           |                       | Min[7]     | Typ[8] | Max[9] | Min        | Typ | Max |                          |
| J2                      | VINTANA2.OUT | A       | Power     | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| B6                      | VINTANA2.OUT | A       | Power     | VINTANA2.OUT          |            |        |        |            |     |     |                          |
| L16                     | VINTDIG.OUT  | A       | Power     | VINTDIG.OUT           |            |        |        |            |     |     |                          |
| E15                     | VDD1.IN      | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| E14                     | VDD1.IN      | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| D14                     | VDD1.IN      | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| D16                     | VDD1.SW      | A       | O         | VBAT                  |            |        |        |            |     |     |                          |
| D15                     | VDD1.SW      | A       | O         | VBAT                  |            |        |        |            |     |     |                          |
| C14                     | VDD1.SW      | A       | O         | VBAT                  |            |        |        |            |     |     |                          |
| E13                     | VDD1.FB      | A       | I         |                       |            |        |        |            |     |     |                          |
| C16                     | VDD1.GND     | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| C15                     | VDD1.GND     | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| B15                     | VDD1.GND     | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| R13                     | VDD2.IN      | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| P14                     | VDD2.IN      | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| N13                     | VDD2.FB      | A       | I         |                       |            |        |        |            |     |     |                          |
| T13                     | VDD2.SW      | A       | O         | VBAT                  |            |        |        |            |     |     |                          |
| R14                     | VDD2.SW      | A       | O         | VBAT                  |            |        |        |            |     |     |                          |
| T14                     | VDD2.GND     | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| R15                     | VDD2.GND     | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| P3                      | VIO.IN       | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| R4                      | VIO.IN       | A       | Power     | VBAT                  |            |        |        |            |     |     |                          |
| N3                      | VIO.FB       | A       | I         |                       |            |        |        |            |     |     |                          |
| R3                      | VIO.SW       | A       | O         | VBAT                  |            |        |        |            |     |     |                          |
| T4                      | VIO.SW       | A       | O         | VBAT                  |            |        |        |            |     |     |                          |
| R2                      | VIO.GND      | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| T3                      | VIO.GND      | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| M14                     | BKBAT        | A       | Power     | VBACK                 |            |        |        |            |     |     |                          |
| C8                      | IO_1P8       | A       | Power     | IO_1P8                |            |        |        |            |     |     |                          |
| H13 / H9 /<br>H10 / H11 | DGND         | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| F16                     | LEDGND       | A       | Power GND | GND                   |            |        |        |            |     |     |                          |
| G11                     | GPIO13       | D       | I/O       | IO_1P8                | 75         | 100    | 202    | 59         | 100 | 144 |                          |
|                         | LEDSYNC      | D       | I         | IO_1P8                |            |        |        |            |     |     |                          |
| F15                     | LEDA         | A       | OD        | VBAT                  |            |        |        |            |     |     |                          |
|                         | VIBRA.P      | A       | OD        | VBAT                  |            |        |        |            |     |     |                          |
| G15                     | LEDB         | A       | OD        | VBAT                  |            |        |        |            |     |     |                          |
|                         | VIBRA.M      | A       | OD        | VBAT                  |            |        |        |            |     |     |                          |
| G8                      | KPD.C0       | D       | OD        | IO_1P8                |            |        |        |            |     |     |                          |
| H7                      | KPD.C1       | D       | OD        | IO_1P8                |            |        |        |            |     |     |                          |
| G6                      | KPD.C2       | D       | OD        | IO_1P8                |            |        |        |            |     |     |                          |
| F7                      | KPD.C3       | D       | OD        | IO_1P8                |            |        |        |            |     |     |                          |
| G7                      | KPD.C4       | D       | OD        | IO_1P8                |            |        |        |            |     |     |                          |
| F4                      | KPD.C5       | D       | OD        | IO_1P8                |            |        |        |            |     |     |                          |
| H6                      | KPD.C6       | D       | OD        | IO_1P8                |            |        |        |            |     |     |                          |
| G4                      | KPD.C7       | D       | OD        | IO_1P8                |            |        |        |            |     |     |                          |
| K9                      | KPD.R0       | D       | I         | IO_1P8                | 8          | 10     | 12     |            |     |     |                          |
| K8                      | KPD.R1       | D       | I         | IO_1P8                | 8          | 10     | 12     |            |     |     |                          |
| L8                      | KPD.R2       | D       | I         | IO_1P8                | 8          | 10     | 12     |            |     |     |                          |
| K7                      | KPD.R3       | D       | I         | IO_1P8                | 8          | 10     | 12     |            |     |     |                          |
| L9                      | KPD.R4       | D       | I         | IO_1P8                | 8          | 10     | 12     |            |     |     |                          |
| J10                     | KPD.R5       | D       | I         | IO_1P8                | 8          | 10     | 12     |            |     |     |                          |
| K10                     | KPD.R6       | D       | I         | IO_1P8                | 8          | 10     | 12     |            |     |     |                          |
| L7                      | KPD.R7       | D       | I         | IO_1P8                | 8          | 10     | 12     |            |     |     |                          |

Table 2-1. Ball Characteristics (continued)

| Ball <sup>[1]</sup> | Pin Name <sup>[2]</sup> | A/D <sup>[3]</sup> | Type <sup>[4]</sup> | Reference Level RL <sup>[5]</sup> | PU <sup>[6]</sup> (kΩ) |                    |                    | PD <sup>[6]</sup> (kΩ) |     |     | Buffer Strength (mA) <sup>[10]</sup> |
|---------------------|-------------------------|--------------------|---------------------|-----------------------------------|------------------------|--------------------|--------------------|------------------------|-----|-----|--------------------------------------|
|                     |                         |                    |                     |                                   | Min <sup>[7]</sup>     | Typ <sup>[8]</sup> | Max <sup>[9]</sup> | Min                    | Typ | Max |                                      |
| C3                  | GPIO16                  | D                  | I/O                 | IO_1P8                            | 75                     | 100                | 202                | 59                     | 100 | 144 |                                      |
|                     | BT.PCM.VDR              | D                  | I/O                 | IO_1P8                            |                        |                    |                    |                        |     |     |                                      |
|                     | DIG.MIC.CLK0            | D                  | O                   | IO_1P8                            |                        |                    |                    |                        |     |     |                                      |
| C5                  | GPIO17                  | D                  | I/O                 | IO_1P8                            | 75                     | 100                | 202                | 59                     | 100 | 144 |                                      |
|                     | BT.PCM.VDX              | D                  | I/O                 | IO_1P8                            |                        |                    |                    |                        |     |     |                                      |
|                     | DIG.MIC.CLK1            | D                  | O                   | IO_1P8                            |                        |                    |                    |                        |     |     |                                      |
| A2                  | RFID.EN                 | D                  | O                   | VMMC2.OUT                         |                        |                    |                    |                        |     |     |                                      |

## 2.3 Signal Description

Table 2-2 lists the signals on the TPS65950; some signals are available on multiple pins.

Table 2-2. Signal Description

| Module         | Signal Name | Description   | Type <sup>(1)</sup> | Ball | Configuration By Default After Reset Released |                     |                      | Unused Features <sup>(2)</sup> |
|----------------|-------------|---|---------------------|------|---|---------------------|----------------------|--------------------------------|
|                |             |   |                     |      | Signal  | Type <sup>(1)</sup> | Internal Pull or Not |                                |
| ADC            | ADCIN0      | Battery type  | I/O                 | H4   | ADCIN0  | I                   |                      | GND                            |
|                | ADCIN1      | Battery temperature                                   | I/O                 | J3   | ADCIN1  | I                   |                      | GND                            |
|                | ADCIN2      | General-purpose (GP) ADC input                        | I                   | G3   | ADCIN2  | I                   |                      | GND                            |
| Charger        | VCCS        | Charge current sensing                                | I                   | P5   | VCCS  | I                   |                      | Cap to GND <sup>(3)</sup>      |
|                | VAC         | Charge device input voltage                           | Power               | N5   | VAC   | Power               |                      | GND                            |
|                | VBATS       | Charge current sensing                                | I                   | P4   | VBATS   | I                   |                      | Cap to GND <sup>(3)</sup>      |
|                | PCHGAC      | ac precharge sense signal. Used also for EEPROM       | I                   | N4   | PCHGAC  | I                   |                      | GND                            |
|                | PCHGUSB     | USB precharge sense signal                            | I                   | N6   | PCHGUSB                                       | I                   |                      | GND                            |
|                | VPRECH      | Precharge regulator output                            | O                   | N2   | VPRECH  | O                   |                      | Cap to GND <sup>(3)</sup>      |
|                | BCIAUTO     | Linear charge specific boot mode                      | I                   | N1   | BCIAUTO                                       | I                   |                      | GND                            |
|                | ICTLUSB1    | USB power device control                              | O                   | P6   | ICTLUSB1                                      | O                   |                      | Floating                       |
|                | ICTLUSB2    | USB power device control                              | O                   | P1   | ICTLUSB2                                      | O                   |                      | Floating                       |
|                | ICTLAC1     | ac power device control                               | O                   | N7   | ICTLAC1                                       | O                   |                      | Floating                       |
|                | ICTLAC2     | ac power device control                               | O                   | P2   | ICTLAC2                                       | O                   |                      | Floating                       |
|                | VBAT        | Battery voltage sensing                               | Power               | R5   | VBAT  | Power               |                      | VBAT                           |
| GPIOs/<br>JTAG | GPIO0/CD1   | GPIO0/card detection 1                                | I/O                 | P12  | GPIO0   | I                   | PD                   | Floating                       |
|                | JTAG.TDO    | JTAG test data output                                 | I/O                 |      |   |                     |                      |                                |
|                | GPIO1/CD2   | GPIO1/card detection 2                                | I/O                 | N12  | GPIO1   | I                   | PD                   | Floating                       |
|                | JTAG.TMS    | JTAG test mode state                                  | I                   |      |   |                     |                      |                                |
|                | GPIO2       | GPIO2   | I/O                 | L4   | GPIO2   | I                   | PD                   | Floating                       |
|                | Test1       | Test1 pin used in test mode only                      | I/O                 |      |   |                     |                      |                                |
|                | GPIO15      | GPIO15  | I/O                 | P13  | GPIO15  | I                   | PD                   | Floating                       |
|                | Test2       | Test2 pin used in test mode only                      | I/O                 |      |   |                     |                      |                                |
|                | GPIO6       | GPIO6   | I/O                 | M4   | GPIO6   | I                   | PD                   | Floating                       |
|                | PWM0        | Pulse width driver 0                                  | O                   |      |   |                     |                      |                                |
|                | Test3       | Test3 pin used in test mode only (controlled by JTAG) | I/O                 |      |   |                     |                      |                                |
|                | GPIO7       | GPIO7   | I/O                 | N14  | GPIO7   | I                   | PD                   | Floating                       |
|                | VIBRA.SYNC  | Vibrator on-off synchronization                       | I                   |      |   |                     |                      |                                |
|                | PWM1        | Pulse width driver                                    | O                   |      |   |                     |                      |                                |
|                | Test4       | Test4 pin used in test mode only (controlled by JTAG) | I/O                 |      |   |                     |                      |                                |
| START.<br>ADC  | START.ADC   | ADC conversion request                                | I                   | J9   | START.ADC                                     | I                   |                      | GND                            |

**Table 2-2. Signal Description (continued)**

| Module                       | Signal Name  | Description   | Type <sup>(1)</sup> | Ball | Configuration By Default After Reset Released |                     |                      | Unused Features <sup>(2)</sup> |
|------------------------------|--------------|---|---------------------|------|---|---------------------|----------------------|--------------------------------|
|                              |              |   |                     |      | Signal  | Type <sup>(1)</sup> | Internal Pull or Not |                                |
| CONTROL                      | SYSEN        | System enable output  | OD/I                | C13  | SYSEN   | OD                  | PU                   | Floating                       |
|                              | CLKEN        | Clock enable  | O                   | C6   | CLKEN   | O                   |                      | Floating                       |
|                              | CLKEN2       | Clock enable 2  | O                   | D7   | CLKEN2  | O                   |                      | Floating                       |
|                              | CLKREQ       | Clock request   | I                   | G10  | CLKREQ  | I                   | PD                   | GND                            |
|                              | INT1         | Output interrupt line 1                                     | O                   | F10  | INT1  | O                   |                      | Floating                       |
|                              | INT2         | Output interrupt line 2                                     | O                   | F9   | INT2  | O                   |                      | Floating                       |
|                              | NRESPWRON    | Output control the NRESPWRON of the application processor   | O                   | A13  | NRESPWRON                                     | O                   |                      | Floating                       |
|                              | NRESWARM     | Input, detect user action on the reset button               | I                   | B13  | NRESWARM                                      | I                   |                      | GND                            |
|                              | PWRON        | Input, detect a control command to start or stop the system | I                   | A11  | PWRON   | I                   |                      | VBAT                           |
|                              | NC           | Not connected   |                     | B14  | NC  |                     |                      | Floating                       |
|                              | NSLEEP1      | Sleep request from device 1                                 | I                   | P7   | NSLEEP1                                       | I                   |                      | GND                            |
|                              | NSLEEP2      | Sleep request from device 2                                 | I                   | G9   | NSLEEP2                                       | I                   |                      | GND                            |
|                              | CLK256FS     | Control for 256 × F <sub>S</sub> CLK output                 | O                   | D13  | CLK256FS                                      | O                   |                      | Floating                       |
|                              | VMODE1       | Digital voltage scaling linked with VDD1                    | I                   | F8   | VMODE1  | I                   |                      | GND                            |
|                              | BOOT0        | Boot pin 0  | I                   | K11  | BOOT0   | I                   | PD                   | N/A                            |
|                              | BOOT1        | Boot pin 1  | I                   | J11  | BOOT1   | I                   | PD                   | N/A                            |
|                              | REGEN        | Enable signal for external LDO                              | OD                  | A10  | REGEN   | OD                  | PU                   | Floating                       |
|                              | MSECURE      | Security and digital rights management                      | I                   | H8   | MSECURE                                       | I                   |                      | N/A                            |
| VREF                         | VREF         | Reference voltage   | Power               | N16  | VREF  | Power               |                      | N/A                            |
|                              | AGND         | Analog ground for reference voltage                         | Power GND           | N15  | AGND  | Power GND           |                      | GND                            |
| I <sup>2</sup> C SmartReflex | NC           | Not connected   |                     | C4   | Signal not functional <sup>(4)</sup>          |                     |                      | Floating                       |
|                              | I2C.SR.SDA   | SmartReflex I <sup>2</sup> C data                           | I/O                 |      |   |                     |                      |                                |
|                              | VMODE2       | Digital voltage scaling linked with VDD2                    | I                   | D6   | VMODE2  | I                   |                      | GND                            |
|                              | I2C.SR.SCL   | SmartReflex I <sup>2</sup> C data                           | I/O                 |      |   |                     |                      |                                |
| I <sup>2</sup> C             | I2C.CNTL.SDA | GP I <sup>2</sup> C data                                    | I/O                 | D4   | I2C.CNTL.SDA                                  | I/O                 | PU                   | N/A                            |
|                              | I2C.CNTL.SCL | GP I <sup>2</sup> C clock                                   | I/O                 | D5   | I2C.CNTL.SCL                                  | I/O                 | PU                   | N/A                            |
| PCM                          | PCM.VCK      | Data clock (voice port)                                     | I/O                 | R1   | PCM.VCK                                       | I/O                 |                      | Floating                       |
|                              | PCM.VDR      | Data receive (voice port)                                   | I/O                 | T2   | PCM.VDR                                       | I/O                 |                      | GND                            |
|                              | PCM.VDX      | Data transmit (voice port)                                  | I/O                 | T15  | PCM.VDX                                       | I/O                 |                      | Floating                       |
|                              | PCM.VFS      | Frame synchronization (voice port)                          | I/O                 | R16  | PCM.VFS                                       | I/O                 |                      | Floating                       |
| TDM                          | I2S.CLK      | Clock signal (audio port)                                   | I/O                 | L3   | I2S.CLK                                       | I/O                 |                      | Floating                       |
|                              | I2S SYNC     | Synchronization signal (audio port)                         | I/O                 | K6   | I2S SYNC                                      | I/O                 |                      | Floating                       |
|                              | I2S.DIN      | Data receive (audio port)                                   | I                   | K4   | I2S.DIN                                       | I                   |                      | GND                            |
|                              | I2S.DOUT     | Data transmit (audio port)                                  | O                   | K3   | I2S.DOUT                                      | O                   |                      | Floating                       |
| ANA.MIC                      | MIC.MAIN.P   | Main microphone left input (P)                              | I                   | E2   | MIC.MAIN.P                                    | I                   |                      | Cap to GND                     |
|                              | MIC.MAIN.M   | Main microphone left input (M)                              | I                   | F2   | MIC.MAIN.M                                    | I                   |                      | Cap to GND                     |
|                              | MIC.SUB.P    | Main microphone right input (P)                             | I                   | G2   | MIC.SUB.P                                     | I                   |                      | Cap to GND                     |
|                              | DIG.MIC.0    | Digital microphone 0 input data                             | I                   |      |   |                     |                      |                                |
|                              | MIC.SUB.M    | Main microphone right input (M)                             | I                   | H2   | MIC.SUB.M                                     | I                   |                      | Cap to GND                     |
|                              | DIG.MIC.1    | Digital microphone 1 input data                             | I                   |      |   |                     |                      |                                |
| Headset microphone           | HSMIC.P      | Headset microphone input (P)                                | I                   | E3   | HSMIC.P                                       | I                   |                      | Cap to GND                     |
|                              | HSMIC.M      | Headset microphone input (M)                                | I                   | F3   | HSMIC.M                                       | I                   |                      | Cap to GND                     |

Table 2-2. Signal Description (continued)

| Module       | Signal Name  | Description  | Type <sup>(1)</sup> | Ball           | Configuration By Default After Reset Released |                     |                      | Unused Features <sup>(2)</sup> |
|--------------|--------------|--|---------------------|----------------|---|---------------------|----------------------|--------------------------------|
|              |              |  |                     |                | Signal  | Type <sup>(1)</sup> | Internal Pull or Not |                                |
| Hands-free   | VBAT.LEFT    | Battery voltage input  | Power               | D10            | VBAT.LEFT                                     | Power               |                      | VBAT                           |
|              | VBAT.LEFT    | Battery voltage input  | Power               | D9             | VBAT.LEFT                                     | Power               |                      | VBAT                           |
|              | IHF.LEFT.P   | Hands-free speaker output left (P)   | O                   | B9             | IHF.LEFT.P                                    | O                   |                      | Floating                       |
|              | IHF.LEFT.M   | Hands-free speaker output left (M)   | O                   | B10            | IHF.LEFT.M                                    | O                   |                      | Floating                       |
|              | GND.LEFT     | GND  | Power GND           | C10            | GND.LEFT                                      | Power GND           |                      | GND                            |
|              | GND.LEFT     | GND  | Power GND           | C9             | GND.LEFT                                      | Power GND           |                      | GND                            |
|              | VBAT.RIGHT   | Battery voltage input  | Power               | D12            | VBAT.RIGHT                                    | Power               |                      | VBAT                           |
|              | VBAT.RIGHT   | Battery voltage input  | Power               | D11            | VBAT.RIGHT                                    | Power               |                      | VBAT                           |
|              | GND.RIGHT    | GND  | Power GND           | C12            | GND.RIGHT                                     | Power GND           |                      | GND                            |
|              | GND.RIGHT    | GND  | Power GND           | C11            | GND.RIGHT                                     | Power GND           |                      | GND                            |
| Earpiece     | IHF.RIGHT.P  | Hands-free speaker output right (P)  | O                   | B11            | IHF.RIGHT.P                                   | O                   |                      | Floating                       |
|              | IHF.RIGHT.M  | Hands-free speaker output right (M)  | O                   | B12            | IHF.RIGHT.M                                   | O                   |                      | Floating                       |
| Headset      | EAR.P        | Earpiece output differential output (P)  | O                   | A6             | EAR.P   | O                   |                      | Floating                       |
|              | EAR.M        | Earpiece output differential output (M)  | O                   | A7             | EAR.M   | O                   |                      | Floating                       |
|              | HSOL         | Differential/single-ended headset left output  | O                   | B4             | HSOL  | O                   |                      | Floating                       |
|              | PreDrv.LEFT  | Predriver output left P for external class-D amplifier                                   | O                   | B7             | VMID  | Power               |                      | Floating                       |
|              | VMID         | Pseudo-ground for headset output   | Power               |                |   |                     |                      |                                |
|              | HSOR         | Differential/single-ended headset right output (P)                                       | O                   | B5             | HSOR  | O                   |                      | Floating                       |
| AUX input    | PreDrv.RIGHT | Predriver output right P for external class-D amplifier                                  | O                   | B8             | ADCIN7  | I                   |                      | GND                            |
|              | ADCIN7       | GP ADC input 7   | I                   |                |   |                     |                      |                                |
| AUX input    | AUXL         | Auxiliary audio input left   | I                   | F1             | AUXL  | I                   |                      | Cap to GND                     |
|              | AUXR         | Auxiliary audio input right  | I                   | G1             | AUXR  | I                   |                      | Cap to GND                     |
| VMIC BIAS    | MICBIAS1.OUT | Analog microphone bias 1   | Power               | D1             | MICBIAS1.OUT                                  | Power               |                      | Floating                       |
|              | VMIC1.OUT    | Digital microphone power supply 1  | Power               |                |   |                     |                      |                                |
|              | MICBIAS2.OUT | Analog microphone bias 2   | Power               | D2             | MICBIAS2.OUT                                  | Power               |                      | Floating                       |
|              | VMIC2.OUT    | Digital microphone power supply 2  | Power               |                |   |                     |                      |                                |
|              | VHSMIC.OUT   | Headset microphone bias  | Power               | E4             | VHSMIC.OUT                                    | Power               |                      | Floating                       |
|              | MICBIAS.GND  | Dedicated ground for microphones   | Power GND           | D3             | MICBIAS.GND                                   | Power GND           |                      | GND                            |
|              | AVSS1        | Analog ground  | Power GND           | J4/J6/J7/J8/E5 | AVSS1   | Power GND           |                      | GND                            |
|              | AVSS2        |  |                     | R10            | AVSS2   |                     |                      |                                |
|              | AVSS3        |  |                     | M15            | AVSS3   |                     |                      |                                |
|              | AVSS4        |  |                     | C7             | AVSS4   |                     |                      |                                |
| Headset UART | UART1.TXD    | Headset UART transmit data   | OD                  | B1             | UART1.TXD                                     | OD                  | PU                   | Floating                       |
|              | GPIO8        | GPIO8  | I/O                 | D8             | GPIO8   | I                   | PD                   | Floating                       |
|              | UART1.RXD    | Headset universal asynchronous receiver/transmitter (UART) receive data/switch detection | I                   |                |   |                     |                      |                                |

**Table 2-2. Signal Description (continued)**

| Module  | Signal Name                | Description   | Type <sup>(1)</sup> | Ball | Configuration By Default After Reset Released |                     |                      | Unused Features <sup>(2)</sup> |
|---------|----------------------------|---|---------------------|------|---|---------------------|----------------------|--------------------------------|
|         |                            |   |                     |      | Signal  | Type <sup>(1)</sup> | Internal Pull or Not |                                |
| MCPC    | RTSO/CLK64K.OUT/BERCLK.OUT | Ready-to-send output/64-kHz output clock/Bit error ratio (BER) clock out in test mode | OD                  | N11  | RTSO/CLK64K.OUT/BERCLK.OUT                    | OD                  |                      | Floating                       |
|         | ADCIN5                     | GP ADC input 5  | I                   |      |   |                     |                      |                                |
|         | CTS/BERDATA.OUT            | Clear-to-send input/BERDATAOUT in test mode   | OD/CMOS/I/O         | P11  | CTS/BERDATA.OUT                               | OD                  |                      | GND                            |
|         | ADCIN3                     | GP ADC input 3  | I                   |      |   |                     |                      |                                |
|         | TXAF                       |   | I                   | N8   | TXAF  | I                   |                      | Cap to GND                     |
|         | ADCIN4                     | GP ADC input 4  | I                   |      |   |                     |                      |                                |
|         | RXAF                       |   | O                   | N9   | RXAF  | O                   |                      | Floating                       |
|         | ADCIN6                     | GP ADC input 6  | I                   |      |   |                     |                      |                                |
|         | MANU                       | Manufacturer pin  | I                   | L10  | MANU  | I                   | PU                   | Floating                       |
| Clock   | 32KCLKOUT                  | Buffered output of the 32-kHz digital clock   | O                   | N10  | 32KCLKOUT                                     | O                   |                      | Floating                       |
|         | 32KXIN                     | Input of the 32-kHz oscillator  | I                   | P16  | 32KXIN  | I                   |                      | N/A                            |
|         | 32KXOUT                    | Output of the 32-kHz oscillator   | O                   | P15  | 32KXOUT                                       | O                   |                      | Floating                       |
|         | HFCLKIN                    | Input of the digital (or sine) HS clock   | I                   | A14  | HFCLKIN                                       | I                   |                      | N/A                            |
|         | HFCLKOUT                   | HS clock output   | O                   | R12  | HFCLKOUT                                      | O                   |                      | Floating                       |
| USB PHY | VBUS                       | VBUS power rail   | Power               | R8   | VBUS  | Power               |                      | N/A                            |
|         | DP/UART3.RXD               | USB data P/USB carkit receive data/UART3 receive data                                 | I/O                 | T10  | DP/UART3.RXD                                  | I/O                 |                      | N/A                            |
|         | DN/UART3.TXD               | USB data N/USB carkit transmit data/UART3 transmit data                               | I/O                 | T11  | DN/UART3.TXD                                  | I/O                 |                      | N/A                            |
|         | ID                         | USB ID  | I/O                 | R11  | ID  | I/O                 |                      | Connected to VRUSB3V1          |
| ULPI    | UCLK                       | HS USB clock  | I                   | L15  | UCLK  | O                   |                      | Floating                       |
|         | STP                        | HS USB stop   | I                   | L14  | STP   | I                   | PU                   | Floating                       |
|         | GPIO9                      | GPIO9   | I/O                 |      |   |                     |                      |                                |
|         | DIR                        | HS USB direction  | O                   | L13  | DIR   | O                   |                      | Floating                       |
|         | GPIO10                     | GPIO10  | I/O                 |      |   |                     |                      |                                |
|         | NXT                        | HS USB next   | O                   | M13  | NXT   | O                   |                      | Floating                       |
|         | GPIO11                     | GPIO11  | I/O                 |      |   |                     |                      |                                |
|         | DATA0                      | HS USB Data0  | I/O                 | K14  | DATA0   | O                   |                      | Floating                       |
|         | UART4.TXD                  | UART4.TXD   | I                   |      |   |                     |                      |                                |
|         | DATA1                      | HS USB Data1  | I/O                 | K13  | DATA1   | O                   |                      | Floating                       |
|         | UART4.RXD                  | UART4.RXD   | O                   |      |   |                     |                      |                                |
|         | DATA2                      | HS USB Data2  | I/O                 | J14  | DATA2   | O                   |                      | Floating                       |
|         | UART4.RTSI                 | UART4.RTSI  | I                   |      |   |                     |                      |                                |
|         | DATA3                      | HS USB Data3  | I/O                 | J13  | DATA3   | O                   |                      | Floating                       |
|         | UART4.CTSO                 | UART4.CTSO  | O                   |      |   |                     |                      |                                |
|         | GPIO12                     | GPIO12  | I/O                 | G14  | DATA4   | O                   |                      | Floating                       |
|         | DATA4                      | HS USB Data4  | I/O                 |      |   |                     |                      |                                |
|         | GPIO14                     | GPIO14  | I/O                 | G13  | DATA5   | O                   |                      | Floating                       |
|         | DATA5                      | HS USB Data5  | I/O                 |      |   |                     |                      |                                |
|         | GPIO3                      | GPIO3   | I/O                 | F14  | DATA6   | O                   |                      | Floating                       |
|         | DATA6                      | HS USB Data6  | I/O                 |      |   |                     |                      |                                |
|         | GPIO4                      | GPIO4   | I/O                 | F13  | DATA7   | O                   |                      | Floating                       |
|         | DATA7                      | HS USB Data7  | I/O                 |      |   |                     |                      |                                |
|         | GPIO5                      | GPIO5   | I/O                 |      |   |                     |                      | Floating                       |

Table 2-2. Signal Description (continued)

| Module     | Signal Name      | Description   | Type <sup>(1)</sup> | Ball | Configuration By Default After Reset Released |                     |                      | Unused Features <sup>(2)</sup> |
|------------|------------------|---|---------------------|------|---|---------------------|----------------------|--------------------------------|
|            |                  |   |                     |      | Signal  | Type <sup>(1)</sup> | Internal Pull or Not |                                |
| Test       | Test.RESET       | Reset T2 device (except power state-machine)                                    | I                   | T16  | Test.RESET                                    | I                   | PD                   | GND                            |
|            | TestV1           | Analog test   | I/O                 | T1   | TestV1  | I/O                 |                      | Floating                       |
|            | TestV2           | Analog test   | I/O                 | A16  | TestV2  | I/O                 |                      | Floating                       |
|            | Test             | Selection between JTAG mode and application mode for JTAG/GPIOS (with PU or PD) | I                   | A1   | Test  | I                   | PD                   | Floating                       |
|            | JTAG.TDI/BERDATA | JTAG.TDI/BERDATA  | I                   | A15  | JTAG.TDI/BERDATA                              | I                   |                      | GND                            |
|            | JTAG.TCK/BERCLK  | JTAG.TCK/BERCLK   | I                   | B16  | JTAG.TCK/BERCLK                               | I                   |                      | GND                            |
| USB CP     | CP.IN            | CP input voltage  | Power               | R7   | CP.IN   | Power               |                      | VBAT                           |
|            | CP.CAPP          | CP flying capacitor P   | O                   | T7   | CP.CAPP                                       | O                   |                      | Floating                       |
|            | CP.CAPM          | CP flying capacitor M   | O                   | T6   | CP.CAPM                                       | O                   |                      | Floating                       |
|            | CP.GND           | CP ground   | Power GND           | R6   | CP.GND  | Power GND           |                      | GND                            |
| VBAT.USB   | VBAT.USB         | USB LDOs (VINTUSB1P5, VINTUSB1P8, VUSB.3P1) VBAT                                | Power               | R9   | VBAT.USB                                      | Power               |                      | VBAT                           |
| USB.LDO    | VUSB.3P1         | USB LDO output  | Power               | P9   | VUSB.3P1                                      | Power               |                      | N/A                            |
| VAUX1      | VAUX12S.IN       | VAUX1/VAUX2/VSIM LDO input voltage  | Power               | L1   | VAUX12S.IN                                    | Power               |                      | VBAT                           |
|            | VAUX1.OUT        | VAUX1 LDO output voltage  | Power               | M2   | VAUX1.OUT                                     | Power               |                      | Floating                       |
| VAUX2      | VAUX2.OUT        | VAUX2 LDO output voltage  | Power               | M3   | VAUX2.OUT                                     | Power               |                      | Floating                       |
| VPLL1      | VPLL1.R1         | Input for VPLL1, VPLL2, VAUX3, VRTC LDOs  | Power               | H15  | VPLL1.R1                                      | Power               |                      | VBAT                           |
| VRTC       | VRTC.OUT         | VRTC internal LDO output (internal use only)                                    | Power               | K16  | VRTC.OUT                                      | Power               |                      | N/A                            |
| VPLL1      | VPLL1.OUT        | LDO output voltage  | Power               | H14  | VPLL1.OUT                                     | Power               |                      | Floating                       |
| VPLL2      | VSDI.CSI.OUT     | Output voltage of the regulator   | Power               | J15  | VSDI.CSI.OUT                                  | Power               |                      | Floating                       |
| VAUX3      | VAUX3.OUT        | VAUX3 LDO output voltage  | Power               | G16  | VAUX3.OUT                                     | Power               |                      | Floating                       |
| VAUX4      | VAUX4.IN         | VAUX4 LDO input voltage   | Power               | B2   | VAUX4.IN                                      | Power               |                      | VBAT                           |
|            | VAUX4.OUT        | VAUX4 LDO output voltage  | Power               | B3   | VAUX4.OUT                                     | Power               |                      | Floating                       |
| VMMC1      | VMMC1.IN         | VMMC1 LDO input voltage   | Power               | C1   | VMMC1.IN                                      | Power               |                      | VBAT                           |
|            | VMMC1.OUT        | VMMC1 LDO output voltage  | Power               | C2   | VMMC1.OUT                                     | Power               |                      | Floating                       |
| VMMC2      | VMMC2.IN         | VMMC2 LDO input voltage   | Power               | A3   | VMMC2.IN                                      | Power               |                      | VBAT                           |
|            | VMMC2.OUT        | VMMC2 LDO output voltage  | Power               | A4   | VMMC2.OUT                                     | Power               |                      | Floating                       |
| VSIM       | VSIM.OUT         | VSIM LDO output voltage   | Power               | K2   | VSIM.OUT                                      | Power               |                      | Floating                       |
| VINTUSB1P5 | VINTUSB1P5.OUT   | VINTUSB1P5 internal LDO output (internal use only)                              | Power               | P8   | VINTUSB1P5.OUT                                | Power               |                      | Floating                       |
| VINTUSB1P8 | VINTUSB1P8.OUT   | VINTUSB1P8 internal LDO output (internal use only)                              | Power               | P10  | VINTUSB1P8.OUT                                | Power               |                      | Floating                       |
| Video DAC  | VDAC.IN          | Input for VDAC, VINTANA1, and VINTANA2 LDOs                                     | Power               | K1   | VDAC.IN                                       | Power               |                      | VBAT                           |
|            | VDAC.OUT         | Output voltage of the regulator   | Power               | L2   | VDAC.OUT                                      | Power               |                      | Floating                       |
| VINT       | VINT.IN          | Input for VINTDIG LDO   | Power               | K15  | VINT.IN                                       | Power               |                      | VBAT                           |
| VINTANA1   | VINTANA1.OUT     | VINTANA1 internal LDO output (internal use only)                                | Power               | H3   | VINTANA1.OUT                                  | Power               |                      | N/A                            |
| VINTANA2   | VINTANA2.OUT     | VINTANA2 internal LDO output (internal use only)                                | Power               | J2   | VINTANA2.OUT                                  | Power               |                      | N/A                            |
|            | VINTANA2.OUT     | VINTANA2 internal LDO output (internal use only)                                | Power               | B6   | VINTANA2.OUT                                  | Power               |                      | N/A                            |
| VINTDIG    | VINTDIG.OUT      | VINTDIG internal LDO output (internal use only)                                 | Power               | L16  | VINTDIG.OUT                                   | Power               |                      | N/A                            |

**Table 2-2. Signal Description (continued)**

| Module         | Signal Name | Description                          | Type <sup>(1)</sup> | Ball                 | Configuration By Default After Reset Released |                     |                      | Unused Features <sup>(2)</sup> |
|----------------|-------------|--------------------------------------|---------------------|----------------------|---|---------------------|----------------------|--------------------------------|
|                |             |                                      |                     |                      | Signal  | Type <sup>(1)</sup> | Internal Pull or Not |                                |
| VDD1           | VDD1.IN     | VDD1 dc-dc input voltage             | Power               | E15                  | VDD1.IN                                       | Power               |                      | VBAT                           |
|                | VDD1.IN     | VDD1 dc-dc input voltage             | Power               | E14                  | VDD1.IN                                       | Power               |                      | VBAT                           |
|                | VDD1.IN     | VDD1 dc-dc input voltage             | Power               | D14                  | VDD1.IN                                       | Power               |                      | VBAT                           |
|                | VDD1.SW     | VDD1 dc-dc switch                    | O                   | D16                  | VDD1.SW                                       | O                   |                      | Floating                       |
|                | VDD1.SW     | VDD1 dc-dc switch                    | O                   | D15                  | VDD1.SW                                       | O                   |                      | Floating                       |
|                | VDD1.SW     | VDD1 dc-dc switch                    | O                   | C14                  | VDD1.SW                                       | O                   |                      | Floating                       |
|                | VDD1.FB     | VDD1 dc-dc output voltage (feedback) | I                   | E13                  | VDD1.FB                                       | I                   |                      | GND                            |
|                | VDD1.GND    | VDD1 dc-dc ground                    | Power GND           | C16                  | VDD1.GND                                      | Power GND           |                      | GND                            |
|                | VDD1.GND    | VDD1 dc-dc ground                    | Power GND           | C15                  | VDD1.GND                                      | Power GND           |                      | GND                            |
|                | VDD1.GND    | VDD1 dc-dc ground                    | Power GND           | B15                  | VDD1.GND                                      | Power GND           |                      | GND                            |
| VDD2           | VDD2.IN     | VDD2 dc-dc input voltage             | Power               | R13                  | VDD2.IN                                       | Power               |                      | VBAT                           |
|                | VDD2.IN     | VDD2 dc-dc input voltage             | Power               | P14                  | VDD2.IN                                       | Power               |                      | VBAT                           |
|                | VDD2.FB     | VDD2 dc-dc output voltage (feedback) | I                   | N13                  | VDD2.FB                                       | I                   |                      | GND                            |
|                | VDD2.SW     | VDD2 dc-dc switch                    | O                   | T13                  | VDD2.SW                                       | O                   |                      | Floating                       |
|                | VDD2.SW     | VDD2 dc-dc switch                    | O                   | R14                  | VDD2.SW                                       | O                   |                      | Floating                       |
|                | VDD2.GND    | VDD2 dc-dc ground                    | Power GND           | T14                  | VDD2.GND                                      | Power GND           |                      | GND                            |
|                | VDD2.GND    | VDD2 dc-dc ground                    | Power GND           | R15                  | VDD2.GND                                      | Power GND           |                      | GND                            |
| VIO            | VIO.IN      | VIO dc-dc input voltage              | Power               | P3                   | VIO.IN  | Power               |                      | VBAT                           |
|                | VIO.IN      | VIO dc-dc input voltage              | Power               | R4                   | VIO.IN  | Power               |                      | VBAT                           |
|                | VIO.FB      | VIO dc-dc output voltage (feedback)  | I                   | N3                   | VIO.FB  | I                   |                      | GND                            |
|                | VIO.SW      | VIO dc-dc switch                     | O                   | R3                   | VIO.SW  | O                   |                      | Floating                       |
|                | VIO.SW      | VIO dc-dc switch                     | O                   | T4                   | VIO.SW  | O                   |                      | Floating                       |
|                | VIO.GND     | VIO dc-dc ground                     | Power GND           | R2                   | VIO.GND                                       | Power GND           |                      | GND                            |
|                | VIO.GND     | VIO dc-dc ground                     | Power GND           | T3                   | VIO.GND                                       | Power GND           |                      | GND                            |
| Backup battery | BKBAT       | Backup battery                       | Power               | M14                  | BKBAT   | Power               |                      | GND                            |
| Digital VDD    | IO.1P8      | TPS65950 I/O input                   | Power               | C8                   | IO.1P8  | Power               |                      | N/A                            |
| Digital ground | DGND        | Digital ground                       | Power GND           | H13 / H9 / H10 / H11 | DGND  | Power GND           |                      | GND                            |
| LED driver     | LEDGND      | LED driver ground                    | Power GND           | F16                  | LEDGND  | Power GND           |                      | GND                            |
|                | GPIO13      | GPIO13                               | I/O                 | G11                  | GPIO13  | I                   | PD                   | Floating                       |
|                | LEDSYNC     | LED synchronization input            | I                   |                      |   |                     |                      |                                |
|                | LEDA        | LED leg A                            | OD                  | F15                  | Signal not functional <sup>(4)</sup>          |                     |                      | Floating                       |
|                | VIBRA.P     | H-bridge vibrator P                  |                     |                      |   |                     |                      |                                |
|                | LEDB        | LED leg B                            | OD                  | G15                  | Signal not functional <sup>(4)</sup>          |                     |                      | Floating                       |
|                | VIBRA.M     | H-bridge vibrator M                  |                     |                      |   |                     |                      |                                |

Table 2-2. Signal Description (continued)

| Module                              | Signal Name  | Description   | Type <sup>(1)</sup> | Ball | Configuration By Default After Reset Released |                     |                      | Unused Features <sup>(2)</sup> |
|-------------------------------------|--------------|---|---------------------|------|---|---------------------|----------------------|--------------------------------|
|                                     |              |   |                     |      | Signal  | Type <sup>(1)</sup> | Internal Pull or Not |                                |
| Keypad                              | KPD.C0       | Keypad column 0   | OD                  | G8   | KPD.C0  | OD                  |                      | Floating                       |
|                                     | KPD.C1       | Keypad column 1   | OD                  | H7   | KPD.C1  | OD                  |                      | Floating                       |
|                                     | KPD.C2       | Keypad column 2   | OD                  | G6   | KPD.C2  | OD                  |                      | Floating                       |
|                                     | KPD.C3       | Keypad column 3   | OD                  | F7   | KPD.C3  | OD                  |                      | Floating                       |
|                                     | KPD.C4       | Keypad column 4   | OD                  | G7   | KPD.C4  | OD                  |                      | Floating                       |
|                                     | KPD.C5       | Keypad column 5   | OD                  | F4   | KPD.C5  | OD                  |                      | Floating                       |
|                                     | KPD.C6       | Keypad column 6   | OD                  | H6   | KPD.C6  | OD                  |                      | Floating                       |
|                                     | KPD.C7       | Keypad column 7   | OD                  | G4   | KPD.C7  | OD                  |                      | Floating                       |
|                                     | KPD.R0       | Keypad row 0  | I                   | K9   | KPD.R0  | I                   | PU                   | Floating                       |
|                                     | KPD.R1       | Keypad row 1  | I                   | K8   | KPD.R1  | I                   | PU                   | Floating                       |
|                                     | KPD.R2       | Keypad row 2  | I                   | L8   | KPD.R2  | I                   | PU                   | Floating                       |
|                                     | KPD.R3       | Keypad row 3  | I                   | K7   | KPD.R3  | I                   | PU                   | Floating                       |
|                                     | KPD.R4       | Keypad row 4  | I                   | L9   | KPD.R4  | I                   | PU                   | Floating                       |
|                                     | KPD.R5       | Keypad row 5  | I                   | J10  | KPD.R5  | I                   | PU                   | Floating                       |
|                                     | KPD.R6       | Keypad row 6  | I                   | K10  | KPD.R6  | I                   | PU                   | Floating                       |
|                                     | KPD.R7       | Keypad row 7  | I                   | L7   | KPD.R7  | I                   | PU                   | Floating                       |
| Bluetooth/<br>digital<br>microphone | GPIO16       | Bluetooth PCM receive data                                  | I/O                 | C3   | GPIO16  |                     | PD                   | Floating                       |
|                                     | BT.PCM.VDR   | GPIO16  | I/O                 |      |   | I                   |                      |                                |
|                                     | DIG.MIC.CLK0 | Digital microphone clock 0                                  | O                   |      |   |                     |                      |                                |
|                                     | GPIO17       | GPIO17  | I/O                 | C5   | GPIO17  |                     | PD                   | Floating                       |
|                                     | BT.PCM.VDX   | Bluetooth PCM transmit data                                 |                     |      |   | I                   |                      |                                |
|                                     | DIG.MIC.CLK1 | Digital microphone clock 1                                  |                     |      |   |                     |                      |                                |
| RFID                                | RFID.EN      | Enable for the radio frequency identification (RFID) device | O                   | A2   | RFID.EN                                       | O                   |                      | Floating                       |

(1) I = Input; O = Output; OD = Open drain

(2) This column provides the connection when the associated feature is not used or not connected. When there is a pin muxing, not all functions on the muxed pin are used. But even if a function is not used, the Default Configuration column applies.

Connection criteria:

- Analog pins:
  - For input: GND
  - For output: Floating (except VPRECH is connected to GND)
  - For I/O if input by default: GND (except for audio features input: capacitor to ground with a 100-nF typical value capacitor)
- Digital pins:
  - For input: GND (except keypad and STP are left floating)
  - For input and pullup: Floating
  - For output: Floating
  - For I/O and pullup: Floating

N/A (not applicable): When the associated feature is mandatory for good functioning of the TPS65950.

(3) The VPRECH, VBATS, and VCCS signals must be connected to each other and with the CPRECH capacitor to GND (see [Section 8.2.3, Configuration with BCI Not Used](#)).

(4) Signal not functional indicates that no signal is presented on the pad after a release reset.

### 3 Electrical Characteristics

#### 3.1 Absolute Maximum Ratings

Table 3-1 lists the absolute maximum ratings.

**Table 3-1. Absolute Maximum Ratings**

| Parameter  | Test Conditions   | Min | Typ | Max        | Unit |
|--|---|-----|-----|------------|------|
| Main battery supply voltage <sup>(1)</sup>               |   | 2.1 |     | 4.5        | V    |
| Voltage on any input                                     | Where supply represents the voltage applied to the power supply pin associated with the input | 0.0 |     | 1.0*Supply | V    |
| Storage temperature range                                |   | -55 |     | 125        | °C   |
| Ambient temperature range                                |   | -40 |     | 85         | °C   |
| Junction temperature ( $T_J$ )                           | At 1.4W (Theta JB 11°C/W 2S2P board)  |     |     | 105        | °C   |
| Junction temperature ( $T_J$ ) for parametric compliance |   | -40 |     | 105        | °C   |

(1) The product can tolerate voltage spikes of 5.2 V for a total duration of 10 milliseconds.

#### 3.2 Minimum Voltages and Associated Currents

Table 3-2 lists the VBAT minimum and maximum currents per VBAT ball.

**Table 3-2. VBAT Min Required Per VBAT Ball and Associated Maximum Current**

| Category                 | Pin and Module      | Maximum Current Specified (mA) | Output Voltage (V)   | VBAT Minimum (V)                                |
|--------------------------|---------------------|--------------------------------|--|---|
| VBAT pin name            | VDD_VPLLA3R_IN_6POV | 340                            |  |   |
| Internal module supplied | VPPLL1 (LDO)        | 40                             | 1.0 / 1.2 / 1.3 / 1.8 / 2.8 / 3.0  | Maximum (2.7, output voltage selected + 250 mV) |
|                          | VPPLL2 (LDO)        | 100                            | 0.7 / 1.0 / 1.2 / 1.3 / 1.5 / 1.8 / 1.85 / 2.5 / 2.6 / 2.8 / 2.85 / 3.0 / 3.15 | Maximum (2.7, output voltage selected + 250 mV) |
|                          | VAUX3 (LDO)         | 200                            | 1.5 / 1.8 / 2.5 / 2.8 / 3.0  | Maximum (2.7, output voltage selected + 250 mV) |
|                          | VDD1 core (DCDC)    | < 1                            |  | 2.7   |
|                          | VDD2 core (DCDC)    | < 1                            |  | 2.7   |
|                          | SYSPOR (power ref)  | < 1                            |  | 2.7   |
|                          | PBIAS (power ref)   | < 1                            |  | 2.7   |
| VBAT pin name            | VDD_VDAC_IN_6POV    | 370                            |  |   |
| Internal module supplied | VDAC (LDO)          | 70                             | 1.2 / 1.3 / 1.8  | Maximum (2.7, output voltage selected + 250 mV) |
|                          | VINTANA1 (LDO)      | 50                             | 1.5  | Maximum (2.7, output voltage selected + 250 mV) |
|                          | VINTANA2 (LDO)      | 250                            | 2.5 / 2.75   | Maximum (2.7, output voltage selected + 250 mV) |
|                          | VIO core (DCDC)     | < 1                            |  | 2.7   |
|                          | VAUX4 core (LDO)    | < 1                            |  | 2.7   |
| VBAT pin name            | VDD_VAUXI2S_IN_6POV | 350                            |  |   |

**Table 3-2. VBAT Min Required Per VBAT Ball and Associated Maximum Current (continued)**

| Category                 | Pin and Module    | Maximum Current Specified (mA) | Output Voltage (V)   | VBAT Minimum (V)                                |
|--------------------------|-------------------|--------------------------------|--|---|
| Internal module supplied | VAUX1 (LDO)       | 200                            | 1.5 / 1.8 / 2.5 / 2.8 / 3.0  | Maximum (2.7, output voltage selected + 250 mV) |
|                          | VAUX2 (LDO)       | 100                            | 1.3 / 1.5 / 1.6 / 1.7 / 1.8 / 1.9 / 2.0 / 2.1 / 2.2 / 2.3 / 2.4 / 2.5 / 2.8    | Maximum (2.7, output voltage selected + 250 mV) |
|                          | VSIM (LDO)        | 50                             | 1.0 / 1.2 / 1.3 / 1.8 / 2.8 / 3.0  | Maximum (2.7, output voltage selected + 250 mV) |
| VBAT pin name            | VDD_VMMC2_IN_6POV | 100                            |  |   |
|                          | VMMC2 (LDO)       | 100                            | 1.0 / 1.2 / 1.3 / 1.5 / 1.8 / 1.85 / 2.5 / 2.6 / 2.8 / 2.85 / 3.0 / 3.15       | Maximum (2.7, output voltage selected + 250 mV) |
|                          | Power_REGBATT     | 0.001                          |  | 2.7   |
| VBAT pin name            | VDD_VMMC1_IN_6POV | 220                            |  |   |
|                          | VMMC1 (LDO)       | 220                            | 1.85 / 2.85 / 3.0 / 3.15   | Maximum (2.7, output voltage selected + 250 mV) |
|                          | Power_REGBATT     | 0.001                          |  | 2.7   |
| VBAT pin name            | VDD_VINT_IN_6POV  | 131                            |  |   |
| Internal module supplied | VINTDIG (LDO)     | 80                             | 1.0 / 1.2 / 1.3 / 1.5  | Maximum (2.7, output voltage selected + 250 mV) |
|                          | VRRTC (LDO)       | 30                             | 1.5  | Maximum (2.7, output voltage selected + 250 mV) |
|                          | VBACKUP (LDO)     | 1                              | 2.5 / 3.0 / 3.1 / 3.2  | Maximum (2.7, output voltage selected + 250 mV) |
| VBAT pin name            | VDD_VAUX4_IN_6POV | 100                            |  |   |
|                          | VAUX4 (LDO)       | 100                            | 0.7 / 1.0 / 1.2 / 1.3 / 1.5 / 1.8 / 1.85 / 2.5 / 2.6 / 2.8 / 2.85 / 3.0 / 3.15 | output voltage selected + 250 mV                |

### 3.3 Recommended Operating Conditions

Table 3-3 lists the recommended operating maximum ratings.

**Table 3-3. Recommended Operating Maximum Ratings**

| Parameter                     | Min                | Typ | Max | Unit |
|-------------------------------|--------------------|-----|-----|------|
| Main battery supply voltage   | 2.7 <sup>(1)</sup> | 3.6 | 4.5 | V    |
| Backup battery supply voltage | 1.8                | 3.2 | 3.3 | V    |
| Ambient temperature range     | -40                |     | 85  | °C   |

(1) 2.7 V is the minimum threshold for the battery at which the device will turn OFF. However, the minimum voltage at which the device will power ON is 3.2 V ±100 mV (if PWRON does not have a switch and is connected to VBAT) considering battery plug as the device switch on event. If PWRON has a switch then 3.2 V is the minimum for the device to turn ON.

### 3.4 Digital I/O Electrical Characteristics

Table 3-4 describes the digital I/O electrical characteristics.

- RL: Reference level voltage applied to the I/O cell
- VOL: Low-level output voltage
- VOH: High-level output voltage
- VIL: Low-level input voltage
- VIH: High-level input voltage

**Table 3-4. Digital I/O Electrical Characteristics**

| Pin Name                   | VOL (V) |      | VOH (V) |     | VIL (V) |           | VIH (V)   |        | Max Freq (MHz) | Load (pF)<br>Output Mode | Rise Time (ns) | Fall Time (ns) |
|----------------------------|---------|------|---------|-----|---------|-----------|-----------|--------|----------------|--------------------------|----------------|----------------|
|                            | Min     | Max  | Min     | Max | Min     | Max       | Min       | Max    |                |                          |                |                |
| GPIO0/CD1                  | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 33             | 30                       | 5.2            | 5.2            |
| JTAG.TDO                   |         |      |         |     |         |           |           |        |                |                          |                |                |
| GPIO0/CD2                  | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 33             | 30                       | 5.2            | 5.2            |
| JTAG.TMS                   |         |      |         |     |         |           |           |        |                |                          |                |                |
| GPIO2                      | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 5.2            | 5.2            |
| Test1                      |         |      |         |     |         |           |           |        |                |                          |                |                |
| GPIO15                     | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 5.2            | 5.2            |
| Test2                      |         |      |         |     |         |           |           |        |                |                          |                |                |
| GPIO16                     |         |      |         |     |         |           |           |        |                |                          |                |                |
| PWM0                       | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 5.2            | 5.2            |
| Test3                      |         |      |         |     |         |           |           |        |                |                          |                |                |
| GPIO17                     |         |      |         |     |         |           |           |        |                |                          |                |                |
| VIBRA.SYNC                 | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 5.2            | 5.2            |
| PWM1                       |         |      |         |     |         |           |           |        |                |                          |                |                |
| Test4                      |         |      |         |     |         |           |           |        |                |                          |                |                |
| START.ADC                  | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 6              |                          | 16.7           | 16.7           |
| SYSEN                      | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     |                |                          | 5.2            | 5.2            |
| CLKEN                      | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 33.3           | 33.3           |
| CLKEN2                     | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 33.3           | 33.3           |
| CLKREQ                     | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              |                          | 33.3           | 33.3           |
| INT1                       | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 33.3           | 33.3           |
| INT2                       | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 33.3           | 33.3           |
| NRESPWRON                  | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 33.3           | 33.3           |
| NRESWARM                   | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 33.3           | 33.3           |
| PWRON                      |         |      |         |     | 0       | 0.35x1.8V | 0.65x1.8V | VBAT   | 3              |                          | 33.3           | 33.3           |
| NSLEEP1                    | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              |                          | 33.3           | 33.3           |
| NSLEEP2                    | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              |                          | 33.3           | 33.3           |
| CLK256FS                   | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 12.288         | 30                       | 16.3           | 16.3           |
| VMODE1                     | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              |                          | 33.3           | 33.3           |
| BOOT0                      | 0       |      |         |     |         |           |           | RL     | 3              |                          | 33.3           | 33.3           |
| BOOT1                      | 0       |      |         |     |         |           |           | RL     | 3              |                          | 33.3           | 33.3           |
| REGEN                      | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 33.3           | 33.3           |
| MSECURE                    | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              |                          | 33.3           | 33.3           |
| I2C.SR.SDA                 | 0       | 0.4  |         |     | -0.5    | 0.3xRL    | 0.7xRL    | RL+0.5 | 3.4            | Up to 400                |                |                |
| VMODE2                     | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3.4            |                          | 29.4           | 29.4           |
| I2C.SR.SCL                 | 0       | 0.4  |         |     | -0.5    | 0.3xRL    | 0.7xRL    | RL+0.5 | 3.4            |                          | 10.0           | 10.0           |
| I2C.CNTL.SDA               | 0       | 0.4  |         |     | -0.5    | 0.3xRL    | 0.7xRL    | RL+0.5 | 3.4            | Up to 400                |                |                |
| I2C.CNTL.SCL               | 0       | 0.4  |         |     | -0.5    | 0.3xRL    | 0.7xRL    | RL+0.5 | 3.4            |                          | 10.0           | 10.0           |
| PCM.VCK                    | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 1              | 30                       | 100.0          | 33.0           |
| PCM.VDR                    | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 1              | 30                       | 100.0          | 100.0          |
| PCM.VDX                    | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 1              | 30                       | 100.0          | 33.0           |
| PCM.VFS                    | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 1              | 30                       | 33.0           | 33.0           |
| I2S.CLK                    | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 6.5            | 30                       | 33.0           | 33.0           |
| I2S SYNC                   | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 6.5            | 30                       | 33.0           | 33.0           |
| I2S.DIN                    | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3.25           | 30                       | 33.0           | 33.0           |
| I2S.DOUT                   | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3.25           | 30                       | 29.0           | 29.0           |
| UART1.TXD                  | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 33.0           | 33.0           |
| GPIO8                      |         |      |         |     |         |           |           | RL     | 3              |                          | 33.0           | 33.0           |
| UART1.RXD                  | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     |                |                          | 33.0           | 33.0           |
| RTSO/CLD64K.OUT/BERCLK.OUT | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 33.0           | 33.0           |
| CTSI/BERDATA.OUT           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              | 30                       | 33.0           | 33.0           |
| MANU                       | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 3              |                          | 33.0           | 33.0           |
| 32KCLKOUT                  | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 0.032          | 30                       | 16             | 16             |
| HFCLKOUT                   | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35xRL   | 0.65xRL   | RL     | 38.4           | 30                       | 2.6            | 2.6            |

**Table 3-4. Digital I/O Electrical Characteristics (continued)**

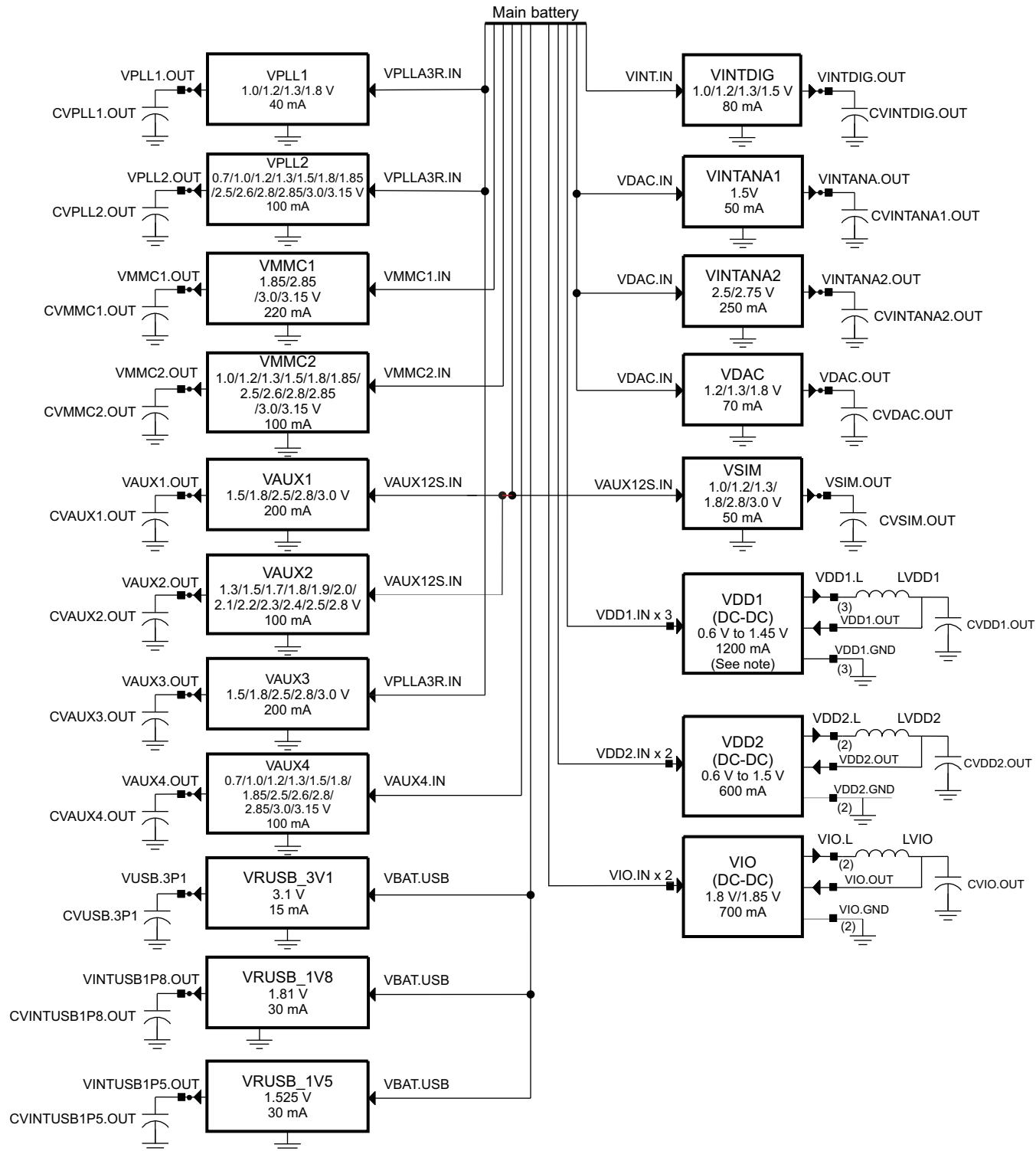
| Pin Name         | VOL (V) |      | VOH (V) |     | VIL (V) |         | VIH (V) |     | Max Freq (MHz) | Load (pF) Output Mode | Rise Time (ns) | Fall Time (ns) |
|------------------|---------|------|---------|-----|---------|---------|---------|-----|----------------|-----------------------|----------------|----------------|
|                  | Min     | Max  | Min     | Max | Min     | Max     | Min     | Max |                |                       |                |                |
| UCLK             | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 60             | 10                    | 1.0            | 1.0            |
| STP              | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 30             | 10                    | 1.0            | 1.0            |
| GPIO9            |         |      |         |     |         |         |         |     |                |                       |                |                |
| DIR              | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 30             | 10                    | 1.0            | 1.0            |
| GPIO10           |         |      |         |     |         |         |         |     |                |                       |                |                |
| NXT              | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 30             | 10                    | 1.0            | 1.0            |
| GPIO11           |         |      |         |     |         |         |         |     |                |                       |                |                |
| DATA0            | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 30             | 10                    | 1.0            | 1.0            |
| UART4.TXD        |         |      |         |     |         |         |         |     |                |                       |                |                |
| DATA1            | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 30             | 10                    | 1.0            | 1.0            |
| UART4.RXD        |         |      |         |     |         |         |         |     |                |                       |                |                |
| DATA2            | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 30             | 10                    | 1.0            | 1.0            |
| UART4.RTSI       |         |      |         |     |         |         |         |     |                |                       |                |                |
| DATA3            | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 30             | 10                    | 1.0            | 1.0            |
| UART4.CTSO       |         |      |         |     |         |         |         |     |                |                       |                |                |
| GPIO12           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 30             | 10                    | 1.0            | 1.0            |
| DATA4            | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 30             | 10                    | 1.0            | 1.0            |
| GPIO14           |         |      |         |     |         |         |         |     |                |                       |                |                |
| DATA5            | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 30             | 10                    | 1.0            | 1.0            |
| GPIO3            |         |      |         |     |         |         |         |     |                |                       |                |                |
| DATA6            | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 30             | 10                    | 1.0            | 1.0            |
| GPIO4            |         |      |         |     |         |         |         |     |                |                       |                |                |
| DATA7            | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 30             | 10                    | 1.0            | 1.0            |
| GPIO5            |         |      |         |     |         |         |         |     |                |                       |                |                |
| Test.RESET       | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 3              |                       | 33.0           | 33.0           |
| Test             | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 3              | 30                    | 29.0           | 29.0           |
| JTAG.TDI/BERDATA | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 3              |                       | 33.0           | 33.0           |
| JTAG.TCK/BERDATA | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 3              |                       | 33.0           | 33.0           |
| GPIO13           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.35×RL |     | 3              | 30                    | 33.3           | 33.3           |
| LEDSYNC          |         |      |         |     |         |         |         |     |                |                       |                |                |
| KPD.C0           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          | 30                    | 29.0           | 29.0           |
| KPD.C1           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          | 30                    | 29.0           | 29.0           |
| KPD.C2           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          | 30                    | 29.0           | 29.0           |
| KPD.C3           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          | 30                    | 29.0           | 29.0           |
| KPD.C4           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          | 30                    | 29.0           | 29.0           |
| KPD.C5           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          | 30                    | 29.0           | 29.0           |
| KPD.C6           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          | 30                    | 29.0           | 29.0           |
| KPD.C7           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          | 30                    | 29.0           | 29.0           |
| KPD.R0           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          |                       | 3051.8         | 3051.8         |
| KPD.R1           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          |                       | 3051.8         | 3051.8         |
| KPD.R2           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          |                       | 3051.8         | 3051.8         |
| KPD.R3           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          |                       | 3051.8         | 3051.8         |
| KPD.R4           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          |                       | 3051.8         | 3051.8         |
| KPD.R5           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          |                       | 3051.8         | 3051.8         |
| KPD.R6           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          |                       | 3051.8         | 3051.8         |
| KPD.R7           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 0.033          |                       | 3051.8         | 3051.8         |
| GPIO16           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 3              | 30                    | 33.3           | 33.3           |
| DIG.MIC.CLK0     | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 2.4            | 30                    | 41.7           | 41.7           |
| BT.PCM.VDX       | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 1              | 30                    | 100.0          | 100.0          |
| GPIO17           | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 3              | 30                    | 33.3           | 33.3           |
| DIG.MIC.CLK1     | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 2.4            | 30                    | 41.7           | 41.7           |
| BT.PCM.VDX       | 0       | 0.45 | RL–0.45 | RL  | 0       | 0.35×RL | 0.65×RL | RL  | 1              | 30                    | 100.0          | 100.0          |
| RFID.EN          |         |      |         |     |         |         |         |     |                |                       |                |                |



## 4 Power Module

This section describes the electrical characteristics of the voltage regulators and timing characteristics of the supplies digitally controlled in the TPS65950.

Figure 4-1 is a block diagram of the power provider.



032-002

NOTE: For TPS65950A3: 0.6V to 1.2V, 1200mA and 1.2V to 1.45V, 1400mA

**Figure 4-1. Power Provider Block Diagram**

### NOTE

 For the component values, see [Table 15-1](#).

## 4.1 Power Providers

Table 4-1 lists the power providers.

**Table 4-1. Summary of the Power Providers**

| Name                           | Use      | Type | Voltage Range (V)  | Default Voltage Depending on Boot Mode <sup>(1)</sup> |  |            | Maximum Current |
|--------------------------------|----------|------|--|---|--|------------|-----------------|
|                                |          |      |  | OMAP2 Mode  |  | OMAP3 Mode |                 |
| VAUX1                          | External | LDO  | 1.5, 1.8, 2.5, 2.8, 3.0  | 3.0 V   |  | 3.0 V      | 200 mA          |
| VAUX2                          | External | LDO  | 1.3, 1.5, 1.7, 1.8, 1.9, 2.0, 2.1, 2.2, 2.3, 2.4, 2.5, 2.8         | 2.8 V   |  | 1.8 V      | 100 mA          |
| VAUX3                          | External | LDO  | 1.5, 1.8, 2.5, 2.8, 3.0  | 2.8 V   |  | 2.8 V      | 200 mA          |
| VAUX4                          | External | LDO  | 0.7, 1.0, 1.2, 1.3 1.5, 1.8, 1.85, 2.5, 2.6, 2.8, 2.85, 3.0, 3.15  | 1.2 V   |  | 2.8 V      | 100 mA          |
| VMMC1                          | External | LDO  | 1.85, 2.85, 3.0, 3.15  | 1.85 V  |  | 3.0 V      | 220 mA          |
| VMMC2                          | External | LDO  | 1.0, 1.2, 1.3, 1.5, 1.8, 1.85, 2.5, 2.6, 2.8, 2.85, 3.0, 3.15      | 2.6 V   |  | 2.6 V      | 100 mA          |
| VPLL1                          | External | LDO  | 1.0, 1.2, 1.3, 1.8, 2.8, 3.0                                       | 1.3 V   |  | 1.8 V      | 40 mA           |
| VPLL2                          | External | LDO  | 0.7, 1.0, 1.2, 1.3, 1.5, 1.8, 1.85, 2.5, 2.6, 2.8, 2.85, 3.0, 3.15 | 1.3 V   |  | 1.3 V      | 100 mA          |
| VSIM                           | External | LDO  | 1.0, 1.2, 1.3, 1.8, 2.8, 3.0                                       | 1.8 V   |  | 1.8 V      | 50 mA           |
| VDAC                           | External | LDO  | 1.2, 1.3, 1.8  | 1.8 V   |  | 1.8 V      | 70 mA           |
| VIO                            | External | SMPS | 1.8, 1.85  | 1.8 V   |  | 1.8 V      | 700 mA          |
| VDD1 for TPS65950A2/TPS65950A3 | External | SMPS | 0.6 ... 1.45   | 1.3 V   |  | 1.2 V      | 1200 mA         |
| VDD1 for TPS65950A3            | External | SMPS | 1.2 ... 1.45   | 1.3 V   |  | 1.2 V      | 1400mA          |
| VDD2                           | External | SMPS | 0.6 ... 1.5  | 1.3 V   |  | 1.2 V      | 600 mA          |
| VINTANA1                       | Internal | LDO  | 1.5  | 1.5 V   |  | 1.5 V      | 50 mA           |
| VINTANA2                       | Internal | LDO  | 2.5, 2.75  | 2.75 V  |  | 2.75 V     | 250 mA          |
| VINTDIG                        | Internal | LDO  | 1.0, 1.2, 1.3, 1.5   | 1.5 V   |  | 1.5 V      | 80 mA           |
| USBCP                          | Internal | CP   | 5  | 5 V   |  | 5 V        | 100 mA          |
| VUSB1V5                        | Internal | LDO  | 1.5  | 1.5 V   |  | 1.5 V      | 30 mA           |
| VUSB1V8                        | Internal | LDO  | 1.8  | 1.8 V   |  | 1.8 V      | 30 mA           |
| VUSB3V1                        | Internal | LDO  | 3.1  | 3.1 V   |  | 3.1 V      | 15 mA           |
| VRRTC                          | Internal | LDO  | 1.5  | 1.5 V   |  | 1.5 V      | 30 mA           |
| VBRTC                          | Internal | LDO  | 1.3  | 1.3 V   |  | 1.3 V      | 100 µA          |

(1) For the significance of boot mode, see [Section 4.5, Power Management](#).

#### 4.1.1 VDD1 dc-dc Regulator

##### 4.1.1.1 VDD1 dc-dc Regulator Characteristics

The VDD1 dc-dc regulator is a stepdown dc-dc converter with a configurable output voltage. The programming of the output voltage and the characteristics of the dc-dc converter are SmartReflex-compatible. The regulator can be put in sleep mode to reduce its leakage (PFM) or power-down mode when it is not being used. [Table 4-3](#) lists the characteristics of the regulator.

**Table 4-2. Part Names With Corresponding VDD1 Current Support**

| Device Name  | VDD1 Current Support |
|--|----------------------|
| TPS65950A2ZXN/R (some bug fixes, see errata)                                     | 1.2 A                |
| TPS65950A3ZXN/R (same as TPS65950A2 + 1 GHz support with higher current support) | 1.4 A                |

**Table 4-3. VDD1 dc-dc Regulator Characteristics**

| Parameter   | Comments  | Min | Typ  | Max  | Unit  |
|---|---|-----|------|------|-------|
| Input voltage range   |   | 2.7 | 3.6  | 4.5  | V     |
| Output voltage  |   | 0.6 |      | 1.45 | V     |
| Output voltage step   | Covering the 0.6 to 1.45-V range                                      |     | 12.5 |      | mV    |
| Output accuracy <sup>(1)</sup>  | 0.6 to < 0.8 V  | -6% |      | 6%   |       |
|   | 0.8 to 1.45 V   | -4% |      | 4%   |       |
| Switching frequency   |   |     | 3.2  |      | MHz   |
| Conversion efficiency <sup>(2)</sup> , <a href="#">Figure 4-2</a> in active and sleep modes | I <sub>O</sub> = 10 mA, sleep   |     | 82%  |      |       |
|   | 100 mA < I <sub>O</sub> < 400 mA                                      |     | 85%  |      |       |
|   | 400 mA < I <sub>O</sub> < 600 mA                                      |     | 80%  |      |       |
|   | 600 mA < I <sub>O</sub> < 800 mA                                      |     | 75%  |      |       |
| Output current  | Active mode, Output Voltage 0.6 V to 1.45 V for TPS65950A2/TPS65950A3 |     |      | 1200 | mA    |
|   | Active mode, Output Voltage 1.2 V to 1.45 V for TPS65950A3            |     |      | 1400 | mA    |
|   | Sleep mode  |     |      | 10   | mA    |
| Ground current (I <sub>G</sub> )  | Off at 30°C   |     |      | 3    | µA    |
|   | Sleep, unloaded   |     | 30   | 50   |       |
|   | Active, unloaded, not switching                                       |     |      | 300  |       |
| Short-circuit current   | V <sub>IN</sub> = V <sub>Max</sub>                                    |     | 2.2  |      | A     |
| Load regulation   | 0 < I <sub>O</sub> < I <sub>Max</sub>                                 |     |      | 20   | mV    |
| Transient load regulation <sup>(3)</sup>  | I <sub>O</sub> = 10 mA to 600 mA, Maximum slew rate is 600mA/100 ns.  | -65 |      | 50   | mV    |
| Line regulation   |   |     |      | 10   | mV    |
| Transient line regulation   | 300 mV <sub>PP</sub> ac input, 10-µs rise and fall time               |     |      | 10   | mV    |
| Startup time  |   |     | 0.25 | 1    | ms    |
| Recovery time   | From sleep mode to on mode with constant load                         |     | <10  | 100  | µs    |
| Slew rate (rising or falling) <sup>(4)</sup>  |   | 4   | 8    | 16   | mV/µs |
| Output shunt resistor (pulldown)  |   |     | 500  | 700  | Ω     |

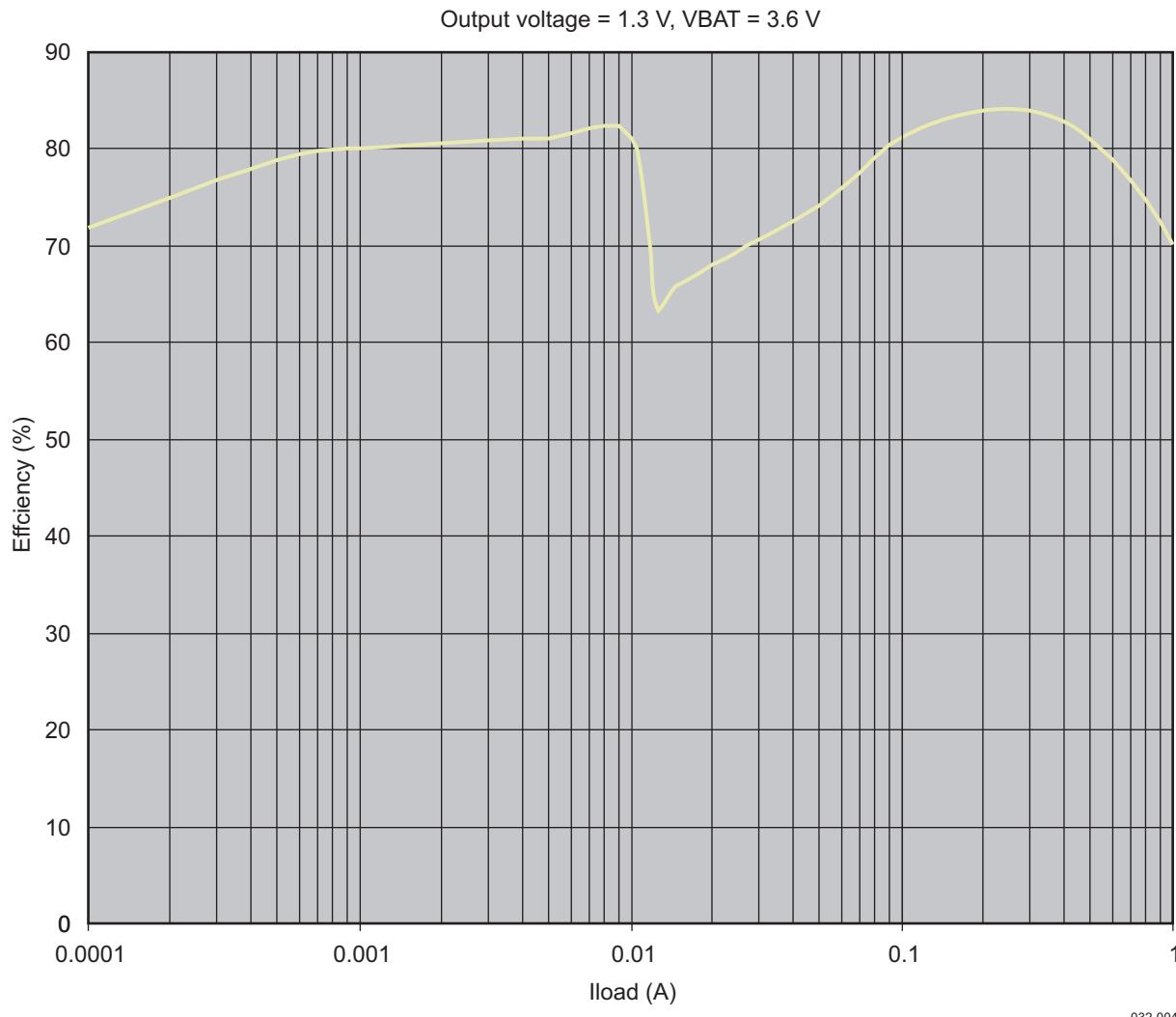
- (1) Accuracy includes all variations (line and load regulations, line and load transients, temperature, and process). Under current load condition step: 600 mA in 100 ns with a ±20% external capacitor accuracy or 400 mA in 100 ns with a ±50% external capacitor accuracy
- (2) V<sub>BAT</sub> = 3.6 V, V<sub>D1</sub> = 1.2 V, F<sub>s</sub> = 3.2 MHz, L = 1 µH, L<sub>DCR</sub> = 100 mΩ, C = 10 µF, ESR = 10 mΩ
- (3) For negative transient load, the output voltage must discharge completely and settle to its final value within 100 ms. Transient load is specified at V<sub>out</sub> max with a ±50% external capacitor accuracy and includes temperature and process variation.
- (4) Load current varies proportionally with the output voltage. The slew rate is for increasing and decreasing voltages and the maximum load current is 1.1 A.

**Table 4-3. VDD1 dc-dc Regulator Characteristics (continued)**

| Parameter                         | Comments  | Min | Typ | Max | Unit |
|-----------------------------------|---|-----|-----|-----|------|
| External coil                     | Value   | 0.7 | 1   | 1.3 | µH   |
|                                   | DCR   |     |     | 0.1 | Ω    |
|                                   | Saturation current for TPS65950A2                         | 1.8 |     |     | A    |
|                                   | Saturation current for TPS65950A3                         | 2.1 |     |     |      |
| External capacitor <sup>(1)</sup> | Value   | 8   | 10  | 12  | µF   |
|                                   | Equivalent series resistance (ESR) at switching frequency | 0   |     | 20  | mΩ   |

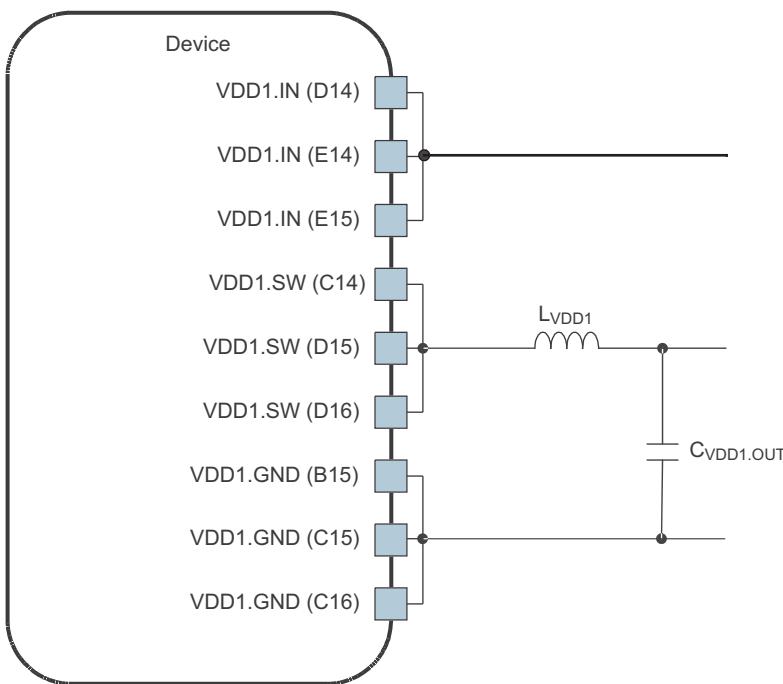
See [Table 2-2](#) for how to connect the VDD1/2 dc-dc converter when it is not used.

[Figure 4-2](#) shows the efficiency of the VDD1 dc-dc regulator in active and sleep modes.

**Figure 4-2. VDD1 dc-dc Regulator Efficiency**

#### 4.1.1.2 External Components and Application Schematic

[Figure 4-3](#) is an application schematic with the external components on the VDD1 dc-dc regulator.



032-005

**Figure 4-3. VDD1 dc-dc Application Schematic****NOTE**

For the component values, see [Table 15-1](#).

## 4.1.2 VDD2 dc-dc Regulator

### 4.1.2.1 VDD2 dc-dc Regulator Characteristics

The VDD2 dc-dc regulator is a programmable output stepdown dc-dc converter with an internal field effect transistor (FET). Like the VDD1 regulator, the VDD2 regulator can be placed in sleep or power-down mode and is SmartReflex-compatible. The VDD2 regulator differs from VDD1 in its current load capability. [Table 4-4](#) lists the characteristics of the regulator.

**Table 4-4. VDD2 dc-dc Regulator Characteristics**

| Parameter   | Comments   | Min | Typ  | Max | Unit   |
|---|--|-----|------|-----|--------|
| Input voltage range   |  | 2.7 | 3.6  | 4.5 | V      |
| Output voltage  |  | 0.6 | 1    | 1.5 | V      |
| Output voltage step   | Covering the 0.6-V to 1.45-V range, 1.5 V is a single programmable value.                                  |     | 12.5 |     | mV     |
| Output accuracy <sup>(1)</sup>  | 0.6 to < 0.8 V   | -6% |      | 6%  |        |
|   | 0.8 to 1.5 V   | -4% |      | 4%  |        |
| Switching frequency   |  |     | 3.2  |     | MHz    |
| Conversion efficiency <sup>(2)</sup> , <a href="#">Figure 4-4</a> in active mode and sleep mode | $I_O = 10 \text{ mA}$ , sleep  |     | 82%  |     |        |
|   | $100 \text{ mA} < I_O < 300 \text{ mA}$  |     | 85%  |     |        |
|   | $300 \text{ mA} < I_O < 500 \text{ mA}$  |     | 80%  |     |        |
| Output current  | Active mode  |     |      | 700 | mA     |
|   | Sleep mode   |     |      | 10  |        |
| Ground current ( $I_Q$ )  | Off at 30°C  |     |      | 1   | μA     |
|   | Sleep, unloaded  |     |      | 50  |        |
|   | Active, unloaded, not switching  |     |      | 300 |        |
| Short-circuit current   | $V_{IN} = V_{MAX}$   |     | 1.2  |     | A      |
| Load regulation   | $0 < I_O < I_{MAX}$  |     |      | 20  | mV     |
| Transient load regulation <sup>(3)</sup>  | $I_O = 10 \text{ mA}$ to $(I_{MAX}/2) + 10 \text{ mA}$ , Maximum slew rate is $I_{MAX}/2/100 \text{ ns}$ . | -65 |      | 50  | mV     |
| Line regulation   |  |     |      | 10  | mV     |
| Transient line regulation   | 300 mV <sub>PP</sub> ac input, 10-μs rise and fall time  |     |      | 10  | mV     |
| Output shunt resistor (internal pulldown)   |  |     | 500  | 700 | Ω      |
| Startup time  |  |     | 0.25 | 1   | ms     |
| Recovery time   | From sleep mode to on mode with constant load  |     | 25   | 100 | μs     |
| External coil   | Value  | 4   | 8    | 16  | mV/μs  |
|   | DCR  |     | 0.7  | 1   | 1.3 μH |
|   | Saturation current   | 900 |      |     | mA     |
| External capacitor <sup>(5)</sup>   | Value  | 8   | 10   | 12  | μF     |
|   | ESR at switching frequency   | 0   |      | 20  | mΩ     |

(1) Accuracy includes all variations (line and load regulations, line and load transients, temperature, and process)

(2)  $V_{BAT} = 3.8 \text{ V}$ ,  $V_{DD2} = 1.3 \text{ V}$ ,  $F_s = 3.2 \text{ MHz}$ ,  $L = 1 \mu\text{H}$ ,  $L_{DCR} = 100 \text{ mΩ}$ ,  $C = 10 \mu\text{F}$ ,  $ESR = 10 \text{ mΩ}$

(3) Output voltage must discharge the load current completely and settle to its final value within 100 μs.

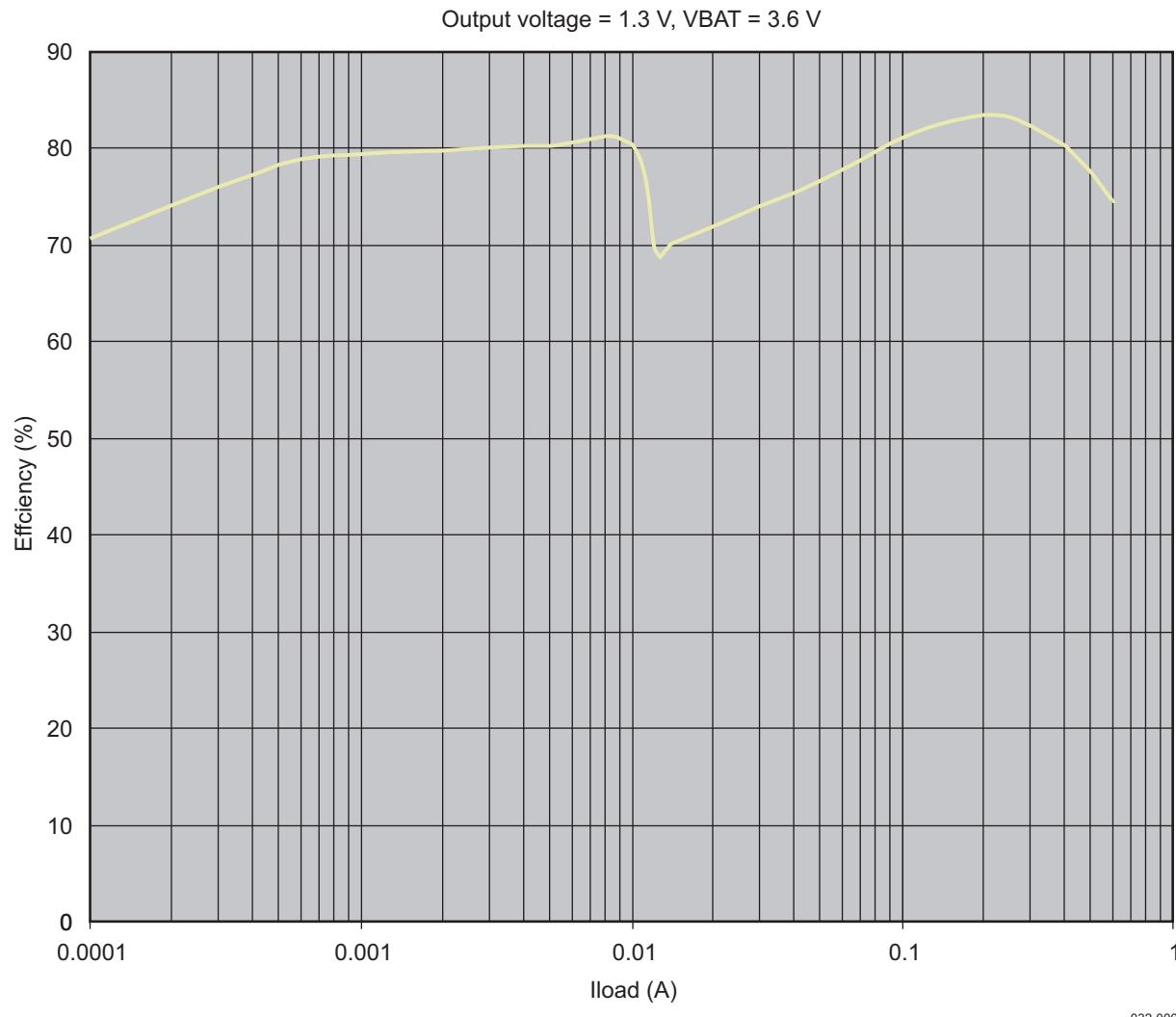
(4) Load current varies proportionally with the output voltage. The slew rate is for increasing and decreasing voltages and the maximum load current is 600 mA.

(5) Under current load condition step:

$I_{MAX}/2$  (300 mA) in 100 ns with a ±20% external capacitor accuracy or  
 $I_{MAX}/3$  (200 mA) in 100 ns with a ±50% external capacitor accuracy

See [Table 2-2](#) for how to connect the VDD2 dc-dc converter when it is not used.

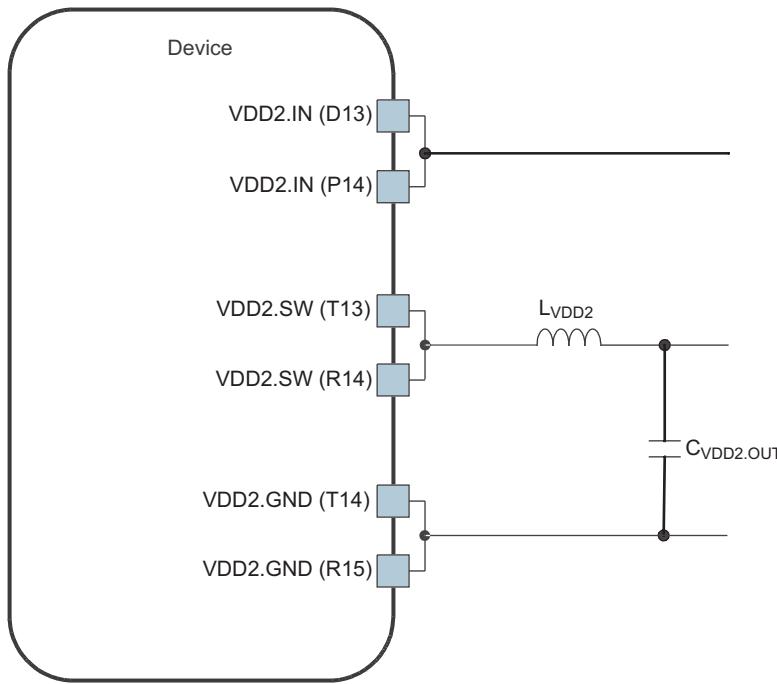
[Figure 4-4](#) shows the efficiency of the VDD2 dc-dc regulator in active and sleep modes.



**Figure 4-4. VDD2 dc-dc Regulator Efficiency**

#### 4.1.2.2 External Components and Application Schematic

[Figure 4-5](#) is an application schematic with the external components of the VDD2 dc-dc regulator.



032-007

**Figure 4-5. VDD2 dc-dc Application Schematic****NOTE**

For the component values, see [Table 15-1](#).

### 4.1.3 VIO dc-dc Regulator

#### 4.1.3.1 VIO dc-dc Regulator Characteristics

The I/Os and memory dc-dc regulator is a 600-mA stepdown dc-dc converter (internal FET) with two output voltage settings. It supplies the memories and all I/O ports in the application and is one of the first power providers to switch on in the power-up sequence. This dc-dc regulator can be placed in sleep or power-down mode; however, care must be taken in the sequencing of this power provider, because numerous electrostatic discharge (ESD) blocks are connected to this supply. [Table 4-5](#) lists the characteristics of the regulator.

**Table 4-5. VIO dc-dc Regulator Characteristics**

| Parameter  | Comments  | Min | Typ         | Max | Unit |
|--|---|-----|-------------|-----|------|
| Input voltage range  |   | 2.7 | 3.6         | 4.5 | V    |
| Output voltage <sup>(1)</sup>  |   |     | 1.8<br>1.85 |     | V    |
| Output accuracy <sup>(2)</sup>   |   | −4% |             | 4%  |      |
|  |   | −3% |             | 3%  |      |
| Switching frequency  |   |     | 3.2         |     | MHz  |
| Conversion efficiency <sup>(3)</sup> <a href="#">Figure 4-6</a> in active mode and sleep modes | I <sub>O</sub> = 10 mA, sleep                           |     | 85%         |     |      |
|  | 100 mA < I <sub>O</sub> < 400 mA                        |     | 85%         |     |      |
|  | 400 mA < I <sub>O</sub> < 600 mA                        |     | 80%         |     |      |
| Output current   | On mode   |     |             | 700 | mA   |
|  | Sleep mode  |     |             | 10  |      |
| Ground current (I <sub>G</sub> )   | Off at 30°C   |     |             | 1   | μA   |
|  | Sleep, unloaded   |     |             | 50  |      |
|  | Active, unloaded, not switching                         |     |             | 300 |      |
| Load transient <sup>(4)</sup>  |   |     |             | 50  | mV   |
| Line transient   | 300 mV <sub>PP</sub> ac, input rise and fall time 10 μs |     |             | 10  | mV   |
| Start-up time  |   |     | 0.25        | 1   | ms   |
| Recovery time  | From sleep mode to on mode with constant load           |     | <10         | 100 | μs   |
| Output shunt resistor (internal pulldown)  |   |     | 500         | 700 | Ω    |
| External coil  | Value   | 0.7 | 1           | 1.3 | μH   |
|  | DCR   |     |             | 0.1 | Ω    |
|  | Saturation current                                      | 900 |             |     | mA   |
| External capacitor   | Value   | 8   | 10          | 12  | μF   |
|  | ESR at switching frequency                              | 1   |             | 20  | mΩ   |

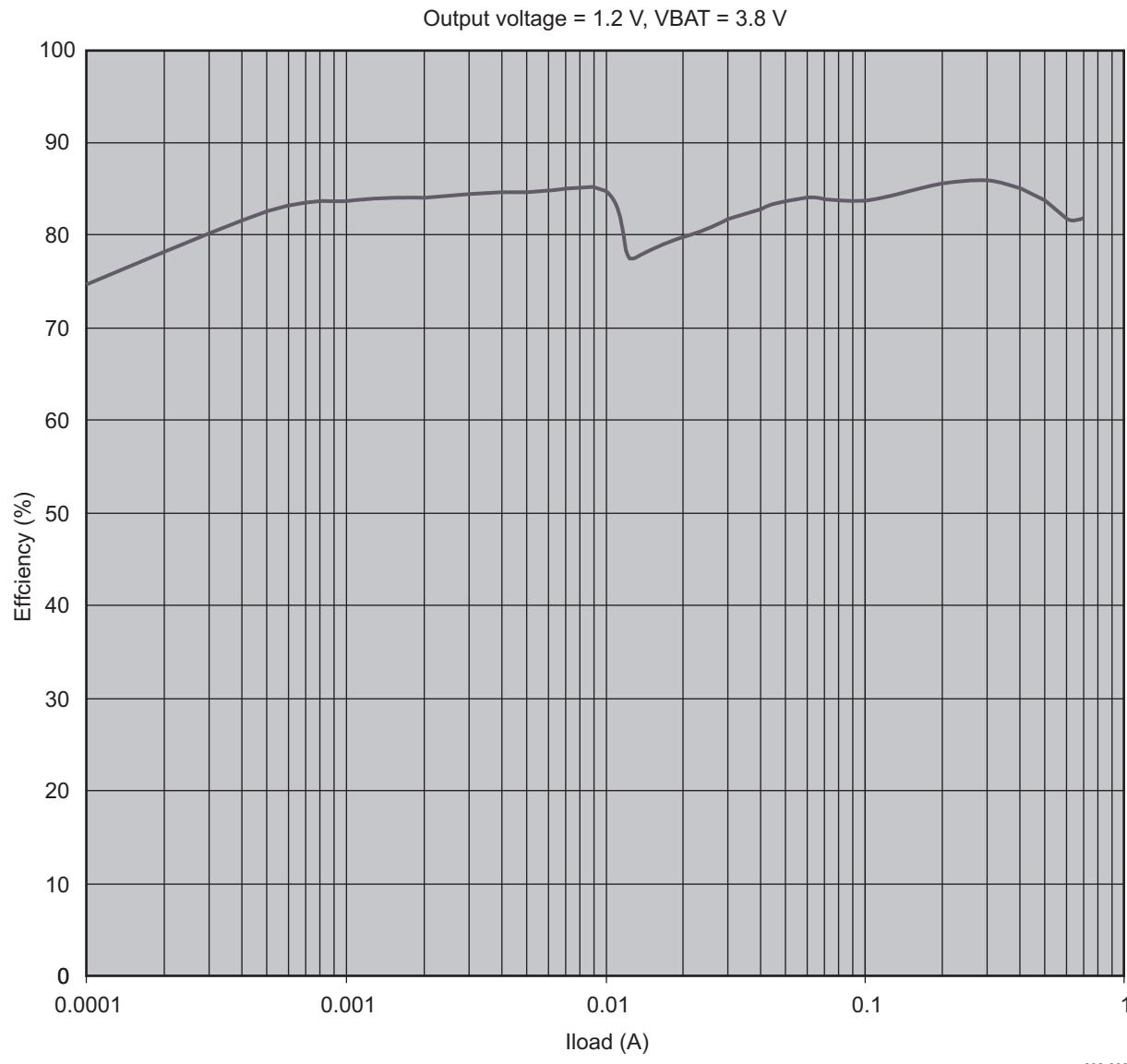
(1) This voltage is tuned according to the platform and transient requirements.

(2) ±4% accuracy includes all variations (line and load regulation, line and load transient, temperature, process).  
±3% accuracy is dc accuracy only.

(3) V<sub>BAT</sub> = 3.8 V, V<sub>IO</sub> = 1.8 V, F<sub>s</sub> = 3.2 MHz, L = 1 μH, L<sub>DCR</sub> = 100 mΩ, C = 10 μF, ESR = 10 mΩ

(4) Load transient can also be specified as 0 < I<sub>O</sub> < I<sub>OUTmax</sub>/2, Δt = 1 μs, 100 mV but this is not included in ±4% accuracy.

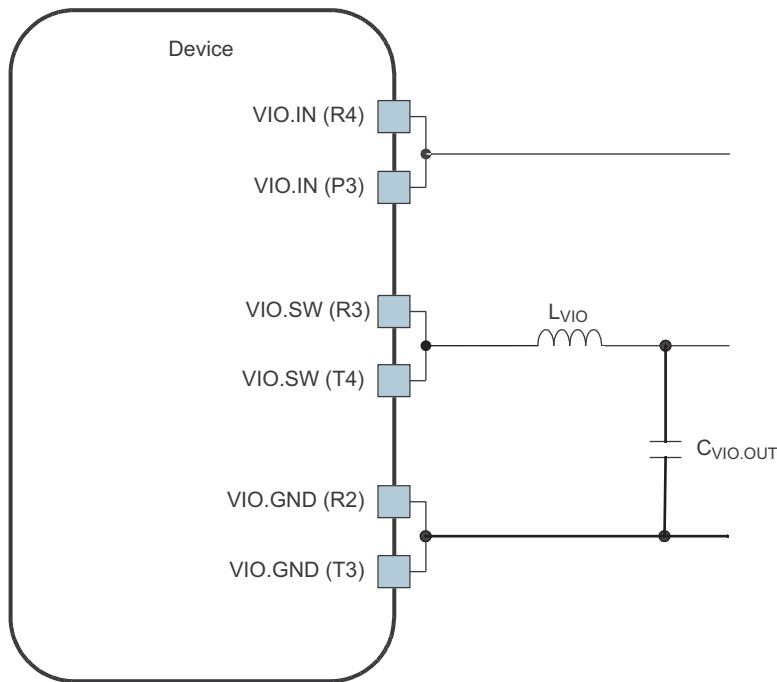
Figure 4-6 shows the efficiency of the VIO dc-dc regulator in active and sleep modes.



**Figure 4-6. VIO dc-dc Regulator Efficiency in Active Mode**

#### 4.1.3.2 External Components and Application Schematic

Figure 4-7 is an application schematic with the external components of the VIO dc-dc regulator.



032-009

**Figure 4-7. VIO dc-dc Application Schematic**

**NOTE**

For the component values, see [Table 15-1](#).

#### 4.1.4 VDAC LDO Regulator

The VDAC programmable LDO regulator is a high power-supply ripple rejection (PSRR), low-noise, linear regulator that powers the host processor dual-video DAC. It is controllable with registers through I<sup>2</sup>C and can be powered down. Table 4-6 lists the characteristics of the regulator.

**Table 4-6. VDAC LDO Regulator Characteristics**

| Parameter                         | Test Conditions   | Min   | Typ | Max   | Unit   |
|-----------------------------------|---|---|-----|-------|--------|
| <b>Output Load Conditions</b>     |   |   |     |       |        |
| Filtering capacitor               | Connected from VDAC.OUT to analog ground                                    | 0.3   | 1   | 2.7   | μF     |
| Filtering capacitor ESR           |   | 20  |     | 600   | mΩ     |
| <b>Electrical Characteristics</b> |   |   |     |       |        |
| V <sub>IN</sub>                   | Input voltage   | 2.7   | 3.6 | 4.5   | V      |
| V <sub>OUT</sub>                  | Output voltage  | 1.164   | 1.2 | 1.236 | V      |
|                                   |   | 1.261   | 1.3 | 1.339 |        |
|                                   |   | 1.746   | 1.8 | 1.854 |        |
| I <sub>OUT</sub>                  | Rated output current  | On mode   |     | 70    | mA     |
|                                   |   | Low-power mode  |     | 5     |        |
|                                   | dc load regulation  | On mode: 0 < I <sub>O</sub> < I <sub>Max</sub>  |     | 20    | mV     |
|                                   | dc line regulation  | On mode, V <sub>IN</sub> = V <sub>INmin</sub> to V <sub>INmax</sub> at I <sub>OUT</sub> = I <sub>OUTmax</sub> |     | 3     | mV     |
|                                   | Turn-on time  | I <sub>OUT</sub> = 0, C <sub>L</sub> = 1 μF (within 10% of V <sub>OUT</sub> )                                 |     | 100   | μs     |
|                                   | Wake-up time  | Full load capability  |     | 10    | μs     |
| Ripple rejection                  | f < 20 kHz  | 65  |     |       | dB     |
|                                   | 20 kHz < f < 100 kHz  | 45  |     |       |        |
|                                   | f = 1 MHz   | 40  |     |       |        |
|                                   | V <sub>IN</sub> = V <sub>OUT</sub> + 1 V, I <sub>O</sub> = I <sub>Max</sub> |   |     |       |        |
| Output noise                      | 100 Hz < f < 5 kHz  |   |     | 400   | nV/√Hz |
|                                   | 5 kHz < f < 400 kHz   |   |     | 125   |        |
|                                   | 400 kHz < f < 10 MHz  |   |     | 50    |        |
| Ground current                    | On mode, I <sub>OUT</sub> = 0   |   |     | 150   | μA     |
|                                   | On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub>                             |   |     | 350   |        |
|                                   | Low-power mode, I <sub>OUT</sub> = 0  |   |     | 15    |        |
|                                   | Low-power mode, I <sub>OUT</sub> = 1 mA                                     |   |     | 25    |        |
|                                   | Off mode at 55°C  |   |     | 1     |        |
| V <sub>DO</sub>                   | Dropout voltage   | On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub>   |     | 250   | mV     |
|                                   | Transient load regulation   | I <sub>Load</sub> : I <sub>Min</sub> – I <sub>Max</sub><br>Slew: 60 mA/μs                                     | -40 | 40    | mV     |
|                                   | Transient line regulation   | V <sub>IN</sub> drops 500 mV<br>Slew: 40 mV/μs  |     | 10    | mV     |

#### 4.1.5 VPLL1 LDO Regulator

The VPLL1 programmable LDO regulator is high-PSRR, low-noise, linear regulator used for the host processor phase-locked loop (PLL) supply. **Table 4-7** lists the characteristics of the regulator.

**Table 4-7. VPLL1 LDO Regulator Characteristics**

| Parameter                             | Test Conditions   | Min   | Typ | Max   | Unit |
|---------------------------------------|---|-------|-----|-------|------|
| <b>Output Load Conditions</b>         |   |       |     |       |      |
| Filtering capacitor                   | Connected from VPLL1.OUT to analog ground   | 0.3   | 1   | 2.7   | μF   |
| Filtering capacitor ESR               |   | 20    |     | 600   | mΩ   |
| <b>Electrical Characteristics</b>     |   |       |     |       |      |
| V <sub>IN</sub> Input voltage         |   | 2.7   | 3.6 | 4.5   | V    |
| V <sub>OUT</sub> Output voltage       | On mode and low-power mode  | 0.97  | 1.0 | 1.03  | V    |
|                                       |   | 1.164 | 1.2 | 1.236 |      |
|                                       |   | 1.261 | 1.3 | 1.339 |      |
|                                       |   | 1.746 | 1.8 | 1.854 |      |
|                                       |   | 2.716 | 2.8 | 2.884 |      |
|                                       |   | 2.91  | 3.0 | 3.090 |      |
| I <sub>OUT</sub> Rated output current | On mode   |       |     | 40    | mA   |
|                                       | Low-power mode  |       |     | 5     |      |
| dc load regulation                    | On mode: 0 < I <sub>O</sub> < I <sub>Max</sub>  |       |     | 20    | mV   |
| dc line regulation                    | On mode, V <sub>IN</sub> = V <sub>INmin</sub> to V <sub>INmax</sub> at I <sub>OUT</sub> = I <sub>OUTmax</sub> |       |     | 3     | mV   |
| Turn-on time                          | I <sub>OUT</sub> = 0, C <sub>L</sub> = 1 μF (within 10% of V <sub>OUT</sub> )                                 |       |     | 100   | μs   |
| Wake-up time                          | Full load capability  |       |     | 10    | μs   |
| Ripple rejection                      | f < 10 kHz  | 50    |     |       | dB   |
|                                       | 10 kHz < f < 100 kHz  | 40    |     |       |      |
|                                       | f = 1 MHz   | 30    |     |       |      |
|                                       | V <sub>IN</sub> = V <sub>OUT</sub> + 1 V, I <sub>O</sub> = I <sub>Max</sub>                                   |       |     |       |      |
| Ground current                        | On mode, I <sub>OUT</sub> = 0   |       |     | 70    | μA   |
|                                       | On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub>   |       |     | 110   |      |
|                                       | Low-power mode, I <sub>OUT</sub> = 0  |       |     | 15    |      |
|                                       | Low-power mode, I <sub>OUT</sub> = 1 mA   |       |     | 16    |      |
|                                       | Off mode at 55°C  |       |     | 1     |      |
| V <sub>DO</sub> Dropout voltage       | On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub>   |       |     | 250   | mV   |
| Transient load regulation             | I <sub>Load</sub> : I <sub>Min</sub> – I <sub>Max</sub><br>Slew: 60 mA/μs                                     | –40   |     | 40    | mV   |
|                                       |   |       |     |       |      |
| Transient line regulation             | V <sub>IN</sub> drops 500 mV<br>Slew: 40 mV/μs  |       |     | 10    | mV   |

#### 4.1.6 VPLL2 LDO Regulator

The VPLL2 programmable LDO regulator is a high-PSRR, low-noise, linear regulator used for the host processor PLL supply. [Table 4-8](#) lists the characteristics of the regulator.

**Table 4-8. VPLL2 LDO Regulator Characteristics**

| Parameter                         | Test Conditions                           | Min   | Typ  | Max   | Unit                          |    |
|-----------------------------------|---|---|--|---|-------------------------------|----|
| <b>Output Load Conditions</b>     |   |   |  |   |                               |    |
| Filtering capacitor               | Connected from VPLL2.OUT to analog ground | 0.3   | 1  | 2.7   | μF                            |    |
| Filtering capacitor ESR           |   | 20  |  | 600   | mΩ                            |    |
| <b>Electrical Characteristics</b> |   |   |  |   |                               |    |
| V <sub>IN</sub>                   | Input voltage                             | 2.7   | 3.6  | 4.5   | V                             |    |
| V <sub>OUT</sub>                  | Output voltage                            | 0.672<br>0.97<br>1.164<br>1.261<br>1.455<br>1.746<br>1.795<br>2.425<br>2.522<br>2.716<br>2.765<br>2.91<br>3.05  | 0.7<br>1.0<br>1.2<br>1.3<br>1.5<br>1.8<br>1.85<br>2.5<br>2.6<br>2.8<br>2.85<br>3.0<br>3.15 | 0.728<br>1.03<br>1.236<br>1.339<br>1.545<br>1.854<br>1.906<br>2.575<br>2.678<br>2.884<br>2.936<br>3.09<br>3.245 |                               | V  |
| I <sub>OUT</sub>                  | Rated output current                      | On mode<br>Low-power mode   |  |   | 100<br>5 mA                   |    |
|                                   | dc load regulation                        | On mode: 0 < I <sub>O</sub> < I <sub>Max</sub>  |  |   | 20 mV                         |    |
|                                   | dc line regulation                        | On mode, V <sub>IN</sub> = V <sub>INmin</sub> to V <sub>INmax</sub> at I <sub>OUT</sub> = I <sub>OUTmax</sub>   |  |   | 3 mV                          |    |
|                                   | Turn-on time                              | I <sub>OUT</sub> = 0, C <sub>L</sub> = 1 μF (within 10% of V <sub>OUT</sub> )   |  |   | 100 μs                        |    |
|                                   | Wake-up time                              | Full load capability  |  |   | 10 μs                         |    |
|                                   | Ripple rejection                          | f < 10 kHz<br>10 kHz < f < 100 kHz<br>f = 1 MHz<br>V <sub>IN</sub> = V <sub>OUT</sub> + 1 V, I <sub>O</sub> = I <sub>Max</sub>  | 50<br>40<br>30   |   |                               | dB |
|                                   | Ground current                            | On mode, I <sub>OUT</sub> = 0<br>On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub><br>Low-power mode, I <sub>OUT</sub> = 0<br>Low-power mode, I <sub>OUT</sub> = 1 mA<br>Off mode at 55°C |  |   | 70<br>160<br>17<br>20<br>1 μA |    |
| V <sub>DO</sub>                   | Dropout voltage                           | On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub>   |  |   | 250 mV                        |    |
|                                   | Transient load regulation                 | I <sub>Load</sub> : I <sub>Min</sub> – I <sub>Max</sub><br>Slew: 40 mA/μs   | -40  |   | 40 mV                         |    |
|                                   | Transient line regulation                 | V <sub>IN</sub> drops 500 mV<br>Slew: 40 mV/μs  |  |   | 10 mV                         |    |

#### 4.1.7 VMMC1 LDO Regulator

The VMMC1 LDO regulator is a programmable linear voltage converter that powers the multimedia channel (MMC) slot. It includes a discharge resistor and overcurrent (short -circuit) protection. This LDO regulator can also be turned off automatically when MMC card extraction is detected. The VMMC1 LDO can be powered through an independent supply other than the battery; for example, a charge pump (CP). In this case, the input from the VMMC1 LDO can be higher than the battery voltage. [Table 4-9](#) lists the characteristics of the regulator.

**Table 4-9. VMMC1 LDO Regulator Characteristics**

| Parameter                         | Test Conditions   | Min   | Typ                         | Max                                | Unit |
|-----------------------------------|---|---|-----------------------------|------------------------------------|------|
| <b>Output Load Conditions</b>     |   |   |                             |                                    |      |
| Filtering capacitor               | Connected from VMMC1.OUT to analog ground   | 0.3   | 1                           | 2.7                                | μF   |
| Filtering capacitor ESR           |   | 20  |                             | 600                                | mΩ   |
| <b>Electrical Characteristics</b> |   |   |                             |                                    |      |
| V <sub>IN</sub>                   | Input voltage   | 2.7   | 3.6                         | 5.5                                | V    |
| V <sub>OUT</sub>                  | Output voltage  | 1.7945<br>2.7645<br>2.91<br>3.0555              | 1.85<br>2.85<br>3.0<br>3.15 | 1.9055<br>2.9355<br>3.09<br>3.2445 | V    |
| I <sub>OUT</sub>                  | Rated output current  | On mode<br>Low-power mode                       |                             | 220<br>5                           | mA   |
| dc load regulation                | On mode: 0 < I <sub>O</sub> < I <sub>Max</sub>  |   |                             | 20                                 | mV   |
| dc line regulation                | On mode, V <sub>IN</sub> = V <sub>INmin</sub> to V <sub>INmax</sub> at I <sub>OUT</sub> = I <sub>OUTmax</sub>   |   |                             | 3                                  | mV   |
| Turn-on time                      | I <sub>OUT</sub> = 0, C <sub>L</sub> = 1 μF (within 10% of V <sub>OUT</sub> )   |   |                             | 100                                | μs   |
| Wake-up time                      | Full load capability  |   |                             | 10                                 | μs   |
| Ripple rejection                  | f < 10 kHz<br>10 kHz < f < 100 kHz<br>f = 1 MHz<br>V <sub>IN</sub> = V <sub>OUT</sub> + 1 V, I <sub>O</sub> = I <sub>Max</sub>  | 50<br>40<br>25                                  |                             |                                    | dB   |
| Ground current                    | On mode, I <sub>OUT</sub> = 0<br>On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub><br>Low-power mode, I <sub>OUT</sub> = 0<br>Low-power mode, I <sub>OUT</sub> = 5 mA<br>Off mode at 55°C |   |                             | 70<br>290<br>17<br>20<br>1         | μA   |
| V <sub>DO</sub>                   | Dropout voltage   | On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub> |                             | 250                                | mV   |
| Transient load regulation         | I <sub>Load</sub> : I <sub>Min</sub> – I <sub>Max</sub><br>Slew: 40 mA/μs   | -40   |                             | 40                                 | mV   |
| Transient line regulation         | V <sub>IN</sub> drops 500 mV<br>Slew: 40 mV/μs  |   |                             | 10                                 | mV   |

#### 4.1.8 VMMC2 LDO Regulator

The VMMC2 LDO regulator is a programmable linear voltage converter that powers MMC slot 2. It includes a discharge resistor and overcurrent (short-circuit) protection. The VMMC2 LDO can be powered through an independent supply other than the battery (for example, a CP). In this case, the input from the VMMC2 LDO can be higher than the battery voltage. [Table 4-10](#) lists the characteristics of the regulator.

**Table 4-10. VMMC2 LDO Regulator Characteristics**

| Parameter                         | Test Conditions  | Min   | Typ  | Max   | Unit             |
|-----------------------------------|--|-------|------|-------|------------------|
| <b>Output Load Conditions</b>     |  |       |      |       |                  |
| Filtering capacitor               | Connected from VMMC2.OUT to analog ground                          | 0.3   | 1    | 2.7   | $\mu\text{F}$    |
| Filtering capacitor ESR           |  | 20    |      | 600   | $\text{m}\Omega$ |
| <b>Electrical Characteristics</b> |  |       |      |       |                  |
| $V_{IN}$                          | Input voltage  | 2.7   | 3.6  | 5.5   | V                |
| $V_{OUT}$                         | Output voltage   | 0.7   | 1.0  | 1.03  |                  |
|                                   |  | 1.164 | 1.2  | 1.236 |                  |
|                                   |  | 1.261 | 1.3  | 1.339 |                  |
|                                   |  | 1.455 | 1.5  | 1.545 |                  |
|                                   |  | 1.746 | 1.8  | 1.854 |                  |
|                                   |  | 1.795 | 1.85 | 1.906 |                  |
|                                   |  | 2.425 | 2.5  | 2.575 |                  |
|                                   |  | 2.522 | 2.6  | 2.678 |                  |
|                                   |  | 2.716 | 2.8  | 2.884 |                  |
|                                   |  | 2.765 | 2.85 | 2.936 |                  |
| $I_{OUT}$                         | Rated output current   | 2.91  | 3.0  | 3.09  |                  |
|                                   | dc load regulation   | 3.056 | 3.15 | 3.245 |                  |
| $f$                               | dc line regulation   |       |      |       | mV               |
|                                   | Turn-on time   |       |      |       | $\mu\text{s}$    |
|                                   | Wake-up time   |       |      |       | $\mu\text{s}$    |
|                                   | Ripple rejection   | 50    |      |       |                  |
| $V_{IN}$                          | $f < 10 \text{ kHz}$   | 40    |      |       |                  |
|                                   | $10 \text{ kHz} < f < 100 \text{ kHz}$                             | 30    |      |       |                  |
|                                   | $f = 1 \text{ MHz}$  |       |      |       | dB               |
|                                   | $V_{IN} = V_{OUT} + 1 \text{ V}$ , $I_O = I_{MAX}$                 |       |      |       |                  |
|                                   |  |       |      |       |                  |
| Ground current                    | On mode, $I_{OUT} = 0$   |       |      |       | $\mu\text{A}$    |
|                                   | On mode, $I_{OUT} = I_{OUTmax}$                                    |       |      |       |                  |
|                                   | Low-power mode, $I_{OUT} = 0$                                      |       |      |       |                  |
|                                   | Low-power mode, $I_{OUT} = 50 \mu\text{A}$                         |       |      |       |                  |
|                                   | Off mode at $55^\circ\text{C}$                                     |       |      |       |                  |
| $V_{DO}$                          | Dropout voltage  |       |      |       | mV               |
| Transient load regulation         | On mode, $I_{OUT} = I_{OUTmax}$                                    |       |      |       |                  |
|                                   | $I_{Load}: I_{Min} - I_{Max}$<br>Slew: $40 \text{ mA}/\mu\text{s}$ | -40   |      |       | mV               |
| Transient line regulation         | $V_{IN}$ drops $500 \text{ mV}$                                    |       |      |       |                  |
|                                   | Slew: $40 \text{ mV}/\mu\text{s}$                                  |       |      |       | mV               |

#### 4.1.9 VSIM LDO Regulator

The VSIM voltage regulator is a programmable, low-dropout, linear voltage regulator that supplies the subscriber identity module (SIM)-card and the SIM-card driver. This LDO regulator can be turned off automatically when SIM card extraction is detected. **Table 4-11** lists the characteristics of the regulator.

**Table 4-11. VSIM LDO Regulator Characteristics**

| Parameter                         | Test Conditions                          | Min  | Typ                                    | Max  | Unit                       |
|-----------------------------------|--|--|--|--|----------------------------|
| <b>Output Load Conditions</b>     |  |  |  |  |                            |
| Filtering capacitor               | Connected from VSIM.OUT to analog ground | 0.3  | 1                                      | 2.7  | μF                         |
| Filtering capacitor ESR           |  | 20   |  | 600  | mΩ                         |
| <b>Electrical Characteristics</b> |  |  |  |  |                            |
| $V_{IN}$                          | Input voltage                            |  | 2.7                                    | 3.6  | 4.5                        |
|                                   |  |  |  |  | V                          |
| $V_{OUT}$                         | Output voltage                           | 0.97<br>1.164<br>1.261<br>1.746<br>2.716<br>2.91   | 1.0<br>1.2<br>1.3<br>1.8<br>2.8<br>3.0 | 1.03<br>1.236<br>1.339<br>1.854<br>2.884<br>3.09 | V                          |
| $I_{OUT}$                         | Rated output current                     | On mode<br>Low-power mode  |  |  | 50<br>1                    |
|                                   | dc load regulation                       | On mode: $0 < I_O < I_{MAX}$   |  |  | 20                         |
|                                   | dc line regulation                       | On mode, $V_{IN} = V_{INmin}$ to $V_{INmax}$ at $I_{OUT} = I_{OUTmax}$   |  |  | 3                          |
|                                   | Turn-on time                             | $I_{OUT} = 0$ , $C_L = 1 \mu F$ (within 10% of $V_{OUT}$ )   |  |  | 100                        |
|                                   | Wake-up time                             | Full load capability   |  |  | 10                         |
|                                   | Ripple rejection                         | $f < 10 \text{ kHz}$<br>$10 \text{ kHz} < f < 100 \text{ kHz}$<br>$f = 1 \text{ MHz}$<br>$V_{IN} = V_{OUT} + 1 \text{ V}$ , $I_O = I_{MAX}$                              | 50<br>40<br>30                         |  | dB                         |
|                                   | Ground current                           | On mode, $I_{OUT} = 0$<br>On mode, $I_{OUT} = I_{OUTmax}$<br>Low-power mode, $I_{OUT} = 0$<br>Low-power mode, $I_{OUT} = 1 \text{ mA}$<br>Off mode at $55^\circ\text{C}$ |  |  | 70<br>120<br>15<br>16<br>1 |
| $V_{DO}$                          | Dropout voltage                          | On mode, $I_{OUT} = I_{OUTmax}$  |  |  | 250                        |
|                                   | Transient load regulation                | $I_{Load}: I_{MIN} - I_{MAX}$<br>Slew: $40 \text{ mA}/\mu\text{s}$   | -40                                    |  | 40                         |
|                                   | Transient line regulation                | $V_{IN}$ drops $500 \text{ mV}$<br>Slew: $40 \text{ mV}/\mu\text{s}$   |  |  | 10                         |
|                                   |  |  |  |  | mV                         |

#### 4.1.10 VAUX1 LDO Regulator

The VAUX1 GP LDO regulator powers the auxiliary devices. The VAUX1 regulator can also support an inductive load such as a vibrator. While operating in vibrator mode, the VAUX1 LDO has the following features:

- Programmable, register-controlled, soft-start function
- Enabled through the VIBRA.SYNC pin
- Programmable, register-controlled, duty cycle (PWM generator) based on a nominal 4-Hz cycle derived from an internal 32-kHz clock

[Table 4-12](#) lists the characteristics of the regulator.

**Table 4-12. VAUX1 LDO Regulator Characteristics**

| Parameter                               | Test Conditions                           | Min  | Typ                             | Max                                      | Unit |
|---|---|--|---------------------------------|--|------|
| <b>Output Load Conditions</b>           |   |  |                                 |  |      |
| Filtering capacitor                     | Connected from VAUX1.OUT to analog ground | 0.3  | 1                               | 2.7                                      | μF   |
| Filtering capacitor ESR                 |   | 20   |                                 | 600                                      | mΩ   |
| Vibrator inductive load <sup>(1)</sup>  | Connected from VAUX1.OUT to analog ground | 70   |                                 | 700                                      | μH   |
| Vibrator load resistance <sup>(1)</sup> |   | 15   |                                 | 50                                       | Ω    |
| <b>Electrical Characteristics</b>       |   |  |                                 |  |      |
| $V_{IN}$                                | Input voltage                             | 2.7  | 3.6                             | 4.5                                      | V    |
| $V_{OUT}$                               | Output voltage                            | 1.455<br>1.746<br>2.425<br>2.716<br>2.91   | 1.5<br>1.8<br>2.5<br>2.8<br>3.0 | 1.545<br>1.854<br>2.575<br>2.884<br>3.09 | V    |
| $I_{OUT}$                               | Rated output current                      | On mode<br>Low-power mode  |                                 | 200<br>5                                 | mA   |
|   | dc load regulation                        | On mode: $I_{OUT} = I_{OUTmax}$ to 0   |                                 | 20                                       | mV   |
|   | dc line regulation                        | On mode, $V_{IN} = V_{INmin}$ to $V_{INmax}$ at $I_{OUT} = I_{OUTmax}$   |                                 | 3  | mV   |
|   | Turn-on time                              | $I_{OUT} = 0$ , $C_L = 1 \mu F$ (within 10% of $V_{OUT}$ )<br>Soft-start function for inductive load   |                                 | 100<br>500                               | μs   |
|   | Turn-off time                             |  |                                 | 5000                                     | μs   |
|   | Wake-up time                              | Full load capability   |                                 | 10                                       | μs   |
|   | Ripple rejection                          | $f < 10 \text{ kHz}$<br>$10 \text{ kHz} < f < 100 \text{ kHz}$<br>$f = 1 \text{ MHz}$<br>$V_{IN} = V_{OUT} + 1 \text{ V}$ , $I_O = I_{Max}$                | 50<br>40<br>25                  |  | dB   |
|   | Ground current                            | On mode, $I_{OUT} = 0$<br>On mode, $I_{OUT} = I_{OUTmax}$<br>Low-power mode, $I_{OUT} = 0$<br>Low-power mode, $I_{OUT} = 5 \text{ mA}$<br>Off mode at 55°C |                                 | 70<br>270<br>15<br>20<br>1               | μA   |
| $V_{DO}$                                | Dropout voltage                           | On mode, $I_{OUT} = I_{OUTmax}$  |                                 | 250                                      | mV   |
|   | Transient load regulation                 | $I_{Load}: I_{Min} - I_{Max}$<br>Slew: 40 mA/μs  | -40                             | 40                                       | mV   |
|   | Transient line regulation                 | $V_{IN}$ drops 500 mV<br>Slew: 40 mV/μs  |                                 | 10                                       | mV   |

(1) Parameter not tested, used for design specification only

#### 4.1.11 VAUX2 LDO Regulator

The VAUX2 GP LDO regulator powers the auxiliary devices. [Table 4-13](#) lists the characteristics of the regulator.

**Table 4-13. VAUX2 LDO Regulator Characteristics**

| Parameter                             | Test Conditions   | Min            | Typ  | Max                        | Unit |
|---------------------------------------|---|----------------|--|----------------------------|------|
| <b>Output Load Conditions</b>         |   |                |  |                            |      |
| Filtering capacitor                   | Connected from VAUX2.OUT to analog ground   | 0.3            | 1  | 2.7                        | μF   |
| Filtering capacitor ESR               |   | 20             |  | 600                        | mΩ   |
| <b>Electrical Characteristics</b>     |   |                |  |                            |      |
| V <sub>IN</sub> Input voltage         |   | 2.7            | 3.6  | 4.5                        | V    |
| V <sub>OUT</sub> Output voltage       | On mode and low-power mode  | -3%            | 1.3<br>1.5<br>1.7<br>1.8<br>1.9<br>2.0<br>2.1<br>2.2<br>2.3<br>2.4<br>2.5<br>2.8 | 3%                         | V    |
| I <sub>OUT</sub> Rated output current | On mode<br>Low-power mode   |                |  | 100<br>5                   | mA   |
| dc load regulation                    | On mode: I <sub>OUT</sub> = I <sub>OUTmax</sub> to 0  |                |  | 20                         | mV   |
| dc line regulation                    | On mode, V <sub>IN</sub> = V <sub>INmin</sub> to V <sub>INmax</sub> at I <sub>OUT</sub> = I <sub>OUTmax</sub>   |                |  | 3                          | mV   |
| Turn-on time                          | I <sub>OUT</sub> = 0, C <sub>L</sub> = 1 μF (within 10% of V <sub>OUT</sub> )   |                |  | 100                        | μs   |
| Wake-up time                          | Full load capability  |                |  | 10                         | μs   |
| Ripple rejection                      | f < 10 kHz<br>10 kHz < f < 100 kHz<br>f = 1 MHz<br>V <sub>IN</sub> = V <sub>OUT</sub> + 1 V, I <sub>O</sub> = I <sub>Max</sub>  | 50<br>40<br>25 |  |                            | dB   |
| Ground current                        | On mode, I <sub>OUT</sub> = 0<br>On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub><br>Low-power mode, I <sub>OUT</sub> = 0<br>Low-power mode, I <sub>OUT</sub> = 5 mA<br>Off mode at 55°C |                |  | 70<br>170<br>17<br>20<br>1 | μA   |
| V <sub>DO</sub> Dropout voltage       | On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub>   |                |  | 250                        | mV   |
| Transient load regulation             | I <sub>Load</sub> : I <sub>Min</sub> – I <sub>Max</sub><br>Slew: 40 mA/μs   | -40            |  | 40                         | mV   |
| Transient line regulation             | V <sub>IN</sub> drops 500 mV<br>Slew: 40 mV/μs  |                |  | 10                         | mV   |

#### 4.1.12 VAUX3 LDO Regulator

The VAUX3 GP LDO regulator powers the auxiliary devices. [Table 4-14](#) lists the characteristics of the regulator.

**Table 4-14. VAUX3 LDO Regulator Characteristics**

| Parameter                             | Test Conditions   | Min                                      | Typ                             | Max                                      | Unit |
|---------------------------------------|---|--|---------------------------------|--|------|
| <b>Output Load Conditions</b>         |   |  |                                 |  |      |
| Filtering capacitor                   | Connected from VAUX3.OUT to analog ground   | 0.3                                      | 1                               | 2.7                                      | μF   |
| Filtering capacitor ESR               |   | 20                                       |                                 | 600                                      | mΩ   |
| <b>Electrical Characteristics</b>     |   |  |                                 |  |      |
| V <sub>IN</sub> Input voltage         |   | 2.7                                      | 3.6                             | 4.5                                      | V    |
| V <sub>OUT</sub> Output voltage       | On mode and low-power mode  | 1.455<br>1.746<br>2.425<br>2.716<br>2.91 | 1.5<br>1.8<br>2.5<br>2.8<br>3.0 | 1.545<br>1.854<br>2.575<br>2.884<br>3.09 | V    |
| I <sub>OUT</sub> Rated output current | On mode<br>Low-power mode   |  |                                 | 200<br>5                                 | mA   |
| dc load regulation                    | On mode: I <sub>OUT</sub> = I <sub>OUTmax</sub> to 0  |  |                                 | 20                                       | mV   |
| dc line regulation                    | On mode, V <sub>IN</sub> = V <sub>INmin</sub> to V <sub>INmax</sub> at I <sub>OUT</sub> = I <sub>OUTmax</sub>   |  |                                 | 3  | mV   |
| Turn-on time                          | I <sub>OUT</sub> = 0, C <sub>L</sub> = 1 μF (within 10% of V <sub>OUT</sub> )   |  |                                 | 100                                      | μs   |
| Wake-up time                          | Full load capability  |  |                                 | 10                                       | μs   |
| Ripple rejection                      | f < 10 kHz<br>10 kHz < f < 100 kHz<br>f = 1 MHz<br>V <sub>IN</sub> = V <sub>OUT</sub> + 1 V, I <sub>O</sub> = I <sub>Max</sub>  | 50<br>40<br>25                           |                                 |  | dB   |
| Ground current                        | On mode, I <sub>OUT</sub> = 0<br>On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub><br>Low-power mode, I <sub>OUT</sub> = 0<br>Low-power mode, I <sub>OUT</sub> = 5 mA<br>Off mode at 55°C |  |                                 | 70<br>270<br>15<br>20<br>1               | μA   |
| V <sub>DO</sub> Dropout voltage       | On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub>   |  |                                 | 250                                      | mV   |
| Transient load regulation             | I <sub>Load</sub> : I <sub>Min</sub> – I <sub>Max</sub><br>Slew: 40 mA/μs   | -40                                      |                                 | 40                                       | mV   |
| Transient line regulation             | V <sub>IN</sub> drops 500 mV<br>Slew: 40 mV/μs  |  |                                 | 10                                       | mV   |

#### 4.1.13 VAUX4 LDO Regulator

The VAUX4 GP LDO regulator powers the auxiliary devices. The VAUX4 regulator has an independent supply input pin and can be preregulated by an external voltage. [Table 4-15](#) lists the characteristics of the regulator.

**Table 4-15. VAUX4 LDO Regulator Characteristics**

| Parameter                             | Test Conditions   | Min   | Typ  | Max   | Unit |   |
|---------------------------------------|---|---|--|---|------|---|
| <b>Output Load Conditions</b>         |   |   |  |   |      |   |
| Filtering capacitor                   | Connected from VAUX4.OUT to analog ground   | 0.3   | 1  | 2.7   | μF   |   |
| Filtering capacitor ESR               |   | 20  |  | 600   | mΩ   |   |
| <b>Electrical Characteristics</b>     |   |   |  |   |      |   |
| V <sub>IN</sub> Input voltage         |   | 2.7   | 3.6  | 4.5   | V    |   |
| V <sub>OUT</sub> Output voltage       | On mode and low-power mode  | 0.672<br>0.97<br>1.164<br>1.261<br>1.455<br>1.746<br>1.795<br>2.425<br>2.522<br>2.716<br>2.765<br>2.91<br>3.056 | 0.7<br>1.0<br>1.2<br>1.3<br>1.5<br>1.8<br>1.85<br>2.5<br>2.6<br>2.8<br>2.85<br>3.0<br>3.15 | 0.728<br>1.03<br>1.236<br>1.339<br>1.545<br>1.854<br>1.906<br>2.575<br>2.678<br>2.884<br>2.936<br>3.09<br>3.245 |      | V |
| I <sub>OUT</sub> Rated output current | On mode<br>Low-power mode   |   |  | 100<br>5  | mA   |   |
| dc load regulation                    | On mode: I <sub>OUT</sub> = I <sub>OUTmax</sub> to 0  |   |  | 20  | mV   |   |
| dc line regulation                    | On mode, V <sub>IN</sub> = V <sub>INmin</sub> to V <sub>INmax</sub> at I <sub>OUT</sub> = I <sub>OUTmax</sub>   |   |  | 3   | mV   |   |
| Turn-on time                          | I <sub>OUT</sub> = 0, C <sub>L</sub> = 1 μF (within 10% of V <sub>OUT</sub> )   |   |  | 100   | μs   |   |
| Wake-up time                          | Full load capability  |   |  | 10  | μs   |   |
| Ripple rejection                      | f < 10 kHz<br>10 kHz < f < 100 kHz<br>f = 1 MHz<br>V <sub>IN</sub> = V <sub>OUT</sub> + 1 V, I <sub>O</sub> = I <sub>Max</sub>  | 50<br>40<br>30  |  |   | dB   |   |
| Ground current                        | On mode, I <sub>OUT</sub> = 0<br>On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub><br>Low-power mode, I <sub>OUT</sub> = 0<br>Low-power mode, I <sub>OUT</sub> = 5 mA<br>Off mode at 55°C |   |  | 70<br>170<br>17<br>20<br>1  | μA   |   |
| V <sub>DO</sub> Dropout voltage       | On mode, I <sub>OUT</sub> = I <sub>OUTmax</sub>   |   |  | 250   | mV   |   |
| Transient load regulation             | I <sub>Load</sub> : I <sub>Min</sub> – I <sub>Max</sub><br>Slew: 40 mA/μs   | -40   |  | 40  | mV   |   |
| Transient line regulation             | V <sub>IN</sub> drops 500 mV<br>Slew: 40 mV/μs  |   |  | 10  | mV   |   |

#### 4.1.14 Internal LDOs

Table 4-16 lists the regulators that power the device, and the output loads associated with them.

**Table 4-16. Output Load Conditions**

| Regulator     | Parameter               | Test Conditions                              | Min | Typ | Max | Unit |
|---------------|-------------------------|--|-----|-----|-----|------|
| VINTDIG LDO   | Filtering capacitor     | Connected from VINTDIG.OUT to analog ground  | 0.3 | 1   | 2.7 | µF   |
|               | Filtering capacitor ESR |  | 20  |     | 600 | mΩ   |
| VINTANA1 LDO  | Filtering capacitor     | Connected from VINTANA1.OUT to analog ground | 0.3 | 1   | 2.7 | µF   |
|               | Filtering capacitor ESR |  | 20  |     | 600 | mΩ   |
| VINTANA2 LDO  | Filtering capacitor     | Connected from VINTANA2.OUT to analog ground | 0.3 | 1   | 2.7 | µF   |
|               | Filtering capacitor ESR |  | 20  |     | 600 | mΩ   |
| VRUSB_3V1 LDO | Filtering capacitor     | Connected from VUSB.3P1 to GND               | 0.3 | 1   | 2.7 | µF   |
|               | Filtering capacitor ESR |  | 0   | 10  | 600 | mΩ   |
| VRUSB_1V8 LDO | Filtering capacitor     | Connected from VINTUSB1P8.OUT to GND         | 0.3 | 1   | 2.7 | µF   |
|               | Filtering capacitor ESR |  | 0   | 10  | 600 | mΩ   |
| VRUSB_1V5 LDO | Filtering capacitor     | Connected from VINTUSB1P5 to GND             | 0.3 | 1   | 2.7 | µF   |
|               | Filtering capacitor ESR |  | 0   | 10  | 600 | mΩ   |

#### 4.1.15 CP

The CP generates a 4.8-V (nominal) power supply voltage from the battery to the VBUS pin. The input voltage range is 2.7 to 4.5 V for the battery voltage. The CP operating frequency is 1 MHz.

The CP tolerates 7 V on VBUS when it is in power-down mode. The CP integrates a short-circuit current limitation at 450 mA. Table 4-17 lists the characteristics of the CP.

**Table 4-17. CP Characteristics**

| Parameter                         | Test Conditions  | Min   | Typ | Max  | Unit |    |
|-----------------------------------|--|---|-----|------|------|----|
| <b>Output Load Conditions</b>     |  |   |     |      |      |    |
| Filtering capacitor               | Connected from VBUS to VSSP  | 1.41  | 4.7 | 6.5  | µF   |    |
| Flying capacitor                  | Connected from CP to CN  | 1.32  | 2.2 | 3.08 | µF   |    |
| Filtering capacitor ESR           |  |   |     | 20   | mΩ   |    |
| <b>Electrical Characteristics</b> |  |   |     |      |      |    |
| V <sub>IN</sub>                   | Input voltage  | On mode: V <sub>IN</sub> = V <sub>BAT</sub> | 2.7 | 3.6  | 4.5  | V  |
| V <sub>O</sub>                    | Output voltage   |   | 4.6 | 4.8  | 5.25 | V  |
| I <sub>load</sub>                 | Rated output current   | VBAT > 3 V at VBUS                          | 0   |      | 100  | mA |
|                                   |  | 2.7 V < VBAT < 3 V, at VBUS                 | 0   |      | 50   |    |
| Efficiency                        | I <sub>Load</sub> = 100 mA, V <sub>BAT</sub> = 3.6 V                       |   |     | 55%  |      |    |
| Setting time                      | I <sub>LOADmax/2</sub> to I <sub>LOADmax</sub> in 5 µs                     |   | 100 | 400  | µs   |    |
| Startup time                      |  |   |     | 3    | ms   |    |
| Short-circuit limitation current  |  | 250   | 350 | 450  | mA   |    |
| dc load regulation                | I <sub>LOADmin</sub> to I <sub>LOADmax</sub>                               |   | 250 | 500  | mV   |    |
| dc line regulation                | 3.0 V to V <sub>BATmax</sub><br>I <sub>Load</sub> = 100 mA                 |   | 250 | 350  | mV   |    |
| Transient load regulation         | I <sub>VBUS_5Vmax/2</sub> – I <sub>VBUS_5Vmax</sub><br>50 µs, C = 2*4.7 µF |   | 300 | 350  | mV   |    |
|                                   | 0 – I <sub>VBUS_5Vmax/2</sub> , 50 µs, C = 2*4.7 µF                        |   |     | 350  |      |    |
| Transient line regulation         | V <sub>BATmin</sub> to V <sub>BATmax</sub> in 50 µs, C = 2*4.7 µF          |   | 300 | 350  | mV   |    |

#### 4.1.16 USB LDO Short-Circuit Protection Scheme

The short-circuit current for the LDOs and dc-dc converters in TPS65950 is approximately twice the maximum load current. In certain cases when the output of the block is shorted to ground, the power dissipation can exceed the 1.2-W requirement if no action is taken. A short-circuit protection scheme is included in the TPS65950 to ensure that if the output of an LDO or dc-dc is short-circuited, the power dissipation does not exceed the 1.2-W level.

The three USB LDOs, VRUSB3V1, VRUSB1V8, and VRUSB1V5, are included in this short-circuit protection scheme, which monitors the LDO output voltage at a frequency of 1 Hz and generates an interrupt (sc\_it) when a short circuit is detected.

The scheme compares the LDO output voltage to a reference voltage and detects a short circuit if the LDO voltage drops below this reference value (0.5 or 0.75 V programmable). In the case of the VRUSB3V1 and VRUSB1V8 LDOs, the reference is compared with a divided-down voltage (1.5 V typical).

If a short circuit is detected on VRUSB3V1, the power subchip FSM switches this LDO to sleep mode.

If a short circuit is detected on VRUSB1V8 or VRUSB1V5, the power subchip FSM switches off the relevant LDO.

#### 4.2 Power References

The bandgap voltage reference is filtered (resistance/capacitance [RC] filter) using an external capacitor connected across the V<sub>REF</sub> output and an analog ground (REFGND). The V<sub>REF</sub> voltage is scaled, distributed, and buffered in the device. The bandgap is started in fast mode (not filtered), and is set automatically by the D machine in slow mode (filtered, less noisy) when required.

**Table 4-18** lists the characteristics of the voltage references.

**Table 4-18. Voltage Reference Characteristics**

| Parameter                         | Test Conditions  | Min   | Typ   | Max                        | Unit    |
|-----------------------------------|--|-------|-------|----------------------------|---------|
| <b>Output Load Condition</b>      |  |       |       |                            |         |
| Filtering capacitor               | Connected from V <sub>REF</sub> to REFGND  | 0.3   | 1     | 2.7                        | μF      |
| <b>Electrical Characteristics</b> |  |       |       |                            |         |
| V <sub>IN</sub>                   | Input voltage  | 2.7   | 3.6   | 4.5                        | V       |
|                                   | Internal bandgap reference voltage   | 1.272 | 1.285 | 1.298                      | V       |
|                                   | Reference voltage (V <sub>REF</sub> terminal)  | 0.725 | 0.75  | 0.7575                     | V       |
|                                   | Retention mode reference   | 0.492 | 0.5   | 0.508                      | V       |
| I <sub>REF</sub>                  | NMOS sink  | 0.9   | 1     | 1.1                        | μA      |
| Ground current                    | Bandgap<br>IREF block<br>Preregulator<br>V <sub>REF</sub> buffer<br>Retention reference buffer |       |       | 25<br>20<br>15<br>10<br>10 | μA      |
| Output spot noise                 | 100 Hz   |       |       | 1                          | μV/√Hz  |
| A-weighted noise (rms)            |  |       | 200   |                            | nV (ms) |
| P-weighted noise (rms)            |  |       | 150   |                            | nV (ms) |
| Integrated noise                  | 20 Hz to 100 kHz   |       | 2.2   |                            | μV      |
| I <sub>BIAS</sub> trim bit LSB    |  |       |       | 0.1                        | μA      |
| Ripple rejection                  | < 1 MHz from V <sub>BAT</sub>  | 60    |       |                            | dB      |
| Start-up time                     |  |       |       | 1                          | ms      |

## 4.3 Power Control

### 4.3.1 Backup Battery Charger

If the backup battery is rechargeable, it can be recharged from the main battery. A programmable voltage regulator powered by the main battery allows recharging of the backup battery. The backup battery charge must be enabled using a control bit register. Recharging starts when two conditions are met:

- Main battery voltage > backup battery voltage
- Main battery > 3.2 V

The comparators of the backup battery system (BBS) give the two thresholds of the backup battery charge startup. The programmed voltage for the charger gives the end-of-charge threshold. The programmed current for the charger gives the charge current.

Overcharging is prevented by measurement of the backup battery voltage through the GP ADC. [Table 4-19](#) lists the characteristics of the backup battery charger.

**Table 4-19. Backup Battery Charger Characteristics**

| Parameter   | Test Conditions                           | Min  | Typ  | Max | Unit |
|---|---|------|------|-----|------|
| VBACKUP-to-MADC input attenuation                 | VBACKUP from 1.8 to 3.3 V                 |      | 0.33 |     | V/V  |
| Backup battery charging current                   | VBACKUP = 2.8 V, BBCHEN = 1, BBSEL = 00   | 10   | 25   | 45  | µA   |
|   | VBACKUP = 2.8 V, BBCHEN = 1, BBSEL = 01   | 105  | 150  | 270 | µA   |
|   | VBACKUP = 2.8 V, BBCHEN = 1, BBSEL = 10   | 350  | 500  | 900 | µA   |
|   | VBACKUP = 2.8 V, BBCHEN = 1, BBSEL = 11   | 0.7  | 1    | 1.8 | mA   |
|   | VBACKUP = 0 V, BBCHEN = 1, BBSEL = 00     | 17.5 | 25   | 45  | µA   |
|   | VBACKUP = 0 V, BBCHEN = 1, BBSEL = 01     | 105  | 150  | 270 | µA   |
|   | VBACKUP = 0 V, BBCHEN = 1, BBSEL = 10     | 350  | 500  | 900 | µA   |
|   | VBACKUP = 0 V, BBCHEN = 1, BBSEL = 11     | 0.7  | 1    | 1.8 | mA   |
| End backup battery charging voltage:<br>VBBCHGEND | I <sub>VBACKUP</sub> = -10 µA, BBSEL = 00 | 2.4  | 2.5  | 2.6 | V    |
|   | I <sub>VBACKUP</sub> = -10 µA, BBSEL = 01 | 2.9  | 3.0  | 3.1 | V    |
|   | I <sub>VBACKUP</sub> = -10 µA, BBSEL = 10 | 3.0  | 3.1  | 3.2 | V    |
|   | I <sub>VBACKUP</sub> = -10 µA, BBSEL = 11 | 3.1  | 3.2  | 3.3 | V    |

### 4.3.2 Battery Monitoring and Threshold Detection

#### 4.3.2.1 Power On/Power Off and Backup Conditions

[Table 4-20](#) lists the threshold levels of the battery.

**Table 4-20. Battery Threshold Levels**

| Parameter                             | Test Conditions  | Min         | Typ          | Max          | Unit |
|---------------------------------------|--|-------------|--------------|--------------|------|
| Main battery charged threshold VMBCH  | Measured on VBAT terminal  | 3.1         | 3.2          | 3.3          | V    |
| Main battery low threshold VMBLO      | VBACKUP = 3.2 V, measured on VBAT terminal (monitored on terminal ONOFF)   | 2.55        | 2.7          | 2.85         | V    |
| Main battery high threshold VMBHI     | Measured on terminal VBAT, VBACKUP = 0 V<br>Measured on terminal VBAT, VBACKUP = 3.2 V                                       | 2.5<br>2.5  | 2.65<br>2.85 | 2.95<br>2.95 | V    |
| Batteries not present threshold VBNPR | Measured on terminal VBACKUP with VBAT < 2.1 V<br>Measured on terminal VBAT with VBACKUP = 0 V (monitored on terminal VRRTC) | 1.6<br>1.95 | 1.8<br>2.1   | 2.0<br>2.25  | V    |

### 4.3.3 VRRTC LDO Regulator

The VRRTC voltage regulator is a programmable, low dropout, linear voltage regulator supplying (1.5 V) the embedded real-time clock (32.768-kHz oscillator) and dedicated I/Os of the digital host counterpart. The VRRTC regulator is also the supply voltage of the power-management digital state-machine. The VRRTC regulator is supplied from the UPR line, switched on by the main or backup battery, depending on the system state. The VRRTC output is present as long as a valid energy source is present. The VRRTC line is supplied by an LDO when  $V_{BAT} > 2.7$ , and a clamp circuit when in backup mode. [Table 4-21](#) describes the regulator characteristics.

**Table 4-21. VRRTC LDO Regulator Characteristics**

| Parameter                         |                                | Test Conditions   | Min  | Typ       | Max  | Unit |
|-----------------------------------|--------------------------------|---|------|-----------|------|------|
| <b>Output Load Conditions</b>     |                                |   |      |           |      |      |
|                                   | Filtering capacitor            | Connected from VRRTC.OUT to analog ground   | 0.3  | 1         | 2.7  | μF   |
|                                   | Filtering capacitor ESR        |   | 20   |           | 600  | mΩ   |
| <b>Electrical Characteristics</b> |                                |   |      |           |      |      |
| $V_{IN}$                          | Input voltage                  | On mode   | 2.7  | $V_{BAT}$ | 4.5  | V    |
| $V_{OUT}$                         | Output voltage                 | On mode   | 1.45 | 1.5       | 1.55 | V    |
| $I_{OUT}$                         | Rated output current           | On mode   |      |           | 30   | mA   |
|                                   |                                | Sleep mode  |      |           | 1    |      |
|                                   | DC load regulation             | On mode: $I_{OUT} = I_{OUT\max}$ to 0   |      |           | 100  | mV   |
|                                   | DC line regulation             | On mode, $V_{IN} = V_{IN\min}$ to $V_{IN\max}$ at $I_{OUT} = I_{OUT\max}$                     |      |           | 100  | mV   |
|                                   | Turn-on time                   | $I_{OUT} = 0$ , at $V_{OUT} = V_{OUT\text{final}} \pm 3\%$                                    |      | 100       |      | μs   |
|                                   | Wake-up time                   | On mode from low power to On mode, $I_{OUT} = 0$ , at $V_{OUT} = V_{OUT\text{final}} \pm 3\%$ |      | 100       |      | μs   |
|                                   |                                | From backup to On mode, $I_{OUT} = 0$ , at $V_{OUT} = V_{OUT\text{final}} \pm 3\%$            |      | 100       |      |      |
|                                   | Ripple rejection (VRRTC)       | $f < 10$ kHz  | 50   |           |      | dB   |
|                                   |                                | $10$ kHz $< f < 100$ kHz  | 40   |           |      |      |
|                                   |                                | $f = 1$ MHz   | 30   |           |      |      |
|                                   |                                | $V_{IN} = V_{OUT} + 1$ V, $I_O = I_{MAX}$   |      |           |      |      |
|                                   | Ground current                 | On mode, $I_{OUT} = 0$  |      |           | 70   | μA   |
|                                   |                                | On mode, $I_{OUT} = I_{OUT\max}$  |      |           | 100  |      |
|                                   |                                | Sleep mode, $I_{OUT} = 0$   |      |           | 10   |      |
|                                   |                                | Sleep mode, $I_{OUT} = 1$ mA  |      |           | 11   |      |
|                                   |                                | Off mode  |      |           | 1    |      |
| $V_{DO}$                          | Dropout voltage <sup>(1)</sup> | On mode, $I_{OUT} = I_{OUT\max}$  |      |           | 250  | mV   |
|                                   | Transient load regulation      | $I_{LOAD}: I_{MIN} - I_{MAX}$<br>Slew: 40 mA/μs   | -40  |           | 40   | mV   |
|                                   | Transient line regulation      | $V_{IN}$ drops 500 mV<br>Slew: 40 mV/μs   |      |           | 10   | mV   |
|                                   | Overshoot                      | Softstart   |      |           | 3%   |      |
|                                   | Pull down resistance           | Default in off mode   | 250  | 320       | 450  | Ω    |

(1) For nominal output voltage

## 4.4 Power Consumption

Table 4-22 describes the power consumption, depending on the use cases.

### NOTE

Typical power consumption is obtained in nominal operating conditions with the TPS65950 in stand-alone mode.

**Table 4-22. Power Consumption**

| Mode           | Description  | Typical Consumption                             |
|----------------|--|---|
| Backup         | Only the RTC date is maintained with a couple of registers in the backup domain. No main source is connected. Consumption is on the backup battery.  | VBAT not present $2.25 * 3.2 = 7.2 \mu\text{W}$ |
| Wait-on        | The phone is apparently off for the user, a main battery is present and well-charged. The RTC registers (registers in the backup domain) are maintained. Wake-up capabilities (like the PWRON button) are available. | VBAT = 3.8 V $64 * 3.8 = 243.2 \mu\text{W}$     |
| Active No Load | The subsystem is powered by the main battery, all supplies are enabled with full current capability, internal reset is released, and the associated processor is running.  | VBAT = 3.8 V $3291 * 3.8 = 12505 \mu\text{W}$   |
| Sleep No Load  | The main battery powers the subsystem, selected supplies are enabled but in low-consumption mode, and the associated processor is in low-power mode.   | VBAT = 3.8 V $496 * 3.8 = 1884.4 \mu\text{W}$   |

Table 4-23 lists the regulator states for each mode.

**Table 4-23. Regulator States Depending on Use Cases**

| Regulator | Mode   |         |               |                |
|-----------|--------|---------|---------------|----------------|
|           | Backup | Wait-On | Sleep No Load | Active No Load |
| VAUX1     | OFF    | OFF     | OFF           | OFF            |
| VAUX2     | OFF    | OFF     | SLEEP         | ON             |
| VAUX3     | OFF    | OFF     | OFF           | OFF            |
| VAUX4     | OFF    | OFF     | SLEEP         | ON             |
| VMMC1     | OFF    | OFF     | OFF           | OFF            |
| VMMC2     | OFF    | OFF     | SLEEP         | ON             |
| VPOLL1    | OFF    | OFF     | SLEEP         | ON             |
| VPOLL2    | OFF    | OFF     | SLEEP         | ON             |
| VSIM      | OFF    | OFF     | OFF           | OFF            |
| VDAC      | OFF    | OFF     | OFF           | OFF            |
| VINTANA1  | OFF    | OFF     | SLEEP         | ON             |
| VINTANA2  | OFF    | OFF     | SLEEP         | ON             |
| VINTDIG   | OFF    | OFF     | SLEEP         | ON             |
| VIO       | OFF    | OFF     | SLEEP         | ON             |
| VDD1      | OFF    | OFF     | SLEEP         | ON             |
| VDD2      | OFF    | OFF     | SLEEP         | ON             |
| VUSB_1V5  | OFF    | OFF     | OFF           | OFF            |
| VUSB_1V8  | OFF    | OFF     | OFF           | OFF            |
| VUSB_3V1  | OFF    | OFF     | SLEEP         | SLEEP          |

## 4.5 Power Management

### 4.5.1 Boot Modes

The modes corresponding to the BOOT0–BOOT1 combination value are listed in [Table 4-24](#).

**Table 4-24. BOOT Mode Description**

| Name  | Description            | BOOT0 | BOOT1 |
|-------|------------------------|-------|-------|
|       | Reserved               | 0     | 0     |
| MC027 | Master_C027_Generic 01 | 0     | 1     |
| MC021 | Master_C021_Generic 10 | 1     | 0     |
| SC021 | Slave_C021_Generic 11  | 1     | 1     |

### 4.5.2 Process Modes

The process modes parameter defines:

- The boot voltage for the host core
- The boot sequence associated with the process
- The dynamic voltage and frequency scaling (DVFS) protocol associated with the process

#### 4.5.2.1 C027.0 Mode

[Table 4-25](#) lists the parameters for C027.0 mode.

**Table 4-25. C027.0 Mode Description**

|                   |                               |
|-------------------|-------------------------------|
| Boot core voltage | 1.3 V                         |
| Power sequence    | VIO followed by VDD1 and VPLL |
| DVFS protocol     | VMODE1/2                      |

#### 4.5.2.2 C021.M Mode

[Table 4-26](#) lists the parameters for C021.M mode.

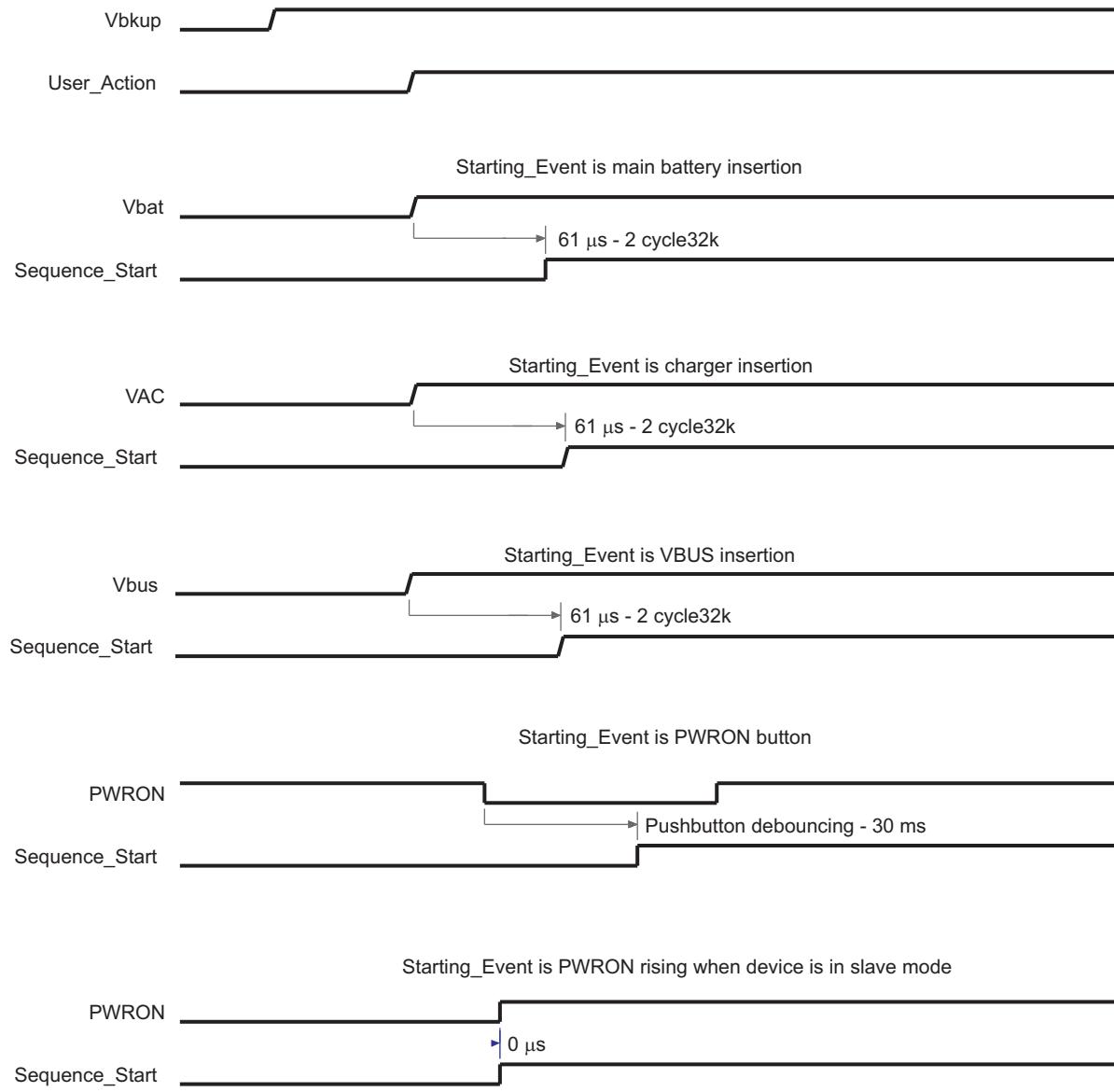
**Table 4-26. C021.M Mode Description**

|                   |                                     |
|-------------------|-------------------------------------|
| Boot core voltage | 1.2 V                               |
| Power sequence    | VIO followed by VPLL1, VDD2, VDD1   |
| DVFS protocol     | SmartReflex IF ( $I^2C$ high speed) |

### 4.5.3 Power-On Sequence

#### 4.5.3.1 Timings Before Sequence\_Start

The starting time of the power-on sequence relative to external events is shown in [Figure 4-8](#).



032-010

**Figure 4-8. Timings Before Sequence Start**

#### 4.5.3.2 OMAP2 Power-On Sequence

Figure 4-9 shows the timing and control that must occur in Master\_C027\_Generic mode. **Sequence\_Start** occurs according to the events shown in Figure 4-8.

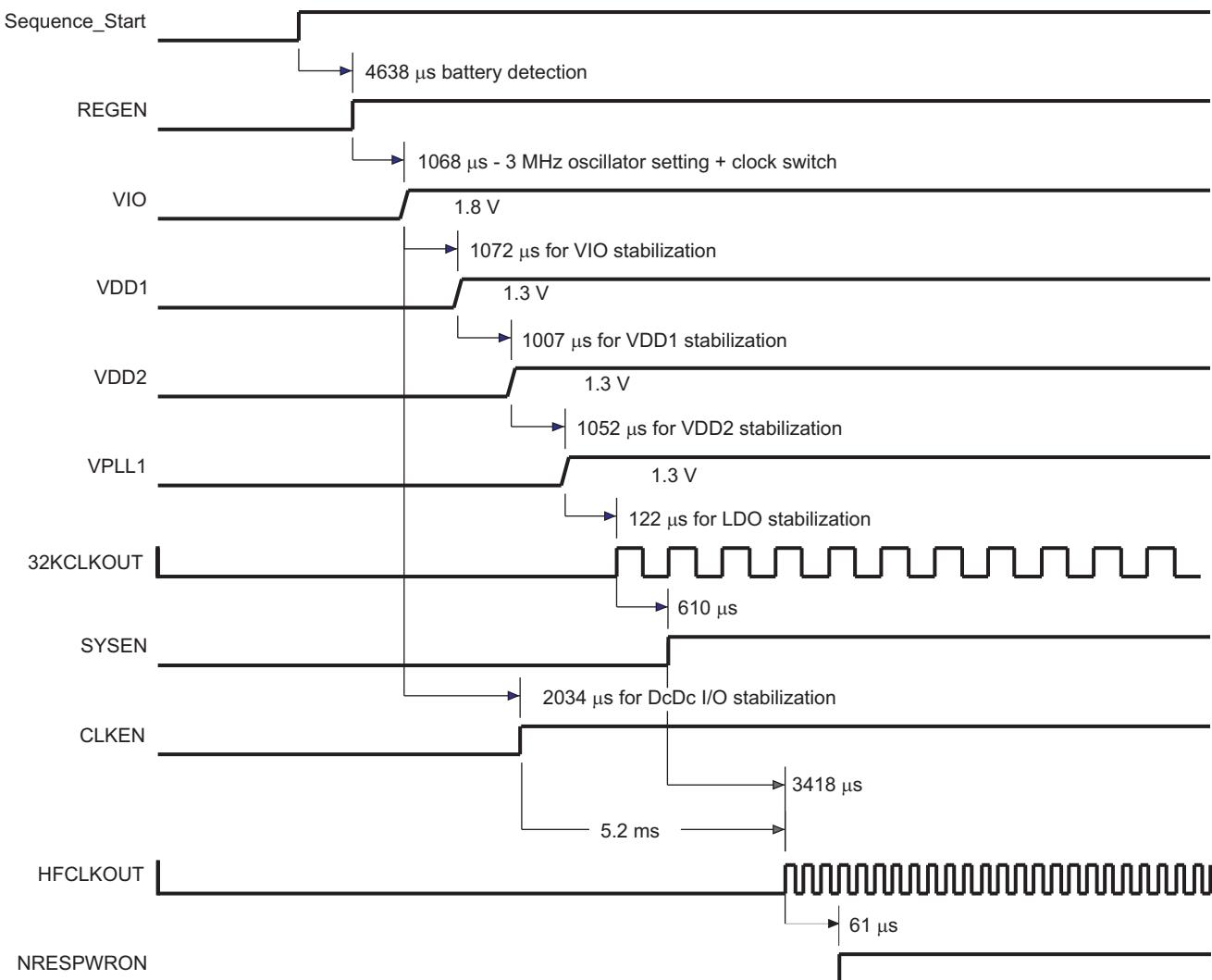
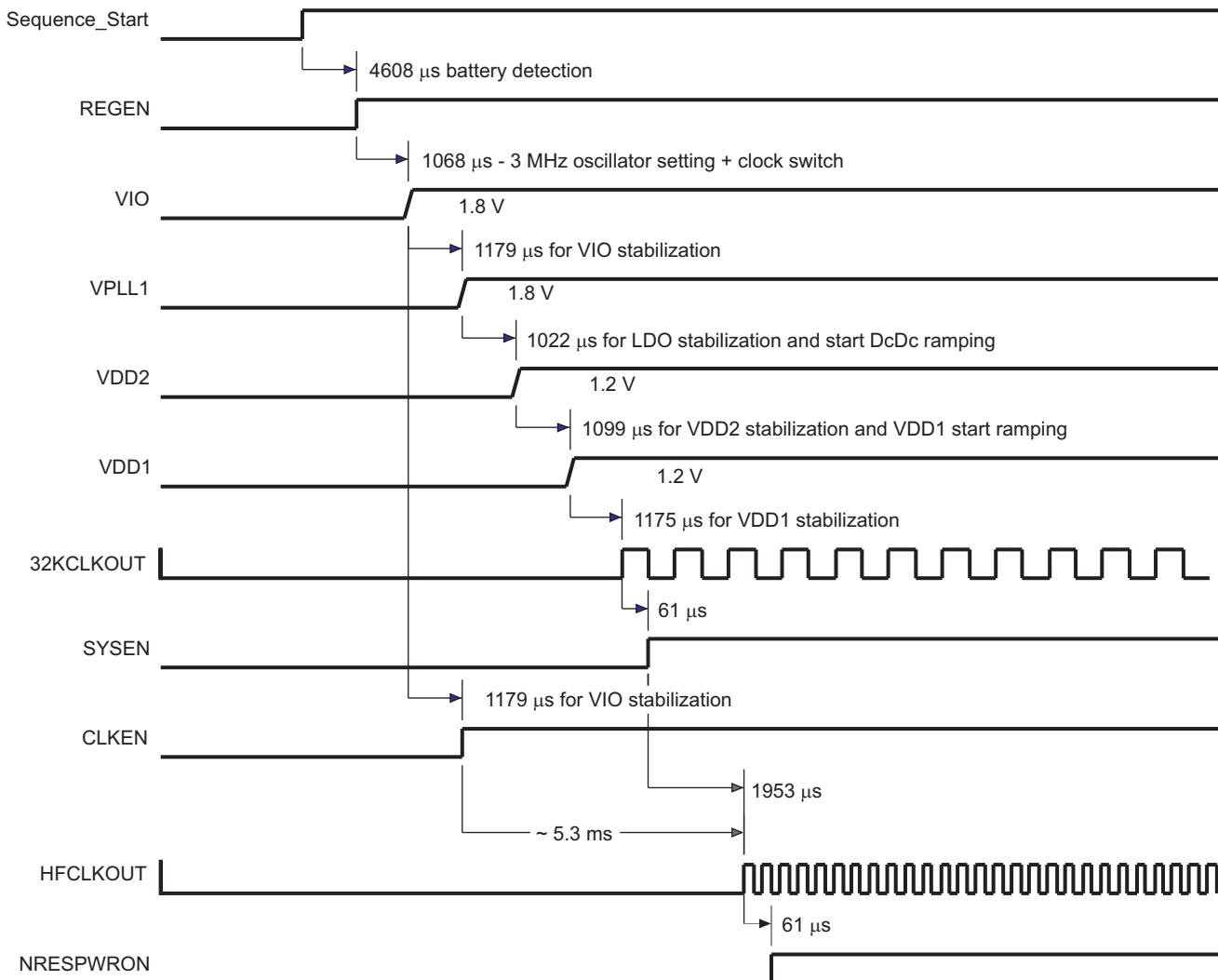


Figure 4-9. Timings—OMAP2 Power-On Sequence

#### 4.5.3.3 OMAP3 Power-On Sequence

Figure 4-10 shows the timing and control that must occur in Master\_C021\_Generic mode. Sequence\_Start occurs according to the events shown in Figure 4-8.

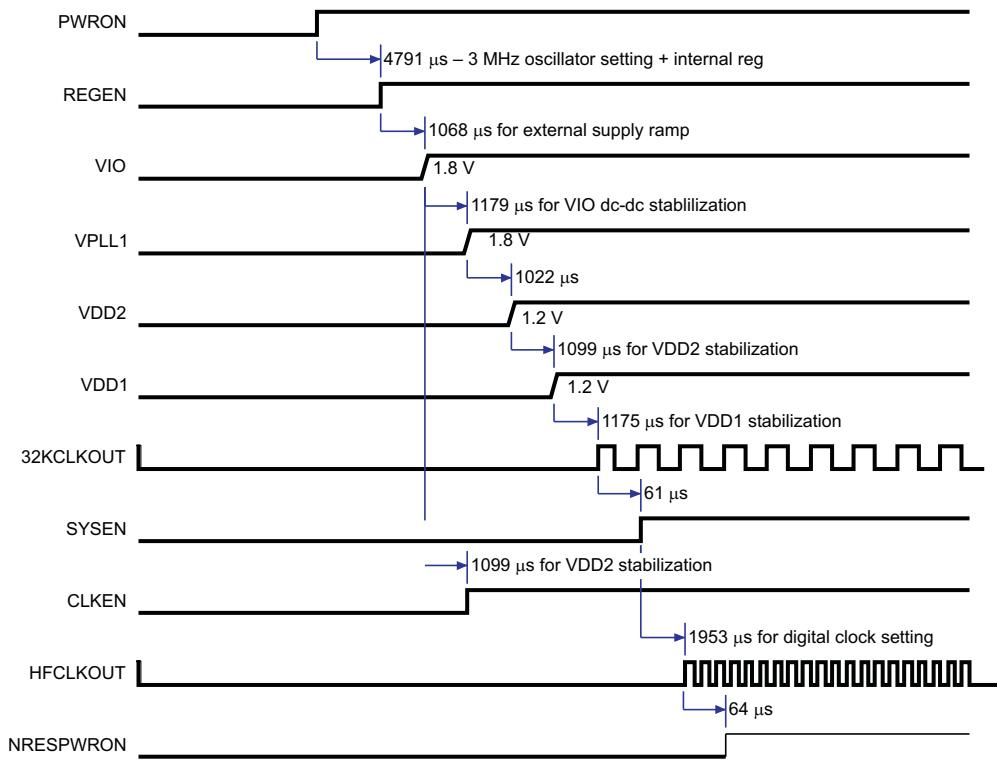


032-012

Figure 4-10. Timings—OMAP3 Power-On Sequence

#### 4.5.3.4 Power On in Slave\_C021\_Generic Mode

Figure 4-11 describes the timing and control that must occur in the Slave\_C021\_Generic mode. Sequence\_Start is a symbolic internal signal to ease the description of the power sequences and occurs according to the different events detailed in Figure 4-8.



030-022

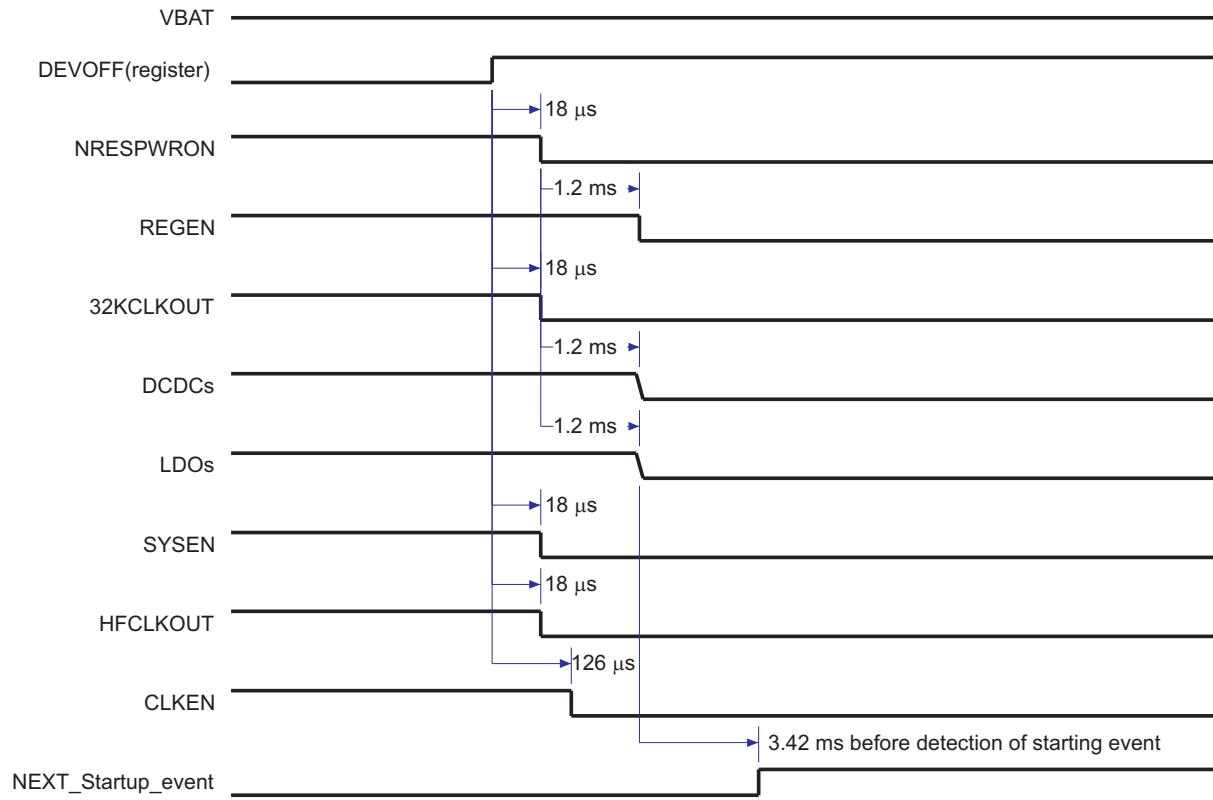
Figure 4-11. Timings—Power On in Slave\_C021\_Generic Model

#### 4.5.4 Power-Off Sequence

This section describes the signal behavior required to power down the system.

##### 4.5.4.1 Power-Off Sequence in Master Modes

Figure 4-12 shows the timing and control that occur during the power-off sequence in master modes.



032-013

NOTE: All timings are typical values with the default setup (depending on the resynchronization between power domains, state machinery priority, etc.).

**Figure 4-12. Power-Off Sequence in Master Modes**

If the value of the HF clock is not 19.2 MHz (with the values of the CFG\_BOOT HFCLK\_FREQ bit field set accordingly), the delay between DEVOFF and NRESPWRON/CLK32KOUT/SYSEN/HFCLKOUT is divided by two (approximately 9 μs). This is caused by the internal frequency used by power STM switching from 3 to 1.5 MHz if the HF clock value is 19.2 MHz.

The DEVOFF event is PWRON falling edge in slave mode and DEVOFF internal register write in master mode.

## 5 Real-Time Clock and Embedded Power Controller

The TPS65950 device contains an RTC to provide clock and timekeeping functions and an EPC to provide battery supervision and control.

### 5.1 RTC

The RTC provides the following basic functions:

- Time information (seconds/minutes/hours) directly in binary-coded decimal (BCD) code
- Calendar information (day/month/year/day of the week) directly in BCD code
- Interrupt generation periodically (1 second/1 minute/1 hour/1 day) or at a precise time (alarm function)
- 32-kHz oscillator drift compensation and time correction
- Alarm-triggered system wake-up event

#### 5.1.1 Backup Battery

The TPS65950 implements a backup mode in which a backup battery can keep the RTC running to maintain clock and time information even if the main supply is not present. If the backup battery is rechargeable, the device also provides a backup battery charger so it can be recharged when the main battery supply is present.

The backup domain powers the following:

- Internal 32.768-kHz crystal oscillator
- RTC
- Eight GP storage registers
- Backup domain low-power regulator (VBRTC)

### 5.2 EPC

The EPC provides five system states for optimal power use by the system, as listed in [Table 5-1](#).

**Table 5-1. System States**

| System State | Description  |
|--------------|--|
| NO SUPPLY    | The system is not powered by any battery.  |
| BACKUP       | The system is powered only with the backup battery and maintains only the VBRTC supply.                          |
| WAIT-ON      | The system is powered by the main battery and maintains only the VRRTC supply. It can accept switch-on requests. |
| ACTIVE       | The system is powered by the main battery; all supplies can be enabled with full current capability.             |
| SLEEP        | The main battery powers the system; selected supplies are enabled, but in low consumption mode.                  |

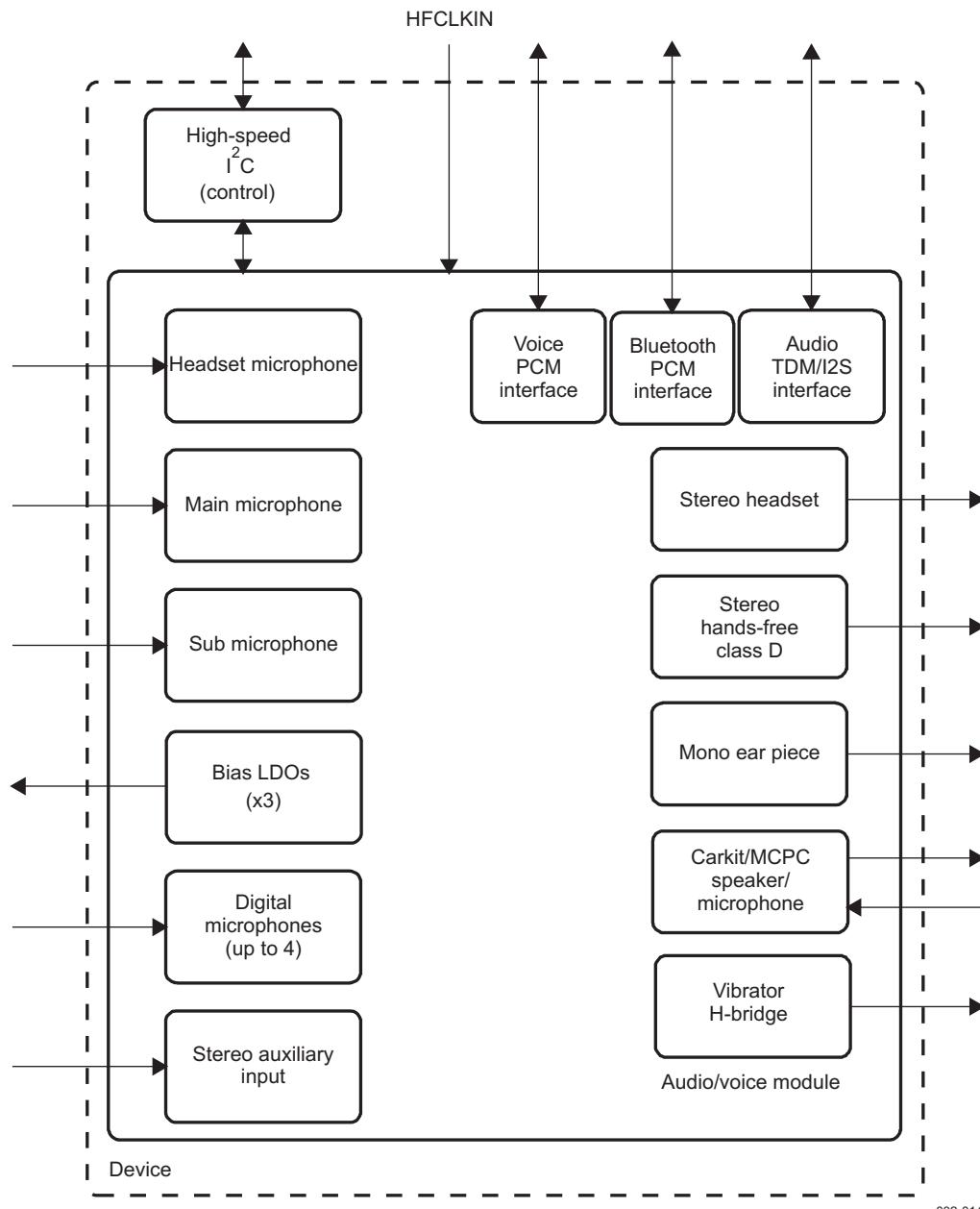
Three categories of events can trigger state transitions:

- Hardware events: Supply/battery insertion, wake-up requests, USB plug, and RTC alarm
- Software events: Switch-off commands, switch-on commands, and sleep-on commands
- Monitoring events: Supply/battery level check, main battery removal, main battery fail, and thermal shutdown

## 6 Audio/Voice Module

The audio codec in the device includes five DACs and two ADCs to provide multiple voice channels and stereo downlink channels that can support all standard audio sample rates through I2S/TDM format interfaces. The audio output stages on the device include stereo headset amplifiers, two integrated class-D amplifiers providing stereo differential outputs, predrivers for line outputs, and an earpiece amplifier. The input audio stages include three differential microphone inputs, stereo line inputs, and interface for digital microphones. Automatic and programmable gain control is available with all necessary digital filtering, side-tone functions, and pop-noise reduction.

[Figure 6-1](#) is a block diagram of the audio/voice module.



**Figure 6-1. Audio/Voice Module Block Diagram**

## 6.1 Audio/Voice Downlink (RX) Module

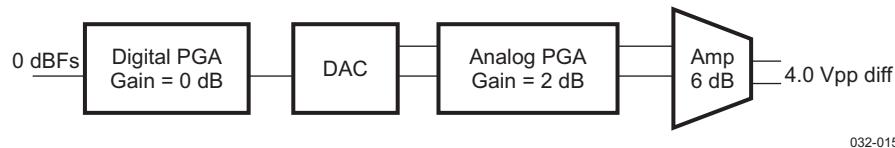
The audio/voice module includes the following output stages:

- Mono/stereo single-ended headset amplifier
- Stereo differential integrated class-D 8- $\Omega$  hands-free amplifiers
- Predriver output signals for external class-D amplifiers (single-ended)
- Mono differential earpiece amplifier
- Vibrator H-bridge

### 6.1.1 Earphone Output

#### 6.1.1.1 Earphone Output Characteristics

Analog signals from the audio and/or voice interface are fed to the earphone amplifier. This amplifier, with different gains, provides a full differential signal on terminals EARP and EARM. [Figure 6-2](#) shows the earphone amplifier. [Table 6-1](#) lists the output characteristics of the earphone amplifier.



032-015

**Figure 6-2. Earphone Amplifier**

**Table 6-1. Earphone Amplifier Output Characteristics**

| Parameter   | Test Conditions   | Min | Typ   | Max | Unit            |
|---|---|-----|-------|-----|-----------------|
| Differential load impedance                         |   | 26  | 32    |     | $\Omega$        |
|   |   | 100 | 100   |     | pF              |
| Gain range <sup>(1)</sup>                           | Audio path  | -86 |       | 36  | dB              |
|   | Voice path  | -60 |       | 36  |                 |
| Absolute gain error                                 |   | -1  |       | 1   | dB              |
| Maximum output power                                | At 1.4 Vrms differential output voltage<br>Load impedance = 32 $\Omega$ |     | 61.25 |     | mW              |
| Peak-to-peak differential output voltage (0 dBFS)   | Default gain <sup>(2)</sup>   |     | 4.0   |     | V <sub>PP</sub> |
| Total harmonic distortion                           | At 0 dBFS   |     | -65   | -60 | dB              |
| Default gain <sup>(2)</sup>                         | At -6 dBFS  |     | -70   | -65 |                 |
| Load impedance = 32 $\Omega$                        | At -20 dBFS   |     |       | -60 |                 |
|   | At -60 dBFS   |     |       | -30 |                 |
| Idle channel noise<br>(20 Hz to 20 kHz, A-weighted) | Gain = 0 dB<br>Load = 32 $\Omega$                                       |     | -90   | -85 | dBFS            |
| Output PSRR (for all gains)                         | 20 Hz to 4 kHz  |     | 90    |     | dB              |
|   | 20 Hz to 20 kHz   |     | 70    |     |                 |

(1) Audio digital filter = -62 to 0 dB (1-dB steps) and 0 to 12 dB (6-dB steps)

Voice digital filter = -36 to 12 dB (1-dB steps)

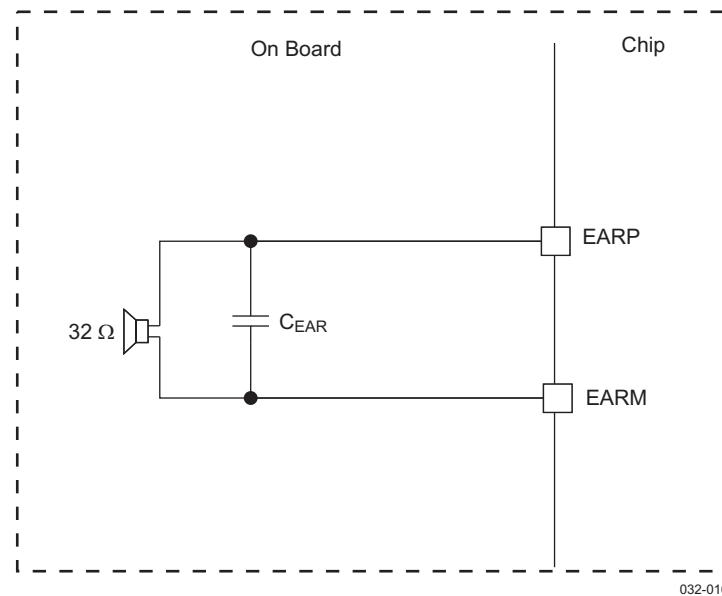
ARXPGA (volume control) = -24 to 12 dB (2-dB steps)

Output driver = 0, 6, 12 dB

(2) The default gain setting assumes the ARXPGA has 2-dB gain setting (volume control) and output driver at 6-dB gain setting.

### 6.1.1.2 External Components and Application Schematic

Figure 6-3 is a simplified schematic of the earphone speaker.



**Figure 6-3. Earphone Speaker**

#### NOTE

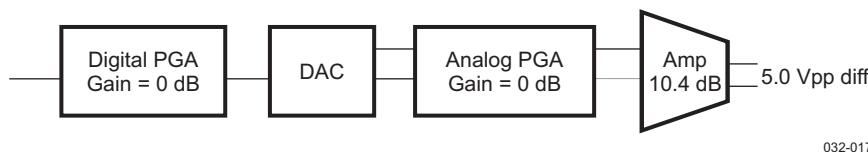
For the component values, see [Table 15-1](#).

### 6.1.2 8-Ω Stereo Hands-Free

The digital signal from the audio and/or voice interface is fed to two class-D amplifiers. These 8-Ω speaker amplifiers provide a stereo differential signal on terminal pairs (IHF.RIGHT.P, IHF.RIGHT.M and IHF.LEFT.P, IHF.LEFT.M).

#### 6.1.2.1 8-Ω Stereo Hands-Free Output Characteristics

Figure 6-4 shows the 8-Ω stereo hands-free amplifier. [Table 6-2](#) lists the output characteristics of the 8-Ω stereo hands-free amplifier.



**Figure 6-4. 8-Ω Stereo Hands-Free Amplifiers**

**Table 6-2. 8-Ω Stereo Hands-Free Output Characteristics**

| Parameter      | Test Conditions | Min | Typ | Max | Unit |
|----------------|-----------------|-----|-----|-----|------|
| VBAT voltage   |                 | 3.0 | 3.6 | 4.6 | V    |
| Load impedance |                 | 6   | 8   |     | Ω    |

**Table 6-2. 8- $\Omega$  Stereo Hands-Free Output Characteristics (continued)**

| Parameter   | Test Conditions                                       | Min   | Typ  | Max   | Unit     |
|---|---|-------|------|-------|----------|
| Gain range <sup>(1)</sup>   | Audio path  | -75.6 |      | 34.4  | dB       |
|   | Voice path  | -49.6 |      | 34.4  |          |
| Absolute gain error   |   | -1    |      | 1     | dB       |
| Maximum output power (load impedance = 8 $\Omega$ )   | VBAT > 3.6 V  |       | 400  |       | mW       |
|   | VBAT > 4.0 V  |       | 700  |       |          |
| Peak-to-peak differential output voltage  | VBAT > 3.6 V (0 dBFs)                                 |       | 5.0  |       | $V_{PP}$ |
|   | VBAT > 4.0 V (2 dBFs)                                 |       | 6.25 |       |          |
| Total harmonic distortion (load impedance = 8 $\Omega$ , gain setting = 0 dB)<br>(VBAT > 3.6 V)                     | At 0 dBFs   |       | -60  | -40   | dBFs     |
|   | At -10 dBFs   |       |      | -60   |          |
|   | At -20 dBFs   |       |      | -45   |          |
|   | At -60 dBFs   |       |      | -20   |          |
| Total harmonic distortion (load impedance = 8 $\Omega$ , (VBAT > 4.2 V)   | 2 dBFs  |       | -60  | -40   | dB       |
| Idle channel noise (20 Hz to 20 kHz)  | 0 dB gain   |       | -88  |       | dBFs     |
| PSRR (input signal 1 kHz sine, 300 mVPP GSM ripple at 217 Hz with 10- $\mu$ s rise/fall times, at 12.5% duty cycle) | From VBAT   | 75    | 80   |       | dB       |
| Efficiency  | Power on load = 400 mW<br>Load impedance = 8 $\Omega$ | 70%   |      |       |          |
| Power dissipation   | Power on load = 400 mW<br>Load impedance = 8 $\Omega$ |       |      | 175   | mW       |
| Idle current consumption on VBAT  | Without input signal                                  |       | 6    |       | mA       |
| Clock frequency for the ramp generation   |   | 384   |      | 426.6 | kHz      |
| $I_{DDQ}$ current   | At 25°C   |       | 0.6  |       | $\mu$ A  |

- (1) Audio digital filter = -62 to 0 dB (1-dB steps) and 0 to 12 dB (6-dB steps)  
 Voice digital filter = -36 to 12 dB (1-dB steps)  
 ARXPGA (volume control) = -24 to 12 dB (2-dB steps)  
 Output driver = 10.4 dB

#### 6.1.2.1.1 Short-Circuit Protection

There is short-circuit protection for hands-free amplifiers to limit power dissipation to 1.2 W. The short-circuit protection can be disabled by register. If a short circuit is detected, the short-circuit detection block switches off the hands-free speaker output stages. A software restart is required to restart the class-D amplifier.

#### 6.1.2.2 External Components and Application Schematic

Figure 6-5 is a simplified schematic of the 8- $\Omega$  stereo hands-free.

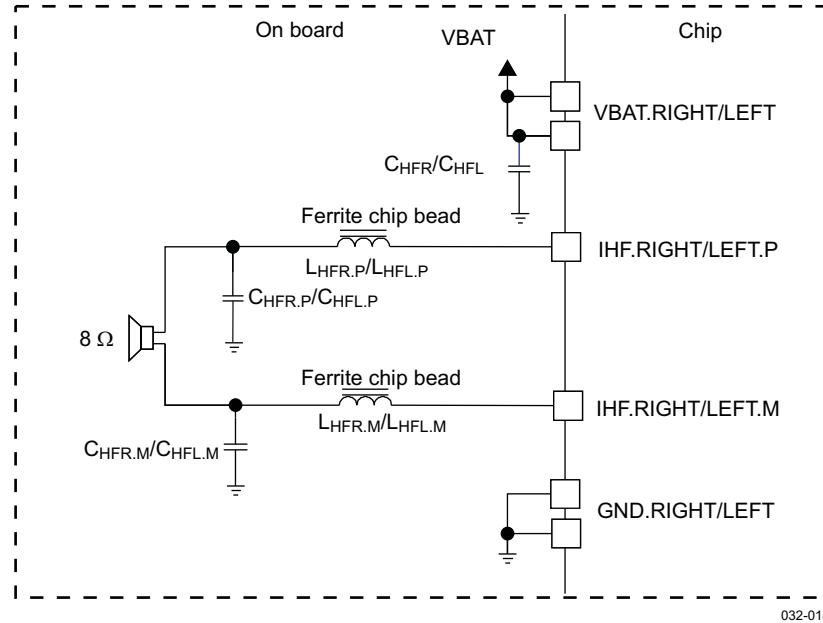


Figure 6-5. 8-Ω Stereo Hands-Free

**NOTE**

For the component values, see [Table 15-1](#).

For ferrite bead, choose one with high impedance at high frequencies, but with very low impedance at low frequencies. For example, MPZ1608S221A (recommended), N2012ZPS121, or MDP BKP1608HS271.

**6.1.3 Headset**

The analog signal from the audio and/or voice interface is fed to two single-ended headset amplifiers.

There are two configurations:

- Stereo single-ended mode: Left and right headset amplifiers with different gains (-6, 0, 6 dB) provide the stereo signal on the HSOL and HSOR terminals. A pseudo-ground is provided on the VMID terminal to eliminate external capacitors.
- Stereo single-ended mode ac-coupled: Left and right headset amplifiers with different gains (-6, 0, 6 dB) provide the stereo signal on the HSOL and HSOR terminals. The external capacitor is required to eliminate the dc component of the signal.

**6.1.3.1 Headset Output Characteristics**

[Figure 6-6](#) shows the headset amplifier. [Table 6-3](#) lists the output characteristics of the headset amplifier.

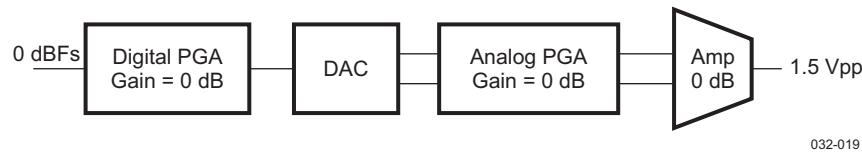


Figure 6-6. Headset Amplifier

**Table 6-3. Headset Output Characteristics**

| Parameter      | Test Conditions | Min | Typ | Max | Unit |
|----------------|-----------------|-----|-----|-----|------|
| Load impedance |                 | 14  | 16  |     | Ω    |

**Table 6-3. Headset Output Characteristics (continued)**

| Parameter  | Test Conditions   | Min | Typ   | Max | Unit            |
|--|---|-----|-------|-----|-----------------|
|  |   | 100 | 100   |     | pF              |
| Gain range <sup>(1)</sup>                                    | Audio path  | -92 |       | 30  | dB              |
|  | Voice path  | -66 |       | 30  |                 |
| Absolute gain error  |   | -1  |       | 1   | dB              |
| Maximum output power   | At 0.53 Vrms differential output voltage<br>Load impedance = 16 Ω |     | 17.56 |     | mW              |
| Peak-to-peak output voltage (0 dBFS)                         | Default gain <sup>(2)</sup>                                       |     | 1.5   |     | V <sub>PP</sub> |
| <b>Single-Ended Mode ac-Coupled</b>                          |   |     |       |     |                 |
| Total harmonic distortion                                    | At 0 dBFS   |     | -80   | -75 | dB              |
| Default gain <sup>(2)</sup><br>Load = 16 Ω                   | At -6 dBFS  |     | -74   | -69 |                 |
|  | At -20 dBFS   |     | -70   | -65 |                 |
|  | At -60 dBFS   |     | -30   | -25 |                 |
| Idle channel noise<br>(20 Hz to 20 kHz, A-weighted)          | Default gain <sup>(3)</sup><br>Load = 16 Ω                        |     | -90   | -85 | dB              |
| SNR (A-weighted over 20-kHz bandwidth)                       | At 0 dBFS   | 82  | 86    |     | dB              |
| Output PSRR (for all gains)                                  | 20 Hz to 4 kHz  |     | 90    |     | dB              |
|  | 20 Hz to 20 kHz   |     | 70    |     |                 |
| Crosstalk between right and left channels                    |   |     | -60   |     | dB              |
| <b>Single-Ended Mode (Pseudo-Ground Provided on HSOVMID)</b> |   |     |       |     |                 |
| Total harmonic distortion                                    | At 0 dBFS   |     | -75   | -70 | dB              |
| Default gain <sup>(3)</sup><br>Load = 16 Ω                   | At -6 dBFS  |     | -74   | -69 |                 |
|  | At -20 dBFS   |     | -70   | -65 |                 |
|  | At -60 dBFS   |     | -30   | -25 |                 |
| Idle channel noise<br>(20 Hz to 20 kHz, A-weighted)          | Default gain <sup>(3)</sup><br>Load = 16 Ω                        |     | -90   | -85 | dB              |
| Output PSRR (for all gains)                                  | 20 Hz to 4 kHz  |     | 85    |     | dB              |
|  | 20 Hz to 20 kHz   |     | 65    |     |                 |

(1) Audio digital filter = -62 to 0 dB (1-dB steps) and 0 to 12 dB (6-dB steps)

Voice digital filter = -36 to 12 dB (1-dB steps)

ARXPGA (volume control) = -24 to 12 dB (2-dB steps)

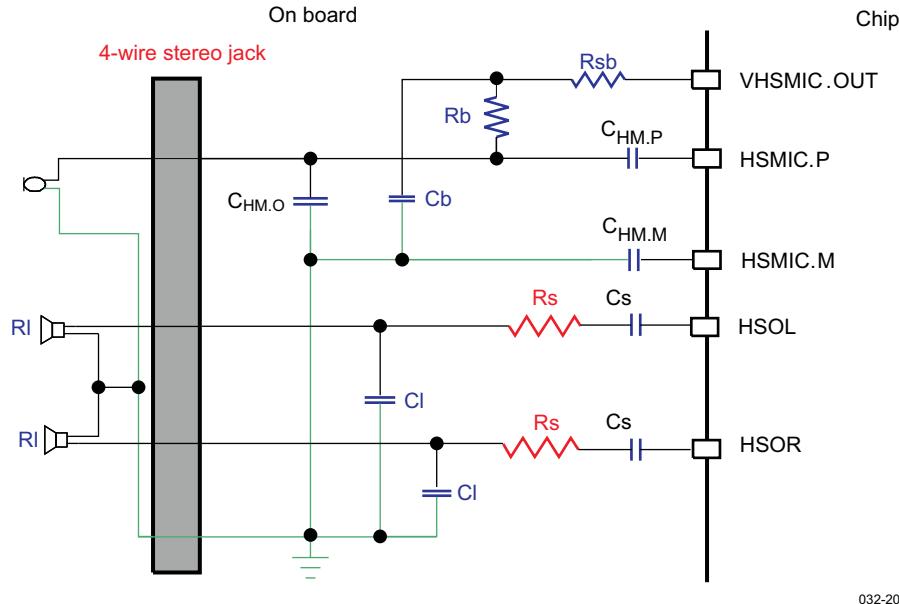
Output driver = -6, 0, 6 dB

(2) The default gain setting assumes the ARXPGA has 0 dB gain setting (volume control) and output driver at 0 dB gain setting.

(3) The default gain setting assumes the ARXPGA has 0 dB gain setting (volume control) and output driver at 0 dB gain setting.

### 6.1.3.2 External Components and Application Schematic

Figure 6-7 is a schematic of a headset 4-wire stereo jack without an external FET. Table 6-4 lists the output characteristics of this configuration.



032-20

**Figure 6-7. Headset 4-Wire Stereo Jack Without an External FET**

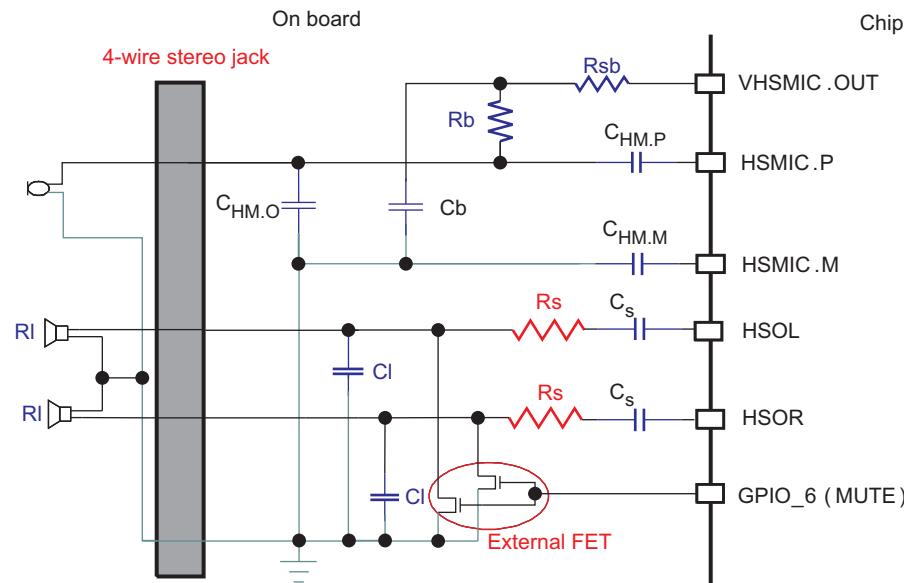
**Table 6-4. Output Characteristics of a Headset 4-Wire Stereo Jack Without an External FET**

| Parameter   | Test Conditions |                | Min | Typ | Max | Unit |
|---|-----------------|----------------|-----|-----|-----|------|
| Rsb   | Cb < 200 pF     |                | 0   |     |     | Ω    |
|   | Cb = 100 nF     |                | 300 |     |     |      |
|   | Cb = 1 μF       |                | 500 |     |     |      |
| Rb + Rsb  |                 |                | 2.2 |     | 2.7 | kΩ   |
| Cs  |                 |                | 22  | 47  |     | μF   |
| The input capacitors and output resistors form a high-pass filter (HPF) with the corner frequency = $1/(2\pi R_{out}/Cs)$ |                 |                |     |     |     |      |
| Rs required to ensure HS amplifier stability  | R <sub>L</sub>  | C <sub>L</sub> |     |     |     | Ω    |
|   | 16 to 32 Ω      | <100 pF        | 0   |     |     |      |
|   | 16 to 32 Ω      | 1 nF           | 4   |     |     |      |
|   | 16 Ω            | 2 nF           | 8   |     |     |      |
|   | 24 Ω            |                | 12  |     |     |      |
|   | 32 Ω            |                | 18  |     |     |      |
|   | 16 Ω            | 3 nF           | 12  |     |     |      |
|   | 24 Ω            |                | 20  |     |     |      |
|   | 32 Ω            |                | 24  |     |     |      |
|   | 16 Ω            | 4 nF           | 16  |     |     |      |
|   | 24 Ω            |                | 24  |     |     |      |
|   | 32 Ω            |                | 32  |     |     |      |
|   | 16 Ω            | 5 nF           | 20  |     |     |      |
|   | 24 Ω            |                | 28  |     |     |      |
|   | 32 Ω            |                | 36  |     |     |      |

**NOTE**

For other component values, see [Table 15-1](#).

**Table 6-5** is a schematic of a headset 4-wire stereo jack with an external FET. **Table 6-5** lists the output characteristics of this configuration.



032-021

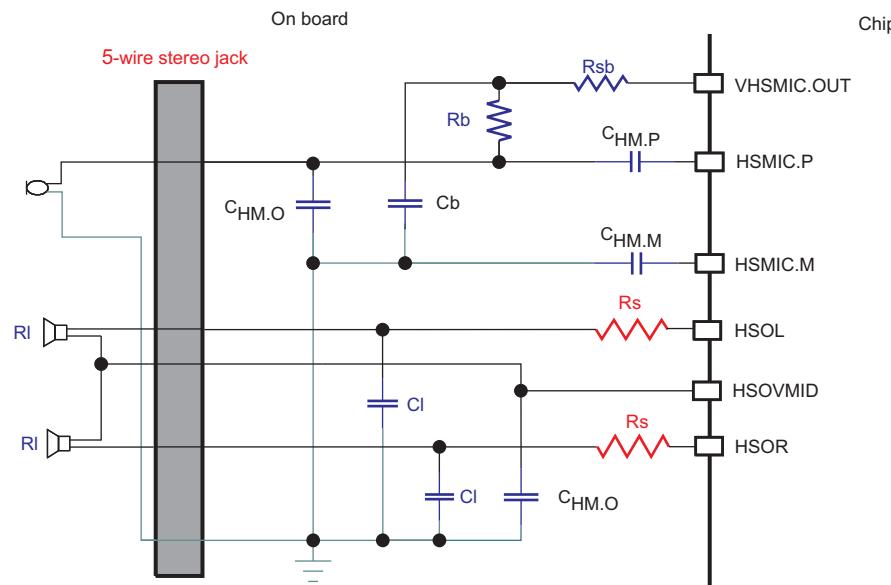
**Figure 6-8. Headset 4-Wire Stereo Jack With an External FET**

**Table 6-5. Output Characteristics of a Headset 4-Wire Stereo Jack With an External FET**

| Parameter  | Test Conditions |       | Min   | Typ | Max | Unit       |
|--|-----------------|-------|-------|-----|-----|------------|
| Rsb  | Cb < 200 pF     |       | 0     |     |     | $\Omega$   |
|  | Cb = 100 nF     |       | 300   |     |     |            |
|  | Cb = 1 $\mu$ F  |       | 500   |     |     |            |
| Rb + Rsb   |                 |       | 2.2   |     | 2.7 | k $\Omega$ |
| Cs   |                 |       | 22    | 47  |     | $\mu$ F    |
| The input capacitors and output resistors form a HPF with the corner frequency = $1/(2\pi R_{out}/Cs)$           |                 | $R_L$ | $C_L$ |     |     |            |
| Rs required to ensure HS amplifier stability and no distortion caused by the parasitic diode of the external FET | 16 $\Omega$     | <2 nF | 10    |     |     | $\Omega$   |
|  |                 |       | 15    |     |     |            |
|  |                 |       | 20    |     |     |            |
|  | 24 $\Omega$     | 3 nF  | 12    |     |     |            |
|  |                 |       | 20    |     |     |            |
|  |                 |       | 24    |     |     |            |
|  | 32 $\Omega$     | 4 nF  | 16    |     |     |            |
|  |                 |       | 24    |     |     |            |
|  |                 |       | 32    |     |     |            |
|  | 16 $\Omega$     | 5 nF  | 20    |     |     |            |
|  |                 |       | 28    |     |     |            |
|  |                 |       | 36    |     |     |            |

**NOTE**For other component values, see [Table 15-1](#).

[Figure 6-9](#) is a schematic of a headset 5-wire stereo jack. [Table 6-6](#) lists the output characteristics of this configuration.



032-022

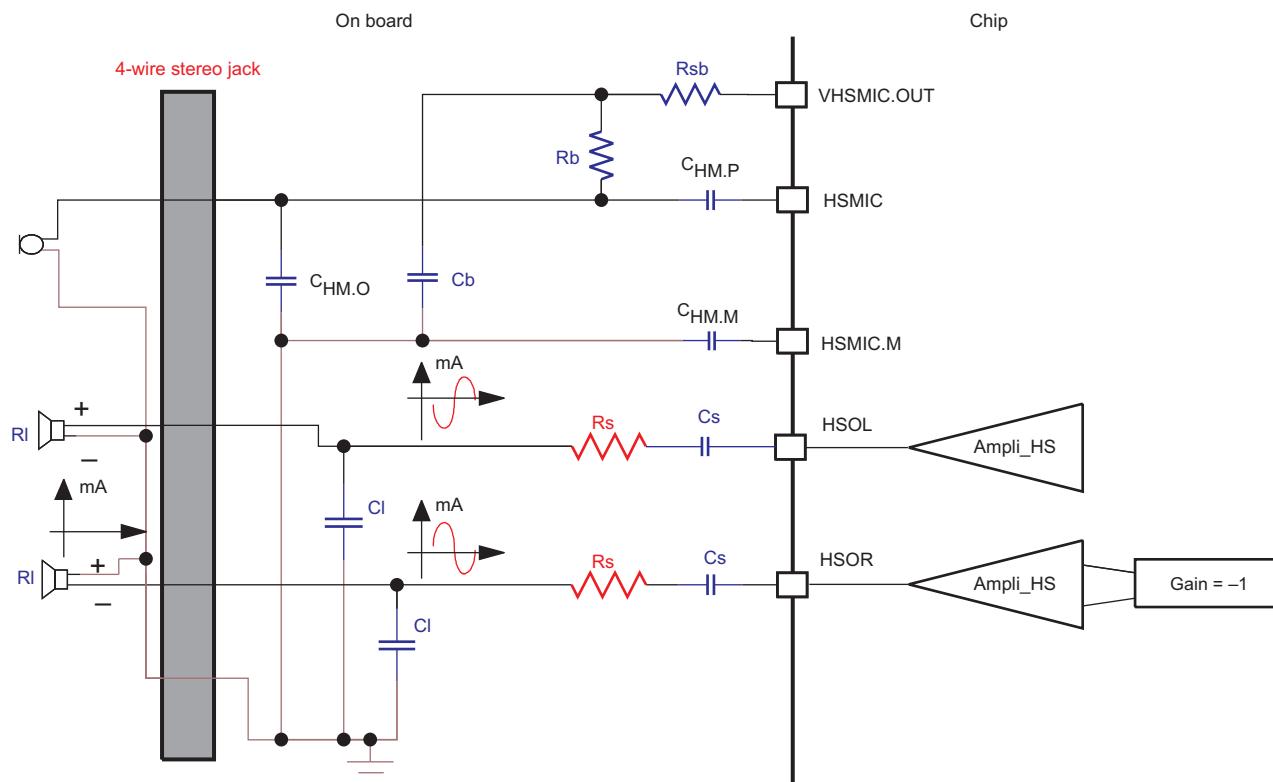
**Figure 6-9. Headset 5-Wire Stereo Jack****Table 6-6. Output Characteristics of a Headset 5-Wire Stereo Jack**

| Parameter                                    | Test Conditions   |       | Min     | Typ | Max | Unit       |
|--|-------------------|-------|---------|-----|-----|------------|
| Rsb  | Cb < 200 pF       |       | 0       |     |     | $\Omega$   |
|  | Cb = 100 nF       |       | 300     |     |     |            |
|  | Cb = 1 $\mu$ F    |       | 500     |     |     |            |
| Rb + Rsb                                     |                   |       | 2.2     |     | 2.7 | k $\Omega$ |
| $R_L$  |                   | $C_L$ |         |     |     |            |
| Rs required to ensure HS amplifier stability | 16 to 32 $\Omega$ |       | <100 pF | 0   |     | $\Omega$   |
|  | 16 to 32 $\Omega$ |       | 1 nF    | 4   |     |            |
|  | 16 $\Omega$       |       | 2 nF    | 8   |     |            |
|  | 24 $\Omega$       |       |         | 12  |     |            |
|  | 32 $\Omega$       |       |         | 18  |     |            |
|  | 16 $\Omega$       |       | 3 nF    | 12  |     |            |
|  | 24 $\Omega$       |       |         | 20  |     |            |
|  | 32 $\Omega$       |       |         | 24  |     |            |
|  | 16 $\Omega$       |       | 4 nF    | 16  |     |            |
|  | 24 $\Omega$       |       |         | 24  |     |            |
|  | 32 $\Omega$       |       |         | 32  |     |            |
|  | 16 $\Omega$       |       | 5 nF    | 20  |     |            |
|  | 24 $\Omega$       |       |         | 28  |     |            |
|  | 32 $\Omega$       |       |         | 36  |     |            |

**NOTE**

For other component values, see [Table 15-1](#).

[Figure 6-10](#) is a schematic of a headset 4-wire stereo jack optimized.



032-023

**Figure 6-10. Headset 4-Wire Stereo Jack Optimized**

**NOTE**

For other component values, see [Table 15-1](#).

#### 6.1.4 Headset Pop-Noise Attenuation

Pop noise occurs when the audio output amplifier is switched on. Although the speaker is ac-coupled through an external capacitor, the sharp rise time given by the activation of the amplifier causes a large spike to propagate to the speakers. Pop attenuation is achieved through a precharge and discharge of the external coupling capacitor.

The antipop system using an internal current generator controlling the ramp of charge or discharge is implemented for the headset output. The pop-noise effect can be dramatically reduced by an external FET controlled by a 1.8-V output signal (MUTE pin).

[Figure 6-11](#) is a diagram of headset pop noise. [Table 6-7](#) lists the characteristics of headset pop noise.

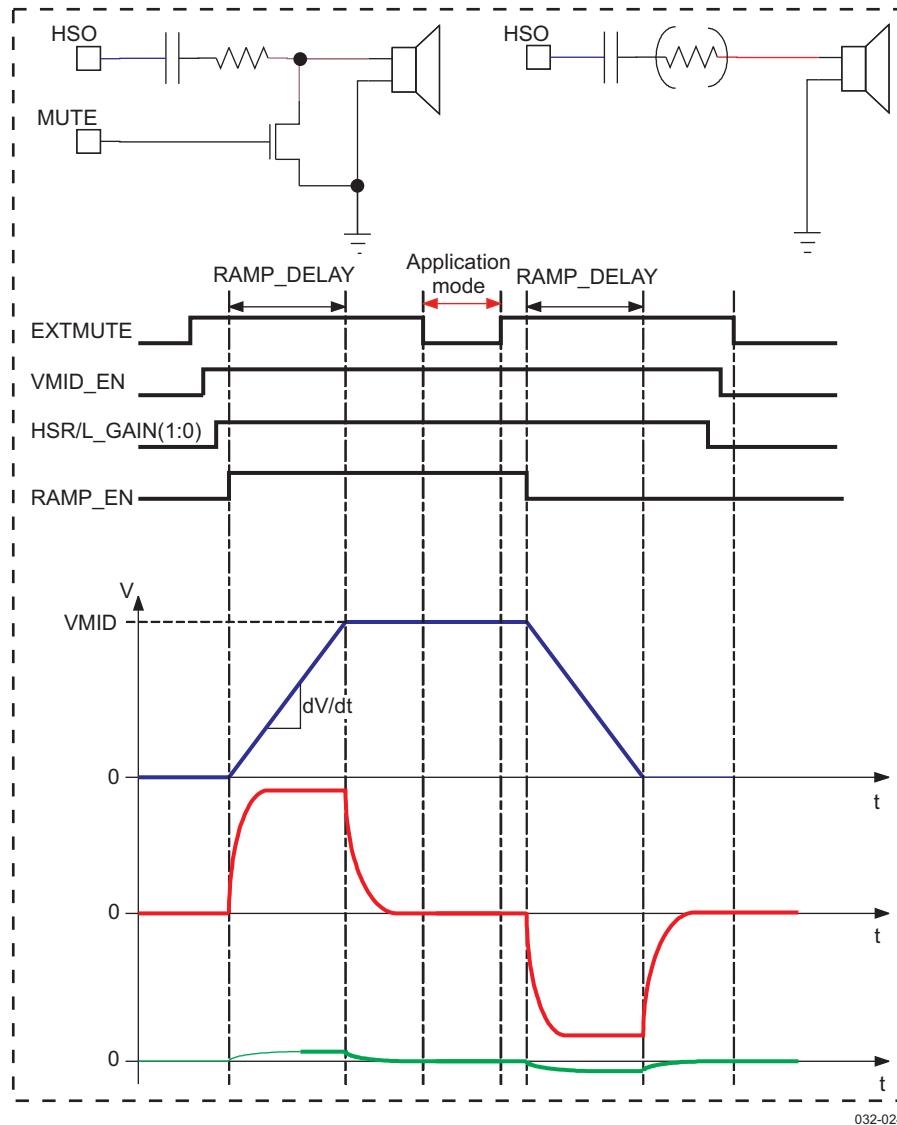


Figure 6-11. Headset Pop-Noise Cancellation Diagram

Table 6-7. Headset Pop-Noise Characteristics

| Parameter              | Test Conditions   | Min | Typ | Max | Unit |
|------------------------|---|-----|-----|-----|------|
| $dv/dt$                | Ramp of charge or discharge   |     |     | 170 | V/s  |
| Pop-noise (A-weighted) | ac-coupling capacitor = 47 $\mu$ F<br>Serial resistor = 33 $\Omega$<br>External FET: $R_{dson} = 0.12 \Omega$ |     |     | 1   | mV   |

### 6.1.5 Predriver for External Class-D Amplifier

Two predriver amplifiers provide a stereo signal on the PreD.LEFT and PreD.RIGHT terminals to drive an external class-D amplifier. These terminals are available if a stereo, single-ended, ac-coupled headset is used.

#### 6.1.5.1 Predriver Output Characteristics

Table 6-8 lists the output characteristics of the predriver.

**Table 6-8. Predriver Output Characteristics**

| Parameter  | Test Conditions                            | Min | Typ | Max | Unit            |
|--|--|-----|-----|-----|-----------------|
| Load impedance                                   |  | 10  |     |     | kΩ              |
|  |  | 50  |     |     | pF              |
| Gain range <sup>(1)</sup>                        | Audio path                                 | -92 |     | 30  | dB              |
|  | Voice path                                 | -66 |     | 30  |                 |
| Absolute gain error                              |  | -1  |     | 1   | dB              |
| Peak-to-peak output voltage (0 dBFS)             | Default gain <sup>(2)</sup>                |     | 1.5 |     | V <sub>PP</sub> |
| Total harmonic distortion                        | At 0 dBFS                                  |     | -80 | -75 | dB              |
|  | At -6 dBFS                                 |     | -74 | -69 |                 |
|  | At -20 dBFS                                |     | -70 | -65 |                 |
|  | At -60 dBFS                                |     | -30 | -25 |                 |
| Idle channel noise (20 Hz to 20 kHz, A-weighted) | Default gain <sup>(3)</sup><br>Load = 10 Ω |     | -90 | -85 | dB              |
| SNR (A-weighted over 20-kHz bandwidth)           | At 0 dBFS                                  | 83  | 88  |     | dB              |
|  | At -60 dBFS                                |     | 30  |     |                 |
| Output PSRR (for all gains)                      | 20 Hz to 4 kHz                             |     | 90  |     | dB              |
|  | 20 Hz to 20 kHz                            |     | 70  |     |                 |

(1) Audio digital filter = -62 to 0 dB (1-dB steps) and 0 to 12 dB (6-dB steps)

Voice digital filter = -36 to 12 dB (1-dB steps)

ARXPGA (volume control) = -24 to 12 dB (2-dB steps)

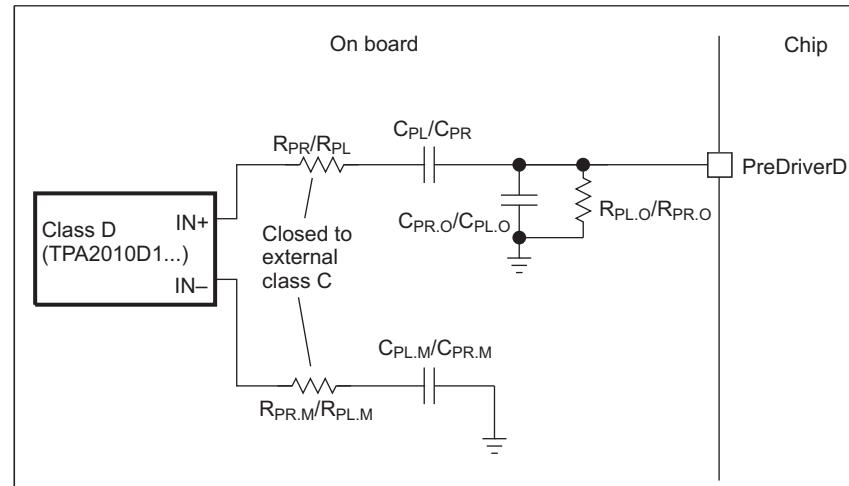
Output driver = -6, 0, 6 dB

(2) The default gain setting assumes the ARXPGA has a 0 dB gain setting (volume control) and output driver has a 0 dB gain setting.

(3) The default gain setting assumes the ARXPGA has a 0 dB gain setting (volume control) and output driver has a 0 dB gain setting.

### 6.1.5.2 External Components and Application Schematic

Figure 6-12 is a simplified schematic of the external class-D predriver.



032-025

**Figure 6-12. Predriver for External Class D**

In Figure 6-12, input resistor ( $R_{PR}$  or  $R_{PL}$ ) sets the gain of the external class D. For TPS2010D1, the gain is defined according to the following equation:

$$\text{Gain (V/V)} = 2 \times 150 \times 10^3 / (R_{PR} \text{ or } R_{PL})$$

$$R_{PR} \text{ or } R_{PL} > 15 \text{ kΩ}$$

**NOTE**

For other component values, see [Table 15-1](#).

### 6.1.6 Vibrator H-Bridge

A digital signal from the pulse width modulated generator is fed to the vibrator H-bridge driver. The vibrator H-bridge is a differential driver that drives vibrator motors. The differential output allows dual rotation directions.

#### 6.1.6.1 Vibrator H-Bridge Output Characteristics

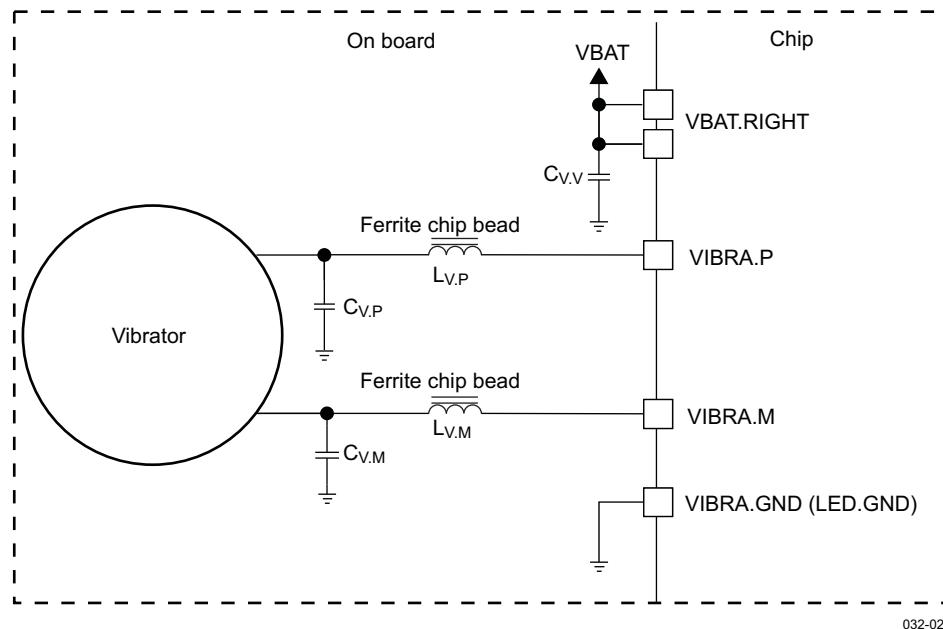
[Table 6-9](#) lists the output characteristics of the vibrator H-bridge.

**Table 6-9. Vibrator H-Bridge Output Characteristics**

| Parameter                                     | Test Conditions | Min | Typ | Max | Unit            |
|---|-----------------|-----|-----|-----|-----------------|
| VBAT voltage                                  |                 | 2.8 | 3.6 | 4.8 | V               |
| Differential output swing (16- $\Omega$ load) | VBAT = 2.8 V    | 3.6 |     |     | V <sub>PP</sub> |
|   |                 | 4.3 |     |     |                 |
| Output resistance (summed for both sides)     |                 |     |     | 8   | $\Omega$        |
| Load capacitance                              |                 |     |     | 100 | pF              |
| Load resistance                               |                 | 8   | 16  | 60  | $\Omega$        |
| Load inductance                               |                 |     |     | 30  | 300 $\mu$ H     |
| Total harmonic distortion                     |                 |     |     | 10% |                 |
| Operating frequency                           |                 | 20  |     | 10k | Hz              |

#### 6.1.6.2 External Components and Application Schematic

[Figure 6-13](#) is a simplified schematic of the vibrator H-bridge.



**Figure 6-13. Vibrator H-Bridge**

**NOTE**

For other component values, see [Table 15-1](#).

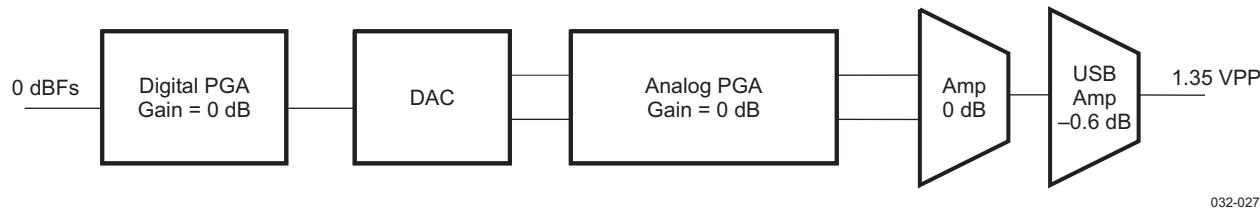
Example of ferrite: BLM 18BD221SN1.

### 6.1.7 Carkit Output

The USB-CEA carkit uses the DP/DM pad to output audio signals (see the *CEA-936A: Mini-USB Analog Carkit Interface Specification*).

The MCPC carkit uses the RXAF analog pad to output audio signals.

[Figure 6-14](#) shows the carkit output downlink full path characteristics for audio and USB.



**Figure 6-14. Carkit Output Downlink Path Characteristics**

[Table 6-10](#) lists the electrical characteristics of the MCPC and USB-CEA carkit audio.

**Table 6-10. MCPC and USB-CEA Carkit Audio Downlink Electrical Characteristics**

| Parameter   | Conditions          | Min | Typ  | Max | Unit            |
|---|---------------------|-----|------|-----|-----------------|
| Output load   | USB-CEA (DP/DM)     | 20  |      |     | kΩ              |
|   | MCPC (RXAF)         | 5   |      |     |                 |
| Gain range <sup>(1)</sup>   | Audio path          | -92 |      | 30  | dB              |
|   | Voice path          | -66 |      | 30  |                 |
| Absolute gain error   | At 1 kHz            | -1  |      | 1   | dB              |
| Peak-to-peak differential output voltage (0 dBFS)                                     | Gain = 0 dB         |     | 1.5  |     | V <sub>PP</sub> |
| Total harmonic distortion   | At 0 dBFS           |     | -80  | -75 | dB              |
|   | At -6 dBFS          |     | -74  | -69 |                 |
|   | At -20 dBFS         |     | -70  | -65 |                 |
|   | At -60 dBFS         |     | -30  | -25 |                 |
| THD+N (20 Hz to 20 kHz, A-weighted)   | At 0 dBFS           |     | 60   |     | dB              |
| Idle channel noise (20 Hz to 20 kHz, A-weighted), default gain setting <sup>(2)</sup> | USB-CEA             |     | -77  |     | dBFS            |
|   | MCPC                |     | -80  | -77 |                 |
| Output PSRR   | 20 Hz to 20 kHz     |     | 60   |     | dB              |
| Supply voltage (VINTANA1)   |                     |     | 1.5  |     | V               |
| Common mode output voltage for USB-CEA  |                     | 1.3 | 1.35 | 1.4 | V               |
| Isolation between D+/D- during audio mode (20 Hz to 20 kHz)                           |                     | 60  |      |     | dB              |
| Crosstalk between right and left channels   | USB-CEA stereo      |     | -90  |     | dB              |
| Crosstalk RX/TX (1 V <sub>PP</sub> output)  | USB-CEA mono/stereo |     |      | -60 | dB              |
|   | MCPC                |     |      | -65 |                 |
| Signal noise ratio (20 Hz to 20 kHz, A-weighted)                                      | At 0 dBFS           |     | 60   |     | dB              |

(1) Audio digital filter = -62 to 0 dB (1-dB steps) and 0 to 12 dB (6-dB steps);

Voice digital filter = -36 to 12 dB (1-dB steps);

ARXPGA (volume control) = -24 to 12 dB (2-dB steps);

Output driver (USB-CEA and MCPC) = -1 dB

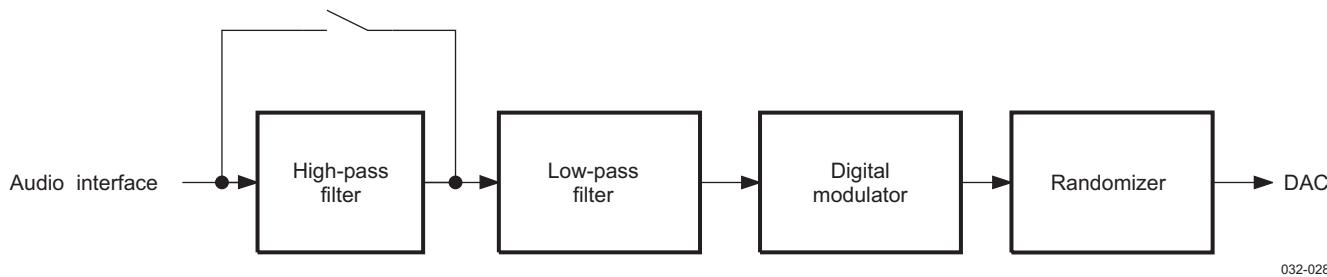
(2) The default gain setting assumes the ARXPGA has 0-dB gain setting (volume control) and output driver at 0.6-dB gain setting.

**Table 6-10. MCPC and USB-CEA Carkit Audio Downlink Electrical Characteristics (continued)**

| Parameter   | Conditions      | Min | Typ | Max | Unit     |
|---|-----------------|-----|-----|-----|----------|
| Phone speaker amplifier output impedance at 1 kHz | USB-CEA (DP/DM) |     |     | 200 | $\Omega$ |
|   | MCPC (RXAF)     |     |     | 200 | $\Omega$ |

**6.1.8 Digital Audio Filter Module**

Figure 6-15 shows the digital audio filter downlink full path characteristics of the audio interface.

**Figure 6-15. Digital Audio Filter Downlink Path Characteristics**

The HPF can be bypassed.

Table 6-11 lists the audio filter frequency responses relative to reference gain at 1 kHz.

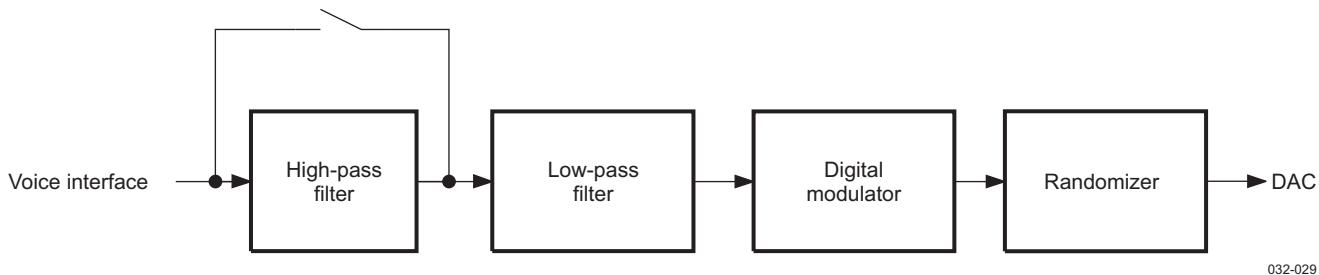
**Table 6-11. Digital Audio Filter RX Electrical Characteristics**

| Parameter            | Conditions   | Min   | Typ                       | Max  | Unit     |
|----------------------|--|-------|---------------------------|------|----------|
| Passband             |  |       | 0.42                      |      | $F_S$    |
| Passband ripple      | 0 to $0.42F_S$ <sup>(1)</sup>                          | -0.25 | 0.1                       | 0.25 | dB       |
| Stopband             |  |       | 0.6                       |      | $F_S$    |
| Stopband attenuation | $F = 0.6F_S$ <sup>(1)</sup> to $0.8F_S$ <sup>(1)</sup> | 60    | 75                        |      | dB       |
| Group delay          |  |       | $15.8/F_S$ <sup>(1)</sup> |      | $\mu s$  |
| Linear phase         |  | -1.4  |                           | 1.4  | $^\circ$ |

(1)  $F_S$  is the sampling frequency (8, 11.025, 12, 16, 22.05, 24, 32, 44.1, or 48 kHz).

**6.1.9 Digital Voice Filter Module**

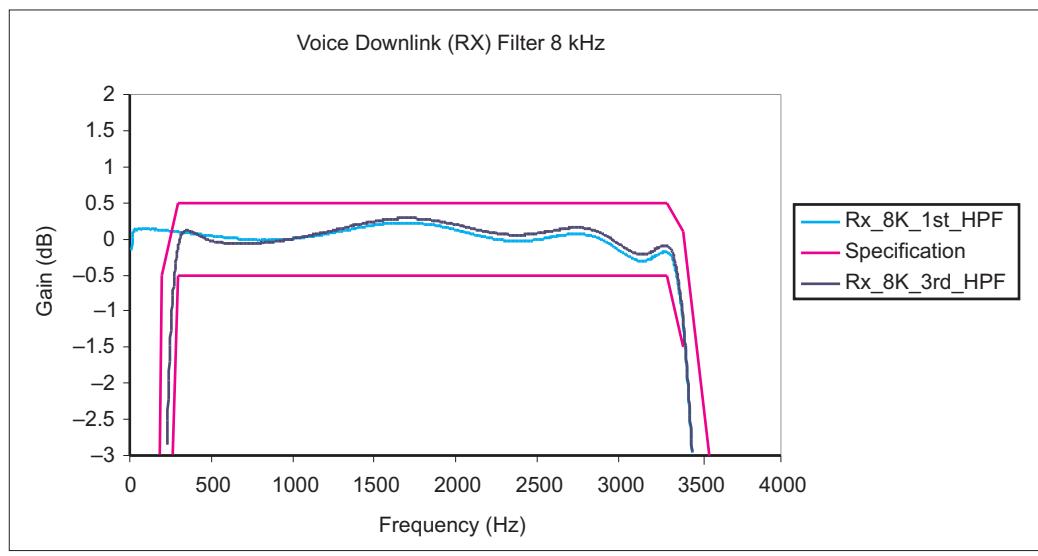
Figure 6-16 shows the digital voice filter downlink full path characteristics of the voice interface.

**Figure 6-16. Digital Voice Filter Downlink Path Characteristics**

The global HPF or only the third-order HPF can be bypassed (when the third-order HPF is skipped, the first-order HPF remains active).

### 6.1.9.1 Voice Downlink Filter (Sampling Frequency at 8 kHz)

Figure 6-17 shows the voice downlink frequency response with  $F_S = 8$  kHz. Table 6-12 lists the voice filter frequency responses relative to the reference gain at 1 kHz with  $F_S = 8$  kHz.



032-030

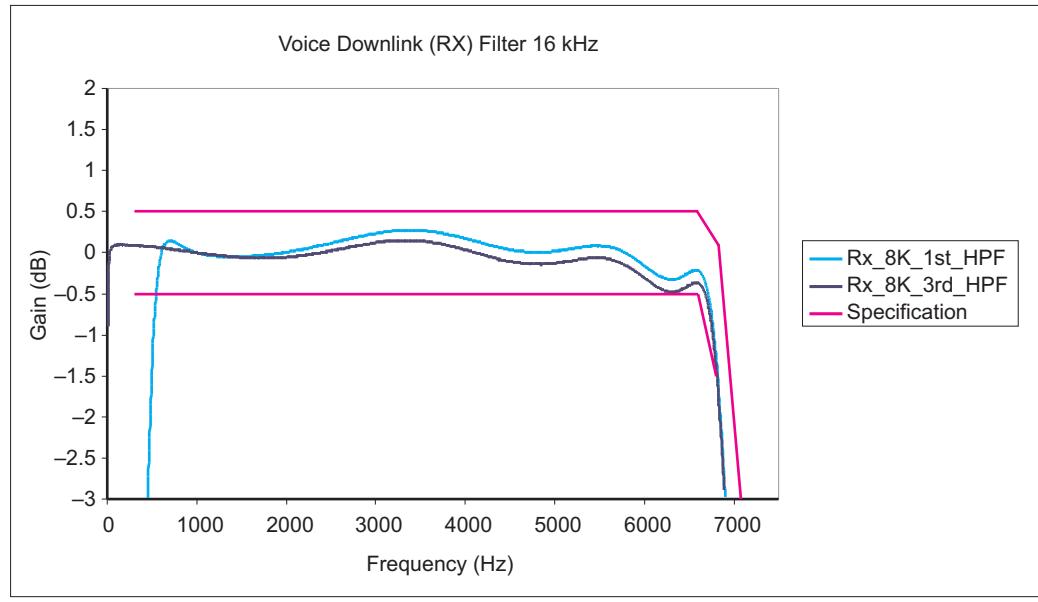
Figure 6-17. Voice Downlink Frequency Response With  $F_S = 8$  kHz

Table 6-12. Digital Voice Filter RX Electrical Characteristics With  $F_S = 8$  kHz

| Parameter  | Test Conditions | Min  | Typ | Max  | Unit |
|--|-----------------|------|-----|------|------|
| Frequency response relative to reference gain at 1 kHz (first-order HPF) | 100 Hz          |      |     | -20  | dB   |
|  | 200 Hz          | -8   |     | -0.5 |      |
|  | 300 to 3300 Hz  | -0.5 | 0   | 0.5  |      |
|  | 3400 Hz         | -1.5 | 0   | 0.1  |      |
|  | 4000 Hz         |      |     | -17  |      |
|  | 4600 Hz         |      |     | -40  |      |
|  | > 6000 Hz       |      |     | -45  |      |
| Pole when third-order HPF is disabled (first-order HPF)                  |                 |      | 2.5 |      | Hz   |
| Group delay  |                 |      | 0.5 |      | ms   |

### 6.1.9.2 Voice Downlink Filter (Sampling Frequency at 16 kHz)

Figure 6-18 shows the voice downlink frequency response with  $F_S = 16$  kHz. Table 6-13 lists the voice filter frequency responses relative to the reference gain at 1 kHz with  $F_S = 16$  kHz.



032-031

**Figure 6-18. Voice Downlink Frequency Response With  $F_S = 16$  kHz**

**Table 6-13. Digital Voice Filter RX Electrical Characteristics With  $F_S = 16$  kHz**

| Parameter  | Test Conditions | Min  | Typ | Max | Unit |
|--|-----------------|------|-----|-----|------|
| Frequency response relative to reference gain at 1 kHz (first-order HPF) | 300 to 6600 Hz  | -0.5 | 0   | 0.5 | dB   |
|  | 6800 Hz         | -1.5 | 0   | 0.1 |      |
|  | 8000 Hz         |      |     | -17 |      |
|  | 9200 Hz         |      |     | -40 |      |
|  | > 12000 Hz      |      |     | -45 |      |
| Pole when third-order HPF is disabled (first-order HPF)                  |                 |      | 5   |     | Hz   |

### 6.1.10 Boost Stage

The boost effect adds emphasis to low frequencies. It compensates for an HPF created by the capacitance resistor (CR) filter of the headset (in ac-coupling configuration).

There are four modes. Three effects are available, with slightly different frequency responses, and the fourth setting disables the boost effect:

- Boost effect 1
- Boost effect 2
- Boost effect 3
- Flat equalization: The boost effect is in bypass mode.

Table 6-14 and Table 6-15 list typical values according to frequency response versus input frequency and  $F_S$  frequency.

**Table 6-14. Boost Electrical Characteristics Versus  $F_S$  Frequency ( $F_S \leq 22.05$  kHz)**

| Frequency (Hz) | $F_S = 8$ kHz |      |      | $F_S = 11.025$ kHz |      |      | $F_S = 12$ kHz |      |      | $F_S = 16$ kHz |      |      | $F_S = 22.05$ kHz |      |      | Unit |
|----------------|---------------|------|------|--------------------|------|------|----------------|------|------|----------------|------|------|-------------------|------|------|------|
|                | 1             | 2    | 3    | 1                  | 2    | 3    | 1              | 2    | 3    | 1              | 2    | 3    | 1                 | 2    | 3    |      |
| 10             | 4.51          | 5.13 | 5.62 | 5.10               | 5.51 | 5.80 | 5.22           | 5.58 | 5.83 | 5.54           | 5.77 | 5.92 | 5.76              | 5.89 | 5.97 | dB   |
| 12             | 4.08          | 4.83 | 5.46 | 4.80               | 5.32 | 5.71 | 4.95           | 5.41 | 5.76 | 5.36           | 5.66 | 5.87 | 5.65              | 5.83 | 5.94 |      |
| 15.2           | 3.43          | 4.32 | 5.18 | 4.28               | 4.97 | 5.54 | 4.47           | 5.11 | 5.61 | 5.03           | 5.47 | 5.79 | 5.45              | 5.71 | 5.90 |      |
| 18.2           | 2.91          | 3.86 | 4.89 | 3.82               | 4.63 | 5.36 | 4.04           | 4.80 | 5.45 | 4.71           | 5.26 | 5.69 | 5.24              | 5.59 | 5.84 |      |
| 20.5           | 2.56          | 3.53 | 4.65 | 3.49               | 4.37 | 5.21 | 3.72           | 4.56 | 5.32 | 4.45           | 5.09 | 5.60 | 5.06              | 5.49 | 5.79 |      |
| 29.4           | 1.62          | 2.49 | 3.78 | 2.45               | 3.42 | 4.57 | 2.68           | 3.74 | 4.73 | 3.51           | 4.39 | 5.24 | 4.35              | 5.02 | 5.59 |      |
| 39.7           | 1.05          | 1.71 | 2.93 | 1.67               | 2.55 | 3.84 | 1.88           | 2.80 | 4.06 | 2.66           | 3.63 | 4.72 | 3.67              | 4.45 | 5.27 |      |
| 50.4           | 0.71          | 1.20 | 2.26 | 1.17               | 1.91 | 3.17 | 1.33           | 2.13 | 3.41 | 2.01           | 2.95 | 4.19 | 2.89              | 3.85 | 4.88 |      |
| 60.3           | 0.51          | 0.92 | 1.79 | 0.89               | 1.49 | 2.65 | 1.00           | 1.68 | 2.89 | 1.57           | 2.43 | 3.72 | 2.39              | 3.35 | 4.52 |      |
| 76.7           | 0.32          | 0.61 | 1.26 | 0.59               | 1.05 | 1.99 | 0.69           | 1.18 | 2.22 | 1.11           | 1.79 | 3.04 | 1.76              | 2.66 | 3.94 |      |
| 97.5           | 0.20          | 0.39 | 0.87 | 0.38               | 0.70 | 1.43 | 0.44           | 0.79 | 1.62 | 0.75           | 1.27 | 2.36 | 1.24              | 2.00 | 3.28 |      |
| 131.5          | 0.12          | 0.21 | 0.50 | 0.20               | 0.39 | 0.88 | 0.25           | 0.47 | 1.02 | 0.42           | 0.78 | 1.59 | 0.75              | 1.30 | 2.41 |      |
| 157            | 0.08          | 0.15 | 0.36 | 0.15               | 0.28 | 0.65 | 0.17           | 0.33 | 0.75 | 0.31           | 0.57 | 1.22 | 0.55              | 0.99 | 1.93 |      |
| 200            | 0.05          | 0.09 | 0.22 | 0.09               | 0.17 | 0.41 | 0.11           | 0.21 | 0.49 | 0.19           | 0.37 | 0.82 | 0.36              | 0.66 | 1.38 |      |
| 240            | 0.03          | 0.06 | 0.15 | 0.06               | 0.12 | 0.29 | 0.07           | 0.14 | 0.35 | 0.14           | 0.26 | 0.60 | 0.25              | 0.48 | 1.04 |      |
| 304            | 0.02          | 0.04 | 0.09 | 0.04               | 0.07 | 0.18 | 0.04           | 0.09 | 0.22 | 0.08           | 0.16 | 0.38 | 0.16              | 0.30 | 0.70 |      |
| 463            | 0.00          | 0.01 | 0.03 | 0.01               | 0.03 | 0.07 | 0.02           | 0.04 | 0.09 | 0.03           | 0.07 | 0.17 | 0.07              | 0.13 | 0.32 |      |
| 704            | 0.00          | 0.00 | 0.01 | 0.00               | 0.01 | 0.03 | 0.01           | 0.01 | 0.03 | 0.01           | 0.03 | 0.07 | 0.03              | 0.06 | 0.14 |      |
| 1008           | 0.00          | 0.00 | 0.00 | 0.00               | 0.01 | 0.00 | 0.00           | 0.00 | 0.01 | 0.00           | 0.01 | 0.03 | 0.01              | 0.02 | 0.06 |      |
| 1444           | 0.00          | 0.00 | 0.00 | 0.00               | 0.00 | 0.00 | 0.00           | 0.00 | 0.00 | 0.00           | 0.00 | 0.00 | 0.00              | 0.01 | 0.02 |      |
| 2070           | 0.00          | 0.00 | 0.00 | 0.00               | 0.00 | 0.00 | 0.00           | 0.00 | 0.00 | 0.00           | 0.00 | 0.00 | 0.00              | 0.00 | 0.01 |      |
| 3770           | 0.00          | 0.00 | 0.00 | 0.00               | 0.00 | 0.00 | 0.00           | 0.00 | 0.00 | 0.00           | 0.00 | 0.00 | 0.00              | 0.00 | 0.00 |      |

**Table 6-15. Boost Electrical Characteristics Versus  $F_S$  Frequency ( $F_S \geq 24$  kHz)**

| Frequency (Hz) | $F_S = 24$ kHz |      |      | $F_S = 32$ kHz |      |      | $F_S = 44.1$ kHz |      |      | $F_S = 48$ kHz |      |      | $F_S = 96$ kHz |      |      | Unit |
|----------------|----------------|------|------|----------------|------|------|------------------|------|------|----------------|------|------|----------------|------|------|------|
|                | 1              | 2    | 3    | 1              | 2    | 3    | 1                | 2    | 3    | 1              | 2    | 3    | 1              | 2    | 3    |      |
| 10             | 5.79           | 5.90 | 5.97 | 5.89           | 5.89 | 5.99 | 5.95             | 5.98 | 6.04 | 5.96           | 5.99 | 6.01 | 5.71           | 5.83 | 5.90 | dB   |
| 12             | 5.70           | 5.85 | 5.95 | 5.84           | 5.84 | 5.98 | 5.92             | 5.97 | 6.03 | 5.94           | 5.98 | 6.00 | 5.54           | 5.68 | 5.81 |      |
| 15.2           | 5.53           | 5.76 | 5.91 | 5.73           | 5.73 | 5.96 | 5.87             | 5.94 | 6.02 | 5.89           | 5.95 | 5.99 | 5.40           | 5.57 | 5.73 |      |
| 18.2           | 5.35           | 5.65 | 5.87 | 5.62           | 5.62 | 5.93 | 5.80             | 5.90 | 6.00 | 5.83           | 5.93 | 5.98 | 5.28           | 5.48 | 5.68 |      |
| 20.5           | 5.19           | 5.56 | 5.83 | 5.52           | 5.52 | 5.91 | 5.74             | 5.87 | 5.99 | 5.78           | 5.90 | 5.97 | 5.19           | 5.42 | 5.64 |      |
| 29.4           | 4.55           | 5.18 | 5.64 | 5.10           | 5.07 | 5.79 | 5.51             | 5.75 | 5.94 | 5.57           | 5.79 | 5.92 | 4.87           | 5.18 | 5.48 |      |
| 39.7           | 3.81           | 4.62 | 5.37 | 4.52           | 4.52 | 5.64 | 5.12             | 5.53 | 5.85 | 5.26           | 5.59 | 5.84 | 4.47           | 4.91 | 5.30 |      |
| 50.4           | 3.14           | 4.06 | 5.02 | 3.94           | 3.95 | 5.43 | 4.69             | 5.27 | 5.72 | 4.88           | 5.37 | 5.73 | 4.08           | 4.63 | 5.11 |      |
| 60.3           | 2.62           | 3.51 | 4.69 | 3.46           | 3.54 | 5.21 | 4.30             | 5.00 | 5.59 | 4.49           | 5.13 | 5.62 | 3.72           | 4.37 | 4.95 |      |
| 76.7           | 1.97           | 2.90 | 4.15 | 2.76           | 2.76 | 4.78 | 3.68             | 4.52 | 5.34 | 3.91           | 4.70 | 5.40 | 3.18           | 3.92 | 4.67 |      |
| 97.5           | 1.41           | 2.22 | 3.51 | 2.10           | 2.09 | 4.27 | 2.99             | 3.94 | 4.99 | 3.24           | 4.15 | 5.07 | 2.59           | 3.41 | 4.33 |      |
| 131.5          | 0.88           | 1.49 | 2.65 | 1.40           | 1.40 | 3.49 | 2.15             | 3.10 | 4.35 | 2.38           | 3.35 | 4.51 | 1.86           | 2.69 | 3.75 |      |
| 157            | 0.65           | 1.13 | 2.15 | 1.04           | 1.04 | 2.96 | 1.70             | 2.58 | 3.90 | 1.90           | 2.82 | 4.08 | 1.47           | 2.24 | 3.35 |      |
| 200            | 0.41           | 0.76 | 1.55 | 0.70           | 0.70 | 2.28 | 1.19             | 1.93 | 3.23 | 1.35           | 2.15 | 3.44 | 1.03           | 1.68 | 2.77 |      |
| 240            | 0.30           | 0.55 | 1.18 | 0.50           | 0.50 | 1.81 | 0.89             | 1.51 | 2.71 | 1.02           | 1.70 | 2.92 | 0.77           | 1.31 | 2.32 |      |
| 304            | 0.18           | 0.35 | 0.80 | 0.33           | 0.32 | 1.27 | 0.58             | 1.04 | 2.05 | 0.68           | 1.19 | 2.24 | 0.51           | 0.90 | 1.75 |      |
| 463            | 0.08           | 0.16 | 0.37 | 0.14           | 0.14 | 0.64 | 0.27             | 0.50 | 1.12 | 0.31           | 0.58 | 1.25 | 0.23           | 0.43 | 0.95 |      |
| 704            | 0.03           | 0.06 | 0.16 | 0.06           | 0.06 | 0.29 | 0.12             | 0.23 | 0.56 | 0.14           | 0.27 | 0.62 | 0.10           | 0.20 | 0.46 |      |
| 1008           | 0.01           | 0.03 | 0.07 | 0.03           | 0.02 | 0.14 | 0.06             | 0.11 | 0.30 | 0.06           | 0.13 | 0.31 | 0.05           | 0.10 | 0.23 |      |
| 1444           | 0.00           | 0.01 | 0.03 | 0.01           | 0.01 | 0.06 | 0.03             | 0.05 | 0.16 | 0.03           | 0.06 | 0.15 | 0.02           | 0.05 | 0.11 |      |
| 2070           | 0.00           | 0.00 | 0.01 | 0.00           | 0.00 | 0.02 | 0.01             | 0.02 | 0.09 | 0.01           | 0.03 | 0.07 | 0.01           | 0.02 | 0.05 |      |
| 3770           | 0.00           | 0.00 | 0.00 | 0.00           | 0.00 | 0.00 | 0.00             | 0.00 | 0.04 | 0.00           | 0.00 | 0.01 | 0.00           | 0.00 | 0.01 |      |

## 6.2 Audio/Voice Uplink (TX) Module

The voice uplink path includes two input amplification stages dedicated to ten analog input terminals:

- MIC\_MAIN\_P, MIC\_MAIN\_M (differential main handset input)
- MIC\_SUB\_P, MIC\_SUB\_M (differential sub handset input)
- HSMICP, HSMICM (differential headset input)
- AUXL (common terminal: single-ended auxiliary/FM radio left channel input)
- AUXR (common terminal: single-ended auxiliary/FM radio right channel input)
- CEA carkit and MCPC transmit audio (TXAF) microphone through DINP/DINM pins

For all cases, only two analog input amplifiers can be used, because two ADCs are available.

The voice uplink path also includes two pulse density modulated (PDM) interfaces for digital microphones. Two stereo digital microphone interfaces are available.

The left and right FM channels can be connected to any audio output stage (for example, earpiece, headset speakers, etc.) through a connection matrix.

### 6.2.1 Microphone Bias Module

Three bias generators provide an external voltage of 2.2 V to bias the analog microphones (MICBIAS1, MICBIAS2, and HSMICBIAS terminals). The typical output current is 1 mA for each analog bias microphone.

Two bias generators can provide an external voltage of 1.8 V to bias digital microphones (DIGMIC\_0 and DIGMIC\_1). The typical output current is 5 mA for each digital bias microphone.

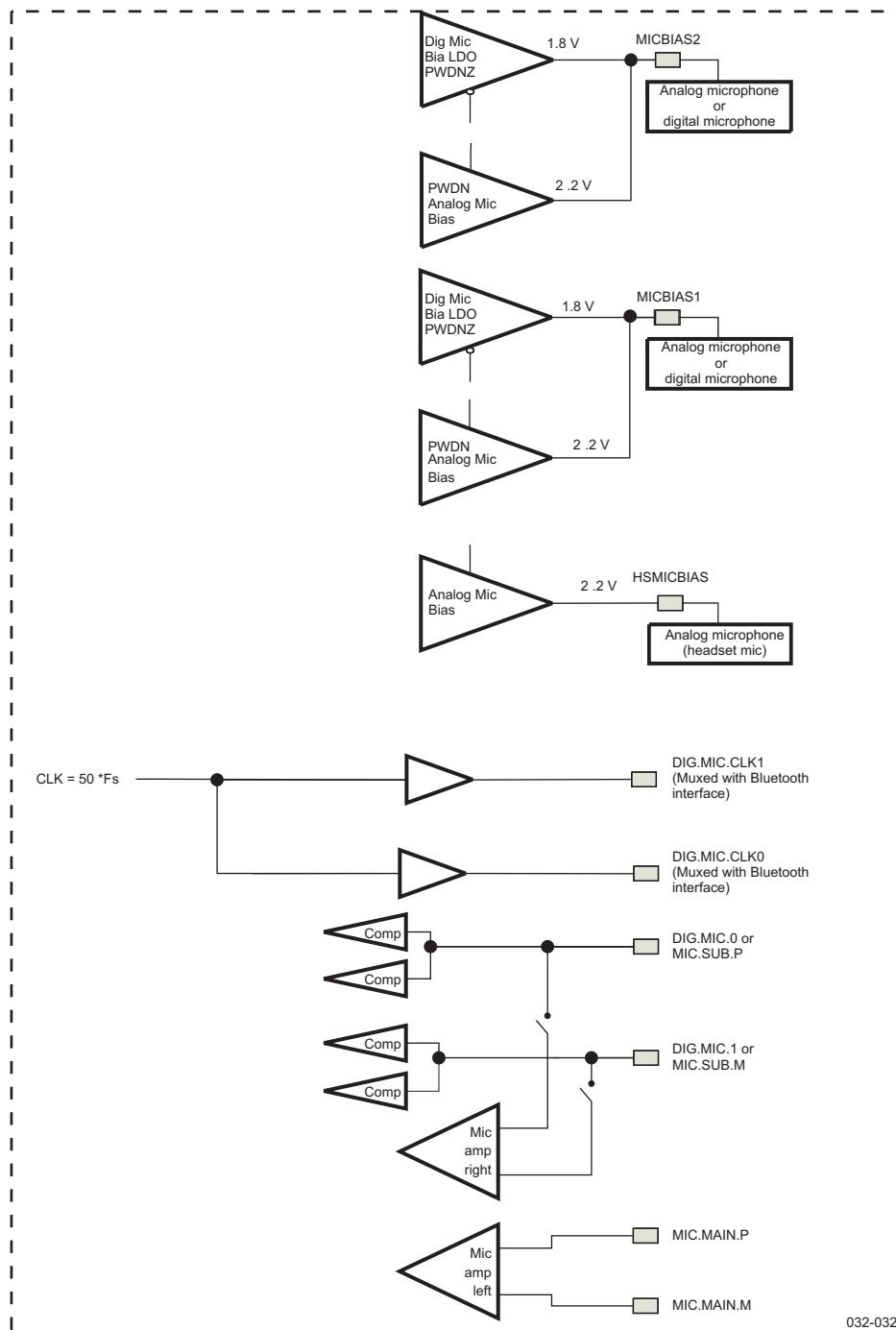
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#### NOTE

One bias generator can bias two digital microphones at the same time; in this case, the typical output current is 10 mA.

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Figure 6-19 shows the multiplexing for the analog and digital microphones.



**Figure 6-19. Analog and Digital Microphone Multiplexing**

#### 6.2.1.1 Analog Microphone Bias Module Characteristics

Table 6-16 lists the characteristics of the analog microphone bias module.

**Table 6-16. Analog Microphone Bias Module Characteristics**

| Parameter    | Test Conditions | Min  | Typ | Max  | Unit |
|--------------|-----------------|------|-----|------|------|
| Bias voltage |                 | 2.15 | 2.2 | 2.25 | V    |
| Load current |                 |      | 1   | mA   |      |

**Table 6-16. Analog Microphone Bias Module Characteristics (continued)**

| Parameter           | Test Conditions             | Min | Typ | Max | Unit                       |
|---------------------|-----------------------------|-----|-----|-----|----------------------------|
| Output noise        | P-weighted 20 Hz to 6.6 kHz |     |     | 1.8 | $\mu\text{V}_{\text{RMS}}$ |
| External capacitor  |                             | 0   |     | 200 | pF                         |
| Internal resistance |                             | 50  | 60  | 70  | k $\Omega$                 |

**NOTE**

If the value of the external capacitor is greater than 200 pF, the analog microphone bias becomes unstable. To stabilize it, a serial resistor must be added.

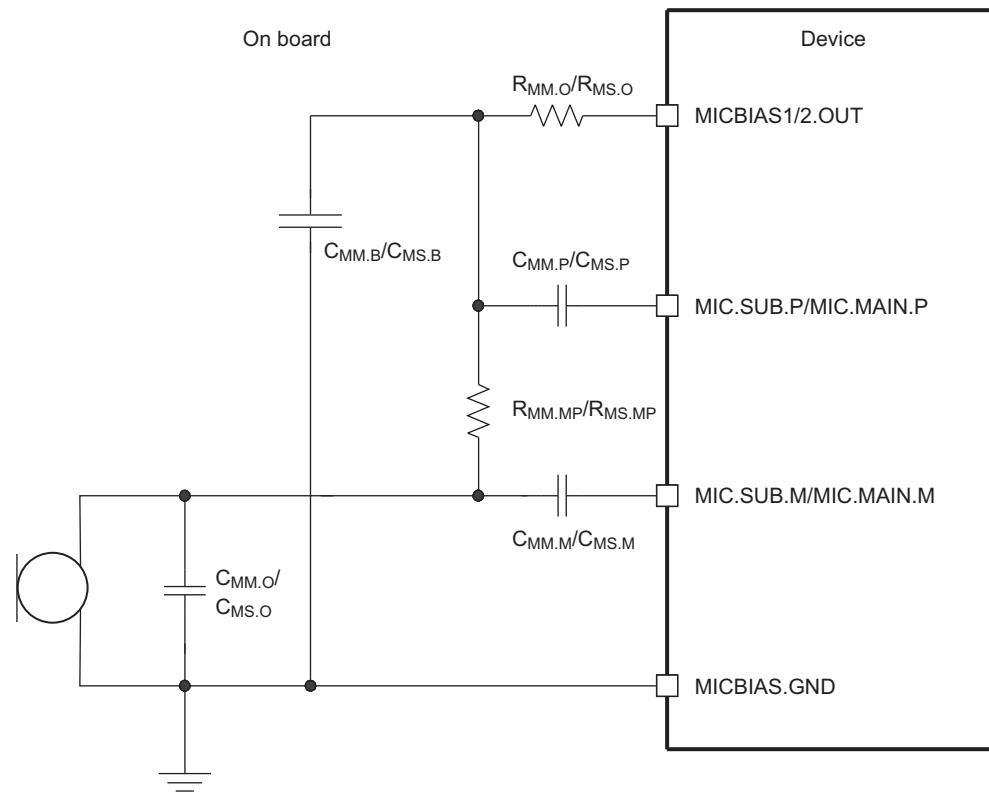
Table 6-17 lists the characteristics of the analog microphone bias module with a bias resistor.

**Table 6-17. Characteristics of Analog Microphone Bias Module With a Bias Resistor**

| Parameter      | Test Conditions        | Min | Typ        | Max | Unit       |
|----------------|------------------------|-----|------------|-----|------------|
| $R_{SB}$       | $C_B < 200 \text{ pF}$ | 0   |            |     | $\Omega$   |
|                | $C_B = 100 \text{ pF}$ | 300 |            |     |            |
|                | $C_B = 1 \mu\text{F}$  | 500 |            |     |            |
| $R_B + R_{SB}$ |                        |     | 2.2 to 2.7 |     | k $\Omega$ |

**6.2.1.2 External Components and Application Schematic**

Figure 6-20 and Figure 6-21 show the external components and application schematics for the analog microphone.

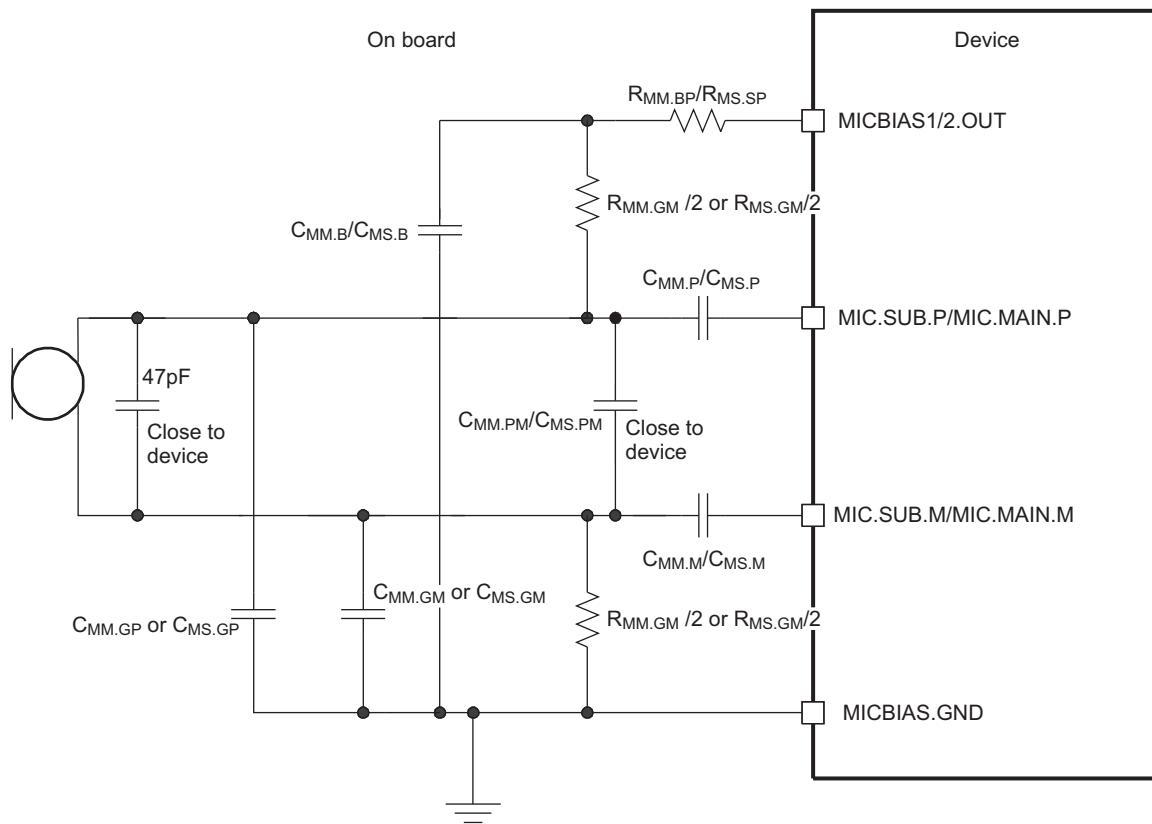


032-033

**Figure 6-20. Analog Microphone Pseudodifferential**

**NOTE**

For other component values, see [Table 15-1](#).



032-034

**Figure 6-21. Analog Microphone Differential**

**NOTE**

For other component values, see [Table 15-1](#).

**NOTE**

To improve the rejection, it is highly recommended to ensure that MICBIAS\_GND is as clean as possible. This ground must be shared with AGND of TPS65950 and must not share with AVSS4, which is the ground used by RX class-AB output stages.

In differential mode, adding a low-pass filter (made by  $R_{SB}$  and  $C_B$ ) is highly recommended if coupling between RX output stages and the microphone is too high (and there is not enough attenuation by the echo cancellation algorithm). The coupling can come from:

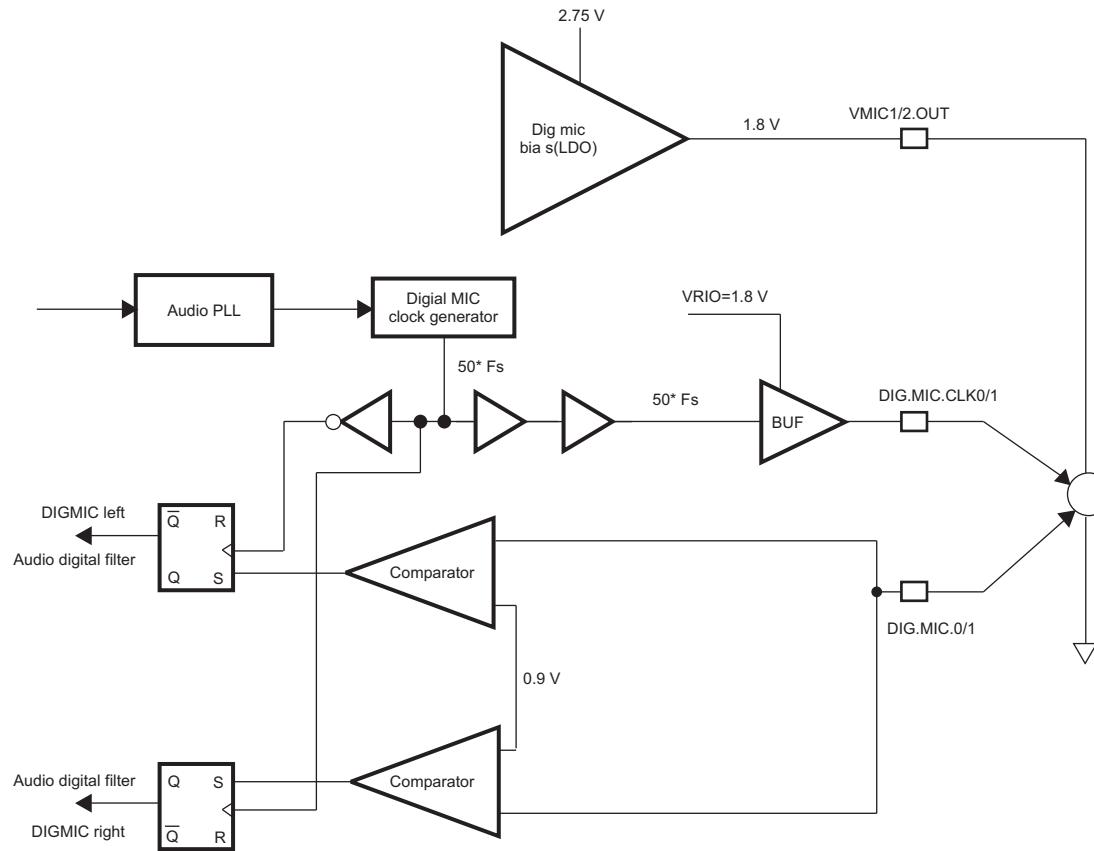
- The internal TPS65950 coupling between MICBIAS.OUT voltage and RX output stages
- Coupling noise between MICBIAS.GND and AVSS4

In pseudodifferential mode, the dynamic resistance of the microphone improves the rejection versus MICBIAS.OUT:

$$PSRR = 20 \cdot \log((R_B + R_{Dyn\_mic})/R_B)$$

### 6.2.1.3 Digital Microphone Bias Module Characteristics

[Figure 6-22](#) is a block diagram of the digital microphone bias module.



032-035

**Figure 6-22. Digital Microphone Bias Module Block Diagram**

[Table 6-18](#) and [Table 6-19](#) list the characteristics of the digital microphone bias module.

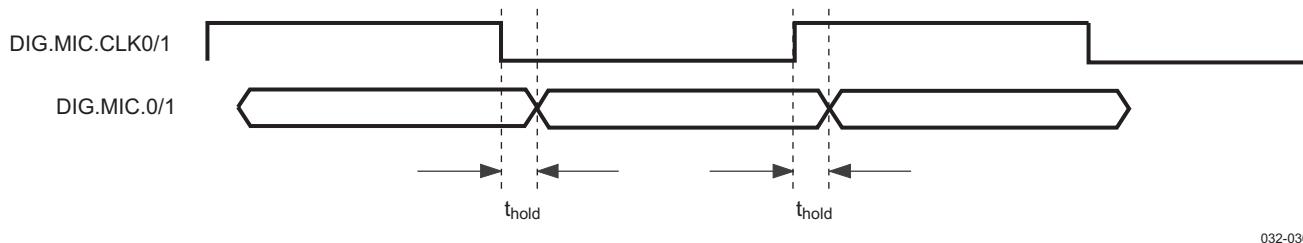
**Table 6-18. Digital Microphone Bias Module Characteristics**

| Parameter          | Test Conditions  | Min  | Typ | Max | Unit |
|--------------------|------------------|------|-----|-----|------|
| Bias voltage       |                  |      | 1.8 |     | V    |
| Load current       |                  |      |     | 10  | mA   |
| PSRR (from VBAT)   | 20 Hz to 6.6 kHz | 60   |     |     | dB   |
| External capacitor |                  | 0.3  | 1   | 3.3 | μF   |
| ESR for capacitor  | At 100 kHz       | 0.02 |     | 0.6 | Ω    |

**Table 6-19. Digital Microphone Bias Module Characteristics (2)**

| Parameter                                       | Test Conditions | Min        | Typ        | Max | Unit |
|---|-----------------|------------|------------|-----|------|
| Comparator high threshold                       |                 | 0.5*VDD_IO | 0.7*VDD_IO |     |      |
| Comparator low threshold                        |                 | 0.3*VDD_IO | 0.5*VDD_IO |     |      |
| Startup time                                    |                 |            |            | 2   | μs   |
| DIG.MIC.0 ( $t_{HOLD}$ ) from DIG.MIC.CLK0 edge |                 | 4          |            |     | ns   |
| DIG.MIC.1 ( $t_{HOLD}$ ) from DIG.MIC.CLK1 edge |                 | 4          |            |     | ns   |

Figure 6-23 is a timing diagram of the digital microphone bias module.



032-036

**Figure 6-23. Digital Microphone Bias Module Timing Diagram**

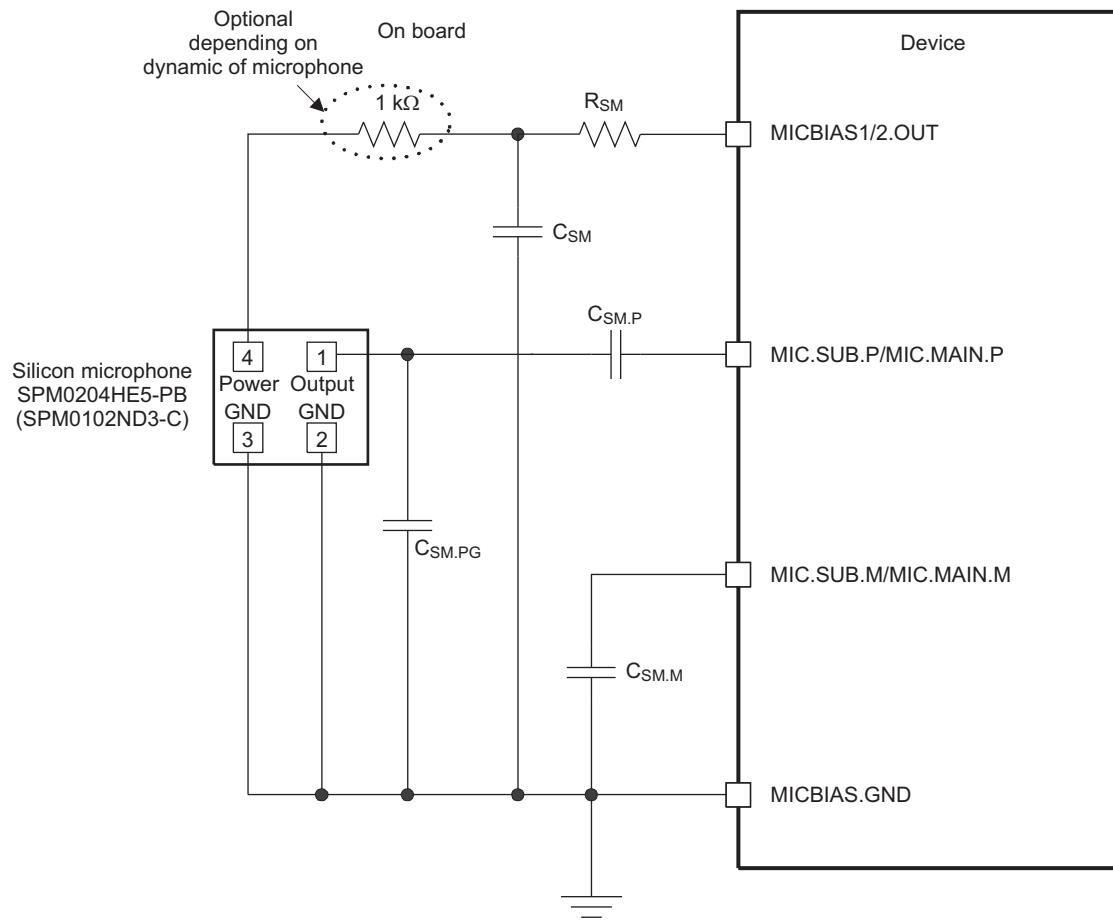
#### 6.2.1.4 Silicon Microphone Characteristics

Based on silicon micro-electrical-mechanical system (MEMS) technology, the new microphone achieves the same acoustic and electrical properties as conventional microphones, but is more rugged and exhibits higher heat resistance. These properties offer designers greater flexibility and new opportunities to integrate microphones.

The silicon microphone is the integration of mechanical elements and electronics on a common silicon substrate through microfabrication technology.

The complementary metal oxide semiconductor (CMOS) MEMS microphone is more like an analog IC than a classic electric condenser microphone (ECM). It is powered as an IC with a direct connection to the power supply. The on-chip isolation between the power input and the rest of the system adds power supply rejection (PSR) to the component, making the CMOS MEMS microphone inherently more immune to power supply noise than an ECM and eliminating the need for additional filtering circuitry to keep the power supply line clean.

Figure 6-24 is a schematic of the silicon microphone module.



032-037

**Figure 6-24. Silicon Microphone Module**

[Table 6-20](#) lists the characteristics of the silicon microphone module.

**Table 6-20. Silicon Microphone Module Characteristics**

| Parameter    | Test Conditions             | Min | Typ | Max | Unit  |
|--------------|-----------------------------|-----|-----|-----|-------|
| Bias voltage |                             |     | 2.2 |     | V     |
| Load current |                             |     |     | 1   | mA    |
| Output noise | P-weighted 20 Hz to 6.6 kHz |     |     | 1.8 | µVRMS |

**NOTE**

For other component values, see [Table 15-1](#).

**6.2.2 Stereo Differential Input**

The stereo differential inputs (the MIC\_MAIN\_P and MIC\_MAIN\_M, and the MIC\_SUB\_P and MIC\_SUB\_M terminals) can be amplified by the microphone amplification stages. The amplification stage outputs are connected to the two ADC inputs.

**6.2.3 Headset Differential Input**

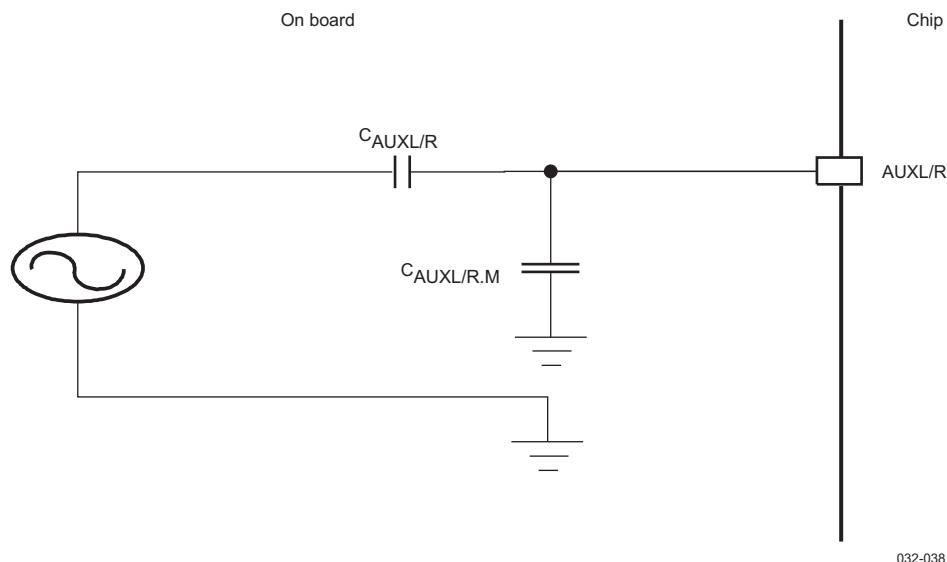
The headset differential inputs (the HSMICP and HSMICM terminals) can be amplified by the microphone amplification stage. The amplification stage outputs are connected to the ADC input.

### 6.2.4 FM Radio/Auxiliary Stereo Input

The auxiliary inputs AUXL/FML and AUXR/FMR can be used as the left and right stereo inputs, respectively, of the FM radio. In that case (because both input amplifiers are busy), the other input terminals are discarded and set to a high-impedance state. Both microphone amplification stages amplify the FM radio stereo signal. Both amplification stage outputs are connected to the ADC input. The left and right channel inputs of the FM radio can also be output through an audio output stage (mono output stage in case of mono input FM radio, stereo output stage in case of stereo input FM radio).

#### 6.2.4.1 External Components

[Figure 6-25](#) shows the external components of the auxiliary stereo input.



**Figure 6-25. Audio Auxiliary Input**

#### NOTE

For other component values, see [Table 15-1](#).

### 6.2.5 PDM Interface for Digital Microphones

The PDM interface is used as digital microphone inputs; each microphone is directly connected to the TX filter decimator to extract the audio samples at the desired accuracy and sample rate. Each digital microphone is stereo (two paths). The digital microphone interface is DIG.MIC.CLK (clock input to the microphone) and DIG.MIC (PDM data output from the microphone). The appropriate frequency of DIG.MIC.CLK is generated by the audio PLL, and the ratio between DIG.MIC.CLK and the sample rate is 50 (see [Figure 6-26](#)). The PDM interface is available only when  $F_S = 48$  kHz.

The data signal output is a 3-state output from the microphone. When a falling-edge DIG.MIC.CLK is detected, DIG.MIC is actively driven. When a rising DIG.MIC.CLK is detected, DIG.MIC is high impedance. The latter DIG.MIC.CLK half-cycle is reserved for stereo operation (the second microphone receives DIG.MIC.CLK inverted).

The  $\Sigma\Delta$  converter in the digital microphones produces PDM.

Digital microphone characteristics:

- PDM clock rate 2.4 MHz
- Fourth-order  $\Sigma\Delta$  converter in the microphone component

[Figure 6-26](#) is an example of PDM interface circuitry.

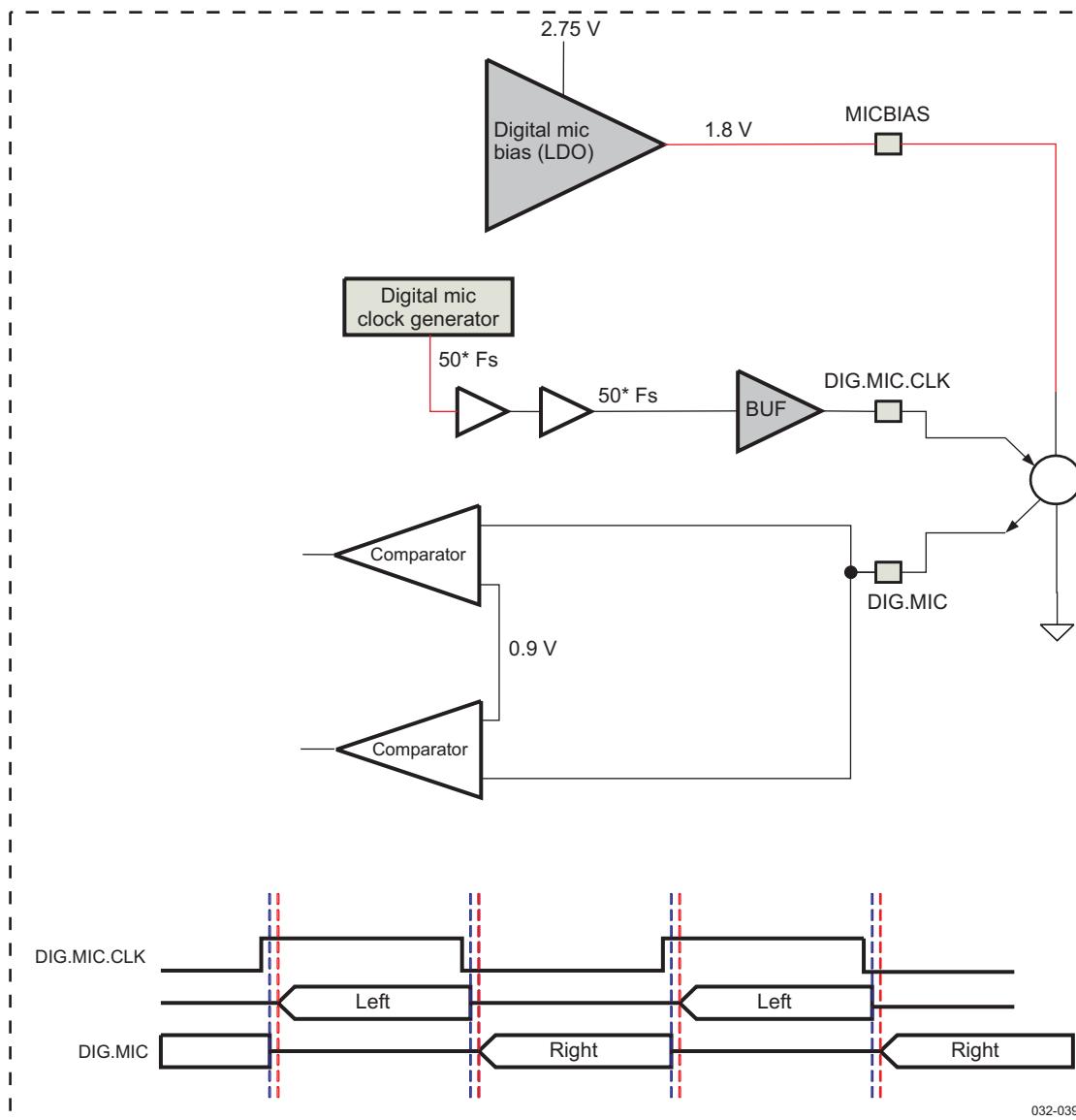


Figure 6-26. Example of PDM Interface Circuitry

### 6.2.6 Uplink Characteristics

Figure 6-27 shows the uplink amplifier. Table 6-21 lists the characteristics of the uplink amplifier.

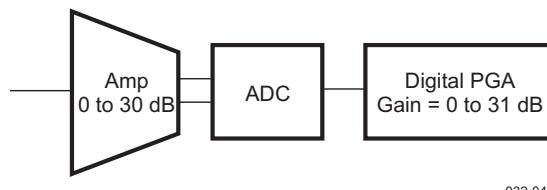


Figure 6-27. Uplink Amplifier

**Table 6-21. Uplink Amplifier Characteristics**

| Parameter   | Test Conditions  | Min | Typ                             | Max                             | Unit            |
|---|--|-----|---------------------------------|---------------------------------|-----------------|
| Speech delay                                      | Voice path   |     | 0.5                             |                                 | ms              |
| Gain range <sup>(1)</sup>                         |  | 0   |                                 | 61                              | dB              |
| Absolute gain                                     | 0 dBFS at 1.02 kHz   | -1  |                                 | 1                               | dB              |
| Peak-to-peak differential input voltage (0 dBFS)  | For differential input<br>0 dB gain setting  |     |                                 | 1.5                             | V <sub>PP</sub> |
| Peak-to-peak single-ended input voltage (0 dBFS)  | For single-ended input<br>0 dB gain setting  |     |                                 | 1.5                             | V <sub>PP</sub> |
| Input impedance <sup>(2)</sup>                    |  | 40k |                                 | 70k                             | Ω               |
| Total harmonic distortion (sine wave at 1.02 kHz) | At -1 dBFS<br>At -6 dBFS<br>At -10 dBFS<br>At -20 dBFS<br>At -60 dBFS  |     | -80<br>-74<br>-70<br>-60<br>-20 | -75<br>-69<br>-65<br>-55<br>-15 | dB              |
| Idle channel noise                                | 20 Hz to 20 kHz, A-weighted, gain = 0 dB<br>16 kHz: < 20 Hz to 7 kHz, gain = 0 dB<br>8 kHz: P-weighted voice, gain = 18 dB<br>16 kHz: < 20 Hz to 7 kHz, gain = 18 dB |     | -85<br>-90<br>-87<br>-82        | -78                             | dBFS            |
| Crosstalk A/D to D/A                              | Gain = 0 dB  |     | -80                             |                                 |                 |
| Crosstalk path between two microphones            |  | -70 |                                 |                                 |                 |
| Intermodulation distortion                        | Two-tone method  |     |                                 | -60                             |                 |

(1) Gain range is defined by: Preamplifier = 0 to 30 dB; Filter = 0 to 31 dB (1-dB steps)

(2) Impedance varies in the specified range with gain selection.

### 6.2.7 Microphone Amplification Stage

Microphone amplification stages perform single-to-differential conversion for single-ended inputs. Two programmable gains from 0 to 30 dB can be set:

- Automatic level control for main microphone or submicrophone input. The gain step is 1 dB.
- Level control by register for line-in or carkit input, or headset microphone. The gain step is 6 dB.

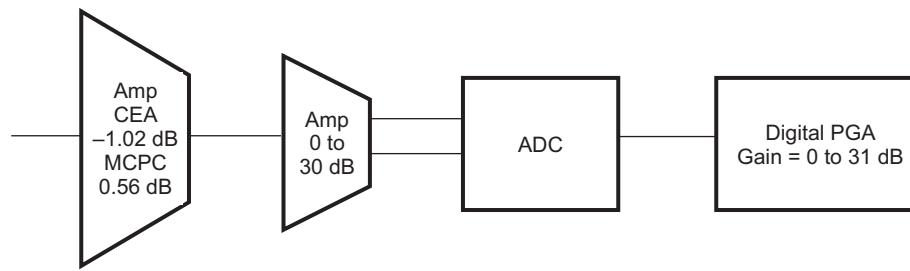
The amplification stage outputs are connected to the ADC input (ADC left and right).

### 6.2.8 Carkit Input

The USB-CEA carkit uses the DP pad to input the audio signal.

The MCPC carkit uses the TXAF analog pad to input the audio signal.

Figure 6-28 shows the uplink carkit full path uplink characteristics for audio and USB.



032-041

**Figure 6-28. Carkit Input Uplink Path Characteristics**

Table 6-22 lists the electrical characteristics of the MCPC and USB-CEA carkit audio.

**Table 6-22. MCPC and USB-CEA Carkit Audio Uplink Electrical Characteristics**

| Parameter  | Test Conditions   | Min    | Typ        | Max   | Unit            |
|--|---|--------|------------|-------|-----------------|
| Gain range <sup>(1)</sup>  |   | -1     |            | 60    | dB              |
| Absolute gain, 0 dBFs at 1.02 kHz <sup>(1) (2) (3)</sup>               | USB-CEA default gain setting<br>MCPC default gain setting             | -1.5   |            | 1.5   | dB              |
| Speech delay   |   | -1.5   |            | 1.5   |                 |
| Input common mode voltage <sup>(4)</sup>                               | USB-CEA   | 1.3    |            | 1.9   | V               |
| Phone microphone amplifier input impedance at 1 kHz                    | USB-CEA<br>MCPC   | 8<br>5 | 120<br>100 |       | kΩ              |
| Peak-to-peak single-ended input voltage (0 dBFs)                       | Default setting   |        |            | 1.414 | V <sub>PP</sub> |
| Total harmonic distortion (sine wave at 1 kHz), default gain setting   | At -1 dBFs<br>At -6 dBFs<br>At -10 dBFs<br>At -20 dBFs<br>At -60 dBFs |        | -74        | -60   | dB              |
| THD + N (20 Hz to 20 kHz, A-weighted)                                  | At 0 dBFs   |        | 60         |       | dB              |
| Signal noise ratio (20 Hz to 20 kHz, A-weighted)                       | At 0 dBFs   |        | 60         |       | dB              |
| Idle channel noise (20 Hz to 20 kHz, A-weighted), default gain setting | USB-CEA<br>MCPC   |        | -77<br>-80 | -77   | dBFs            |
| Output PSRR (20 Hz to 20 kHz, A-weighted)                              | USB-CEA<br>MCPC   |        | 50<br>35   |       |                 |

(1) Gain range is defined by: MCPC/CEA amplifier = 0.56 dB/-1.02 dB; Preamplifier = 0 to 30 dB; Filter = 0 to 31 dB (1-dB steps).

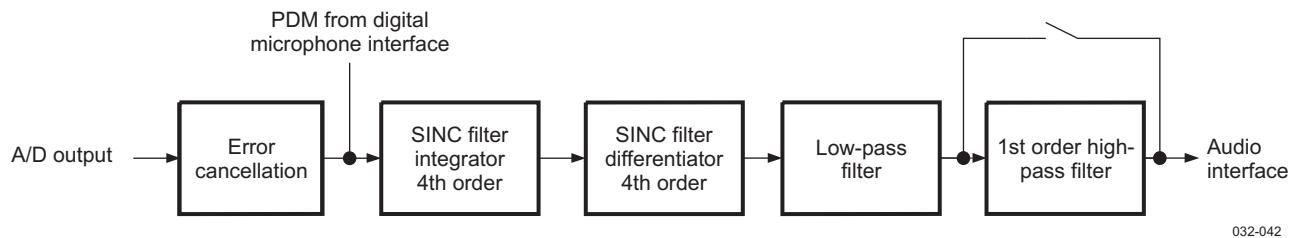
(2) The CEA default gain setting assumes 0 dB on the preamplifier, 1 dB on the digital filter, and the MCPC/CEA amplifier at -1.02 dB.

(3) The MCPC default gain setting assumes 0 dB on the preamplifier, 0 dB on the digital filter, and the MCPC/CEA amplifier at 0.56 dB.

(4) Full-scale input voltage is 1 V minimum.

### 6.2.9 Digital Audio Filter Module

Figure 6-29 shows the digital audio filter uplink full path characteristics for the audio interface.

**Figure 6-29. Digital Audio Filter Uplink Path Characteristics**

The HPF can be bypassed. It is controlled by the MISC\_SET\_2 ATX\_HPF\_BYP bit, address 0x49.

Table 6-23 lists the audio filter frequency responses relative to reference gain at 1 kHz.

**Table 6-23. Digital Audio Filter TX Electrical Characteristics**

| Parameter            | Test Conditions   | Min    | Typ | Max                 | Unit           |
|----------------------|---|--------|-----|---------------------|----------------|
| Passband             |   | 0.0005 |     | 0.42                | F <sub>S</sub> |
| Passband gain        | In region 0.0005*F <sub>S</sub> to 0.42*F <sub>S</sub> <sup>(1)</sup> | -0.25  |     | 0.25                | dB             |
| Stopband             |   |        |     | 0.6                 | F <sub>S</sub> |
| Stopband attenuation | In region 0.6*F <sub>S</sub> to 1*F <sub>S</sub> <sup>(1)</sup>       |        |     | 60                  | dB             |
| Group delay          |   |        |     | 15.8/F <sub>S</sub> | μs             |

(1) F<sub>S</sub> is the sampling frequency (8, 11.025, 12, 16, 22.05, 24, 32, 44.1, or 48 kHz).

### 6.2.10 Digital Voice Filter Module

Figure 6-30 shows the digital voice filter uplink full path characteristics of the voice interface.

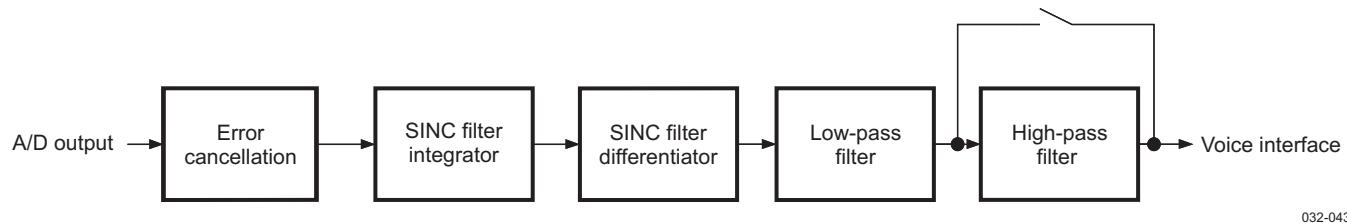


Figure 6-30. Digital Audio Filter Uplink Path Characteristics

The global HPF or only the third-order HPF can be bypassed (when the third-order HPF is skipped, the first-order HPF remains active). It is controlled by the MISC\_SET\_2 VTX\_3RD\_HPF\_BYP bit, address 0x49, the for the third-order HPF, and by the VTX\_HPF\_BYP bit for the global HPF.

#### 6.2.10.1 Voice Uplink Filter (Sampling Frequency at 8 kHz)

Figure 6-31 and Figure 6-32 show the voice uplink frequency response with a sampling frequency of 8 kHz.

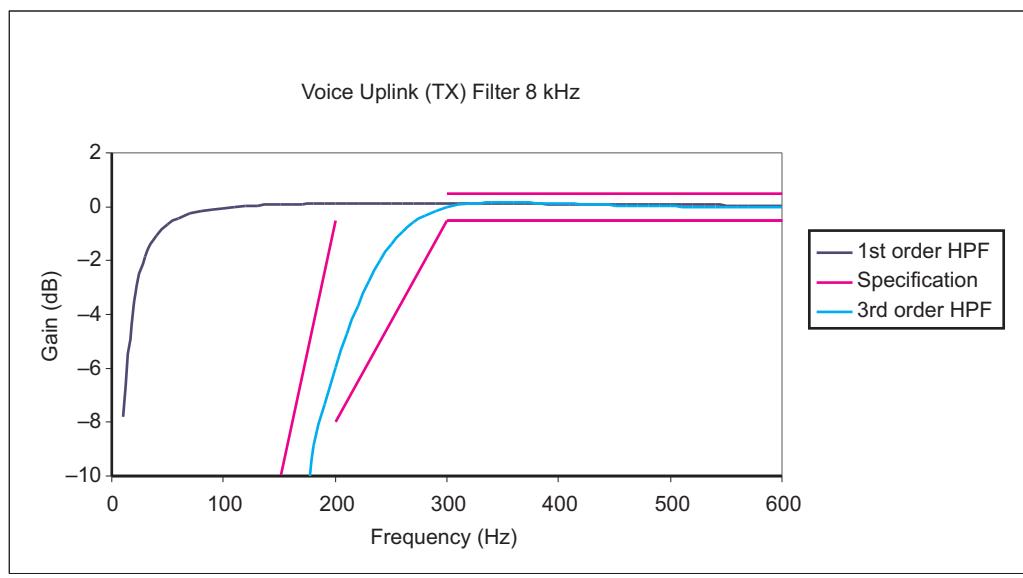
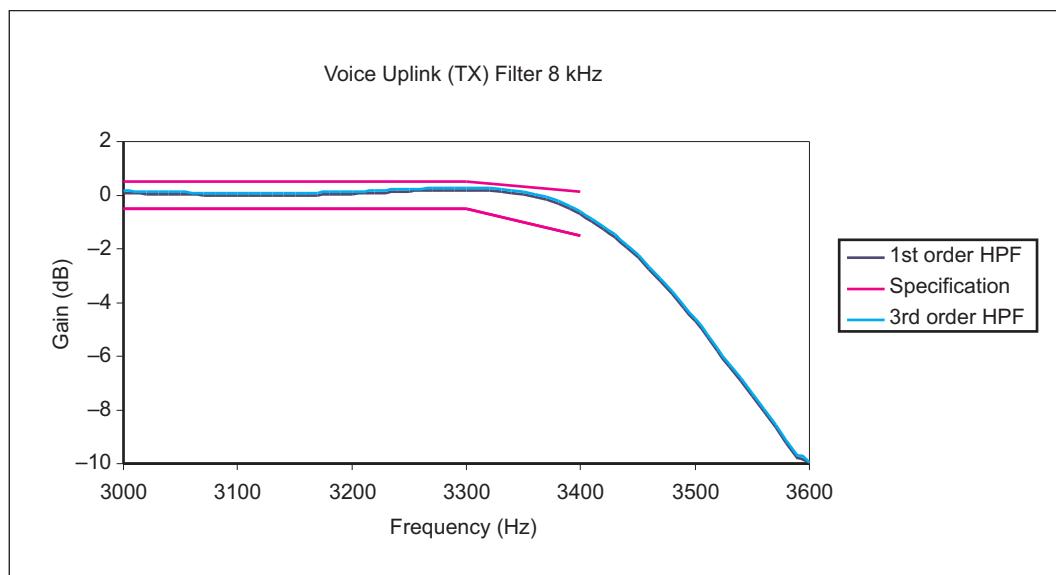


Figure 6-31. Voice Uplink Frequency Response With  $F_s = 8$  kHz (Frequency Range 0 to 600 Hz)



032-045

**Figure 6-32. Voice Uplink Frequency Response With  $F_S = 8$  kHz (Frequency Range 3000 to 3600 Hz)**

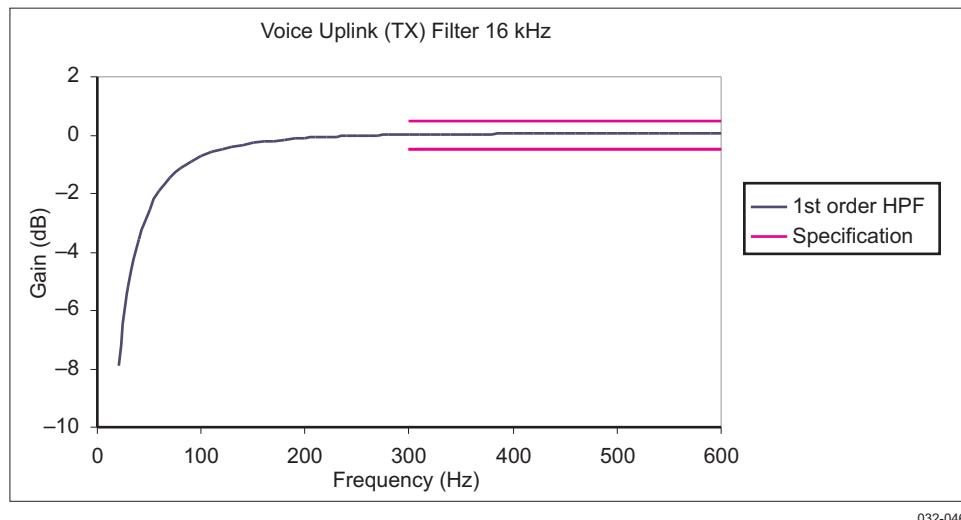
Table 6-24 lists the voice filter frequency responses relative to reference gain at 1 kHz with  $F_S = 8$  kHz.

**Table 6-24. Digital Voice Filter TX Electrical Characteristics With  $F_S = 8$  kHz**

| Parameter  | Test Conditions | Min  | Typ | Max  | Unit |
|--|-----------------|------|-----|------|------|
| Frequency response relative to reference gain at 1 kHz | 100 Hz          |      |     | -20  | dB   |
|  | 200 Hz          | -8   |     | -0.5 |      |
|  | 300 to 3300 Hz  | -0.5 | 0   | 0.5  |      |
|  | 3400 Hz         | -1.5 | 0   | 0.1  |      |
|  | 4000 Hz         |      |     | -17  |      |
|  | 4600 Hz         |      |     | -40  |      |
|  | >6000 Hz        |      |     | -45  |      |
| Pole when HPF is disabled (first-order HPF)            |                 |      | 24  |      | Hz   |
| Group delay  |                 |      | 0.5 |      | ms   |

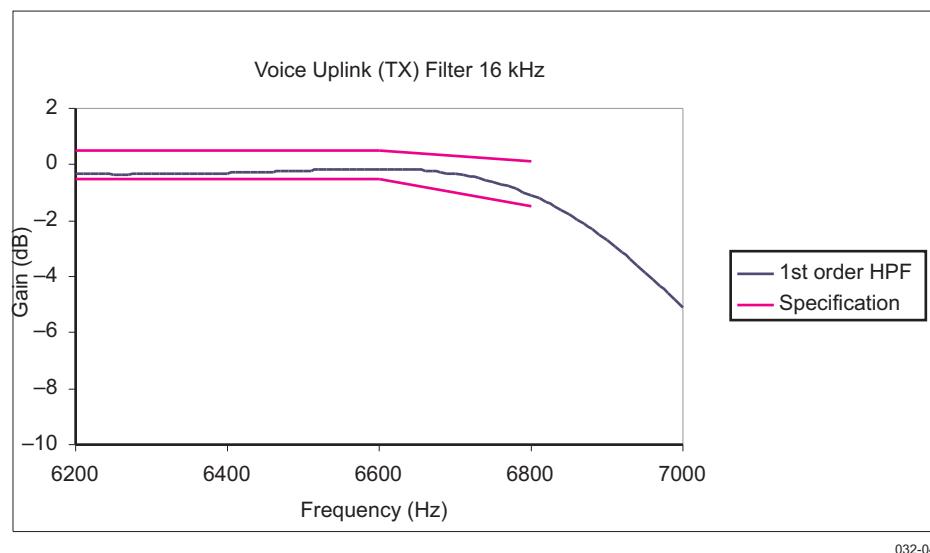
### 6.2.10.2 Voice Uplink Filter (Sampling Frequency at 16 kHz)

Figure 6-33 and Figure 6-34 show the voice uplink frequency response with a sampling frequency of 16 kHz.



032-046

**Figure 6-33. Voice Uplink Frequency Response With  $F_S = 16$  kHz (Frequency Range 0 to 600 Hz)**



032-047

**Figure 6-34. Voice Uplink Frequency Response With  $F_S = 16$  kHz (Frequency Range 6200 to 7000 Hz)**

Table 6-25 lists the voice filter frequency responses relative to reference gain at 1 kHz with  $F_S = 16$  kHz.

**Table 6-25. Digital Voice Filter TX Electrical Characteristics With  $F_S = 16$  kHz**

| Parameter  | Test Conditions | Min  | Typ | Max | Unit |
|--|-----------------|------|-----|-----|------|
| Frequency response relative to reference gain at 1 kHz (first-order HPF) | 300 to 6600 Hz  | -0.5 |     | 0.5 | dB   |
|  | 6800 Hz         | -1.5 |     | 0.1 |      |
|  | 8000 Hz         | -0.5 | 0   | -17 |      |
|  | 9200 Hz         | -1.5 | 0   | -40 |      |
|  | 12000 Hz        |      |     | -45 |      |

**Table 6-25. Digital Voice Filter TX Electrical Characteristics With  $F_S = 16$  kHz (continued)**

| Parameter   | Test Conditions | Min | Typ | Max | Unit |
|---|-----------------|-----|-----|-----|------|
| Pole when third-order HPF is disabled (first-order HPF) |                 |     | 47  |     | Hz   |

## 7 USB HS 2.0 OTG Transceiver

The TPS65950 includes a USB OTG transceiver with CEA and MCPC carkit interfaces that support USB 480 Mbps HS, 12 Mbps full-speed (FS), and USB 1.5 Mbps low-speed (LS) through a 4-pin ULPI.

The carkit block ensures the interface between the phone and a carkit device. The TPS65950 USB supports CEA and MCPC carkit standards.

Figure 7-1 is a block diagram of the USB 2.0 physical layer (PHY).

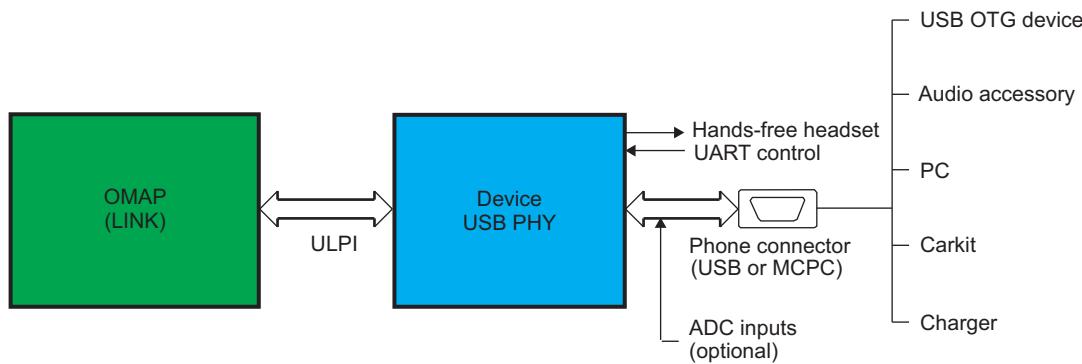


Figure 7-1. USB 2.0 PHY Overview

### 7.1 USB Features

The device has a USB OTG carkit transceiver that allows system implementation that complies with the following specifications:

- *Universal Serial Bus 2.0 Specification*
- *On-The-Go Supplement to the USB 2.0 Specification*
- *CEA-2011: OTG Transceiver Interface Specification*
- *CEA-936A: Mini-USB Analog Carkit Interface Specification*
- *MCPC ME-UART GL-006 Specification*
- *UTMI+ Low Pin Interface Specification*

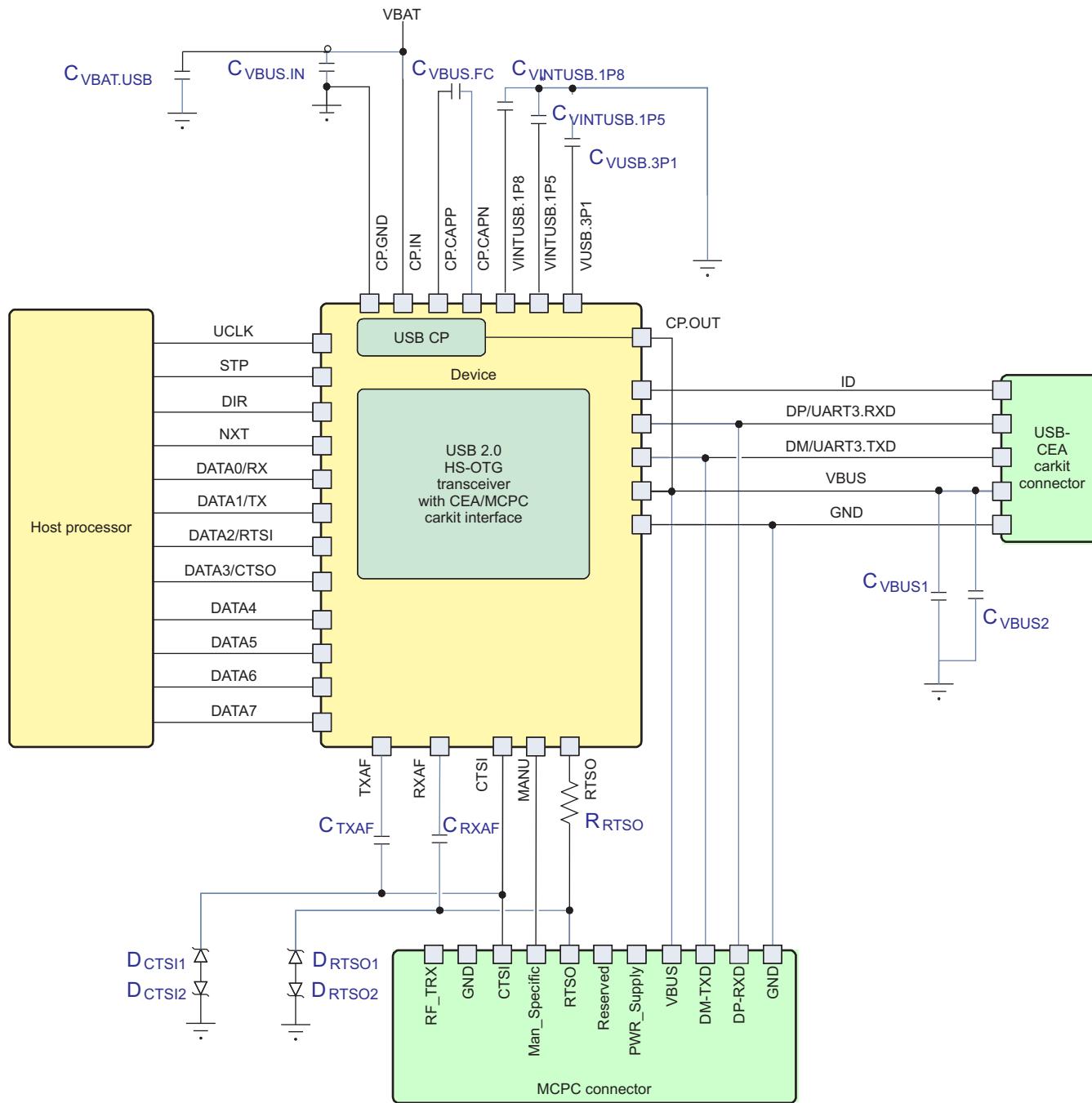
The features of the individual specifications are:

- *Universal Serial Bus 2.0 Specification* (hereafter referred to as the USB 2.0 specification):
  - 5-V-tolerant data line at HS/FS, FS-only, and LS-only transmission rates
  - 7-V-tolerant video bus (VBUS) line
  - Integrated data line serial termination resistors (factory-trimmed)
  - Integrated data line pullup and pulldown resistors
  - On-chip 480-MHz PLL from the internal system clock (19.2, 26, and 38.4 MHz)
  - Synchronization (SYNC)/end-of-period (EOP) generation and checking
  - Data and clock recovery from the USB stream
  - Bit-stuffing/unstuffing and error detection
  - Resume signaling, wakeup, and suspend detection
  - USB 2.0 test modes
- *On-The-Go Supplement to the USB 2.0 Specification* (hereafter referred to as the OTG supplement to the USB 2.0 specification):
  - 3-pin LS/FS serial mode (DAT\_SE0)
  - 4-pin LS/FS serial mode (VP\_VM)
- *CEA-2011: OTG Transceiver Interface Specification*:

- 3-pin LS/FS serial mode (DAT\_SE0)
- 4-pin LS/FS serial mode (VP\_VM)
- *CEA-936A: Mini-USB Analog Carkit Interface Specification* (hereafter referred to as the CEA-936A specification):
  - 5-pin CEA mini-USB analog carkit interface
  - UART signaling
  - Audio (mono/stereo) signaling
  - UART transactions during audio signaling
  - Basic and smart 4-wire/5-wire carkit, chargers, and accessories
  - ID CEA resistor comparators
- *MCPC ME-UART GL-006 Specification* (hereafter referred to as the MCPC ME-UART specification):
  - 11-pin MCPC Association of Radio Industries and Businesses (ARIB)-USBi (USB interface standard) analog carkit interface
  - UART signaling
- *UTMI+ Low Pin Interface Specification* (hereafter referred to as the ULPI specification):
  - 12-pin ULPI with 8-pin parallel data for USB signaling and register access
  - 60-MHz clock generation
  - Register mapping

## 7.2 USB Transceiver

[Figure 7-2](#) is an application schematic of the USB system.



032-049

**Figure 7-2. USB System Application Schematic**
**NOTE**

 For the component values, see [Table 15-1](#).

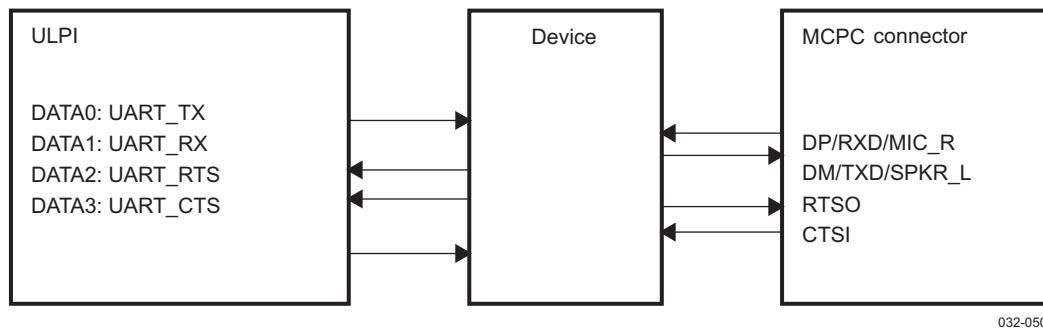
### 7.2.1 MCPC Carkit Port Timing

MCPC UART specification:

- 11-pin MCPC ARIB-USBI analog carkit interface
- Integrated 50 RRTSO resistor
- UART signaling (from 600 bps to 460.8 kbps)
- Audio (mono/stereo) signaling: In this mode, the ULPI data bus is redefined as a 4-pin UART interface, which exchanges data through a direct access to the FS/LS analog transmitter and receiver.

The UART data are sent and received on the USB D+/D– pads, and the handshake signals are sent and received on the RTSO/CTSI pads.

Figure 7-3 shows the MCPC UART and handshake mode data flow.



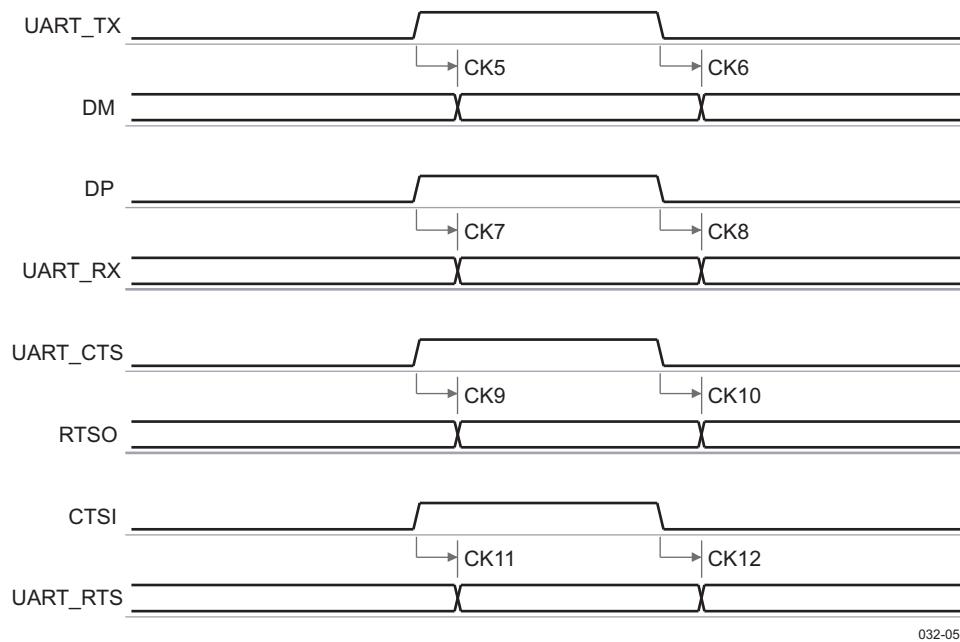
**Figure 7-3. MCPC UART and Handshake Mode Data Flow**

Table 7-1 lists the McPC UART and handshake mode timings.

**Table 7-1. MCPC UART and Handshake Mode Timings**

| Notation | Parameter              |  | Min | Max | Unit |
|----------|------------------------|--|-----|-----|------|
| CK5      | $t_d(UART\_TXH-DM)$    | Delay time, UART_TX rising edge to DM transition     | 10  | 37  | ns   |
| CK6      | $t_d(UART\_TXL-DM)$    | Delay time, UART_TX falling edge to DM transition    | 2.5 | 13  | ns   |
| CK7      | $t_d(DPH-UART_RX)$     | Delay time, DP rising edge to UART_RX transition     | 17  | 40  | ns   |
| CK8      | $t_d(DPL-UART_RX)$     | Delay time, DP falling edge to UART_RX transition    | 26  | 50  | ns   |
| CK9      | $t_d(UART\_CTSH-RTSO)$ | Delay time, UART_CTS rising edge to RTSO transition  | 1   | 18  | ns   |
| CK10     | $t_d(UART\_CTSL-RTSO)$ | Delay time, UART_CTS falling edge to RTSO transition | 1   | 18  | ns   |
| CK11     | $t_d(CTSIH-UART_RTS)$  | Delay time, CTSI rising edge to UART_RTS transition  | 3   | 16  | ns   |
| CK12     | $t_d(CTSIL-UART_RTS)$  | Delay time, CTSI falling edge to UART_RTS transition | 3   | 16  | ns   |

Figure 7-4 shows the MCPC UART and handshake mode timings.



**Figure 7-4. MCPC UART and Handshake Mode Timings**

### 7.2.2 USB-CEA Carkit Port Timing

CEA carkit mode lets the link communicate through the USB PHY to a remote carkit in CEA audio + data during audio (DDA) mode as defined in the CEA-936A specification. In this mode, the ULPI data bus is redefined as a 2-pin UART interface, which exchanges data through a direct access to the FS/LS analog transmitter and receiver.

UART data are sent and received on the USB D+/D– pads. D+/D– are also used in this mode to carry audio I/O signals.

Table 7-2 assumes testing over the recommended operating conditions (see the CEA-936A specification).

**Table 7-2. USB-CEA Carkit Interface Timing Parameters**

| Parameter           |  | Min | Max  | Unit |
|---------------------|--|-----|------|------|
| $t_{PH\_DP\_CON}$   | Phone D+ connect time                          | 100 |      | ms   |
| $t_{CR\_DP\_CON}$   | Carkit D+ connect time                         | 150 | 300  | ms   |
| $t_{PH\_DM\_CON}$   | Phone D– connect time                          |     | 10   | ms   |
| $t_{PH\_CMD\_DLY}$  | Phone command delay                            | 2   |      | ms   |
| $t_{PH\_MONO\_ACK}$ | Phone mono acknowledge                         |     | 10   | ms   |
| $t_{PH\_DISC\_DET}$ | Phone D+ disconnect time                       | 150 |      | ms   |
| $t_{CR\_DISC\_DET}$ | Carkit D– disconnect detect                    | 50  | 150  | ms   |
| $t_{PH\_AUD\_BIAS}$ | Phone audio bias                               | 1   |      | ms   |
| $t_{CR\_AUD\_DET}$  | Carkit audio detect                            | 400 | 800  | μs   |
| $t_{CR\_UART\_DET}$ | Carkit UART detect (DDA enabled)               | 700 | 1200 | ns   |
| $t_{PH\_STLO\_DET}$ | Phone stereo D+ low detect                     | 30  | 100  | ms   |
| $t_{PH\_PLS\_POS}$  | Phone D– interrupt pulse width                 | 200 | 600  | ns   |
| $t_{CR\_PLS\_NEG}$  | Carkit D+ interrupt pulse width                | 200 | 600  | ns   |
| $t_{DAT\_AUD\_POL}$ | DDA polarity                                   | 20  | 60   | ms   |
| $t_{ACC\_COL\_DET}$ | Accessory identification (ID) collision detect | 2   | 3    | ms   |

**Table 7-2. USB-CEA Carkit Interface Timing Parameters (continued)**

| Parameter            |  | Min | Max  | Unit |
|----------------------|--|-----|------|------|
| $t_{ACC\_INT\_PW}$   | Accessory ID interrupt pulse width         | 200 | 400  | μs   |
| $t_{ACC\_INT\_WAIT}$ | Accessory ID interrupt wait time           | 10  | 15   | ms   |
| $t_{ACC\_CMD\_WAIT}$ | Accessory ID command wait time             | 0   |      | ms   |
| $t_{PH\_INT\_PW}$    | Phone ID interrupt pulse width             | 4   | 8    | ms   |
| $t_{PH\_INT\_WAIT}$  | Phone ID interrupt wait time               | 4   | 8    | ms   |
| $t_{PH\_CMD\_WAIT}$  | Phone ID command wait time                 | 0   |      | ms   |
| $t_{PH\_UART\_RPT}$  | Phone command repeat time                  | 50  |      | ms   |
| $t_{CR\_UART\_RSP}$  | Carkit UART response                       |     | 30   | ms   |
| $t_{CR\_INT\_RPT}$   | Carkit interrupt repeat time               | 50  |      | ms   |
| $f_{UART\_DFLT}$     | Default UART signaling rate (typical rate) |     | 9600 | bps  |

Figure 7-5 shows the USB-CEA carkit UART data flow.

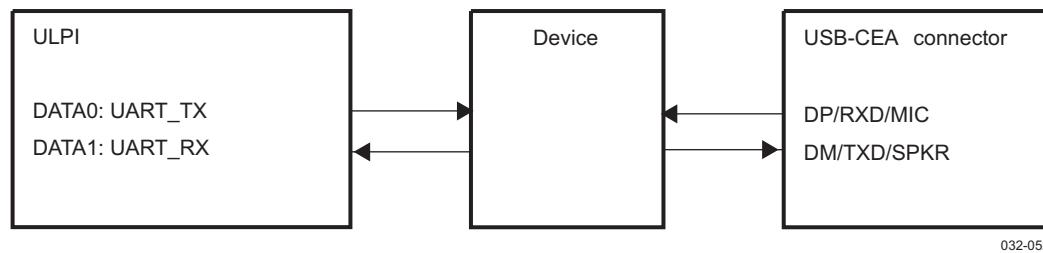
**Figure 7-5. USB-CEA Carkit UART Data Flow**

Table 7-3 lists the USB-CEA carkit UART timing parameters.

**Table 7-3. USB-CEA Carkit UART Timing Parameters**

| Notation | Parameter           |   |             | Min | Max | Unit |
|----------|---------------------|---|-------------|-----|-----|------|
| CK1      | $t_d(UART\_TXH-DM)$ | Delay time, UART_TX rising edge to DM transition  |             | 4.0 | 11  | ns   |
| CK2      | $t_d(UART\_TXL-DM)$ | Delay time, UART_TX falling edge to DM transition |             | 4.0 | 11  | ns   |
| CK3      | $t_d(DPH-UART\_RX)$ | Delay time, DP rising edge to UART_RX transition  | At 38.4 MHz | 205 | 234 | ns   |
|          |                     |   | At 19.2 MHz | 310 | 364 |      |
| CK4      | $t_d(DPL-UART\_RX)$ | Delay time, DP falling edge to UART_RX transition | At 38.4 MHz | 205 | 234 | ns   |
|          |                     |   | At 19.2 MHz | 310 | 364 |      |

Figure 7-6 shows the USB-CEA carkit UART timings.

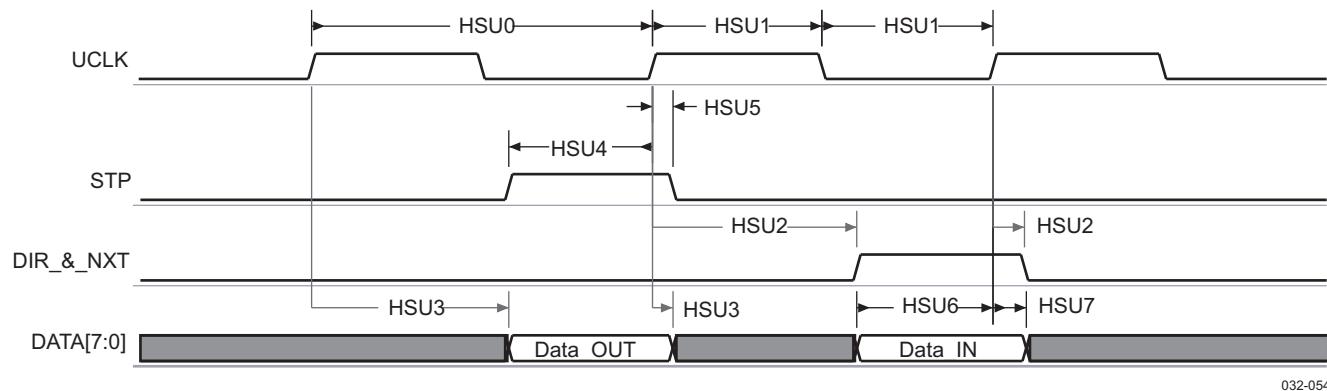
**Figure 7-6. USB-CEA Carkit UART Timing Parameters**

### 7.2.3 HS USB Port Timing

The ULPI interface supports an 8-bit data bus and the internal clock mode. The 4-bit data bus and the external clock mode are not supported.

The HS functional mode supports an operating rate of 480 Mbps.

Table 7-4 and Table 7-5 assume testing over the recommended operating conditions (see Figure 7-7).



032-054

**Figure 7-7. HS USB Interface—Transmit and Receive Modes (ULPI 8-Bit)**

#### NOTE

ULPI data [7:0] lines are set to 1 after USB PHY power up, and before the clock signal is stable.

The input timing requirements are given by considering a rising or falling time of 1 ns.

**Table 7-4. HS USB Interface Timing Requirement Parameters**

| Notation | Parameter         |   |  | Min | Max | Unit |
|----------|-------------------|---|--|-----|-----|------|
| HSU4     | $t_s(STPV-CLKH)$  | Setup time, STP valid before UCLK rising edge       |  | 6   |     | ns   |
| HSU5     | $t_h(CLKH-STPIV)$ | Hold time, STP valid after UCLK rising edge         |  | 0   |     | ns   |
| HSU6     | $t_s(DATAV-CLKH)$ | Setup time, DATA[0:7] valid before UCLK rising edge |  | 6   |     | ns   |
| HSU7     | $t_h(CLKH-DATIV)$ | Hold time, DATA[0:7] valid after UCLK rising edge   |  | 0   |     | ns   |

**Table 7-5. HS USB Interface Switching Requirement Parameters<sup>(1)</sup>**

| Notation | Parameter        |  |              | Min   | Typ | Max   | Unit |
|----------|------------------|--|--------------|-------|-----|-------|------|
| HSU0     | $f_p(CLK)$       | UCLK clock frequency                                 | Steady state | 58.42 | 60  | 61.67 | MHz  |
| HSU1     | $t_w(CLK)$       | UCLK duty cycle                                      | Steady state | 48.3% | 50% | 51.7% |      |
| HSU2     | $t_d(CLKH-DIR)$  | Delay time, UCLK rising edge to DIR transition       | Steady state | 0     |     | 9     | ns   |
|          | $t_d(CLKH-NXTV)$ | Delay time, UCLK rising edge to NXT transition       | Steady state | 0     |     | 9     | ns   |
| HSU3     | $t_d(CLKH-DATV)$ | Delay time, UCLK rising edge to DATA[0:7] transition | Steady state | 0     |     | 9     | ns   |

- (1) The capacitive load for output data and control load is 10 pF (rising and falling time is 2 ns).  
The capacitive load for the CLK port is 6 pF (rising and falling time is 1 ns).  
The HS USB interface has only one state: steady state.

### 7.2.4 PHY Electrical Characteristics

The PHY is the physical signaling layer of the USB 2.0. It contains the drivers and receivers required for physical data and protocol signaling on the DP and DM lines.

The PHY interfaces to the USB controller through UTMI.

There are two main classes of transmitters and receivers in the PHY:

- FS and LS transceivers. These are the legacy USB1.x transceivers.
- HS transceivers

To bias the transistors and run the logic, the PHY also contains reference generation circuitry which consists of:

- A digital phase-locked loop (DPLL) that does a frequency multiplication to achieve the 480-MHz low-jitter lock necessary for USB, and the clock required for the switched capacitor resistance block
- A switched capacitor resistance block that replicates an external resistor on chip

Built-in pullup and pulldown resistors are used as part of the protocol signaling.

The PHY also contains circuitry that protects it from an accidental 5-V short on the DP and DM lines and from 8-kV IEC ESD strikes.

#### 7.2.4.1 5-V Tolerance

When the voltage on DP or DM exceeds 3.6 V, a stress condition is detected. In this case, the current is drawn from the DP/DM line, to prevent damage caused by the stress voltage. In this condition, the VRUSB\_3V supply can be charged as high as 3.6 V. [Table 7-6](#) lists the tolerances.

**Table 7-6. 5V-Tolerant Electrical Summary**

| Parameter                                  |             | Comments   | Min | Typ | Max | Unit |
|--|-------------|--|-----|-----|-----|------|
| Continuous short-circuit stress            | DCSTRESS    | 50% TX/50% RX/50% LS/50% FS/VBUS = 5.25 V  | 24  |     |     | h    |
| Worst case overshoot and undershoot stress | ACSTRESS    | $t_{HI} = 60 \text{ ns}/t_{LO} = 100 \text{ ns}/t_R = t_F = 4 \text{ ns}$ /<br>$V_{HI} = 4.6 \text{ V}/V_{LO} = -1.0 \text{ V}/R_{SRC} = 39\Omega/$<br>50% TX/50% RX/VBUS = 5.25 V | 24  |     |     | h    |
| Internal DP/DM stress voltage              | VDX_STRESS  | Force 5.25 V VBUS/DP/DM  |     |     | 4.3 | V    |
| V3P1 stress voltage                        | V3P1_STRESS | Force 5.25 V VBUS/DP/DM/ID   |     |     | 3.6 | V    |
| DP/DM input stress current                 | IDX_STRESS  | Force 5.25 V VBUS/DP/DM  | 30  |     |     | mA   |
| ID input stress current                    | IID_STRESS  | Force 5.25 V VBUS/DP/DM/ID   |     |     | 25  | µA   |

#### 7.2.4.2 LS/FS Single-Ended Receivers

In addition to the differential receiver, there is a single-ended receiver (SE-, SE+) for each of the two data lines D+/- . The main purpose of the single-ended receivers is to qualify the D+ and D- signals in the FS/LS modes of operation. [Table 7-7](#) lists the parameters of the LS/FS single-ended receivers.

**Table 7-7. LS/FS Single-Ended Receivers**

| Parameter                         |                 | Comments                | Min | Typ | Max | Unit |
|-----------------------------------|-----------------|-------------------------|-----|-----|-----|------|
| <b>USB Single-Ended Receivers</b> |                 |                         |     |     |     |      |
| Skew between VP and VM            | SKWVP_VM        | Driver outputs unloaded | -2  | 0   | 2   | ns   |
| Single-ended hysteresis           | VSE_HYS         |                         |     | 0   |     | mV   |
| High (driven)                     | V <sub>IH</sub> |                         | 2   |     |     | V    |
| Low                               | V <sub>IL</sub> |                         |     |     | 0.8 | V    |
| Switching threshold               | V <sub>TH</sub> |                         | 0.8 |     | 2   | V    |

**Table 7-7. LS/FS Single-Ended Receivers (continued)**

| Parameter                             | Comments            |   | Min        | Typ  | Max  | Unit |
|---------------------------------------|---------------------|---|------------|------|------|------|
| <b>UART Receiver CEA</b>              |                     |   |            |      |      |      |
|                                       | VIH_SER             | DP_PULLDOWN asserted  | 2          |      |      | V    |
| Serial interface input low            | VIL_SER             | DP_PULLDOWN asserted  |            |      | 0.8  | V    |
| Switching threshold                   | V <sub>TH</sub>     |   | 0.8        |      | 2    | V    |
| <b>UART Receiver MCPC From DP.RXD</b> |                     |   |            |      |      |      |
| MCPC DP pullup                        | RMCPCDP             | Internal pullup   | 4.7k       |      | 10k  | Ω    |
| Open-drain input high level           | Z <sub>IH</sub>     | Internal MCPC DP pullup asserted  |            | Open |      | Ω    |
| Open-drain input low level            | Z <sub>IL</sub>     | External open-drain NMOS impedance to ground.<br>With internal MCPC DP pullup asserted. |            |      | 100  | Ω    |
| Output high level                     | V <sub>OH</sub> (*) | At DATA1 pin  | VIO – 0.45 |      |      | V    |
| Output low level                      | V <sub>OL</sub>     | At DATA1 pin  |            |      | 0.45 | V    |

#### 7.2.4.3 LS/FS Differential Receiver

A differential input receiver (RX) retrieves the LS/FS differential data signaling. The differential voltage on the line is converted to digital data by a differential comparator on DP/DM. This data is then sent to a clock and data recovery circuit that recovers the clock from the data. In an additional serial mode, the differential data is directly output on the RXRCV pin. [Table 7-8](#) lists the parameters of the LS/FS differential receiver.

**Table 7-8. LS/FS Differential Receiver**

| Parameter                      | Comments        |                         | Min | Typ | Max | Unit |
|--------------------------------|-----------------|-------------------------|-----|-----|-----|------|
| Skew between VP/VM             | SKWVP_VM        | Driver outputs unloaded | -16 | 0   | 16  | ns   |
| Receiver power-up time         | TPWR_UP_RCV     |                         | 0   | 100 | 200 | μs   |
| Differential common mode range | V <sub>CM</sub> |                         | 0.8 |     | 2.5 | V    |
| Differential input sensitivity | V <sub>DI</sub> |                         | 0.2 |     |     | V    |

#### 7.2.4.4 LS/FS Differential Transmitter

The USB transceiver (TX) uses a differential output driver to drive the USB data signal D+/- onto the USB cable. The driver outputs support 3-state operation to achieve bidirectional half-duplex transactions. [Table 7-9](#) lists the parameters of the LS/FS differential transmitter.

**Table 7-9. LS/FS Differential Transmitter**

| Parameter   | Comments                          |   | Min | Typ | Max  | Unit |
|---|-----------------------------------|---|-----|-----|------|------|
| B-device (dual-role) unconfigured average current   | IB_OTG_UNCFG                      | 0 V = VBUS = 5.25 V, t <sub>Avg</sub> = 1 ms  |     |     | 150  | μA   |
| B-device (secure remote password [SRP] capable, peripheral only) unconfigured average current |                                   |   |     |     | 8    | mA   |
| FS fall time/rise time  | t <sub>Ff</sub> , t <sub>Fr</sub> | 10%–90%<br>C <sub>L</sub> = 50 pF on DP and DM  | 4   |     | 20   | ns   |
| FS rise and fall time matching  | TFRFM                             | 10%–90%<br>C <sub>L</sub> = 50 pF on DP and DM  | 90% |     | 110% |      |
| FS width of SE0 interval during differential transition                                       | t <sub>Fst</sub>                  | Pulldowns R = 15 kΩ on DP and DM<br>Pullup R = 1.5 kΩ at 3.6 V on DP only                       |     |     | 14   | ns   |
| LS fall time/rise time  | t <sub>Lf</sub> , t <sub>LR</sub> | 10%–90%<br>C <sub>L</sub> = [200–600] pF on DP and DM<br>Pullup R = 1.5 kΩ at 3.6 V for DM only | 75  |     | 300  | ns   |
| LS rise and fall time matching  | TLRFM                             | 10%–90%<br>C <sub>L</sub> = [200–600] pF on DP and DM<br>Pullup R = 1.5 kΩ at 3.6 V for DM only | 80% |     | 120% |      |

**Table 7-9. LS/FS Differential Transmitter (continued)**

| Parameter  |               | Comments  | Min | Typ | Max | Unit |
|--|---------------|---|-----|-----|-----|------|
| LS width of SE0 interval during differential transition        | $t_{LST}$     | Pulldowns R = 15 kΩ on DP and DM<br>Pullup R = 1.5 kΩ at 3.6 V on DM only                   |     |     | 210 | ns   |
| Driver power-up time   | TPWR_UP_TXD   | Pulldowns R = 15 kΩ on DP and DM<br>Pullup R = 1.5 kΩ at 3.6 V on DM only                   | 0   | 100 | 200 | μs   |
| FS source driver jitter to next transition                     | $t_{SDJ1}$    | $C_L = 50 \text{ pF}$ on DP and DM  | -2  |     | 2   | ns   |
| FS source driver jitter for paired transitions                 | $t_{SDJ2}$    | $C_L = 50 \text{ pF}$ on DP and DM  | -1  |     | 1   | ns   |
| LS upstream facing port source driver jitter (next transition) | $t_{USDJ1}$   | $C_L = [200\text{--}600] \text{ pF}$ on DP and DM<br>Pullup R = 1.5 kΩ at 3.6 V for DM only | -25 |     | 25  | ns   |
| LS upstream facing port source driver jitter (next transition) | $t_{USDJ2}$   | $C_L = [200\text{--}600] \text{ pF}$ on DP and DM<br>Pullup R = 1.5 kΩ at 3.6 V for DM only | -10 |     | 10  | ns   |
| Output signal cross-over voltage                               | $V_{CRS}$     | Pulldowns R = 15 kΩ on DP and DM<br>Pullup R = 1.5 kΩ at 3.6 V on DM only                   | 1.3 |     | 2   | V    |
| High (driven)  | $V_{OH}$      | Pulldowns R = 15 kΩ on DP and DM  | 2.8 | 3.3 | 3.6 | V    |
| Low  | $V_{OL}$      | Pullups R = 1.5 kΩ at 3.6 V on DP and DM  | 0   | 0.1 | 0.3 | V    |
| Driver output resistance                                       | $Z_{DRV}/R_S$ |   | 28  | 36  | 44  | Ω    |

#### 7.2.4.5 HS Differential Receiver

The HS receiver consists of the following blocks:

- A differential input comparator to receive the serial data
- A squelch detector to qualify the received data
- An oversampler-based clock data recovery scheme followed by a nonreturn to zero inverted (NRZI) decoder, bit unstuffing, and a serial-to-parallel converter to generate the UTMI DATAOUT

Table 7-10 lists the parameters of the HS differential receiver.

**Table 7-10. HS Differential Receiver**

| Parameter  |               | Comments                        | Min  | Typ | Max | Unit |
|--|---------------|---------------------------------|------|-----|-----|------|
| <b>Input Levels for HS</b>   |               |                                 |      |     |     |      |
| HS squelch detection threshold   | $V_{HSSQ}$    | (Differential signal amplitude) | 100  | 125 | 150 | mV   |
| HS disconnect detection threshold  | $V_{HSDSC}$   | (Differential signal amplitude) | 525  | 600 | 625 | mV   |
| HS data signaling common mode voltage range  | $V_{HSCM}$    |                                 | -50  | 200 | 500 | mV   |
| HS differential input sensitivity  | $V_{DIHS}$    | (Differential signal amplitude) | -100 |     | 100 | mV   |
| <b>Input Impedance for HS</b>  |               |                                 |      |     |     |      |
| Internal specification for input capacitance                                       | $C_{HSLOAD}$  |                                 |      | 11  |     | pF   |
| Internal $C_{HSLOAD}$ DP/DM matching   | $C_{HSLOADM}$ |                                 |      | 0.2 |     | pF   |
| <b>External Components With the Total Budget Combined (Without USB Cable Load)</b> |               |                                 |      |     |     |      |
| External capacitance on DP or DM   |               |                                 |      |     | 2   | pF   |
| External series resistance on DP or DM   |               |                                 |      |     | 1   | Ω    |

#### 7.2.4.6 HS Differential Transmitter

The HS transmitter is always operated on the UTMI parallel interface. The parallel data on the interface is serialized, bit-stuffed, NRZI-encoded, and transmitted as a dc output current on DP or DM, depending on the data. Each line has an effective  $22.5\text{-}\Omega$  load to ground, which generates the voltage levels for signaling.

A disconnect detector is also part of the HS transmitter. A disconnect on the far end of the cable causes the impedance seen by the transmitter to double, thereby doubling the differential amplitude seen on the DP/DM lines.

**Table 7-11** lists the parameters of the HS differential transmitter.

**Table 7-11. HS Differential Transmitter**

| Parameter                     | Comments      |   | Min  | Typ  | Max  | Unit     |
|-------------------------------|---------------|---|------|------|------|----------|
| <b>Output Levels for HS</b>   |               |   |      |      |      |          |
| HS TX idle level              | $V_{HSOI}$    | Absolute voltage DP/DM – Both internal/external 45 $\Omega$ | -10  | 0    | 10   | mV       |
| HS TX data signaling high     | $V_{HSOH}$    | Absolute voltage DP/DM – Both internal/external 45 $\Omega$ | 360  | 400  | 440  | mV       |
| HS data signaling low         | $V_{HSOL}$    |   | -10  | 0    | 10   | mV       |
| Chirp J level                 | $V_{CHIRPJ}$  | Differential voltage  | 700  | 800  | 1100 | mV       |
| Chirp K level                 | $V_{CHIRPK}$  | Differential voltage  | -900 | -800 | -500 | mV       |
| HS TX disconnect threshold    | $V_{DISCOUT}$ | Absolute voltage DP/DM—No external 45 $\Omega$              | 700  |      |      | mV       |
| <b>Driver Characteristics</b> |               |   |      |      |      |          |
| Rise time                     | $t_{HSR}$     | (10%–90%)   | 500  |      |      | ps       |
| Fall time                     | $t_{HSF}$     | (10%–90%)   | 500  |      |      | ps       |
| Driver output resistance      | $Z_{HSDRV}$   | Also serves as HS termination                               | 40.5 | 45   | 49.5 | $\Omega$ |

#### 7.2.4.7 CEA/MCPC/UART Driver

**Table 7-12** lists the parameters of the CEA/MCPC/UART driver.

**Table 7-12. CEA/MCPC/UART Driver**

| Parameter                         | Comments             |   | Min        | Typ | Max  | Unit     |
|-----------------------------------|----------------------|---|------------|-----|------|----------|
| <b>UART Driver CEA</b>            |                      |   |            |     |      |          |
| Phone UART edge rates             | $t_{PH\_UART\_EDGE}$ | DP_PULLDOWN asserted  |            |     | 1    | $\mu s$  |
| Serial interface output high      | $V_{OH\_SER}$        | ISOURCE = 4 mA  | 2.4        | 3.3 | 3.6  | V        |
| Serial interface output low       | $V_{OL\_SER}$        | ISINK = -4 mA   | 0          | 0.1 | 0.4  | V        |
| <b>UART Driver MCPC to DM.TX.</b> |                      |   |            |     |      |          |
| Input high level                  | $V_{IH} (*)$         | At DATA0 pin  | VIO – 0.45 |     |      | V        |
| Input low level                   | $V_{IL}$             | At DATA0 pin  |            |     | 0.45 | V        |
| MCPC DM external pullup           | $R_{MCPCDM}$         | External pullup   | 4.7k       |     | 10k  | $\Omega$ |
| MCPC DM pullup supply             | MCPCVDDEXT           | External pullup supply  | 1.8        |     | 3.3  | V        |
| Open-drain output high level      | $Z_{OH}$             | External pullup asserted  |            | HiZ |      | $\Omega$ |
|                                   |                      | HiZ means high impedance equivalent to open                           |            |     |      |          |
| Open-drain output low level       | $V_{OL}$             | With open-drain NMOS to ground is ON and external pullup is asserted. | 0          |     | 0.6  | V        |
| <b>Carkit Pulse Driver</b>        |                      |   |            |     |      |          |
| Pulse match tolerance             | QPLS_MTCH            | $ZCR\_SPKR\_IN = 60 \text{ k}\Omega$ at $f = 1 \text{ kHz}$           |            |     | 5%   |          |
| Phone D– interrupt pulse width    | $t_{PH\_PLS\_POS}$   | $ZCR\_SPKR\_IN = 60 \text{ k}\Omega$ at $f = 1 \text{ kHz}$           | 200        |     | 600  | ns       |
| Phone positive pulse voltage      | $V_{PH\_PLS\_POS}$   | $ZCR\_SPKR\_IN = 60 \text{ k}\Omega$ at $f = 1 \text{ kHz}$           | 2.8        |     | 3.6  | V        |

### 7.2.4.8 Pullup/Pulldown Resistors

Table 7-13 lists the parameters of the pullup/pulldown resistors.

**Table 7-13. Pullup/Pulldown Resistors**

| Parameter   | Comments                  |   | Min   | Typ | Max   | Unit |
|---|---------------------------|---|-------|-----|-------|------|
| <b>Pullup Resistors</b>                                     |                           |   |       |     |       |      |
| Bus pullup resistor on upstream port (idle bus)             | R <sub>PUI</sub>          | Bus idle  | 0.9   | 1.1 | 1.575 | kΩ   |
| Bus pullup resistor on upstream port (receiving)            | R <sub>PUA</sub>          | Bus driven/driver outputs unloaded                                | 1.425 | 2.2 | 3.09  |      |
| High (floating)   | V <sub>IHZ</sub>          | Pullups/pulldowns on DP and DM lines                              | 2.7   |     | 3.6   | V    |
| Phone D+ pullup voltage                                     | V <sub>PH_DP_UP</sub>     | Driver outputs unloaded   | 3     | 3.3 | 3.6   | V    |
| <b>Pulldown Resistors</b>                                   |                           |   |       |     |       |      |
| Phone D+/- pulldown   | R <sub>PH_DP_DWN</sub>    | Driver outputs unloaded   | 14.25 | 18  | 24.8  | kΩ   |
|   | R <sub>PH_DM_DWN</sub>    |   |       |     |       |      |
| High (floating)   | V <sub>IHZ</sub>          | Pullups/pulldowns on DP and DM lines                              | 2.7   |     | 3.6   | V    |
| <b>D+/- Data Line</b>                                       |                           |   |       |     |       |      |
| Upstream facing port  | C <sub>INUB</sub>         |   |       | 22  | 75    | pF   |
| OTG device leakage  | V <sub>OTG_DATA_LKG</sub> |   |       |     | 0.342 | V    |
| Input impedance exclusive of pullup/pulldown <sup>(1)</sup> | Z <sub>INP</sub>          | Driver outputs unloaded (waiver from usb.org standards committee) | 80    | 120 |       | kΩ   |

(1) Waiver received from usb.org standards committee on ZINP 300kmin specification

### 7.2.4.9 PHY DPLL Electrical Characteristics

USB DPLL supports input frequencies of 12, 13, 19.2, 24, and 26 MHz. The input frequency must be programmed through frequency select bits. USB DPLL provides a low jitter and gives eight equidistant phases of the 480-MHz clock for the USB receiver.

Table 7-14 lists the electrical characteristics of the PHY DPLL.

**Table 7-14. PHY DPLL Electrical Characteristics**

| Parameter   | Comments                       | Min  | Typ  | Max  | Unit |
|---|--------------------------------|------|------|------|------|
| Input clock                                       |                                |      | 12   |      | MHz  |
|   |                                |      | 13   |      |      |
|   |                                |      | 19.2 |      |      |
|   |                                |      | 24   |      |      |
|   |                                |      | 26   |      |      |
| Digital supply                                    | V <sub>INTDIG</sub>            | 1.35 | 1.5  | 1.65 | V    |
| Analog 1.5-V supply                               | V <sub>RUSB_1V5</sub>          | 1.35 | 1.5  | 1.65 | V    |
| Analog 1.8-V supply                               | V <sub>RUSB_1V8</sub>          | 1.62 | 1.8  | 1.98 | V    |
| Output frequency (eight phases)                   |                                |      | 480  |      | MHz  |
| RMS period jitter (output)                        |                                |      |      | 10   | ps   |
| Deterministic period jitter (output)              |                                |      |      | 50   | ps   |
| RMS jitter per phase noise frequency band (input) | Frequency band: 1 to 10 Hz     |      |      | 310  | ps   |
|   | Frequency band: 10 to 100 Hz   |      |      | 90   |      |
|   | Frequency band: 100 to 1000 Hz |      |      | 30   |      |
|   | Frequency band: 1 to 10 kHz    |      |      | 10   |      |
|   | Frequency band: 10 to 100 kHz  |      |      | 10   |      |
|   | Frequency band: 0.1 to 0.5 MHz |      |      | 290  |      |
|   | Frequency band: 0.5 to 1 MHz   |      |      | 650  |      |

**Table 7-14. PHY DPLL Electrical Characteristics (continued)**

| Parameter                           | Comments | Min | Typ | Max  | Unit |
|-------------------------------------|----------|-----|-----|------|------|
| Deterministic period jitter (input) |          |     |     | 100  | ps   |
| Frequency error (input)             |          |     |     | ±150 | ppm  |
| Frequency error (output)            |          |     |     | ±500 | ppm  |
| Phase-to-phase variation            |          |     |     | 35   | ps   |
| Noise on digital 1.5-V supply       |          |     |     | 100  | mV   |
| Noise on analog 1.5-V supply        |          |     |     | 50   | mV   |
| Noise on analog 1.8-V supply        |          |     |     | 36   | mV   |

#### 7.2.4.10 PHY Power Consumption

Table 7-15 lists, by mode, the power consumption values of the modules.

**Table 7-15. PHY Power Consumption**

| Supply                        | Min | Typ  | Max | Unit |
|-------------------------------|-----|------|-----|------|
| <b>HS Mode</b>                |     |      |     |      |
| VUSB.3P1                      |     | 8.5  |     | mA   |
| VINTUSB1P8.OUT                |     | 25   |     | mA   |
| VINTUSB1P5.OUT                |     | 24   |     | mA   |
| VINTDIG.OUT                   |     | 0.3  |     | mA   |
| <b>FS Mode</b>                |     |      |     |      |
| VUSB.3P1                      |     | 13   |     | mA   |
| VINTUSB1P8.OUT                |     | 5.4  |     | mA   |
| VINTUSB1P5.OUT                |     | 17.5 |     | mA   |
| VINTDIG.OUT                   |     | 0.3  |     | mA   |
| <b>LS Mode</b>                |     |      |     |      |
| VUSB.3P1                      |     | 12.5 |     | mA   |
| VINTUSB1P8.OUT                |     | 5.4  |     | mA   |
| VINTUSB1P5.OUT                |     | 17.5 |     | mA   |
| VINTDIG.OUT                   |     | 0.3  |     | mA   |
| <b>Low-Power/Suspend Mode</b> |     |      |     |      |
| VUSB.3P1                      |     | 0    |     | mA   |
| VINTUSB1P8.OUT                |     | 0    |     | mA   |
| VINTUSB1P5.OUT                |     | 2    |     | µA   |
| VINTDIG.OUT                   |     | 0    |     | mA   |
| <b>Power-Down Mode</b>        |     |      |     |      |
| VUSB.3P1                      |     | 0    |     | mA   |
| VINTUSB1P8.OUT                |     | 0    |     | mA   |
| VINTUSB1P5.OUT                |     | 2    |     | µA   |
| VINTDIG.OUT                   |     | 0    |     | mA   |

#### 7.2.5 OTG Electrical Characteristics

The OTG block integrates three main functions:

- USB plug detection function on VBUS and ID
- ID resistor detection
- VBUS level detection

### 7.2.5.1 OTG VBUS Electrical

[Table 7-16](#) lists the OTG VBUS electrical parameters.

**Table 7-16. OTG VBUS Electrical**

| Parameter  | Comments                     | Min  | Typ   | Max | Unit |    |
|--|------------------------------|--|-------|-----|------|----|
| <b>VBUS Wake-Up Comparator</b>   |                              |  |       |     |      |    |
| VBUS wake-up delay   | DEL_VBUS_WK_UP               |  |       | 15  | μs   |    |
| VBUS wake-up threshold   | V_VBUS_WK_UP                 | 0.5  | 0.6   | 0.7 | V    |    |
| <b>VBUS Comparators</b>  |                              |  |       |     |      |    |
| A-device session valid   | V_A_SESS_VLD                 | 0.8  | 1.1   | 1.4 | V    |    |
| A-device V <sub>BUS</sub> valid  | V_A_VBUS_VLD                 | 4.4  | 4.5   | 4.6 | V    |    |
| B-device session end   | V_B_SESS_END                 | 0.2  | 0.5   | 0.8 | V    |    |
| B-device session valid   | V_B_SESS_VLD                 | 2.1  | 2.4   | 2.7 | V    |    |
| <b>VBUS Line</b>   |                              |  |       |     |      |    |
| A-device V <sub>BUS</sub> input impedance to ground                          | R <sub>A_BUS_IN</sub>        | SRP (V <sub>BUS</sub> pulsing) capable A-device not driving V <sub>BUS</sub> |       | 100 | kΩ   |    |
| B-device V <sub>BUS</sub> SRP pulldown                                       | R <sub>B_SRP_DWN</sub>       | 5.25 V/8 mA, pullup voltage = 3 V  | 0.656 | 10  | kΩ   |    |
| B-device V <sub>BUS</sub> SRP pullup   | R <sub>B_SRP_UP</sub>        | (5.25 V – 3 V)/8 mA, pullup voltage = 3 V                                    | 0.281 | 1   | 2    | kΩ |
| B-device V <sub>BUS</sub> SRP rise time maximum for OTG-A communication      | t <sub>Rise_SRP_UP_Max</sub> | 0 to 2.1 V with < 13 μF load   |       | 36  | ms   |    |
| B-device V <sub>BUS</sub> SRP rise time minimum for standard host connection | t <sub>Rise_SRP_UP_Min</sub> | 0.8 to 2.0 V with > 97 μF load   | 60    |     | ms   |    |
| VBUS line maximum voltage  |                              | If VBUS_CHRG bit is low*   |       | 7   | V    |    |

### 7.2.5.2 OTG ID Electrical

[Table 7-17](#) lists the OTG ID electrical parameters.

**Table 7-17. OTG ID Electrical**

| Parameter   | Comments              | Min  | Typ  | Max  | Unit |    |
|---|-----------------------|--|------|------|------|----|
| <b>ID Wake-Up Comparator</b>                              |                       |  |      |      |      |    |
| ID wake-up comparator                                     | R <sub>ID_WK_UP</sub> | Wake up when ID shorted to ground through a resistor lower than 445 kΩ (±1%)       | 445  |      | kΩ   |    |
| <b>ID Comparators—ID External Resistor Specifications</b> |                       |  |      |      |      |    |
| ID ground comparator                                      | R <sub>ID_GND</sub>   | ID_GND interrupt when ID shorted to ground through a resistor lower than 10 Ω      | 0    | 5    | 10   | Ω  |
| ID 100k comparators                                       | R <sub>ID_100K</sub>  | ID_100K interrupt when 102 kΩ (1%) resistor plugged in                             | 101  | 102  | 103  | kΩ |
| ID 200k comparators                                       | R <sub>ID_200K</sub>  | ID_200K interrupt when 200 kΩ (1%) resistor plugged in                             | 198  | 200  | 202  | kΩ |
| ID 440k comparators                                       | R <sub>ID_440K</sub>  | ID_440K interrupt when 440 kΩ (1%) resistor plugged in                             | 435  | 440  | 445  | kΩ |
| ID float comparator                                       | R <sub>ID_FLOAT</sub> | ID_FLOAT interrupt when ID shorted to ground through a resistor higher than 560 kΩ | 1400 |      | kΩ   |    |
| <b>ID Line</b>  |                       |  |      |      |      |    |
| Phone I <sub>D</sub> pullup to V <sub>PH_ID_UP</sub>      | R <sub>PH_ID_UP</sub> | ID unloaded (VRUSB)  | 70   | 200  | 286  | kΩ |
| Phone I <sub>D</sub> pullup voltage                       | V <sub>PH_ID_UP</sub> | Connected to VRUSB   | 2.5  |      | 3.2  | V  |
| ID line maximum voltage                                   |                       |  |      | 5.25 | V    |    |



## 8 Battery Interface

### 8.1 General Description

#### 8.1.1 *Battery Charger Interface Overview*

The TPS65950 has a BCI for complete battery management. The main function of the BCI is to control the charging of either 1-cell Li-ion or Li-ion polymer batteries, or 1-cell Li-ion batteries with cobalt-nickel-manganese anodes. It supports regulated ac chargers of 7-V absolute maximum and can charge with USB host devices, MCPC devices, USB chargers, or carkits of 7-V absolute maximum. The BCI can perform software-controlled linear charging with the sources mentioned, software-controlled pulsed charging with current-limited ac chargers, and automatic linear charging with ac chargers, USB chargers, and carkits.

The battery is monitored using the 10-bit ADC from the MADC to measure battery voltage, battery temperature, battery type, battery charge current, USB device input voltage, and ac charger input voltage. The magnitude of the charging current and the charging voltage is set by 10 bits of a programming register converted by a 10-bit DAC, whose output sets the reference input of the charging current and charging voltage control loop.

The BCI also performs monitoring functions:

- ac charger detection
- VBUS detection
- Battery detection
- ac charger overvoltage detection
- VBUS overvoltage detection
- Battery overvoltage detection
- Battery voltage level detection
- Battery charge current level detection
- Battery temperature out-of-range detection
- Battery end-of-charge detection
- Battery overcurrent detection
- Watchdog

#### 8.1.2 *Battery Backup Overview*

The TPS65950 implements a backup mode, in which the backup battery keeps the RTC running. A rechargeable backup battery can be recharged from the main battery.

When the main battery is below 2.7 V or is removed, the backup battery powers the backup if the backup battery voltage is greater than 1.8 V. The backup domain powers up the following:

- Internal 32.768-kHz oscillator
- RTC
- Hash table (20 registers of 8 bits each)
- Eight GP storage registers

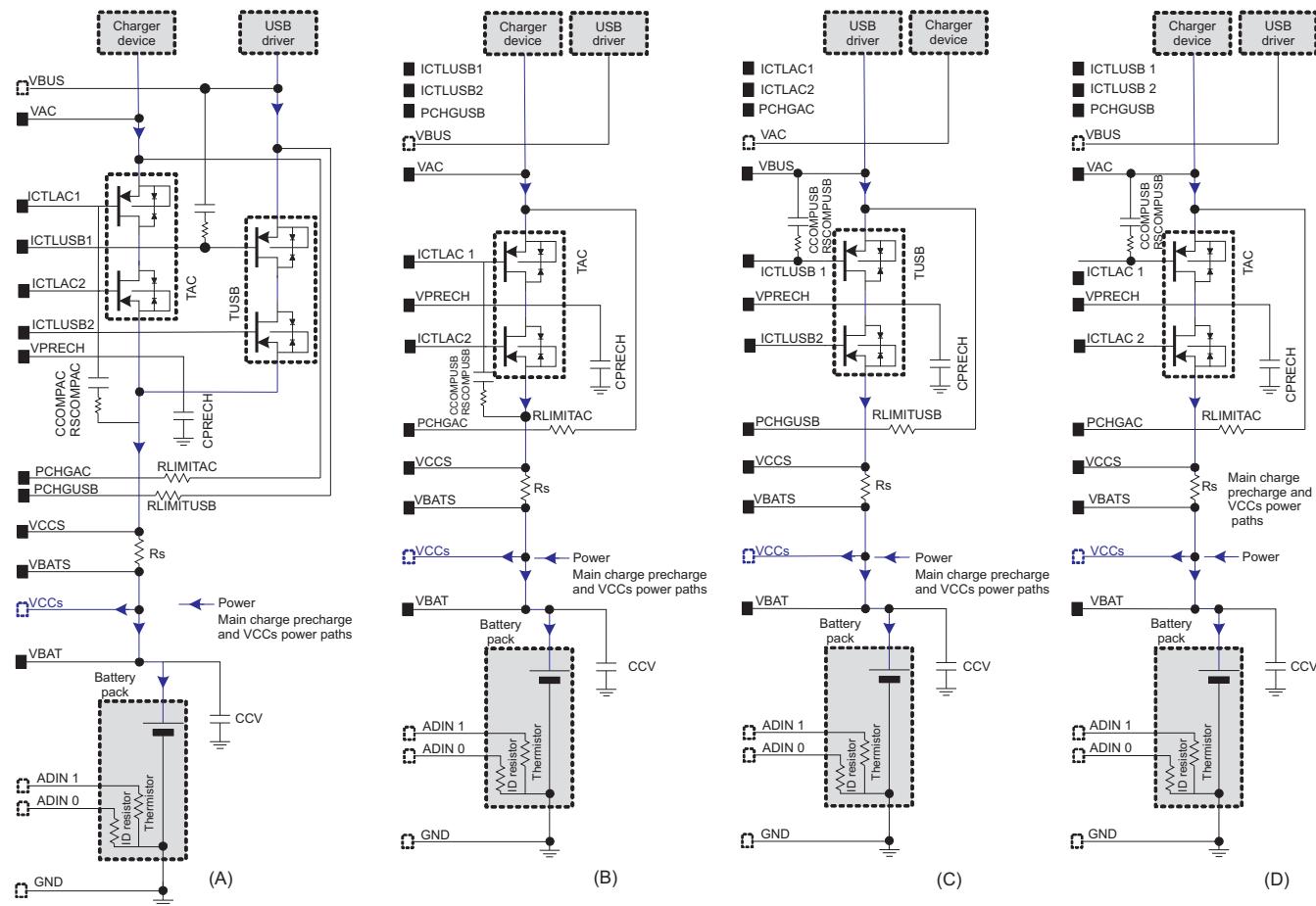
## 8.2 Typical Application Schematics

### 8.2.1 *Functional Configurations*

The BCI can be used in different configurations (see [Figure 8-1](#)). Each configuration requires a dedicated typical application schematic:

- ac charge supported (see [Figure 8-1A](#), [Figure 8-1B](#), and [Figure 8-1D](#))
- USB charge supported (see [Figure 8-1A](#) and [Figure 8-1C](#))

- ac constant voltage mode supported (see [Figure 8-1A](#) and [Figure 8-1B](#))
- ac charger with current nonlimited (see [Figure 8-1D](#))



032-055

- Schematic that supports ac charge, ac constant voltage mode, and USB charge. With this ac compensation schematic, constant voltage mode is possible, but only current limited chargers are supported.
- Schematic that supports only ac charge and ac constant voltage mode. With this ac compensation schematic, constant voltage mode is possible, but only current limited chargers are supported.
- Schematic that supports only USB charge.
- Schematic that supports only ac charge. With this ac compensation schematic, constant voltage mode is not possible, but current nonlimited chargers are supported.

**Figure 8-1. Typical Application Schematics**

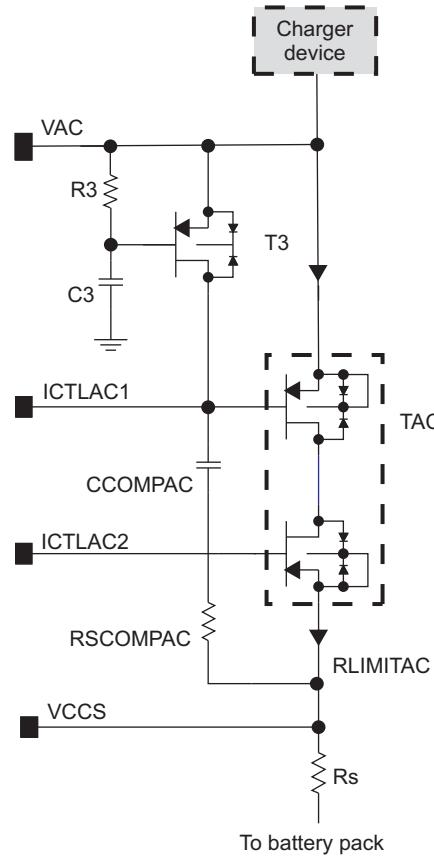
#### NOTE

For the component values, see [Table 15-1](#).

#### 8.2.2 In-Rush Current Limitation Schematic

With the typical application schematic supporting constant voltage mode ([Figure 8-1 A and B](#)), battery in-rush current is limited by the charging device. The application schematic can be enhanced to support in-rush current at the charging device plug to maximum 850 mA as detailed by [Figure 8-2](#). T3, R3, and C3 are connected between VAC and ICTLAC1 and intentionally bring in-rush curation. The described enhancement is not required for [Figure 8-1 D](#), where constant voltage mode is not supported.

[Figure 8-2](#) shows a typical application schematic with in-rush current limitation.

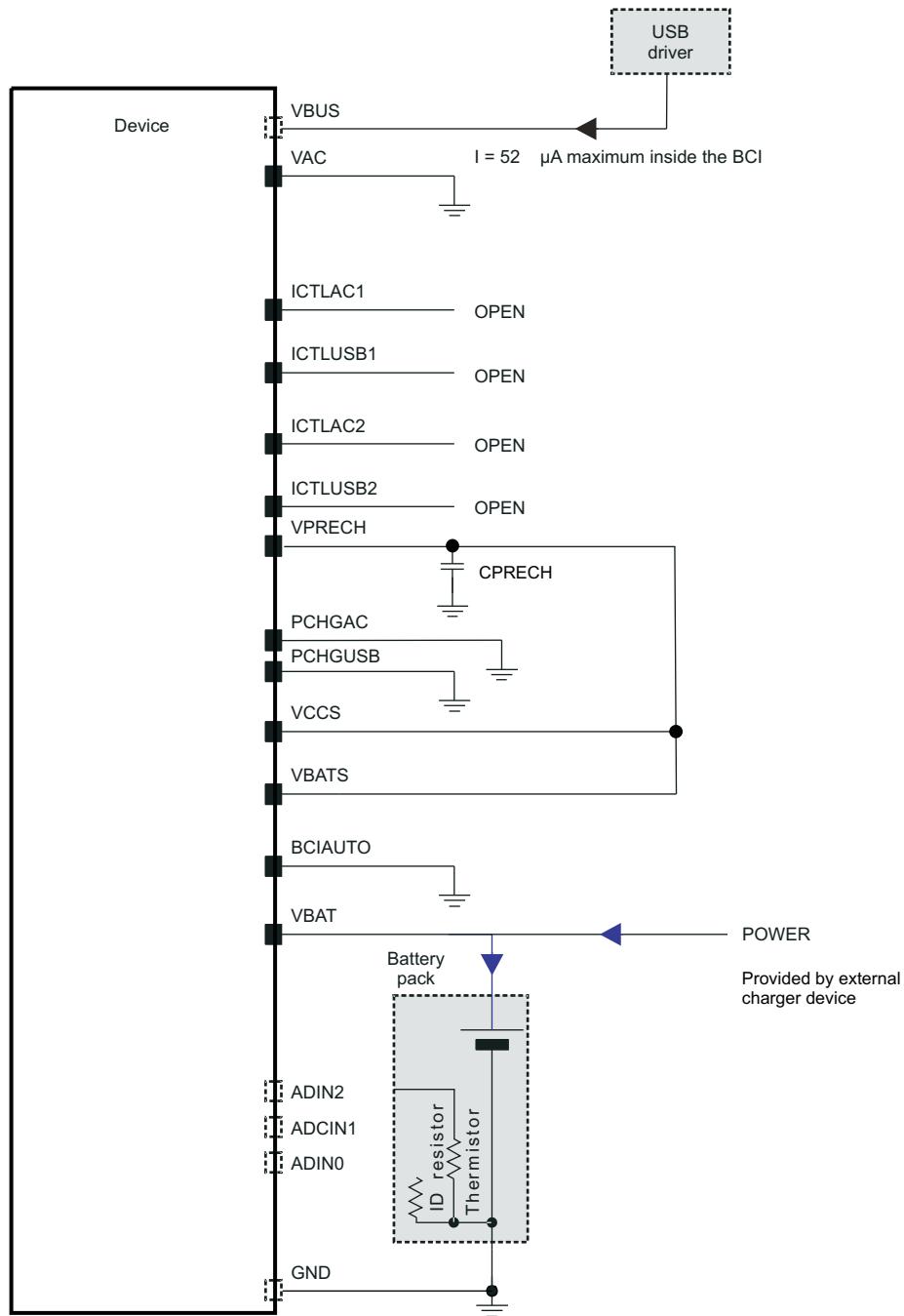


032-056

**Figure 8-2. Typical Application Schematic (In-Rush Current Limitation)**

### 8.2.3 Configuration With BCI Not Used

Figure 8-3 shows how to connect the BCI when it is not in use. The SUSPENDM bit must be set to disable the BCI internally.



**Figure 8-3. Typical Application Schematic (BCI Not Used)**

## 8.3 Electrical Characteristics

This section describes the electrical characteristics of the BCI in the TPS65950.

### 8.3.1 Main Charge

**Table 8-1** lists the electrical characteristics of the main charge.

**Table 8-1. Main Charge Electrical Characteristics**  
**V<sub>BAT</sub> = 3.6 V, R<sub>S</sub> = 0.22 Ω, unless otherwise specified**

| Parameter                                     | Test Conditions   | Min      | Typ   | Max  | Unit |
|---|---|----------|-------|------|------|
| VAC input voltage range <sup>(1)</sup>        | dc voltage  | 4.8      | 5.4   | 7    | V    |
| VBUS input voltage range (external)           | dc voltage  | 4.4      | 5     | 7    | V    |
| Charge current range                          |   |          |       | 1.7  | A    |
| VAC accessory supply mode consumption         | V <sub>BAT</sub> = 3.6 V, consumption on V <sub>BAT</sub> when ACCSUPEN = 1 and ACPATHEN = 1 connected to V <sub>BAT</sub> , current limitation enabled   |          | 0.75  | 1    | mA   |
|   | V <sub>BAT</sub> = 3.6 V, consumption on V <sub>BAT</sub> when ACCSUPEN = 1 and ACPATHEN = 1 connected to V <sub>BAT</sub> , current limitation disabled  |          | 0.525 | 0.7  |      |
| VBUS accessory supply mode consumption        | V <sub>BAT</sub> = 3.6 V, consumption on V <sub>BAT</sub> when ACCSUPEN = 1 and USBPATHEN = 1 connected to V <sub>BAT</sub> , current limitation enabled  |          | 0.64  | 0.85 | mA   |
|   | V <sub>BAT</sub> = 3.6 V, consumption on V <sub>BAT</sub> when ACCSUPEN = 1 and USBPATHEN = 1 connected to V <sub>BAT</sub> , current limitation disabled |          | 0.415 | 0.55 |      |
| ICTLAC1 output voltage swing (PWM charge)     | I <sub>ICTLAC1</sub> = -10 μA, ACPATHEN = 1, PWMEN = 1, PWMDTYCY = 0x000  | VAC-0.3  |       |      | V    |
|   | I <sub>ICTLAC1</sub> = 10 μA, ACPATHEN = 1, PWMEN = 1, PWMDTYCY = 0x3FF   |          |       | 0.35 |      |
| ICTLAC1 output voltage swing (linear charge)  | I <sub>ICTLAC1</sub> = -10 μA, ACPATHEN = 1, LINCHEN = 1, MESBAT = 1, CHGVREG = 0x000   | VAC-0.3  |       |      | V    |
|   | I <sub>ICTLAC1</sub> = 10 μA, ACPATHEN = 1, LINCHEN = 1, MESBAT = 1, CHGVREG = 0x3FF  |          |       | 0.35 |      |
| ICTLUSB1 output voltage swing (linear charge) | I <sub>ICTLUSB1</sub> = -10 μA, USBPATHEN = 1, LINCHEN = 1, MESBAT = 1, CHGVREG = 0x000   | VBUS-0.3 |       |      | V    |
|   | I <sub>ICTLUSB1</sub> = 10 μA, USBPATHEN = 1, LINCHEN = 1, MESBAT = 1, CHGVREG = 0x3FF  |          |       | 0.35 |      |
| ICTLAC2 output voltage swing (linear charge)  | I <sub>ICTLAC2</sub> = -10 μA, ACPATHEN = 1, LINCHEN = 1, ACPATHEN = 0  | VCCS-0.3 |       |      | V    |
|   | I <sub>ICTLAC2</sub> = 10 μA, ACPATHEN = 1, LINCHEN = 1, ACPATHEN = 1   |          |       | 0.35 |      |
| ICTLUSB2 output voltage swing (linear charge) | I <sub>ICTLUSB2</sub> = -10 μA, USBPATHEN = 1, LINCHEN = 1, USBPATHEN = 0   | VCCS-0.3 |       |      | V    |
|   | I <sub>ICTLUSB2</sub> = 10 μA, USBPATHEN = 1, LINCHEN = 1, USBPATHEN = 1  |          |       | 0.35 |      |
| PWM mode output current                       | PWM = 1 (ICTLAC1 = 0), VAC = 6.8 V  |          | 5.0   |      | mA   |
|   | PWM = 0 (ICTLAC1 = VAC), VAC = 6.8 V  |          | -2.0  |      |      |

(1) The maximum voltage value of the charging device is 7 V (process limitation). The minimum voltage value of the charging device is: V<sub>BATMAX</sub> + 2 PMOS drop + 0.22 Ω resistor drop (where V<sub>BATMAX</sub> is the maximum voltage value of the battery; that is, 4.2 V for Li-ion battery). User must consider maximum dissipation while using maximum ac/USB voltage (7 V) or maximum current load (1.7 A).

**Table 8-1. Main Charge Electrical Characteristics**  
**VBAT = 3.6 V, R<sub>S</sub> = 0.22 Ω, unless otherwise specified (continued)**

| Parameter  | Test Conditions   | Min   | Typ   | Max    | Unit   |
|--|---|-------|-------|--------|--------|
| ac main charge battery removal switch-off time     | CHGIREG = (value relative to I <sub>CHG</sub> = 0.6 A), VAC = 5.4 V,<br>C = 100 nF connected to ICTLAC1, VBAT threshold = 4.55 V, measure charge current from removal to 10% Miller compensation  |       |       | 150    | μs     |
|  | CHGIREG = (value relative to I <sub>CHG</sub> = 0.6 A), VAC = 5.4 V,<br>C = 100 nF connected to ICTLAC1, VBAT threshold = 4.55 V, measure charge current from removal to 10% Regular compensation |       |       | 150    |        |
| USB main charge battery removal switch-off time    | CHGIREG = (value relative to I <sub>CHG</sub> = 0.6 A), VBUS = 5.0 V,<br>C = 100 nF connected to ICTLUSB1, VBAT threshold = 4.55 V, measure charge current from removal to 10%                    |       |       | 150    | μs     |
| VAC-to-MADC input attenuation                      | VAC from 4.8 V to 6.8 V (maximum MADC input voltage = 1.224 V)  | 0.12  | 0.15  | 0.18   | V/V    |
| VBAT-to-MADC input attenuation                     | VBAT from 3.0 V to 4.5 V (maximum MADC input voltage = 1.35 V)  | 0.2   | 0.25  | 0.3    | V/V    |
| Current-to-voltage conversion slope <sup>(2)</sup> | (VCCS–VBATS) rising from 0 V to 0.17 V: CGAIN = 0 equivalent to 0–775 mA range  | 0.704 | 0.88  | 1.056  | mV/m A |
|  | (VCCS–VBATS) rising from 0 V to 0.33 V: CGAIN = 1 equivalent to 0–1500 mA range   | 0.352 | 0.44  | 0.528  |        |
| Current-to-voltage conversion positive offset      | OFFSEN = 1, OFFSN[1:0] = 00, CGAIN = 0, OFFSIGN = 0   |       | 18.7  |        | mV     |
|  | OFFSEN = 1, OFFSN[1:0] = 01, CGAIN = 0, OFFSIGN = 0   |       | 38.8  |        |        |
|  | OFFSEN = 1, OFFSN[1:0] = 10, CGAIN = 0, OFFSIGN = 0   |       | 60.1  |        |        |
|  | OFFSEN = 1, OFFSN[1:0] = 11, CGAIN = 0, OFFSIGN = 0   |       | 82.6  |        |        |
| Current-to-voltage conversion negative offset      | OFFSEN = 1, OFFSN[1:0] = 00, CGAIN = 0, OFFSIGN = 1   |       | -18.2 |        | mV     |
|  | OFFSEN = 1, OFFSN[1:0] = 01, CGAIN = 0, OFFSIGN = 1   |       | -35.6 |        |        |
|  | OFFSEN = 1, OFFSN[1:0] = 10, CGAIN = 0, OFFSIGN = 1   |       | -52.2 |        |        |
|  | OFFSEN = 1, OFFSN[1:0] = 11, CGAIN = 0, OFFSIGN = 1   |       | -67.6 |        |        |
| Charge voltage and charge current DAC              | Linear range  | 1FF   |       | 3BA    | hex    |
|  | Differential nonlinearity   | -2    |       | 2      | LSB    |
|  | Integrated nonlinearity   | -2    |       | 2      | LSB    |
|  | Offset  | -25   |       | 25     | mV     |
| ADIN0 dc current source                            | ADIN0 = 1 V   | 7     | 10    | 13     | μA     |
| ADCIN1 dc current source                           | ADCIN1 = 1 V, ITHSENS[2:0] = 000 (maximum MADC input voltage = 0.875 V), After TRIM done by ISRCTRIM[3:0], at ambient temperature   | 9.875 | 10    | 10.125 | μA     |

(2) MADC output code = (VCCS – VBATS) × 4 with CGAIN = 0  
MADC output code = (VCCS – VBATS) × 2 with CGAIN = 1

**Table 8-1. Main Charge Electrical Characteristics**  
**VBAT = 3.6 V,  $R_S = 0.22 \Omega$ , unless otherwise specified (continued)**

| Parameter  | Test Conditions  | Min       | Typ      | Max       | Unit |
|--|--|-----------|----------|-----------|------|
| ADCIN1 dc current source for temperature measurement               | ADCIN1 = 1 V, ITHSENS[2:0] = 000 (maximum MADC input voltage = 0.875 V), after TRIM done by ISRCTRIM[3:0]  | 9.5       | 10       | 10.5      | µA   |
|  | ITHSENS[2:0] = 001   | 14        | 20       | 26        |      |
|  | ITHSENS[2:0] = 010   | 21        | 30       | 39        |      |
|  | ITHSENS[2:0] = 011   | 28        | 40       | 52        |      |
|  | ITHSENS[2:0] = 100   | 35        | 50       | 65        |      |
|  | ITHSENS[2:0] = 101   | 42        | 60       | 78        |      |
|  | ITHSENS[2:0] = 110   | 49        | 70       | 91        |      |
|  | ITHSENS[2:0] = 111   | 56        | 80       | 104       |      |
| Constant current loop accuracy                                     | After trimming ( $\pm 1.10\%$ ), VAC = 5.4 V or VBUS = 5.0 V, VBAT = 3.6 V, CHGIREG = (value relative to $I_{CHG} = 0.6$ A), VCCS–VBATS rising voltage, monitoring ICTLAC1 or ICTLUSB1, CGAIN = 1, overtemperature (ambient 0°C to 50°C) (including the bandgap accuracy overtemperature $\pm 0.5\%$ and the $R_{sense}$ resistor accuracy $\pm 1\%$ ) | -11%      |          | 11%       |      |
|  | After trimming ( $\pm 0.55\%$ ), VAC = 5.4 V or VBUS = 5.0 V, VBAT = 3.6 V, CHGIREG = (value relative to $I_{CHG} = 0.6$ A), VCCS–VBATS rising voltage, monitoring ICTLAC1 or ICTLUSB1, CGAIN = 0, overtemperature (ambient 0°C to 50°C) (including the bandgap accuracy overtemperature $\pm 0.5\%$ and the $R_{sense}$ resistor accuracy $\pm 1\%$ ) | -3.15%    |          | 3.15%     |      |
| Constant current loop offset                                       | At error amplifier input, before loop trim. Including DAC offset, I-to-V offset after I-to-V trim, error amplifier offset  | -46.8     |          | 46.8      | mV   |
| Constant voltage loop accuracy                                     | After trimming ( $\pm 0.14\%$ ), VAC = 5.4 V or VBUS = 5.0 V, at room temperature, CHGVREG = (value relative to VBAT = 4.37 V), VBAT rising voltage, monitoring ICTLAC1 or ICTLUSB1  | -0.28%    |          | 0.28%     |      |
|  | After trimming ( $\pm 0.14\%$ ), VAC = 5.4 V or VBUS = 5.0 V overtemperature (ambient 0°C to 50°C), CHGVREG = (value relative to VBAT = 4.37 V), VBAT rising voltage, monitoring ICTLAC1 or ICTLUSB1 (including the bandgap accuracy overtemperature $\pm 0.5\%$ )   | -0.82%    |          | 0.82%     |      |
| Charger presence detect threshold                                  | VBAT = 3.6 V, rising edge  | VBAT+0.3  | VBAT+0.4 | VBAT+0.6  | V    |
|  | VBAT = 3.6 V, falling edge   | VBAT      | VBAT+0.1 | VBAT+0.3  |      |
| Battery threshold when default value <sup>(3)</sup>                | VAC = 5.4 V or VBUS = 5.0 V, VBATOVEN = 1, VBATOVTH(3:0) = default, MESBAT = 1, VBAT rising voltage, monitoring VBATOV status signal   | 4.45      | 4.55     | 4.65      | V    |
| ac charger overvoltage threshold when default value <sup>(3)</sup> | VBAT = 3.6 V, VACCHGOVEN = 1, VACCHGOVTH(3:0) = default, VAC rising voltage, monitoring VACCHGOV status signal   | 6.24      | 6.5      | 7         | V    |
| VBUS overvoltage threshold when default value <sup>(3)</sup>       | VBAT = 3.6 V, VBUSOVEN = 1, VBUSOVTH(3:0) = default, VBUS rising voltage, monitoring VBUSOV status signal  | 5.28      | 5.5      | 5.9       | V    |
| Main charge main battery presence impedance detection threshold    | Measured through ADCIN1 rising voltage and sourced current, monitoring BATSTS value  | 67.5      | 75       | 82.5      | kΩ   |
| Main charge main battery presence voltage detection threshold      | Force ADCIN1 voltage, monitor BATSTS value   |           | 750      |           | mV   |
| Temperature detection accuracy                                     | For low temperature (2°C/3°C)<br>For high temperature (43°C/50°C)  | -3<br>-5  |          | 3<br>5    | °C   |
| Battery voltage accuracy   | Tested for VBAT = 2.9, 3.6, and 4.2 V  | VBAT-0.1  | VBAT     | VBAT+0.1  | V    |
| Current charge accuracy  | Tested for ICHG = 600 mA   | ICHG-0.04 | ICHG     | ICHG+0.04 | A    |

(3) Can be changed by programming the associated threshold register

**Table 8-1. Main Charge Electrical Characteristics**  
**VBAT = 3.6 V,  $R_S = 0.22 \Omega$ , unless otherwise specified (continued)**

| Parameter     | Test Conditions      | Min | Typ | Max | Unit     |
|---------------|----------------------|-----|-----|-----|----------|
| Battery $R_S$ | ESR (including FUSE) |     |     | 0.5 | $\Omega$ |

### 8.3.2 Precharge

During slow precharge and fast precharge, a precharge voltage loop is always enabled and limits the battery voltage charge to 3.6 V typical. To use the constant voltage loop, a battery voltage prescaler is also always enabled. The voltage loop is nonlinear. A fast comparator switches off the external power portable media operating system (PMOS) when VBAT is higher than 3.6 V and switches on the PMOS when VBAT is lower than 3.6 V. When the USB charger is used, fast precharge is not available (to comply with USB standards).

In precharge mode, the threshold of the ac charger overvoltage detection is forced to 6.8 V.

Table 8-2 lists the precharge electrical characteristics.

**Table 8-2. Precharge Electrical Characteristics**  
 **$R_S = 0.22 \Omega$ , unless otherwise specified**

| Parameter                                     | Test Conditions  | Min      | Typ  | Max    | Unit    |
|---|--|----------|------|--------|---------|
| ICTLAC1 output voltage swing (precharge)      | $I_{ICTLAC1} = -10 \mu A$ , VBAT = 1.5 V, VCCS = VBAT+200 mV, VAC = 5.4 V, SYSACTIV = 0                                      | VAC–0.3  |      |        | V       |
|   | $I_{ICTLAC1} = 10 \mu A$ , VBAT = 1.5 V, VCCS = VBAT, VAC = 5.4 V, SYSACTIV = 0  |          |      | 0.35   |         |
| ICTLUSB1 output voltage swing (precharge)     | $I_{ICTLUSB1} = -10 \mu A$ , VBAT = 1.5 V, VCCS = VBAT+200 mV, VAC = 0.0 V, VBUS = 5 V, SYSACTIV = 0                         | VAC–0.3  |      |        | V       |
|   | $I_{ICTLUSB1} = 10 \mu A$ , VBAT = 1.5 V, VCCS = VBAT, VAC = 0.0 V, VBUS = 5 V, SYSACTIV = 0                                 |          |      | 0.35   |         |
| ICTLAC2 output voltage swing (precharge)      | $I_{ICTLAC2} = -10 \mu A$ , VBAT = 1.5 V, VCCS = VBAT+200 mV, VAC = 5.4 V, SYSACTIV = 0                                      | VCCS–0.3 |      |        | V       |
|   | $I_{ICTLAC2} = 10 \mu A$ , VBAT = 1.5 V, VCCS = VBAT, VAC = 5.4 V, SYSACTIV = 0  |          |      | 0.35   |         |
| ICTLUSB2 output voltage swing (precharge)     | $I_{ICTLUSB2} = -10 \mu A$ , VBAT = 1.5 V, VCCS = VBAT+200 mV, VAC = 0.0 V, VBUS = 5 V, SYSACTIV = 0                         | VCCS–0.3 |      |        | V       |
|   | $I_{ICTLUSB2} = 10 \mu A$ , VBAT = 1.5 V, VCCS = VBAT, VAC = 0.0 V, VBUS = 5 V, SYSACTIV = 0                                 |          |      | 0.35   |         |
| ac precharge battery removal switch-off time  | In fast precharge, Rlimit = 700 k $\Omega$ , VAC = 5.4 V, VBAT threshold = 3.6 V, measure charge current from removal to 10% |          |      | 150    | $\mu s$ |
| USB precharge battery removal switch-off time | In precharge, Rlimit = 500 k $\Omega$ , VBUS = 5.0 V, VBAT threshold = 3.6 V, measure charge current from removal to 10%     |          |      | 150    | $\mu s$ |
| PCHGPOR voltage threshold                     | VAC = 5.4 V or VBUS = 5.0 V, PCHGPOR raise when VPRECH voltage higher than the voltage threshold                             |          | 1.2  |        | V       |
| PCHGCLK click frequency                       | VAC = 5.4 V or VBUS = 5.0 V (including temperature variation)  | 18.5     | 32   | 45.4   | kHz     |
|   | VAC = 5.4 V or VBUS = 5.0 V (at room temperature)  | 24.3     | 32   | 39.68  |         |
| PCHGVREF band gap voltage                     | VAC = 5.4 V or VBUS = 5.0 V  | 0.7125   | 0.75 | 0.7875 | V       |
| VPRECH regulator output                       | VAC = 5.4 V or VBUS = 5.0 V  | 1.4      | 1.5  | 1.6    | V       |
| Small precharge output current                | VBAT = 0.0 V, VAC = 5.4 V or (VBUS = 5.0 V and USBSLOWPCHG = 1)  | 3        | 5    | 7      | mA      |
| Slow precharge loop accuracy                  | After TRIMinG, VAC = 5.4 V or VBUS = 5.0 V, VBAT = 1.5 V, VCCS–VBATS rising voltage, monitoring ICTLAC1 or ICTLUSB1          | 14       | 17.2 | 20.3   | mV      |

**Table 8-2. Precharge Electrical Characteristics**  
 **$R_S = 0.22 \Omega$ , unless otherwise specified (continued)**

| Parameter   | Test Conditions   | Min      | Typ      | Max      | Unit |
|---|---|----------|----------|----------|------|
| Fast precharge loop accuracy                                  | After TRIMinG, PCHGAC or PCHGUSB floating, VAC = 5.4 V, VBAT = 3.0 V, VCCS–VBATS rising voltage, monitoring ICTLAC1 or ICTLUSB1 | 56       | 68.8     | 81.2     | mV   |
| Precharge constant voltage loop limitation                    | System did not start after VBAT > 3.2 V, VBATS input.   | 3.4      | 3.6      | 3.8      | V    |
| VBUSOVPRECH threshold (for USB reliability)                   | VBUS input  | 5.04     | 5.25     | 5.46     | V    |
| ac charger overvoltage threshold                              | VBAT = 2.8 V, VAC input   | 6.5      | 6.8      | 7.3      | V    |
| VBUS overvoltage threshold                                    | VBAT = 2.8 V, VBUS input  | 6.5      | 6.8      | 7.3      | V    |
| Battery voltage threshold to start ac fast precharge          | VBATS input   | 1.8      | 2.0      | 2.2      | V    |
| Battery voltage threshold to start ac slow precharge          | VBATS input   | 1.0      | 1.2      | 1.4      | V    |
| Charger presence detect threshold                             | VBATS = 2.8 V, rising edge  | VBAT+0.3 | VBAT+0.4 | VBAT+0.6 | V    |
|   | VBATS = 2.8 V, falling edge   | VBAT     | VBAT+0.1 | VBAT+0.3 |      |
| VBUS presence detect threshold                                | Rising edge   |          |          | 4.4      | V    |
|   | Falling edge  |          |          | 4.3      |      |
| BCIAUTO detection impedance threshold                         | To obtain CVENACA = BCIAUTOACA = 0  |          |          | 10       | kΩ   |
|   | To obtain CVENACA = BCIAUTOACA = 1  | 140      |          |          |      |
| BCIAUTO detection voltage threshold                           | CVENACA = 0 below the voltage threshold   | 100      | 150      | 200      | mV   |
|   | CVENACA = 1 below the voltage threshold   | 700      | 750      | 800      |      |
| BCIAUTO detection output current                              | Measured on BCIAUTO pin   | 4.5      | 7.5      | 9.5      | μA   |
| Precharge main battery presence impedance detection threshold | Measured through ADCIN1 rising voltage and sourced current, monitoring BATSTS value   | 115      | 140      | 192      | kΩ   |
| Precharge main battery presence voltage detection threshold   | Force ADCIN1 voltage, monitor BATSTS value.   |          | 750      |          | mV   |
| Precharge main battery presence detection output current      | Measured on ADCIN1 pin  |          | 5.5      |          | μA   |

### 8.3.3 Constant Voltage Mode

The BCI supports a constant voltage (CV) mode. CV mode is automatically started when there is no battery pack, a regulated ac charger is plugged in, and CVENAC = 1. The charging device outputs a constant voltage at the VBAT node. To start CV mode, the precharge analog hardware detects whether a battery pack is open using the battery presence comparator, and detects whether an ac charger is connected using the ac charger presence comparator.

CV mode is disabled when VAC is greater than 6.5 V typical. ac overvoltage protection is also enabled during CV mode.

Hardware implementation for CV mode uses the main charge constant voltage loop. In CV mode, a 35-mA typical load is synced internally to keep the regulated VBAT voltage output stable. An 80-μF typical external capacitor must be connected to the VBAT node.

Table 8-3 lists the electrical characteristics of CV mode.

**Table 8-3. CV Mode Electrical Characteristics<sup>(1)</sup>**

| Parameter   | Test Conditions  | Min  | Typ | Max  | Unit |
|---|--|------|-----|------|------|
| Main charge constant voltage mode   | VAC = 5.4 V, ADCIN1 pin floating, LDOOK = 1  |      |     |      |      |
| CBAT  | Battery node capacitor   | 37   | 80  | 167  | µF   |
|   | ESR (including FUSE)   |      | 0.4 | 0.5  | Ω    |
| VBAT regulated voltage, including dc (posttrim), dc load regulation, and dc line regulation | Typical condition is VBAT for VAC = 5.4 V, ILOAD = 0.5 A   | 3.88 | 4.0 | 4.12 | V    |
|   | dc load regulation: VAC = VACmin, ILOAD varying from 0 to ILOADmax   |      |     |      |      |
|   | dc line regulation: ILOAD = ILOADmax, VAC varying from VACmin to VACmax                                    |      |     |      |      |
|   | Maximum condition is ILOAD = 0, VAC = 6.2 V  |      |     |      |      |
|   | Minimum condition is ILOAD = 1 A, VAC = 4.8 V  |      |     |      |      |
| ILOAD   |  |      |     | 1    | A    |
| BCI VBAT load current   | VAC = 5.4 V  | 15   | 35  | 55   | mA   |
| VAC   |  | 4.8  | 5.4 | 6.2  | V    |
| Transient load regulation during internal LDO startup                                       | VBAT(Iout 20 mA) – VBAT(Iout 500 mA) in load change time = 1 µs (BCI in precharge CV mode)                 | 300  |     | 300  | mV   |
| Transient load during LDO and dc-dc startup   | VBAT(Iout 30 mA) – VBAT(Iout 830 mA) in load change time = 1 µs (BCI in main charge CV mode)               | 300  |     | 300  | mV   |
| Transient load regulation   | VBAT(Iout 30 mA) – VBAT(Iout 300 mA) in load change time = 1 µs (BCI in main charge CV mode) (ESR = 0.4 Ω) | 100  |     | 100  | mV   |

(1) In CV mode, an external FET characteristic is critical. This mode has been validated for FDJ1027P FET.

## 8.4 Charge Sequence Timing Diagram

Figure 8-4 is the charge sequence timing diagram.

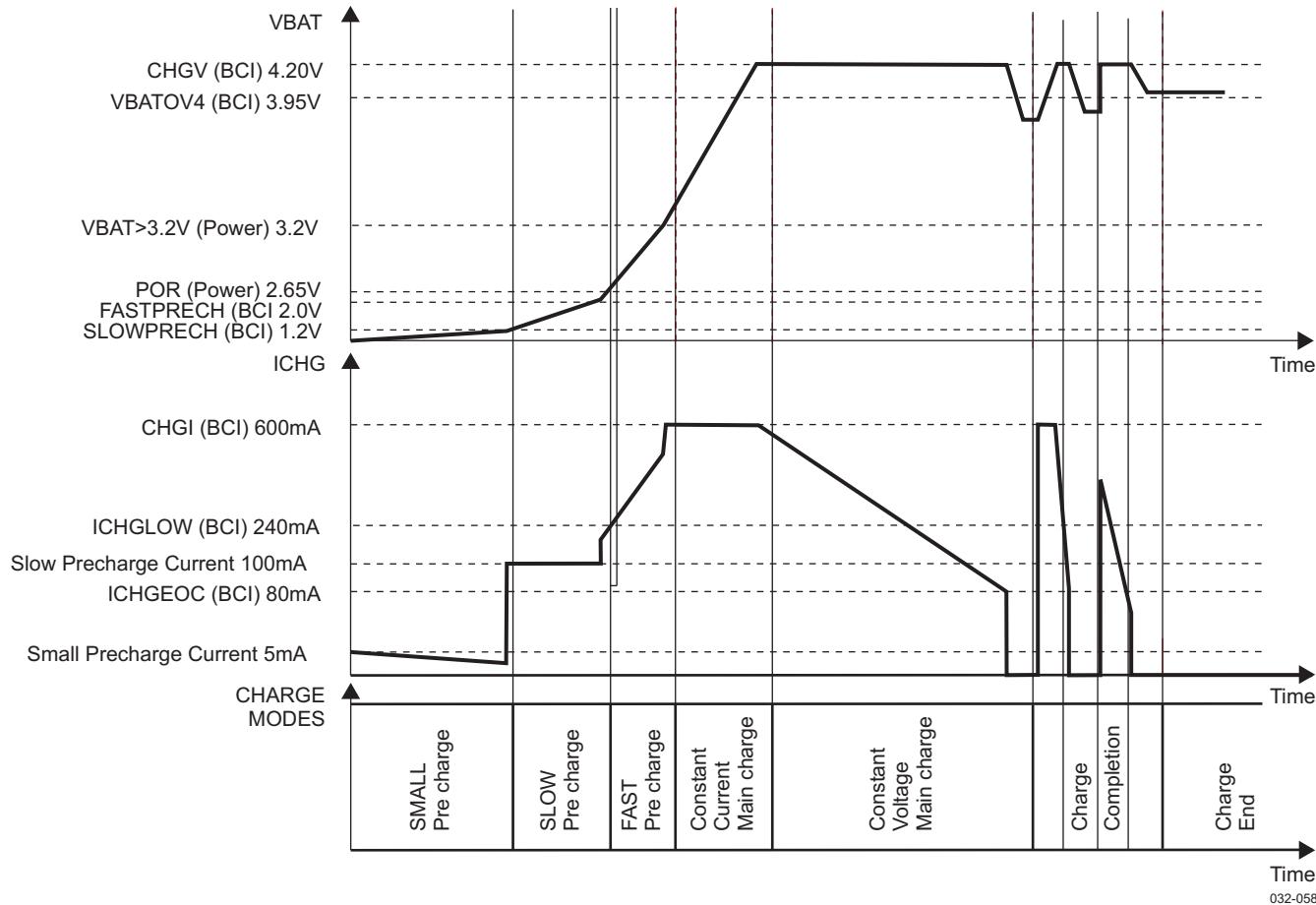


Figure 8-4. Automatic Charge Sequence Timing Diagram

## 8.5 CEA Charger Type

Depending on the device and according to the charger type, the DM and DP lines have different characteristics:

- Hub: DP and DM not shorted, DM low
- Charger: DP and DM shorted
- Carkit: DP and DM not shorted, DM high

These characteristics reflect to which of these devices the phone is connected.

Table 8-4 lists the important characteristics in precharge detection.

Table 8-4. Precharge Detection Characteristics

| Symbol           | Parameter                                     | Comments   | Min  | Max | Unit    |
|------------------|---|--|------|-----|---------|
| $I_{CCINIT}$     | Supply current of unconfigured function/hub   | Hub: DP and DM not shorted, DM low                                   |      | 100 | mA      |
| $I_{CRINIT}$     | Supply current of unconfigured charger/carkit | Charger: DP and DM shorted<br>Carkit: DP and DM not shorted, DM high |      | 100 | mA      |
| $T_{DELAY}$      | Delay for power up all blocks                 |  | 1000 |     | $\mu$ s |
| $T_{DMOD_DELAY}$ | Time pulling down DM line                     |  | 19.5 |     | $\mu$ s |

**Table 8-4. Precharge Detection Characteristics (continued)**

| Symbol             | Parameter                 | Comments | Min | Max | Unit |
|--------------------|---------------------------|----------|-----|-----|------|
| T <sub>CHECK</sub> | Repeat time check process |          |     | 500 | ms   |
| T <sub>PULSE</sub> | DP pullup pulse width     |          |     | 20  | ms   |

In main charge, the basic chargers and basic carkits indicate their default current limit, versus the value of the ID resistor, between the ID pin and the ground, and also versus the data bus D± connection type (shorted or not shorted).

Table 8-5 lists the output current limit ranges according to the device type and parameters.

**Table 8-5. Main Charge Current Limit Indication**

| Device Type             | Parameter        |                      |                                 |                 |                                  | Output Current Limit |                    |      |
|-------------------------|------------------|----------------------|---------------------------------|-----------------|----------------------------------|----------------------|--------------------|------|
|                         | ID Resistor (1%) | Output Voltage (nom) | D+/D– Connection <sup>(1)</sup> | ID Pin State    | ID Pin Current Limit Implemented | Min                  | Max                | Unit |
| Phone-powered accessory | 102k             | N/A <sup>(2)</sup>   | Not shorted                     | N/A             | N/A                              | N/A                  | N/A                |      |
| Charger 5-wire          | 200k             | 5.0 V                | Shorted                         | Low             | N/A                              | 450                  | 650                | mA   |
|                         |                  |                      |                                 | High            | No                               | 450                  | 650                |      |
|                         |                  |                      |                                 | High            | Yes                              | 750                  | 950                |      |
|                         | 440k             | 5.0 V                | Shorted                         | Low             | N/A                              | 750                  | 950                | mA   |
|                         |                  |                      |                                 | High            | No                               | 750                  | 950                |      |
|                         | 4.5 V            | Shorted              | High                            | Yes             | 1.8                              | 3.0 <sup>(3)</sup>   | A                  |      |
| Basic carkit 5-wire     | 200k             | 5.0 V                | D-high                          | Used for muting | N/A                              | 450                  | 650                | mA   |
|                         | 440k             | 5.0 V                | D-high                          | Used for muting | N/A                              | 750                  | 950                |      |
| Smart carkit 5-wire     | N/A              | 5.0 V                | D-high                          | N/A             | N/A                              | 0.450                | 3.0 <sup>(3)</sup> | A    |
| Carkit 4-wire           | N/A              | 5.0 V                | D-high                          | N/A             | N/A                              | 0.450                | 3.0 <sup>(3)</sup> | A    |

(1) Shorted indicates that D+ (DP) is shorted to D– (DM).

(2) N/A = Not applicable

(3) The maximum current limit in this configuration is for safety. It does not indicate normal current loads for the phone.

## 9 MADC

### 9.1 General Description

The TPS65950 shares the MADC resource with the host processors in the system (hardware and software conversion modes) and its BCI. Therefore, the TPS65950 must:

- Manage potential concurrent requests of conversions and priority among resource users
- Flag, using interrupt signals, the end-of-sequence of conversions
- Grant quarter-bit accuracy for modem conversion of battery voltage

The quarter-bit accurate start signal is provided through a STARTADC from the host processor (real-time conversion).

The MADC generates interrupt signals to the host processors. Interrupts are handled primarily by the MADC internal secondary interrupt handler (SIH) and secondly at the upper level (outside the MADC) by the TPS65950 primary interrupt handler (PIH). The MADC indicates to the BCI module, through a data ready signal, that conversion results are available.

### 9.2 Main Electrical Characteristics

[Table 9-1](#) lists the electrical characteristics of the MADC.

**Table 9-1. Electrical Characteristics**

| Parameter  | Conditions  | Min   | Typ | Max  | Unit |
|--|---|-------|-----|------|------|
| Resolution   |   |       | 10  |      | Bit  |
| Input dynamic range for external input   | Except ADIN0 and ADCIN1 and internal MADC input (0 to 1.5 V)        | 0     |     | 2.5  | V    |
| MADC voltage reference   |   |       | 1.5 |      | V    |
| Differential nonlinearity  | For all channels (except ADIN2 through ADIN7 channels)              | -1    |     | 1    | LSB  |
| Integral nonlinearity  | Best fitting. For all channels (except ADIN2 through ADIN7)         | -2    |     | 2    | LSB  |
| Differential nonlinearity for ADIN2 through ADIN7                              |   | -1    |     | 1    | LSB  |
| Integral nonlinearity for ADIN2 through ADIN7                                  | Best fitting for codes 230 to maximum                               | -2    |     | 2    | LSB  |
|  | Best fitting considering offset of 25 least-significant bits (LSBs) | -3.75 |     | 3.75 | LSB  |
| Offset   | Best fitting  | -28.5 |     | 28.5 | mV   |
| Input bias   |   |       | 1   |      | µA   |
| Input capacitor $C_{BANK}$   |   |       |     | 10   | pF   |
| Maximum source input resistance $R_s$ (for all 16 internal or external inputs) |   |       |     | 100  | kΩ   |
| Input current leakage (for all 16 internal or external inputs)                 |   |       |     | 1    | µA   |

## 9.3 Channel Voltage Input Range

Table 9-2 lists the channel voltage input ranges.

**Table 9-2. Analog Input Voltage Range**

| Channel                        | Min | Typ | Max | Unit | Prescaler   |
|--------------------------------|-----|-----|-----|------|---|
| ADIN0: Battery type/GP input   | 0   |     | 1.5 | V    | No prescaler<br>dc current source for battery identification through external resistor (10 $\mu$ A typical)             |
| ADCIN1: Battery temperature    | 0   |     | 1.5 | V    | No prescaler<br>dc current source for temperature measurement through external resistor (10 to 80 $\mu$ A programmable) |
| ADIN2: GP input <sup>(1)</sup> | 0   |     | 2.5 | V    | MADC prescaler from 0 to >1.5 V   |
| ADIN3: GP input <sup>(1)</sup> | 0   |     | 2.5 | V    | MADC prescaler from 0 to >1.5 V   |
| ADIN4: GP input <sup>(1)</sup> | 0   |     | 2.5 | V    | MADC prescaler from 0 to >1.5 V   |
| ADIN5: GP input <sup>(1)</sup> | 0   |     | 2.5 | V    | MADC prescaler from 0 to >1.5 V   |
| ADIN6: GP input <sup>(1)</sup> | 0   |     | 2.5 | V    | MADC prescaler from 0 to >1.5 V   |
| ADIN7: GP input <sup>(1)</sup> | 0   |     | 2.5 | V    | MADC prescaler from 0 to >1.5 V   |

(1) GP inputs must be tied to ground when TPS65950 internal power supplies (VINTANA1 and VINTANA2) are off.

### 9.3.1 Sequence Conversion Time (Real-Time or Nonaborted Asynchronous)

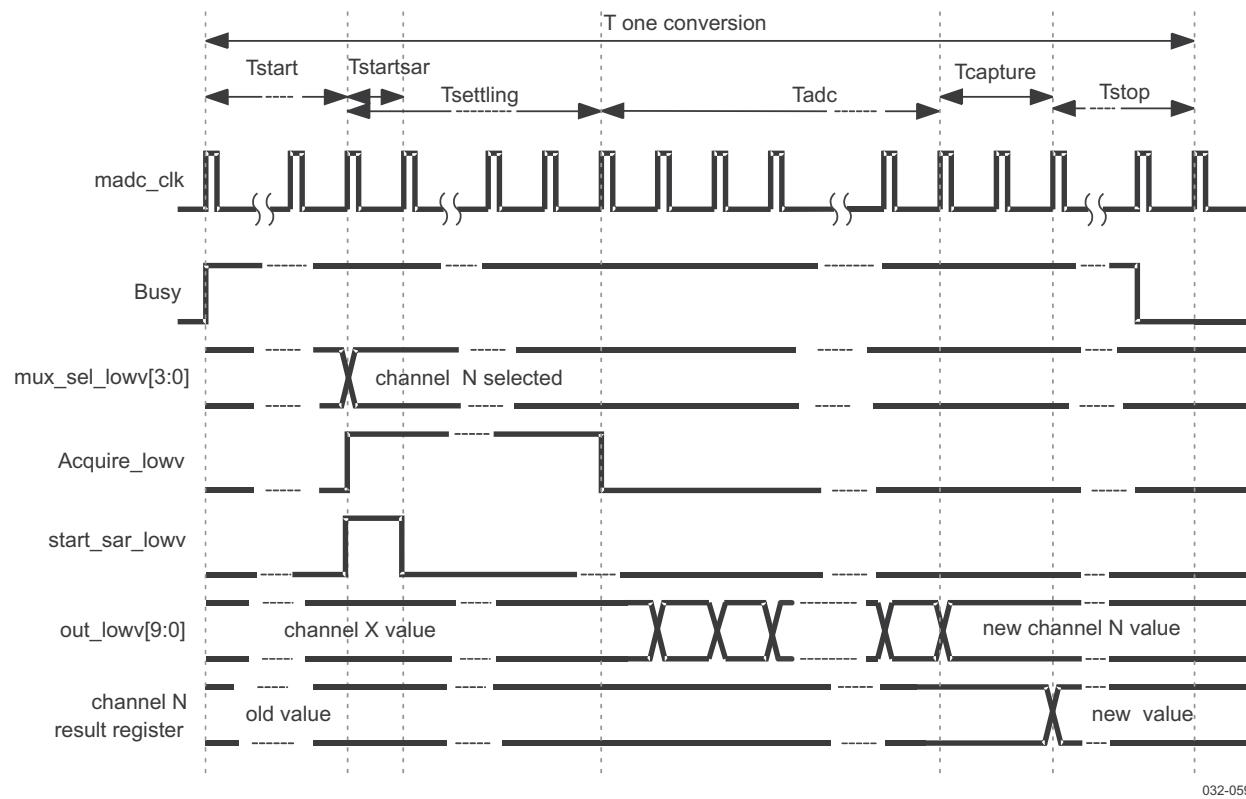
Table 9-3 lists the sequence conversion timing characteristics. Figure 9-1 is a conversion sequence general timing diagram.

**Table 9-3. Sequence Conversion Timing Characteristics**

| Parameter                     | Comments  | Min  | Typ | Max | Unit    |
|-------------------------------|---|------|-----|-----|---------|
| F                             | Running frequency   |      |     | 1   | MHz     |
| T = 1/F                       | Clock period  |      |     | 1   | $\mu$ s |
| N                             | Number of analog inputs to convert in a single sequence   | 0    |     | 16  |         |
| Tstart                        | SW1, SW2, or USB asynchronous request or real-time STARTADC request   | 3    |     | 4   | $\mu$ s |
| Tsettling time                | Settling time to wait before sampling a stable analog input (capacitor bank charge time)<br><br>Tsettling is calculated from the max ((Rs + Ron)*Cbank) of the 16 possible input sources (internal or external). Ron is the resistance of the selection analog input switches (5 k $\Omega$ ). This time is software-programmable in the open-core protocol (OCP) register. | 5    | 12  | 20  | $\mu$ s |
| Tstartsar                     | The successive approximation registers ADC start time.  |      |     | 1   | $\mu$ s |
| Tadc time                     | The successive approximation registers ADC conversion time.   |      |     | 10  | $\mu$ s |
| Tcapture time                 | Tcapture time is the conversion result capture time.  |      |     | 2   | $\mu$ s |
| Tstop                         |   | 1    |     | 2   | $\mu$ s |
| Full conversion sequence time | One channel (N = 1) <sup>(1)</sup><br>All channels (N = 16) <sup>(1)</sup>  | 22   |     | 39  | $\mu$ s |
|                               |   | 352  |     | 624 |         |
| Conversion sequence time      | Without Tstart and Tstop: One channel (N = 1) <sup>(1)</sup><br>Without Tstart and Tstop: All channels (N = 16) <sup>(1)</sup>  | 18   |     | 33  | $\mu$ s |
|                               |   | 288  |     | 528 |         |
| STARTADC pulse duration       | STARTADC period is T  | 0.33 |     | 24  | $\mu$ s |

(1) Total sequence conversion time general formula: Tstart + N\*(1 + Tsettling + Tadc + Tcapture) + Tstop

Table 9-3 shows the information in Figure 9-1. The *Busy* parameter shows that a conversion sequence is running, and the *channel N result register* parameter corresponds to the result register of RT/GP/BCI selected channel.



**Figure 9-1. Conversion Sequence General Timing Diagram**

## 10 LED Drivers

### 10.1 General Description

Two arrays of parallel LEDs are driven (dedicated for the phone light). The parallel LEDs are supplied by VBAT and the external resistor value is given for each of them. The TPS65950 has two open-drain LED drivers for keypad backlighting. The keypad backlighting must incorporate any required current limiting and be rated for operation at the main battery voltage.

Figure 10-1 is a block diagram of the LED driver. Table 10-1 lists the electrical characteristics of the LED driver.

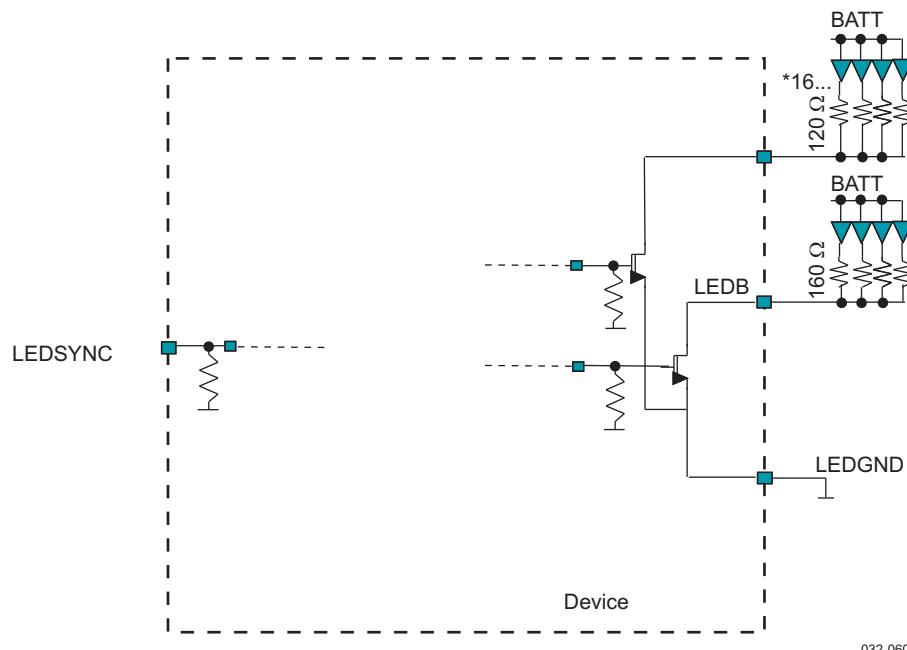


Figure 10-1. LED Driver Block Diagram

For the component values, see Table 15-1.

Table 10-1. Electrical Characteristics

| Parameter              | Conditions             | Min | Typ | Max | Unit     |
|------------------------|------------------------|-----|-----|-----|----------|
| Software On resistance | $I_O = 160 \text{ mA}$ |     | 3   | 4   |          |
|                        | $I_O = 60 \text{ mA}$  |     | 10  | 12  | $\Omega$ |

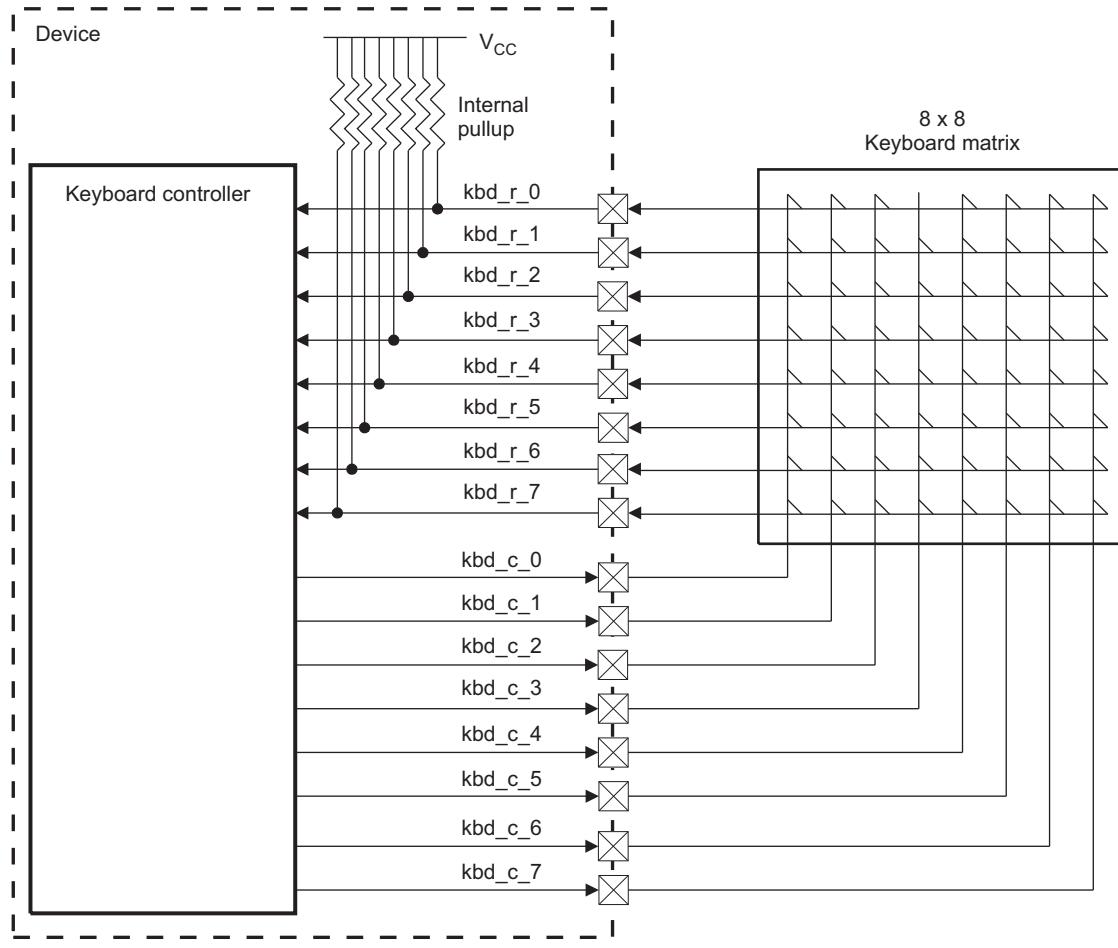
## 11 Keyboard

### 11.1 Keyboard Connection

The keyboard is connected to the chip using:

- KBR (7:0) input pins for row lines
- KBC (7:0) output pins for column lines

[Figure 11-1](#) shows the keyboard connection.



032-061

**Figure 11-1. Keyboard Connection**

When a key button of the keyboard matrix is pressed, the corresponding row and column lines are shorted together. To allow key press detection, all input pins (KBR) are pulled up to  $V_{CC}$  and all output pins (KBC) are driven low.

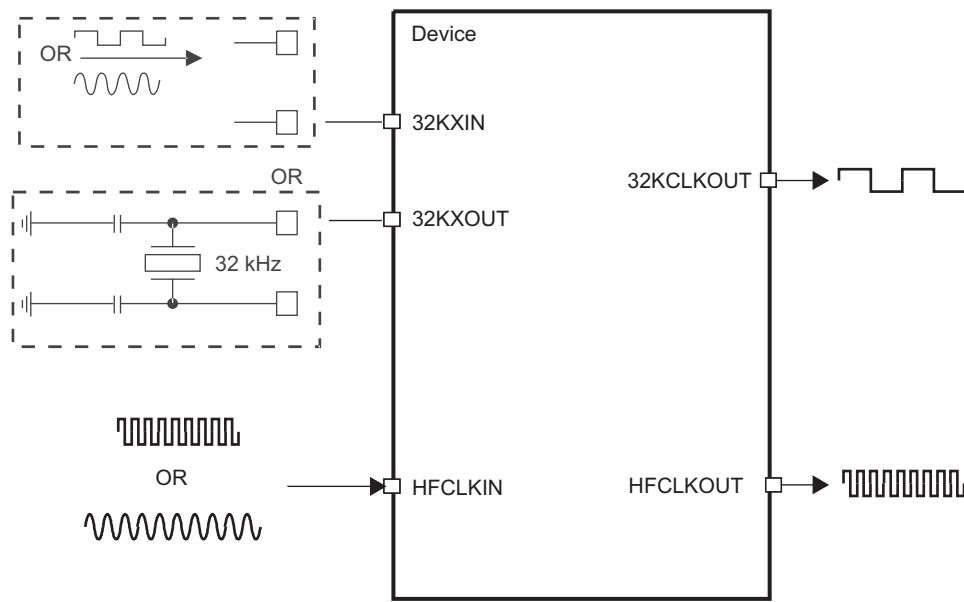
Any action on a button generates an interrupt to the sequencer.

The decoding sequence is written to allow detection of simultaneous press actions on several key buttons.

The keyboard interface can be used with a smaller keyboard area than  $8 \times 8$ . To use a  $6 \times 6$  keyboard, KBR(6) and KBR(7) must be tied high to prevent any scanning process distribution.

## 12 Clock Specifications

The TPS65950 includes several I/O clock pins. The TPS65950 has two sources of high-stability clock signals: the external high-frequency clock (HFCLKIN) input and an onboard 32-kHz oscillator (an external 32-kHz signal can be provided). [Figure 12-1](#) is an overview of the clocks.



032-062

**Figure 12-1. Clock Overview**

### 12.1 Features

The TPS65950 accepts two sources of high-stability clock signals:

- 32KXIN/32KXOUT: Onboard 32-kHz crystal oscillator (an external 32-kHz input clock can be provided)
- HFCLKIN: External high-frequency clock (19.2, 26, or 38.4 MHz).

The TPS65950 can provide:

- 32KCLKOUT digital output clock
- HFCLKOUT digital output clock with the same frequency as the HFCLKIN input clock

## 12.2 Input Clock Specifications

The clock system accepts two input clock sources:

- 32-kHz crystal oscillator clock or sinusoidal/squared clock
- HFCLKIN high-frequency input clock

### 12.2.1 Clock Source Requirements

[Table 12-1](#) lists the input clock requirements.

**Table 12-1. TPS65950 Input Clock Source Requirements**

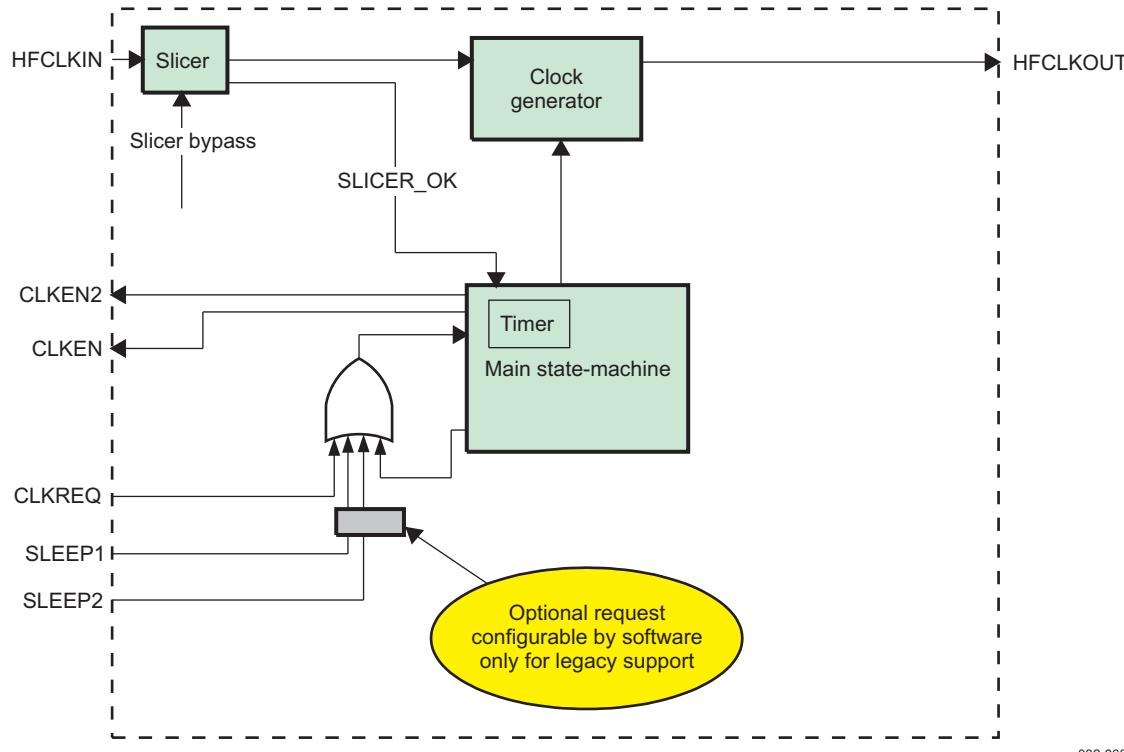
| Pad               | Clock Frequency    | Stability   | Duty Cycle |
|-------------------|--------------------|-------------|------------|
| 32KXIN<br>32KXOUT | 32.768 kHz         | Crystal     | ±30 ppm    |
|                   |                    | Square wave | –          |
|                   |                    | Sine wave   | –          |
| HFCLKIN           | 19.2, 26, 38.4 MHz | Square wave | ±150 ppm   |
|                   |                    | Sine wave   | –          |

(1) HFCLK duty cycle and frequency is not altered by the internal circuit. The input clock accuracy must match that of the system requirement, for example, OMAP device.

### 12.2.2 High-Frequency Input Clock

HFCLKIN is the high-frequency input clock. It can be a square- or sine-wave input clock. If a square-wave input clock is provided, it is recommended to switch the block to bypass mode when possible to avoid loading the clock.

[Figure 12-2](#) shows the HFCLKIN clock distribution.



**Figure 12-2. HFCLKIN Clock Distribution**

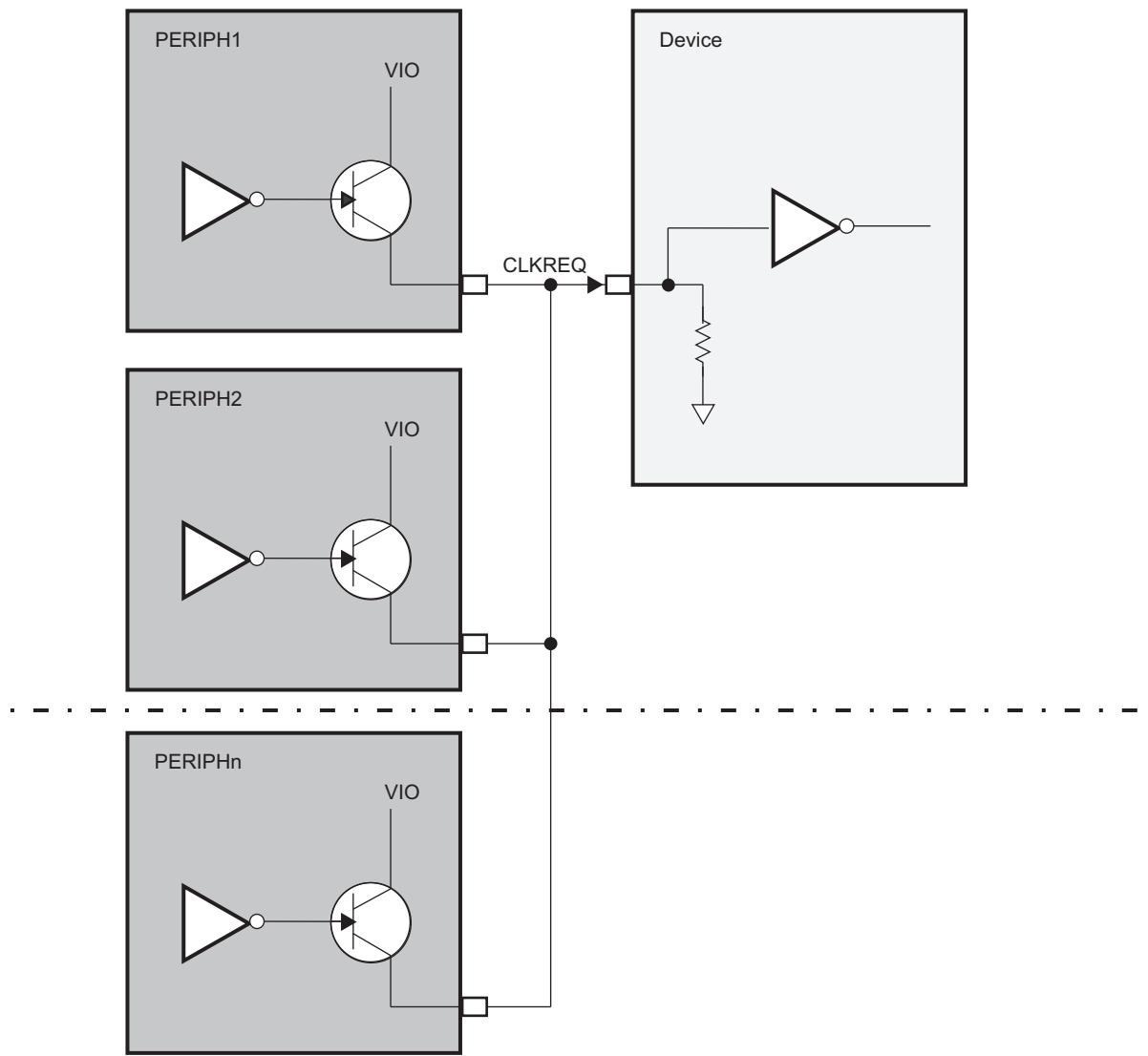


When a device needs a clock signal other than 32.768 kHz, it makes a clock request and activates the CLKREQ pin. As a result, the TPS65950 immediately sets CLKEN to 1 to warn the clock provider in the system about the clock request and starts a timer (maximum of 5.2 ms using the 32.768-kHz clock). When the timer expires, the TPS65950 opens a gated clock, the timer automatically reloads the defined value, and a high-frequency output clock signal is available through the HFCLKOUT pin. The output drive of HFCLKOUT is programmable (minimum load 10 pF, maximum load 40 pF) and must be at 40 pF by default.

With a register setting, the mirroring of CLKEN can be enabled on CLKEN2. When this mirroring feature is not enabled, CLKEN2 can be used as a GP output controlled through I<sup>2</sup>C accesses.

CLKREQ, when enabled, has a weak pulldown resistor to support the wired-OR clock request.

Figure 12-3 shows an example of the wired-OR clock request.



032-064

**Figure 12-3. Example of Wired-OR Clock Request**

**NOTE**

The timer default value must be the worst case (10 ms) for the clock providers. For legacy or workaround support, the signals NSLEEP1 and NSLEEP2 can also be used as a clock request even if it is not their primary goal. By default, this feature is disabled and must be enabled individually by setting the register bits associated with each signal.

When the external clock signal is present on the HFCLKIN ball, it is possible to use this clock instead of the internal RC oscillator and then synchronize the system on the same clock. The RC oscillator can then go to idle mode.

**Table 12-2** lists the input clock electrical characteristics of the HFCLKIN input clock.

**Table 12-2. HFCLKIN Input Clock Electrical Characteristics**

| Parameter   | Configuration Mode Slicer                | Min             | Typ | Max                         | Unit            |
|---|--|-----------------|-----|-----------------------------|-----------------|
| Frequency   |  | 19, 26, or 38.4 |     |                             | MHz             |
| Startup time  | LP/HP (sine wave)                        |                 |     | 4                           | μs              |
| Input dynamic range   | LP/HP (sine wave)<br>BP/PD (square wave) | 0.3<br>0        | 0.7 | 1.45<br>1.85 <sup>(1)</sup> | V <sub>PP</sub> |
| Current consumption   | LP<br>HP<br>BP/PD                        |                 |     | 175<br>235<br>39            | μA<br>nA        |
| Harmonic content of input signal (with 0.7-V <sub>PP</sub> amplitude): second component | LP/HP (sine wave)                        |                 |     | -25                         | dBc             |
| Voltage input high (V <sub>IH</sub> )   | BP (square wave)                         | 1               |     |                             | V               |
| Voltage input low (V <sub>IL</sub> )  | BP (square wave)                         |                 |     | 0.6                         | V               |

(1) Bypass input max voltage is the same as the maximum voltage provided for the I/O interface (IO.1P8V).

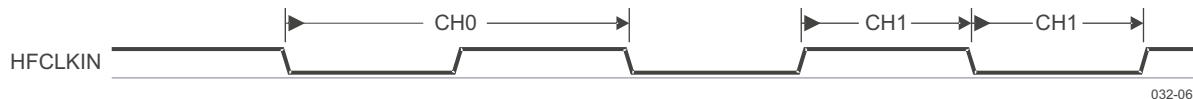
**Table 12-3** lists the input clock timing requirements of the HFCLKIN input clock when the source is a square wave.

**Table 12-3. HFCLKIN Square Input Clock Timing Requirements With Slicer in Bypass**

| Name | Parameter                 | Description                         | Min                          | Typ               | Max                          | Unit |
|------|---------------------------|-------------------------------------|------------------------------|-------------------|------------------------------|------|
| CH0  | 1/t <sub>C(HFCLKIN)</sub> | Frequency, HFCLKIN                  |                              | 19.2, 26, or 38.4 |                              | MHz  |
| CH1  | t <sub>W(HFCLKIN)</sub>   | Pulse duration, HFCLKIN low or high | 0.45*t <sub>C(HFCLKIN)</sub> |                   | 0.55*t <sub>C(HFCLKIN)</sub> | ns   |
| CH3  | t <sub>R(HFCLKIN)</sub>   | Rise time, HFCLKIN <sup>(1)</sup>   |                              |                   | 5                            | ns   |
| CH4  | t <sub>F(HFCLKIN)</sub>   | Fall time, HFCLKIN <sup>(1)</sup>   |                              |                   | 5                            | ns   |

(1) Default drive capability is 40 pF.

**Figure 12-4** shows the timing of the HFCLKIN squared input clock.



**Figure 12-4. HFCLKIN Squared Input Clock**

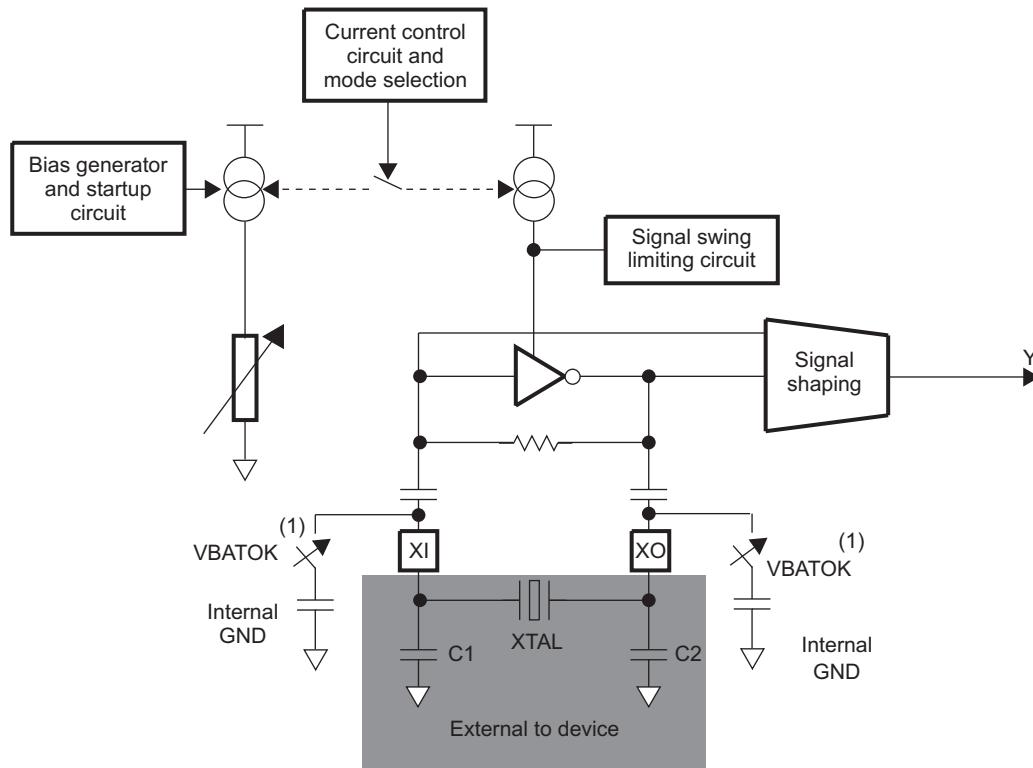
### 12.2.3 32-kHz Input Clock

A 32.768-kHz input clock (often abbreviated to 32-kHz) generates the clocks for the RTC. It has a low-jitter mode where the current consumption increases for lower jitter. It is possible to use the 32-kHz input clock with an external crystal or clock source. Depending on the mode, the 32K oscillator is configured as being either:

- An external 32.768-kHz crystal through the 32KXIN/32KXOUT balls (see [Figure 12-5](#)). This configuration is available for master mode only (for more information, see [Section 13, Timing Requirements and Switching Characteristics](#)).
- An external square or sine wave of 32.768 kHz through 32KXIN with amplitude of 1.8 or 1.85 V (see [Figure 12-7](#), [Figure 12-8](#), and [Figure 12-9](#)). This configuration is available for master and slave modes (for more information, see [Section 13, Timing Requirements and Switching Characteristics](#)).

### 12.2.3.1 External Crystal Description

[Figure 12-5](#) is a block diagram of the 32-kHz oscillator with crystal in master mode.



032-066

NOTE: Switches close by default and open only if register access enables very-low-power mode when  $V_{BAT} < 2.7$  V.

**Figure 12-5. 32-kHz Oscillator Block Diagram In Master Mode With Crystal**

CXIN and CXOUT represent the total capacitance of the printed circuit board (PCB) and components, excluding the crystal. Their values depend on the datasheet of the crystal, the internal capacitors, and the parallel capacitor. The frequency of the oscillations depends on the value of the capacitors. The crystal must be in the fundamental mode of operation and parallel resonant.

#### NOTE

For the values of CXIN and CXOUT, see [Table 15-1](#).

[Table 12-4](#) lists the required electrical constraints.

**Table 12-4. Crystal Electrical Characteristics**

| Parameter                             | Min | Typ    | Max  | Unit |
|---------------------------------------|-----|--------|------|------|
| Parallel resonance crystal frequency  |     | 32.768 |      | kHz  |
| Input voltage, $V_{in}$ (normal mode) | 1.0 | 1.3    | 1.55 | V    |

**Table 12-4. Crystal Electrical Characteristics (continued)**

| Parameter   | Min                                   | Typ | Max | Unit |
|---|---------------------------------------|-----|-----|------|
| Internal capacitor on each input (Cint)                                 |                                       | 10  |     | pF   |
| Parallel input capacitance (Cpin)                                       |                                       |     | 1   | pF   |
| Nominal load cap on each oscillator input CXIN and CXOUT <sup>(1)</sup> | CXIN = CXOUT = Cosc*2 – (Cint + Cpin) |     |     | pF   |
| Pin-to-pin capacitance  |                                       | 1.6 | 1.8 | pF   |
| Crystal ESR <sup>(2)</sup>  |                                       |     | 75  | kΩ   |
| Crystal shunt capacitance, C <sub>O</sub>                               |                                       |     | 1   | pF   |
| Crystal tolerance at room temperature, 25°C                             | -30                                   |     | 30  | ppm  |
| Crystal tolerance versus temperature range (-40°C to 85°C)              | -200                                  |     | 200 | ppm  |
| Maximum drive power   |                                       |     | 1   | μW   |
| Operating drive level   |                                       |     | 0.5 | μW   |

(1) Nominal load capacitor on each oscillator input defined as CXIN = CXOUT = Cosc\*2 – (Cint + Cpin). Cosc is the load capacitor defined in the crystal oscillator specification, Cint is the internal capacitor, and Cpin is the parallel input capacitor.

(2) The crystal motional resistance R<sub>m</sub> relates to the equivalent series resistance (ESR) by the following formula:

$$ESR = R_m \left( 1 + \frac{C_O}{C_L} \right)^2$$

Measured with the load capacitance specified by the crystal manufacturer. If CXIN = CXOUT = 10 pF, then C<sub>L</sub> = 5 pF. Parasitic capacitance from the package and board must also be considered.

When selecting a crystal, the system design must consider the temperature and aging characteristics of a crystal versus the user environment and expected lifetime of the system.

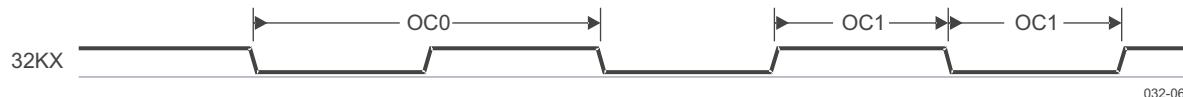
[Table 12-5](#) and [Table 12-6](#) list the switching characteristics of the oscillator and the input requirements of the 32.768-kHz input clock, respectively. [Figure 12-6](#) shows the crystal oscillator output in normal mode.

**Table 12-5. Base Oscillator Switching Characteristics**

| Name             | Parameter Description      |                          | Min | Typ    | Max | Unit |
|------------------|----------------------------|--------------------------|-----|--------|-----|------|
| f <sub>P</sub>   | Oscillation frequency      |                          |     | 32.768 |     | kHz  |
| t <sub>SX</sub>  | Startup time               |                          |     |        | 0.5 | s    |
| I <sub>DDA</sub> | Active current consumption | LOJIT <1:0> = 00         |     |        | 1.8 | μA   |
|                  |                            | LOJIT <1:0> = 11         |     |        | 8   | μA   |
| I <sub>DDQ</sub> | Current consumption        | Low battery mode (1.2 V) |     |        | 1   | μA   |
|                  |                            | Startup                  |     |        | 8   | μA   |

**Table 12-6. 32-kHz Crystal Input Clock Timing Requirements**

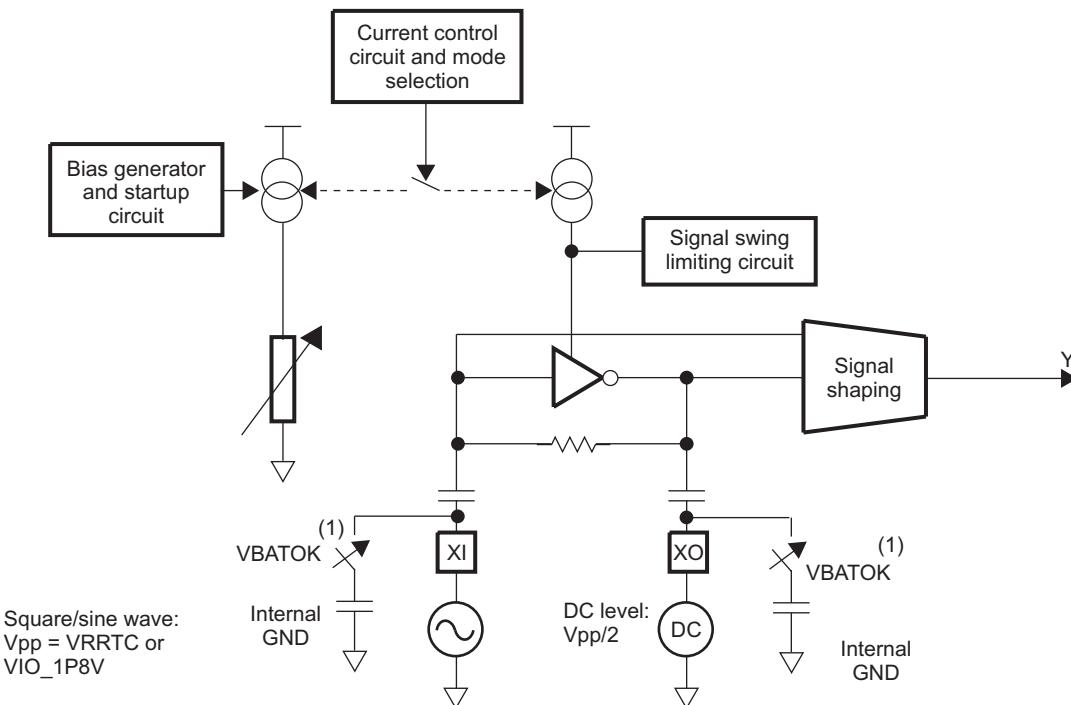
| Name | Parameter Description                     |                                    | Min                        | Typ    | Max                        | Unit |
|------|---|------------------------------------|----------------------------|--------|----------------------------|------|
| OC0  | 1/t <sub>C(32KHZ)</sub> Frequency, 32 kHz |                                    |                            | 32.768 |                            | kHz  |
| OC1  | t <sub>W(32KHZ)</sub>                     | Pulse duration, 32 kHz low or high | 0.40*t <sub>C(32KHZ)</sub> |        | 0.60*t <sub>C(32KHZ)</sub> | μs   |


**Figure 12-6. 32-kHz Crystal Input**

### 12.2.3.2 External Clock Description

Figure 12-7 and Figure 12-8 show the 32-kHz oscillator with a 32.768-kHz square or sine signal in master and slave modes. Figure 12-9 shows an external clock source when the oscillator is configured in bypass mode. Thus, there are three configurations:

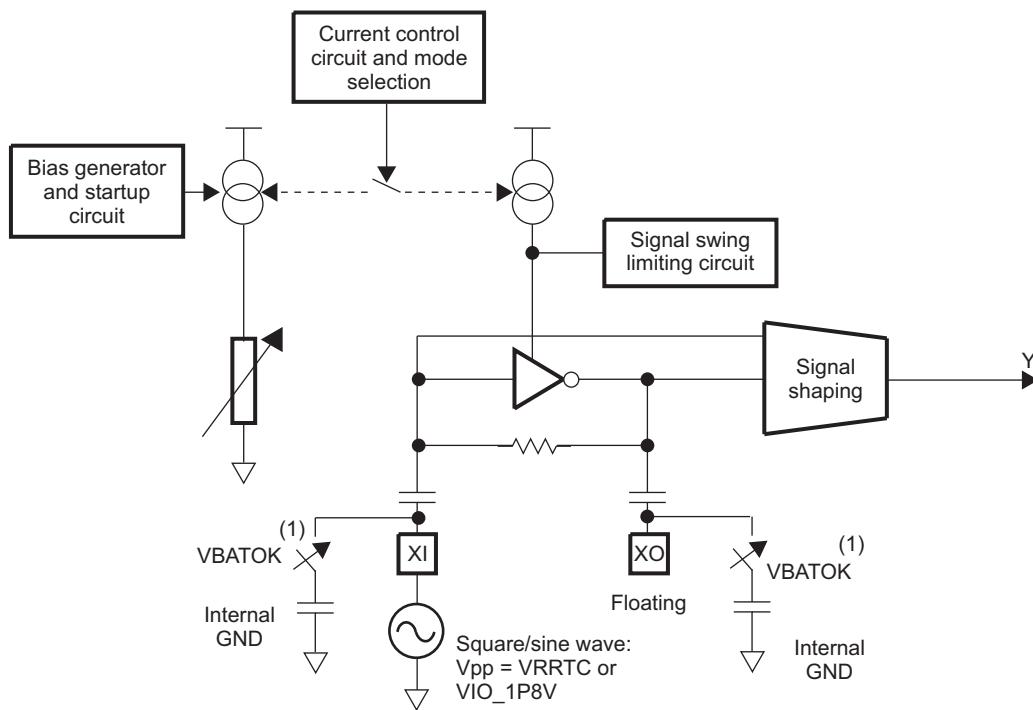
- A square- or sine-wave input can be applied to the 32KXIN pin with an amplitude of 1.85 or 1.8 V. The 32KXOUT pin can be driven to a dc value of the square- or sine-wave amplitude divided by 2. This configuration, shown in Figure 12-7, is recommended if a large load is applied on the 32KXOUT pin.
- A square- or sine-wave input can be applied to the 32KXIN pin with an amplitude of 1.85 or 1.8 V. The 32KXOUT pin can be left floating. This configuration, showed in Figure 12-8, is used if no charge is applied on the 32KXOUT pin.
- The oscillator is in bypass mode and a square-wave input can be applied to the 32KXIN pin with an amplitude of 1.8 V. The 32KXOUT pin can be left floating. This configuration, shown in Figure 12-9, is used if the oscillator is in bypass mode.



032-068

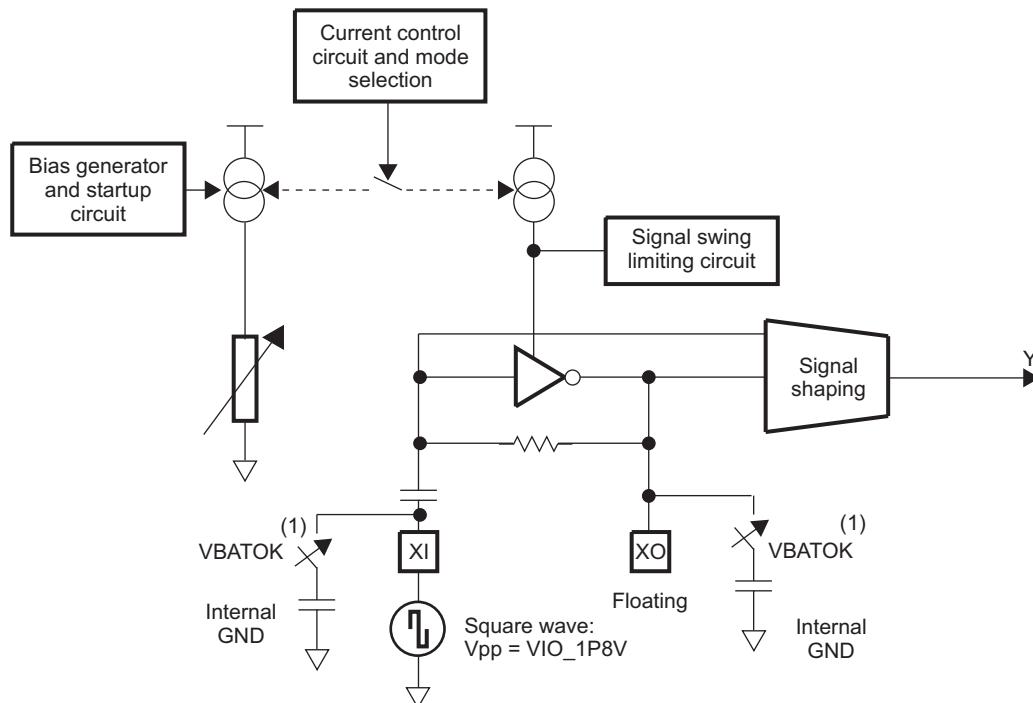
(1) Switches close by default and open only if register access enables very-low-power mode when  $V_{BAT} < 2.7$  V.

**Figure 12-7. 32-kHz Oscillator Block Diagram Without Crystal Option 1**



(1) Switches close by default and open only if register access enables very-low-power mode when  $V_{BAT} < 2.7$  V.

**Figure 12-8. 32-kHz Oscillator Block Diagram Without Crystal Option 2**



(1) Switches close by default and open only if register access enables very-low-power mode when  $V_{BAT} < 2.7$  V.

**Figure 12-9. 32-kHz Oscillator in Bypass Mode Block Diagram Without Crystal Option 3**

**Table 12-7** lists the electrical constraints required by the 32-kHz input square- or sine-wave clock used.

**Table 12-7. 32-kHz Input Square- or Sine-Wave Clock Source Electrical Characteristics**

| Name            | Parameter Description  | Min | Typ                | Max | Unit |
|-----------------|--|-----|--------------------|-----|------|
| f               | Frequency  |     | 32.768             |     | kHz  |
| C <sub>I</sub>  | Input capacitance  |     | 35                 |     | pF   |
| C <sub>FI</sub> | On-chip foot capacitance to GND on each input (see <a href="#">Figure 12-7</a> , <a href="#">Figure 12-8</a> , and <a href="#">Figure 12-9</a> ) |     | 10                 |     | pF   |
| V <sub>PP</sub> | Square-/sine-wave amplitude in bypass mode or not  |     | 1.8 <sup>(1)</sup> |     | V    |
| V <sub>IH</sub> | Voltage input high, square wave in bypass mode   | 0.8 |                    |     | V    |
| V <sub>IL</sub> | Voltage input low, square wave in bypass mode  |     |                    | 0.6 | V    |

(1) Bypass input maximum voltage is the same as the maximum voltage provided for the I/O interface.

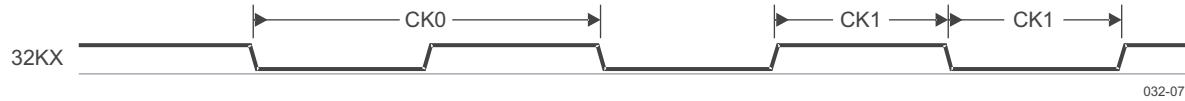
[Table 12-8](#) lists the input requirements of the 32-kHz square-wave input clock.

**Table 12-8. 32-kHz Square-Wave Input Clock Source Timing Requirements**

| Name | Parameter               | Description                        | Min                        | Typ    | Max                        | Unit |
|------|-------------------------|------------------------------------|----------------------------|--------|----------------------------|------|
| CK0  | 1/t <sub>C(32KHZ)</sub> | Frequency, 32 kHz                  |                            | 32.768 |                            | MHz  |
| CK1  | t <sub>W(32KHZ)</sub>   | Pulse duration, 32 kHz low or high | 0.45*t <sub>C(32KHZ)</sub> |        | 0.55*t <sub>C(32KHZ)</sub> | μs   |
| CK3  | t <sub>R(32KHZ)</sub>   | Rise time, 32 kHz <sup>(1)</sup>   |                            |        | 0.1*t <sub>C(32KHZ)</sub>  | μs   |
| CK4  | t <sub>F(32KHZ)</sub>   | Fall time, 32 kHz <sup>(1)</sup>   |                            |        | 0.1*t <sub>C(32KHZ)</sub>  | μs   |

(1) The capacitive load is 30 pF.

[Figure 12-10](#) shows the timing of the 32-kHz square- or sine-wave input clock.



032-071

**Figure 12-10. 32-kHz Square- or Sine-Wave Input Clock**

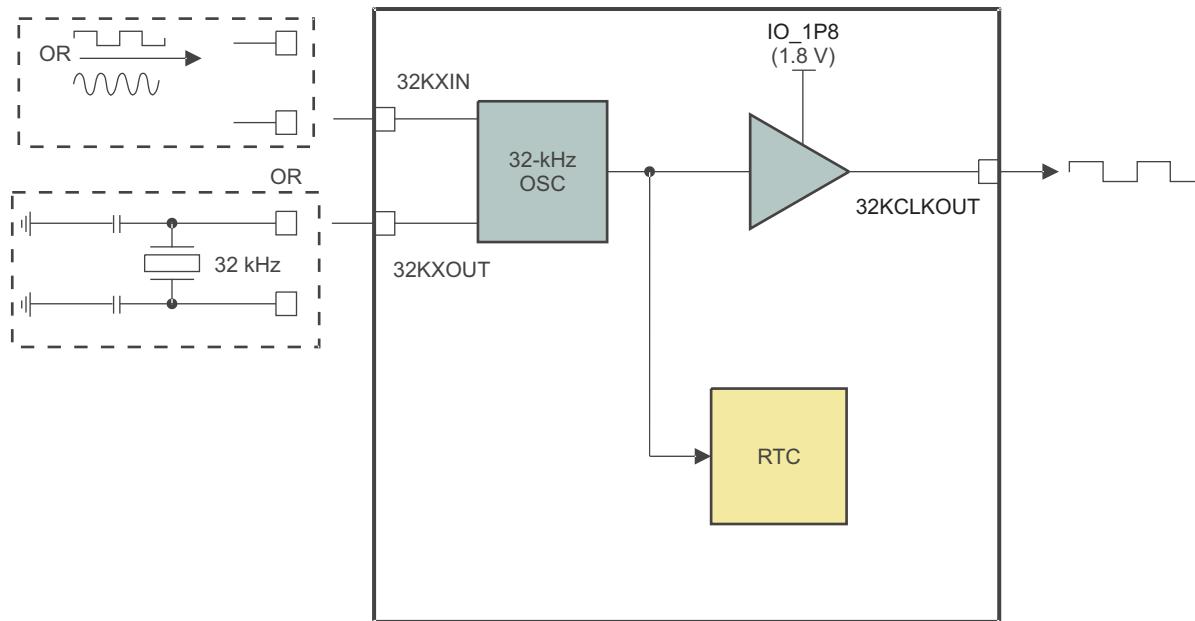
## 12.3 Output Clock Specifications

The TPS65950 provides two output clocks:

- 32KCLKOUT
- HFCLKOUT

### 12.3.1 32KCLKOUT Output Clock

[Figure 12-11](#) is a block diagram of the 32.768-kHz clock output.



032-072

**Figure 12-11. 32.768-kHz Clock Output Block Diagram**

The TPS65950 has an internal 32.768-kHz oscillator connected to an external 32.768-kHz crystal through the 32KXIN/32KXOUT balls or an external digital 32.768-kHz clock through the 32KXIN input (see [Figure 12-11](#)). The TPS65950 also generates a 32.768-kHz digital clock through the 32KCLKOUT pin and can broadcast it externally to the application processor or any other devices. The 32KCLKOUT clock is broadcast by default in the TPS65950 active mode, but can be disabled if it is not used.

The 32.768-kHz clock (or signal) also clocks the RTC embedded in the TPS65950. The RTC is not enabled by default. The host processor must set the correct date and time and enable the RTC.

The 32KCLKOUT output buffer can drive several devices (up to a 40-pF load). At startup, the 32.768-kHz output clock (32KCLKOUT) must be stabilized (frequency/duty cycle) before the signal output. Depending on the startup condition, this can delay the startup sequence.

[Table 12-9](#) lists the electrical characteristics of the 32KCLKOUT output clock.

**Table 12-9. 32KCLKOUT Output Clock Electrical Characteristics**

| Name             | Parameter Description   | Min                     | Typ                | Max              | Unit |
|------------------|---|-------------------------|--------------------|------------------|------|
| f                | Frequency   |                         | 32.768             |                  | kHz  |
| C <sub>L</sub>   | Load capacitance  |                         |                    | 40               | pF   |
| V <sub>OUT</sub> | Output clock voltage, depending on output reference level IO_1P8 (see <a href="#">Section 2</a> ) |                         | 1.8 <sup>(1)</sup> |                  | V    |
| V <sub>OH</sub>  | Voltage output high   | V <sub>OUT</sub> – 0.45 |                    | V <sub>OUT</sub> | V    |
| V <sub>OL</sub>  | Voltage output low  | 0                       |                    | 0.45             | V    |

(1) The output voltage depends on output reference level, which is IO\_1P8 (see [Section 2, Terminal Description](#)).

[Table 12-10](#) lists the timing characteristics of the 32KCLKOUT output clock. [Figure 12-12](#) shows the waveform of the 32KCLKOUT output clock.

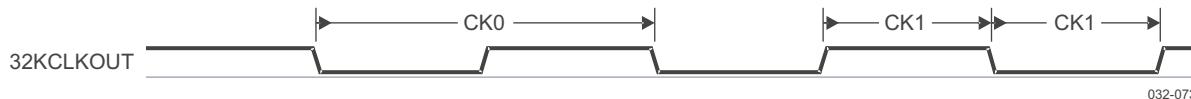
**Table 12-10. 32KCLKOUT Output Clock Switching Characteristics**

| Name | Parameter                   | Description                           | Min                            | Typ    | Max                            | Unit |
|------|-----------------------------|---------------------------------------|--------------------------------|--------|--------------------------------|------|
| CK0  | 1/t <sub>C(32KCLKOUT)</sub> | Frequency                             |                                | 32.768 |                                | MHz  |
| CK1  | t <sub>W(32KCLKOUT)</sub>   | Pulse duration, 32KCLKOUT low or high | 0.40*t <sub>C(32KCLKOUT)</sub> |        | 0.60*t <sub>C(32KCLKOUT)</sub> | ns   |

**Table 12-10. 32KCLKOUT Output Clock Switching Characteristics (continued)**

| Name | Parameter               | Description                         | Min | Typ | Max | Unit |
|------|-------------------------|-------------------------------------|-----|-----|-----|------|
| CK2  | $t_R(32\text{KCLKOUT})$ | Rise time, 32KCLKOUT <sup>(1)</sup> |     |     | 16  | ns   |
| CK3  | $t_F(32\text{KCLKOUT})$ | Fall time, 32KCLKOUT <sup>(1)</sup> |     |     | 16  | ns   |

(1) The output capacitive load is 30 pF.

**Figure 12-12. 32KCLKOUT Output Clock**

### 12.3.2 HFCLKOUT Output Clock

Table 12-11 lists the electrical characteristics of the HFCLKOUT output clock.

**Table 12-11. HFCLKOUT Output Clock Electrical Characteristics**

| Name      | Parameter Description  | Min               | Typ                | Max       | Unit |
|-----------|--|-------------------|--------------------|-----------|------|
| f         | Frequency  | 19.2, 26, or 38.4 |                    |           | MHz  |
| $C_L$     | Load capacitance   |                   |                    | 30        | pF   |
| $V_{OUT}$ | Output clock voltage, depending on output reference level IO_1P8 (see Section 2) |                   | 1.8 <sup>(1)</sup> |           | V    |
| $V_{OH}$  | Voltage output high  | $V_{OUT} - 0.45$  |                    | $V_{OUT}$ | V    |
| $V_{OL}$  | Voltage output low   | 0                 |                    | 0.45      | V    |

(1) The output voltage depends on output reference level, which is IO\_1P8 (see Section 2).

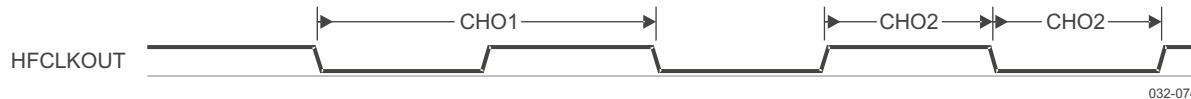
Table 12-12 lists the timing characteristics of the HFCLKOUT output clock.

**Table 12-12. HFCLKOUT Output Clock Switching Characteristics**

| Name | Parameter                | Description                          | Min                         | Typ | Max                         | Unit |
|------|--------------------------|--------------------------------------|-----------------------------|-----|-----------------------------|------|
| CHO1 | $1/t_C(\text{HFCLKOUT})$ | Frequency                            | 19.2, 26, or 38.4           |     |                             | MHz  |
| CHO2 | $t_W(\text{HFCLKOUT})$   | Pulse duration, HFCLKOUT low or high | $0.40*t_C(\text{HFCLKOUT})$ |     | $0.60*t_C(\text{HFCLKOUT})$ | ns   |
| CHO3 | $t_R(\text{HFCLKOUT})$   | Rise time, HFCLKOUT <sup>(1)</sup>   |                             |     | 2.6                         | ns   |
| CHO4 | $t_F(\text{HFCLKOUT})$   | Fall time, HFCLKOUT <sup>(1)</sup>   |                             |     | 2.6                         | ns   |

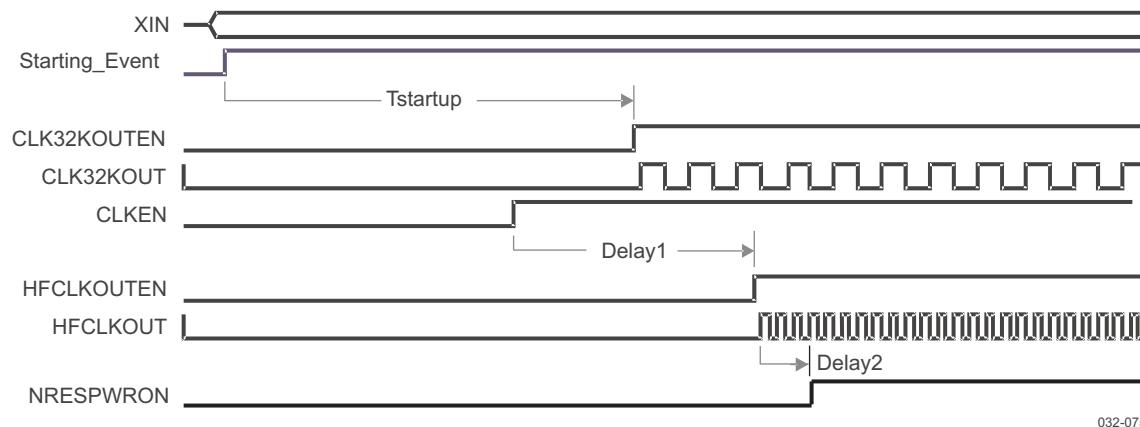
(1) The output capacitive load is 30 pF.

Figure 12-13 shows the waveform of the HFCLKOUT output clock.

**Figure 12-13. HFCLKOUT Output Clock**

### 12.3.3 Output Clock Stabilization Time

Figure 12-14 shows the 32KCLKOUT and HFCLKOUT clock stabilization time.

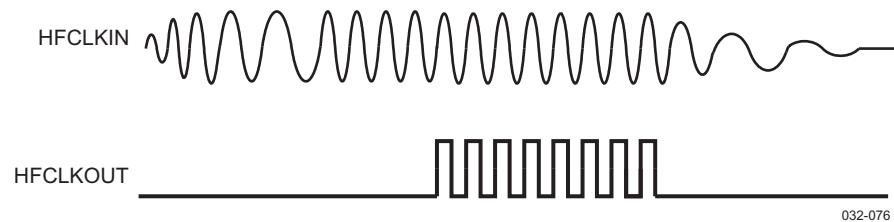


NOTE: Tstartup, Delay1, and Delay2 depend on the boot mode (see [Section 4.5, Power Management](#)).

NOTE: Ensure that the high frequency oscillator start-up time is in spec for the boot mode used. During power-up the internal delay, Delay1 above is fixed (5.2 ms and 5.3 ms depending on boot mode). The start-up time for the oscillator must be less than the fixed delay.

**Figure 12-14. 32KCLKOUT and HFCLKOUT Clock Stabilization Time**

Figure 12-15 shows the behavior of HFLCKOUT.



**Figure 12-15. HFCLKOUT Behavior**

## 13 Timing Requirements and Switching Characteristics

### 13.1 Timing Parameters

The timing parameter symbols used in the timing requirement and switching characteristic tables are created in accordance with JEDEC Standard 100. To shorten the symbols, some pin names and other related terminologies are abbreviated as shown in [Table 13-1](#).

**Table 13-1. Timing Parameters**

| Lowercase Subscripts |  |
|----------------------|--|
| Symbol               | Parameter                              |
| c                    | Cycle time (period)                    |
| d                    | Delay time                             |
| dis                  | Disable time                           |
| en                   | Enable time                            |
| h                    | Hold time                              |
| su                   | Setup time                             |
| START                | Start-bit                              |
| t                    | Transition time                        |
| v                    | Valid time                             |
| w                    | Pulse duration (width)                 |
| X                    | Unknown, changing, or don't care level |
| H                    | High                                   |
| L                    | Low                                    |
| V                    | Valid                                  |
| IV                   | Invalid                                |
| AE                   | Active edge                            |
| FE                   | First edge                             |
| LE                   | Last edge                              |
| Z                    | High impedance                         |

### 13.2 Target Frequencies

[Table 13-2](#) assumes testing over the recommended operating conditions.

**Table 13-2. TPS65950 Interface Target Frequencies**

| I/O Interface                                       | Interface Designation      | Target Frequency      |          |
|---|----------------------------|-----------------------|----------|
|   |                            | 1.5 V                 |          |
| SmartReflex I <sup>2</sup> C<br>GP I <sup>2</sup> C | I <sup>2</sup> C interface | Slave HS mode         | 3.6 Mbps |
|   |                            | Slave fast-speed mode | 400 kbps |
|   |                            | Slave standard mode   | 100 kbps |
| USB   | USB                        | HS                    | 480 Mbps |
|   |                            | FS                    | 12 Mbps  |
|   |                            | LS                    | 1.5 Mbps |
| JTAG  | RealView® ICE tool         |                       | 30 MHz   |
|   | XDS560 and XDS510 tools    |                       | 30 MHz   |
|   | Lauterbach™ tool           |                       | 30 MHz   |

**Table 13-2. TPS65950 Interface Target Frequencies (continued)**

| I/O Interface                 | Interface Designation | Target Frequency                 |
|-------------------------------|-----------------------|----------------------------------|
|                               |                       | 1.5 V                            |
| TDM/I2S                       | Inter-IC sound (I2S™) | 1/(64 * Fs) <sup>(1)</sup>       |
|                               | Right-justified       | 1/(64 * Fs) <sup>(1)</sup>       |
|                               | Left-justified        | 1/(64 * Fs) <sup>(1)</sup>       |
|                               | TDM                   | 1/(128 * Fs) <sup>(1)</sup>      |
| Voice/Bluetooth PCM interface | PCM (master mode)     | 1/(65 * Fs) <sup>(2)</sup>       |
|                               | PCM (slave mode)      | 1/(33 to 65 * Fs) <sup>(2)</sup> |

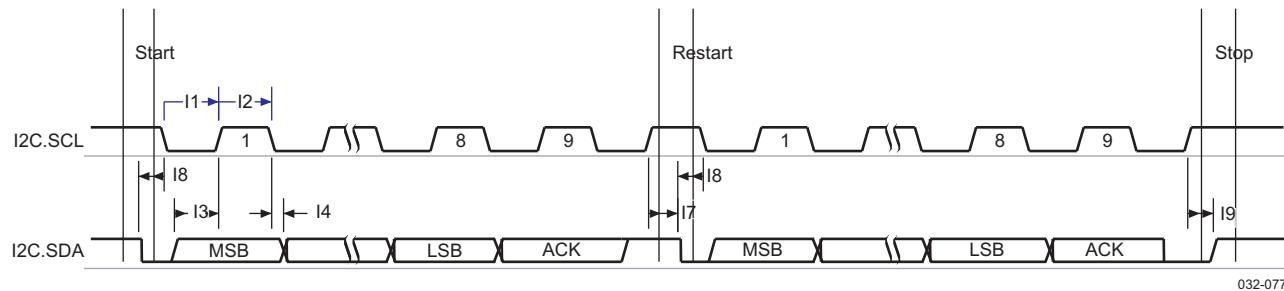
(1)  $F_s = 8$  to 48 kHz; 96 kHz for RX path only (TDM/I2S interface)

(2)  $F_s = 8$  or 16 kHz (voice/Bluetooth PCM interface)

### 13.3 I<sup>2</sup>C Timing

The TPS65950 provides two I<sup>2</sup>C HS slave interfaces (one for GP and one for SmartReflex). These interfaces support the standard mode (100 kbps), fast mode (400 kbps), and HS mode (3.4 Mbps). The GP I<sup>2</sup>C module embeds four slave hard-coded addresses (ID1 = 48h, ID2 = 49h, ID3 = 4Ah, and ID4 = 4Bh). The SmartReflex I<sup>2</sup>C module uses one slave hard-coded address (ID5). Master mode is not supported.

Table 13-3 and Table 13-4 assume testing over the recommended operating conditions (see Figure 13-1).


**Figure 13-1. I<sup>2</sup>C Interface—Transmit and Receive in Slave Mode**
**Table 13-3. I<sup>2</sup>C Interface Timing Requirements<sup>(1) (2)</sup>**

| Notation                     | Parameter           |                                   | Min | Max | Unit |
|------------------------------|---------------------|-----------------------------------|-----|-----|------|
| <b>Slave HS Mode</b>         |                     |                                   |     |     |      |
| I3                           | $t_{su}(SDA-SCLH)$  | Setup time, SDA valid to SCL high | 10  |     | ns   |
| I4                           | $t_h(SCLL-SDA)$     | Hold time, SDA valid from SCL low | 0   | 70  | ns   |
| I7                           | $t_{su}(SCLH-SDAL)$ | Setup time, SCL high to SDA low   | 160 |     | ns   |
| I8                           | $t_h(SDAL-SCLL)$    | Hold time, SCL low from SDA low   | 160 |     | ns   |
| I9                           | $t_{su}(SDAH-SCLH)$ | Setup time, SDA high to SCL high  | 160 |     | ns   |
| <b>Slave Fast-Speed Mode</b> |                     |                                   |     |     |      |
| I3                           | $t_{su}(SDA-SCLH)$  | Setup time, SDA valid to SCL high | 100 |     | ns   |
| I4                           | $t_h(SCLL-SDA)$     | Hold time, SDA valid from SCL low | 0   | 0.9 | ns   |
| I7                           | $t_{su}(SCLH-SDAL)$ | Setup time, SCL high to SDA low   | 0.6 |     | ns   |
| I8                           | $t_h(SDAL-SCLL)$    | Hold time, SCL low from SDA low   | 0.6 |     | ns   |
| I9                           | $t_{su}(SDAH-SCLH)$ | Setup time, SDA high to SCL high  | 0.6 |     | ns   |

(1) The input timing requirements are given by considering a rising or falling time of:

80 ns in HS mode (3.4 Mbps)

300 ns in fast-speed mode (400 Kbps)

1000 ns in standard mode (100 Kbps)

(2) SDA equals I2C.SR.SDA or I2C.CNTL.SDA  
SCL equals I2C.SR.SCL or I2C.CNTL.SCL

**Table 13-3. I<sup>2</sup>C Interface Timing Requirements (continued)**

| Notation                   | Parameter                  |                                   | Min | Max | Unit |
|----------------------------|----------------------------|-----------------------------------|-----|-----|------|
| <b>Slave Standard Mode</b> |                            |                                   |     |     |      |
| I3                         | $t_{su}(\text{SDA-SCLH})$  | Setup time, SDA valid to SCL high | 250 |     | ns   |
| I4                         | $t_h(\text{SCLL-SDA})$     | Hold time, SDA valid from SCL low | 0   |     | ns   |
| I7                         | $t_{su}(\text{SCLH-SDAL})$ | Setup time, SCL high to SDA low   | 4.7 |     | ns   |
| I8                         | $t_h(\text{SDAL-SCLL})$    | Hold time, SCL low from SDA low   | 4   |     | ns   |
| I9                         | $t_{su}(\text{SDAH-SCLH})$ | Setup time, SDA high to SCL high  | 4   |     | ns   |

**Table 13-4. I<sup>2</sup>C Interface Switching Requirements<sup>(1)</sup> (2)**

| Notation                     | Parameter          |                          | Min                | Max | Unit |
|------------------------------|--------------------|--------------------------|--------------------|-----|------|
| <b>Slave HS Mode</b>         |                    |                          |                    |     |      |
| I1                           | $t_w(\text{SCLL})$ | Pulse duration, SCL low  | 160                |     | ns   |
| I2                           | $t_w(\text{SCLH})$ | Pulse duration, SCL high | 60                 |     | ns   |
| <b>Slave Fast-Speed Mode</b> |                    |                          |                    |     |      |
| I1                           | $t_w(\text{SCLL})$ | Pulse duration, SCL low  | 1.3 <sup>(3)</sup> |     | μs   |
| I2                           | $t_w(\text{SCLH})$ | Pulse duration, SCL high | 0.6                |     | μs   |
| <b>Slave Standard Mode</b>   |                    |                          |                    |     |      |
| I1                           | $t_w(\text{SCLL})$ | Pulse duration, SCL low  | 4.7                |     | μs   |
| I2                           | $t_w(\text{SCLH})$ | Pulse duration, SCL high | 4                  |     | μs   |

- (1) The capacitive load is:
  - 100 pF in HS mode (3.4 Mbps)
  - 400 pF in fast-speed mode (400 Kbps)
  - 400 pF in standard mode (100 Kbps)
- (2) SDA equals I2C.SR.SDA or I2C.CNTL.SDA  
SCL equals I2C.SR.SCL or I2C.CNTL.SCL
- (3) SCL low timing for slave fast-speed mode is compatible with 0.79 μs.

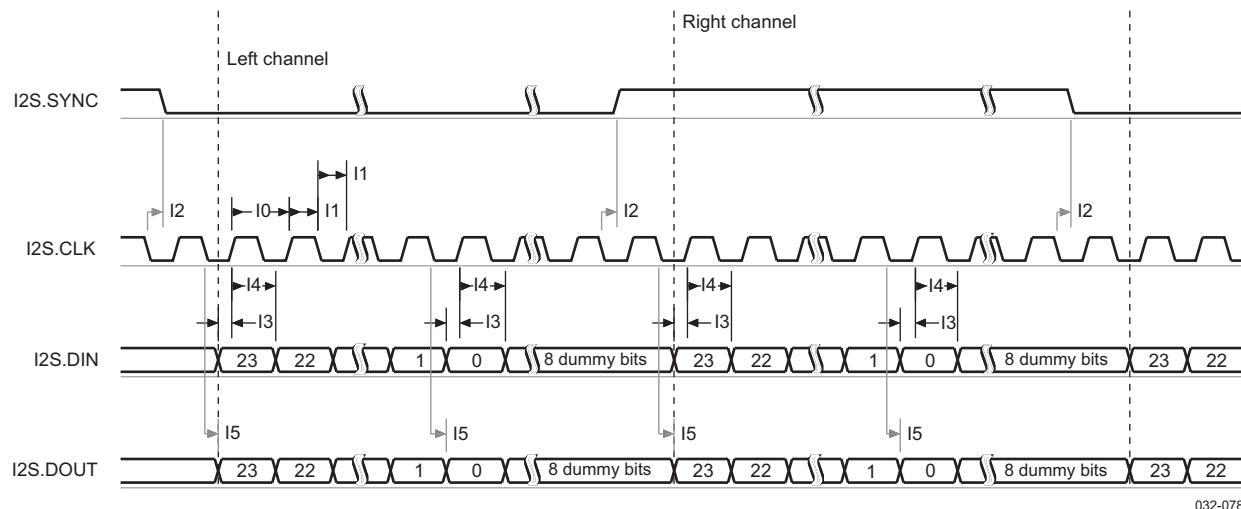
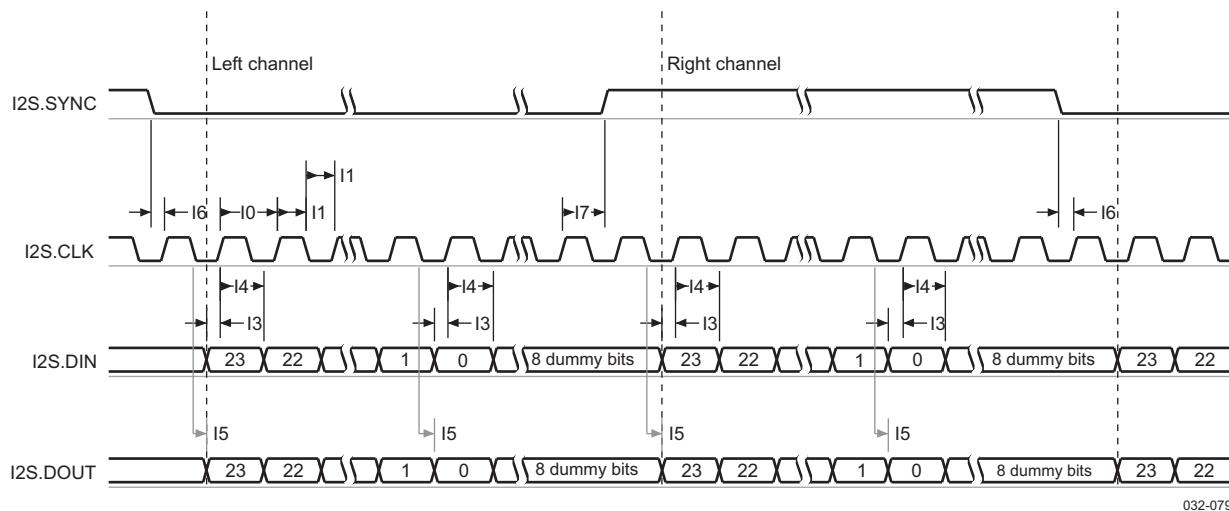
### 13.4 Audio Interface: TDM/I2S Protocol

The TPS65950 acts as a master for the TDM and I2S interface or as a slave only for the I2S interface. If the TPS65950 is the master, it must provide frame synchronization (TDM/I2S\_SYNC) and bit clock (TDM/I2S\_CLK) to the host processor. If the TPS65950 is the slave, it receives frame synchronization and bit clock.

The TPS65950 supports the I2S, TDM, left-justified, and right-justified data formats, but does not support TDM slave mode.

#### 13.4.1 I2S Right- and Left-Justified Data Format

Table 13-5 and Table 13-6 assume testing over the recommended operating conditions (see Figure 13-2 and Figure 13-3).


**Figure 13-2. I2S Interface—I2S Master Mode**

**Figure 13-3. I2S Interface—I2S Slave Mode**

The timing requirements in [Table 13-5](#) are valid on the following conditions of input slew and output load:

- Rise and fall time range of inputs (SYNC, DIN) is  $t_R/t_F = 1.0 \text{ ns}/6.5 \text{ ns}$
- Capacitance load range of outputs (CLK, SYNC, DOUT) is  $C_{\text{Load}} = 1 \text{ pF}/30 \text{ pF}$

The input timing requirements in [Table 13-5](#) are given by considering a rising or falling time of 6.5 ns.

**Table 13-5. I2S Interface—Timing Requirements**

| Notation           | Parameter                        |  |  | Min          | Max        | Unit |
|--------------------|----------------------------------|--|--|--------------|------------|------|
| <b>Master Mode</b> |                                  |  |  |              |            |      |
| I3                 | $t_{\text{su}}(\text{DIN-CLKH})$ | Setup time, I2S.DIN valid to I2S.CLK high2         |  | 25           |            | ns   |
| I4                 | $t_h(\text{DIN-CLKH})$           | Hold time, I2S.DIN valid from I2S.CLK high.        |  | 0            |            | ns   |
| <b>Slave Mode</b>  |                                  |  |  |              |            |      |
| I0                 | $t_c(\text{CLK})$                | Cycle time, I2S.CLK <sup>(1)</sup>                 |  | $1/64 * F_s$ |            | ns   |
| I1                 | $t_w(\text{CLK})$                | Pulse duration, I2S.CLK high or low <sup>(2)</sup> |  | $0.45 * P$   | $0.55 * P$ | ns   |

(1)  $F_s = 8 \text{ to } 48 \text{ kHz}; 96 \text{ kHz for RX path only}$

(2)  $P = I2S.\text{CLK}$  period

**Table 13-5. I2S Interface—Timing Requirements (continued)**

| Notation | Parameter                  |   | Min | Max | Unit |
|----------|----------------------------|---|-----|-----|------|
| I3       | $t_{su}(\text{DIN-CLKH})$  | Setup time, I2S.DIN valid to I2S.CLK high   | 5   |     | ns   |
| I4       | $t_h(\text{DIN-CLKH})$     | Hold time, I2S.DIN valid from I2S.CLK high. | 5   |     | ns   |
| I6       | $t_{su}(\text{SYNC-CLKH})$ | Setup time, I2S.SYNC valid to I2S.CLK high  | 5   |     | ns   |
| I7       | $t_h(\text{SYNC-CLKH})$    | Hold time, I2S.SYNC valid from I2S.CLK high | 5   |     | ns   |

The capacitive load for [Table 13-6](#) is 7 pF.

**Table 13-6. I2S Interface—Switching Characteristics**

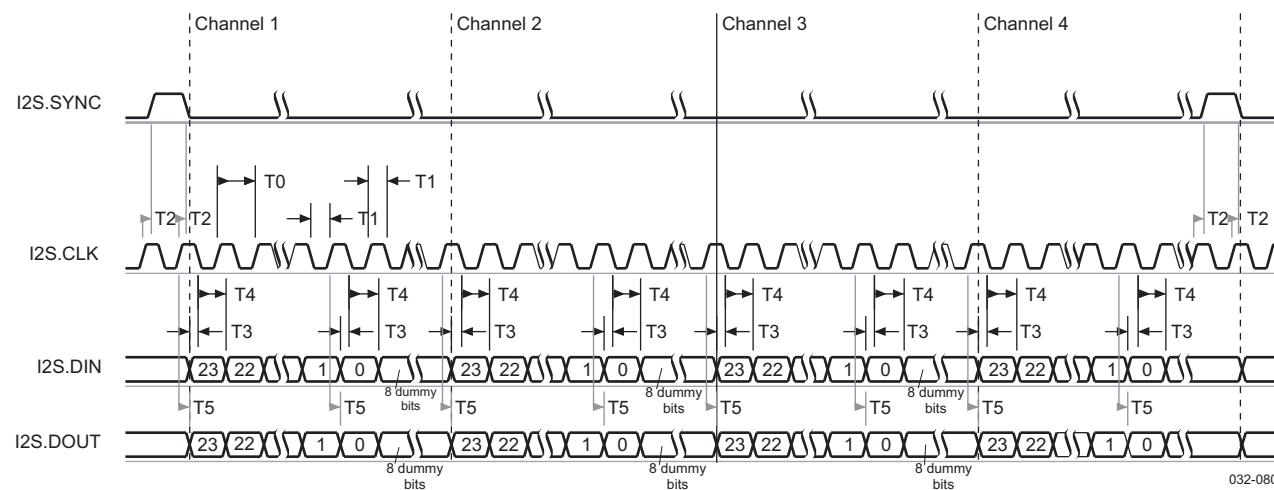
| Notation           | Parameter               |   | Min          | Max        | Unit |
|--------------------|-------------------------|---|--------------|------------|------|
| <b>Master Mode</b> |                         |   |              |            |      |
| I0                 | $t_c(\text{CLK})$       | Cycle time, I2S.CLK <sup>(1)</sup>                      | $1/64 * F_s$ |            | ns   |
| I1                 | $t_w(\text{CLK})$       | Pulse duration, I2S.CLK high or low <sup>(2)</sup>      | $0.45 * P$   | $0.55 * P$ | ns   |
| I2                 | $t_d(\text{CLKL-SYNC})$ | Delay time, I2S.CLK falling edge to I2S.SYNC transition | -10          | 10         | ns   |
| I5                 | $t_d(\text{CLKL-DOUT})$ | Delay time, I2S.CLK falling edge to I2S.DOUT transition | -10          | 10         | ns   |
| <b>Slave Mode</b>  |                         |   |              |            |      |
| I5                 | $t_d(\text{CLKL-DOUT})$ | Delay time, I2S.CLK falling edge to I2S.DOUT transition | 0            | 20         | ns   |

(1)  $F_s = 8$  to 48 kHz; 96 kHz for RX path only

(2)  $P = \text{I2S.CLK}$  period

### 13.4.2 TDM Data Format

[Table 13-7](#) and [Table 13-8](#) assume testing over the recommended operating conditions (see [Figure 13-4](#)).

**Figure 13-4. TDM Interface—TDM Master Mode**

The timing requirements in [Table 13-7](#) are valid on the following conditions of input slew and output load:

- Rise and fall time range of inputs (SYNC, DIN) is  $t_R/t_F = 1.0$  ns/6.5 ns
- Capacitance load range of outputs (CLK, SYNC, DOUT) is  $C_{\text{Load}} = 1$  pF/30 pF

[Table 13-7](#) lists the master mode timing requirements for the TDM interface.

**Table 13-7. TDM Interface Master Mode Timing Requirements**

| Notation | Parameter                 |  | Min | Max | Unit |
|----------|---------------------------|--|-----|-----|------|
| T3       | $t_{su}(\text{DIN-CLKH})$ | Setup time, TDM.DIN valid to TDM.CLK high  | 25  |     | ns   |
| T4       | $t_h(\text{DIN-CLKH})$    | Hold time, TDM.DIN valid from TDM.CLK high | 0   |     | ns   |

**Table 13-8** lists the master mode switching characteristics of the TDM interface.

**Table 13-8. TDM Interface Master Mode Switching Characteristics**

| Notation | Parameter               |  | Min       | Max    | Unit |
|----------|-------------------------|--|-----------|--------|------|
| T0       | $t_c(\text{CLK})$       | Cycle time, TDM.CLK <sup>(1)</sup>                     | 1/64 * Fs |        | ns   |
| T1       | $t_w(\text{CLK})$       | Pulse duration, TDM.CLK high or low <sup>(2)</sup>     | 0.45*P    | 0.55*P | ns   |
| T2       | $t_d(\text{CLKL-SYNC})$ | Delay time, TDM.CLK rising edge to TDM.SYNC transition | -10       | 10     | ns   |
| T5       | $t_d(\text{CLKL-DOUT})$ | Delay time, TDM.CLK rising edge to TDM.DOUT transition | -10       | 12     | ns   |

(1)  $F_s = 8$  to  $48$  kHz;  $96$  kHz for RX path only

(2) P = TDM.CLK period

### 13.5 Voice/Bluetooth PCM Interfaces

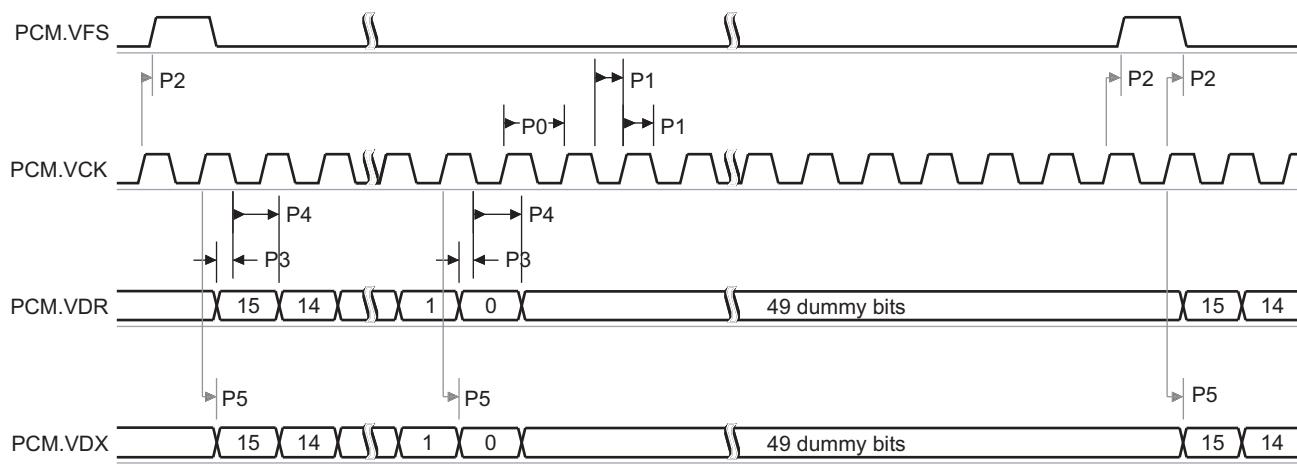
The PCM interface transfers voice data at 8-kHz (default narrowband mode) or 16-kHz (wideband mode) sample rates. The CM interface can act as a slave or master. No PLL is used for the PCM interface, but dividers are used to derive the 8- or 16-kHz clock from HFCLKIN (only when HFCLKIN = 26 MHz). If the system master clock is not 26 MHz, the voice PCM interface is not available.

For the Bluetooth interface, the PCM is supported to transfer voice data to the Bluetooth chip at 8-kHz (default narrowband mode) or 16-kHz sample rate.

The TPS65950 acts as a master for the Bluetooth interface. The frame synchronization and the bit clock are shared from the voice PCM interface. If the system master clock is not 26 MHz, the Bluetooth interface is not available.

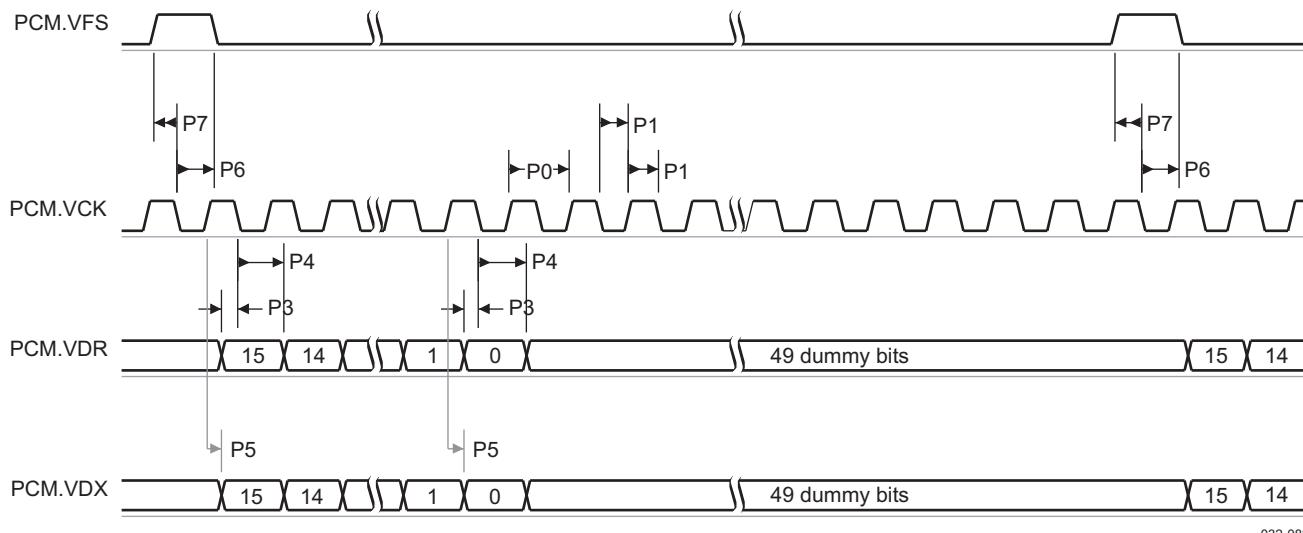
Two modes are available for the PCM interfaces: mode 1 (writing on the PCM\_VCK rising edge) and mode 2 (writing on the PCM\_VCK falling edge).

**Table 13-9** and **Table 13-10** assume testing over the recommended operating conditions (see [Figure 13-5](#) and [Figure 13-6](#)).



032-081

**Figure 13-5. Voice/BT PCM Interface—Master Mode (Mode 1)**

**Figure 13-6. Voice PCM Interface—Slave Mode (Mode 1)**

The timing requirements in [Table 13-9](#) are valid on the following conditions of input slew and output load:

- Rise and fall time range of inputs (SYNC, DIN) is  $t_R/t_F = 1.0 \text{ ns}/6.5 \text{ ns}$
- Capacitance load range of outputs (CLK, SYNC, DOUT) is  $C_{\text{Load}} = 1 \text{ pF}/30 \text{ pF}$

[Table 13-9](#) lists the timing requirements for the voice PCM interface, mode 1.

**Table 13-9. Voice PCM Interface Timing Requirements (Mode 1)**

| Notation                               | Parameter                       |  | Min               | Max      | Unit |
|--|---------------------------------|--|-------------------|----------|------|
| <b>Voice/Bluetooth PCM Master Mode</b> |                                 |  |                   |          |      |
| P3                                     | $t_{\text{su}}(\text{VDR-VCK})$ | Setup time, PCM.VDR valid to PCM. VCK transition <sup>(1)</sup>  | 30                |          | ns   |
| P4                                     | $t_h(\text{VDR-VCK})$           | Hold time, PCM.VDR valid from PCM.VCK transition <sup>(1)</sup>  | 0                 |          | ns   |
| <b>Voice PCM Slave Mode</b>            |                                 |  |                   |          |      |
| P0                                     | $t_c(\text{VCK})$               | Cycle time, PCM.VCK <sup>(2)</sup>                               | 1/(33 to 65 * Fs) |          | ns   |
| P1                                     | $t_w(\text{VCK})$               | Pulse duration, PCM.VCK high or low <sup>(3)</sup>               | 0.45 * P          | 0.55 * P | ns   |
| P3                                     | $t_{\text{su}}(\text{VDR-VCK})$ | Setup time, PCM.VDR valid to PCM. VCK transition <sup>(1)</sup>  | 10                |          | ns   |
| P4                                     | $t_h(\text{VDR-VCK})$           | Hold time, PCM.VDR valid from PCM. VCK transition <sup>(1)</sup> | 5                 |          | ns   |
| P6                                     | $t_h(\text{VFS-VCK})$           | Hold time, PCM.VFS valid from PCM.VCK transition <sup>(1)</sup>  | 5                 |          | ns   |
| P7                                     | $t_{\text{SU}}(\text{VFS-VCK})$ | Setup time, PCM.VFS valid to PCM. VCK transition <sup>(1)</sup>  | 10                |          | ns   |

(1) Writing on PCM.VCK rising edge (mode 1) and writing on PCM.VCK falling edge (mode 2).

(2)  $F_s = 8$  or  $16 \text{ kHz}$

(3)  $P = \text{PCM.CLK period}$

[Table 13-10](#) lists the switching characteristics of the voice PCM interface, mode 1.

**Table 13-10. Voice PCM Interface Switching Characteristics (Mode 1)**

| Notation                               | Parameter         |  | Min          | Max      | Unit |
|--|-------------------|--|--------------|----------|------|
| <b>Voice/Bluetooth PCM Master Mode</b> |                   |  |              |          |      |
| P0                                     | $t_c(\text{VCK})$ | Cycle time, PCM.VCK <sup>(1)</sup>                 | 1/65 * $F_s$ |          | ns   |
| P1                                     | $t_w(\text{VCK})$ | Pulse duration, PCM.VCK high or low <sup>(2)</sup> | 0.45 * P     | 0.55 * P | ns   |

(1)  $F_s = 8$  or  $16 \text{ kHz}$

(2)  $P = \text{PCM.CLK period}$

**Table 13-10. Voice PCM Interface Switching Characteristics (Mode 1) (continued)**

| Notation                    | Parameter        |   | Min | Max         | Unit |
|-----------------------------|------------------|---|-----|-------------|------|
| P2                          | $t_{d(VCK-VFS)}$ | Delay time, PCM.VCK transition to PCM.VFS transition <sup>(3)</sup> | -10 | 10 + Pvoice | ns   |
| P5                          | $t_{d(VCL-VDX)}$ | Delay time, PCM.VCK transition to PCM.VDX transition                | -10 | 10          | ns   |
| <b>Voice PCM Slave Mode</b> |                  |   |     |             |      |
| P5                          | $t_{d(VCL-VDX)}$ | Delay time, PCM.VCK transition to PCM.VDX transition                | 0   | 20          | ns   |

(3) When TPS65950 is master, the PCM.VFS is delivered one cycle time of 26-MHz voice clock (Pvoice=38.4 ns) after the PCM.VCK rising edge.

### 13.6 JTAG Interfaces

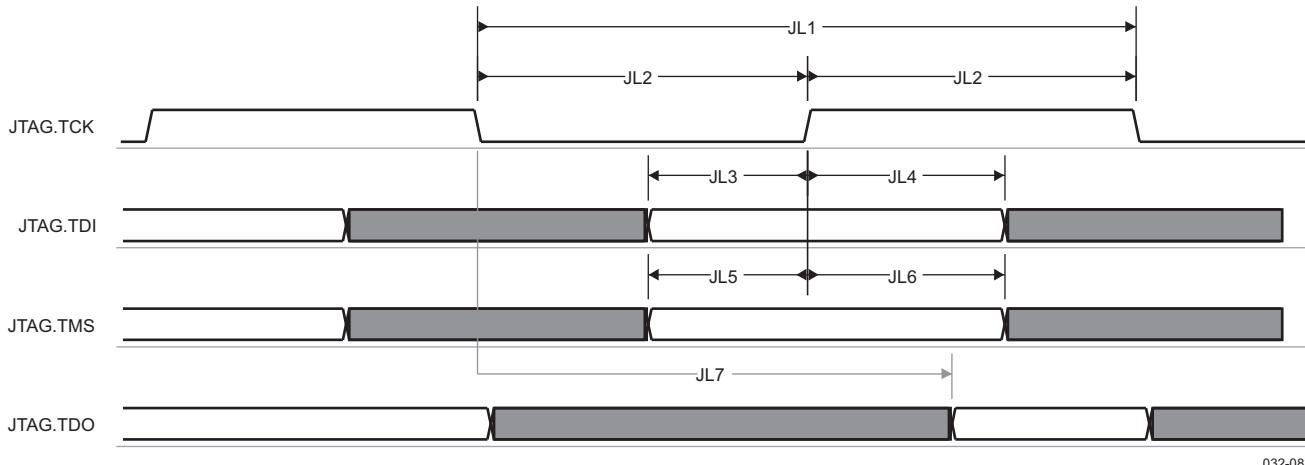
The TPS65950 Joint Test Action Group (JTAG) test access port (TAP) controller handles standard IEEE JTAG interfaces. This section describes the timing requirements for the tools used to test TPS65950 power management.

The JTAG/TAP module provides a JTAG interface according to IEEE Standard 1149.1a. This interface uses the four I/O pins TMS, TCK, TDI, and TDO. The TMS, TCK, and TDI inputs contain a pullup device, which makes their state high when they are not driven. The output TDO is a 3-state output, which is high impedance except when data are shifted between TDI and TDO:

- TCK is the test clock signal.
- TMS is the test mode select signal.
- TDI is the scan path input.
- TDO is the scan path output.

TMS and TDO are multiplexed at the top level with the GPIO0 and GPIO1 pins. The dedicated external test pin switches from functional mode (GPIO0 and GPIO1) to JTAG mode (TMS and TDO). The JTAG operations are controlled by a state-machine that follows the IEEE Standard 1149.1a state diagram. This state-machine is reset by the TPS65950 internal power-on reset (POR). A test mode is selected by writing a 6-bit word (instruction) into the instruction register and then accessing the related data register.

Table 13-11 and Table 13-12 assume testing over the recommended operating conditions (see Figure 13-7). The input timing requirements are given by considering a rising or falling edge of 7 ns. The capacitive load is 35 pF.


**Figure 13-7. JTAG Interface Timing**

032-083

**Table 13-11. JTAG Interface Timing Requirements**

| Notation           | Parameter           |   | Min    | Max    | Unit |
|--------------------|---------------------|---|--------|--------|------|
| <b>Clock</b>       |                     |   |        |        |      |
| JL1                | $t_c(TCK)$          | Cycle time, JTAG.TCK period                         | 30     |        | ns   |
| JL2                | $t_w(TCK)$          | Pulse duration, JTAG.TCK high or low <sup>(1)</sup> | 0.48*P | 0.52*P | ns   |
| <b>Read Timing</b> |                     |   |        |        |      |
| JL3                | $t_{su}(TDIV-TCKH)$ | Setup time, JTAG.TDI valid before JTAG.TCK high     | 8      |        | ns   |
| JL4                | $t_h(TDIV-TCKH)$    | Hold time, JTAG.TDI valid after JTAG.TCK high       | 5      |        | ns   |
| JL5                | $t_{su}(TMSV-TCKH)$ | Setup time, JTAG.TMS valid before JTAG.TCK high     | 8      |        | ns   |
| JL6                | $t_h(TMSV-TCKH)$    | Hold time, JTAG.TMS valid after JTAG.TCK high       | 5      |        | ns   |

(1) P = JTAG.TCK clock period

**Table 13-12. JTAG Interface Switching Characteristics**

| Notation            | Parameter       |   | Min | Max | Unit |
|---------------------|-----------------|---|-----|-----|------|
| <b>Write Timing</b> |                 |   |     |     |      |
| JL7                 | $t_d(TCK-TDOV)$ | Delay time, JTAG, TCK active edge to JTAG.TDO valid | 0   | 14  | ns   |

## 14 Debouncing Time

[Table 14-1](#) lists the debouncing functions.

**Table 14-1. Debouncing Time**

| Debouncing Functions   | Block                     | Programmable | Debouncing Time                         | Default   |
|--|---------------------------|--------------|---|-----------|
| Main battery charged threshold (<3.2 V)  | Battery monitoring        | No           | 580 µs                                  | 580 µs    |
| Main battery low threshold detection (<2.7 V)                                      |                           | No           | 60 µs                                   | 60 µs     |
| Main battery plug detection (with charger connected)                               |                           | No           | 60 µs                                   | 60 µs     |
| Charger unplug detection <sup>(1)</sup>  | BCI<br>(automatic charge) | No           | 1 x 50 ms                               | 1 x 50 ms |
| Charger plug detection <sup>(1)</sup>  | BCI                       | No           | 9 x 50 ms                               | 9 x 50 ms |
| Debouncing functions interrupt generation debounce for charger plug                | Power                     | No           | 125.6 µs                                | 125.6 µs  |
| USB plug detection/VBUS precharge (same debouncing as charger plug) <sup>(1)</sup> | BCI                       | No           | 9 x 50 ms                               | 9 x 50 ms |
| Battery presence plug/unplug <sup>(1)</sup>  | BCI                       | No           | 9 x 50 ms                               | 9 x 50 ms |
| Battery thermistor in/out of range <sup>(1)</sup>                                  | BCI                       | No           | 4 x 50 ms                               | 4 x 50 ms |
| Plug/unplug detection VBUS <sup>(2)</sup>  | USB                       | Yes          | 0 to 250 ms<br>(32/32,468-second steps) | 28 ms     |
| Plug/unplug detection ID <sup>(3)</sup>  | USB                       | Yes          | 0 to 250 ms<br>(32/32,468-second steps) | 50 ms     |
| Debouncing functions interrupt generation debounce for VBUS and ID <sup>(4)</sup>  | Power                     | Yes          | 0 to 250 ms                             | 30 ms     |
| Hot-die detection  | Thermistor                | No           | 60 µs                                   | 60 µs     |
| Thermal shutdown detection   |                           | No           | 60 µs                                   | 60 µs     |
| PWRON <sup>(5)</sup>   | Start/stop button         | No           | 31.25 ms                                | 31.25 ms  |
| NRESWARM   | Button reset              | No           | 60 µs                                   | 60 µs     |
| SIM card plug/unplug   | GPIO                      | Yes          | 0 or 30 ms ± 1 ms                       | 0 ms      |
| Headset detection (plug/unplug)  | GPIO                      | Yes          | 0 or 30 ms ± 1 ms                       | 0 ms      |
| MMC1/2 (plug/unplug)   | GPIO                      | Yes          | 0 or 30 ms ± 1 ms                       | 0 ms      |

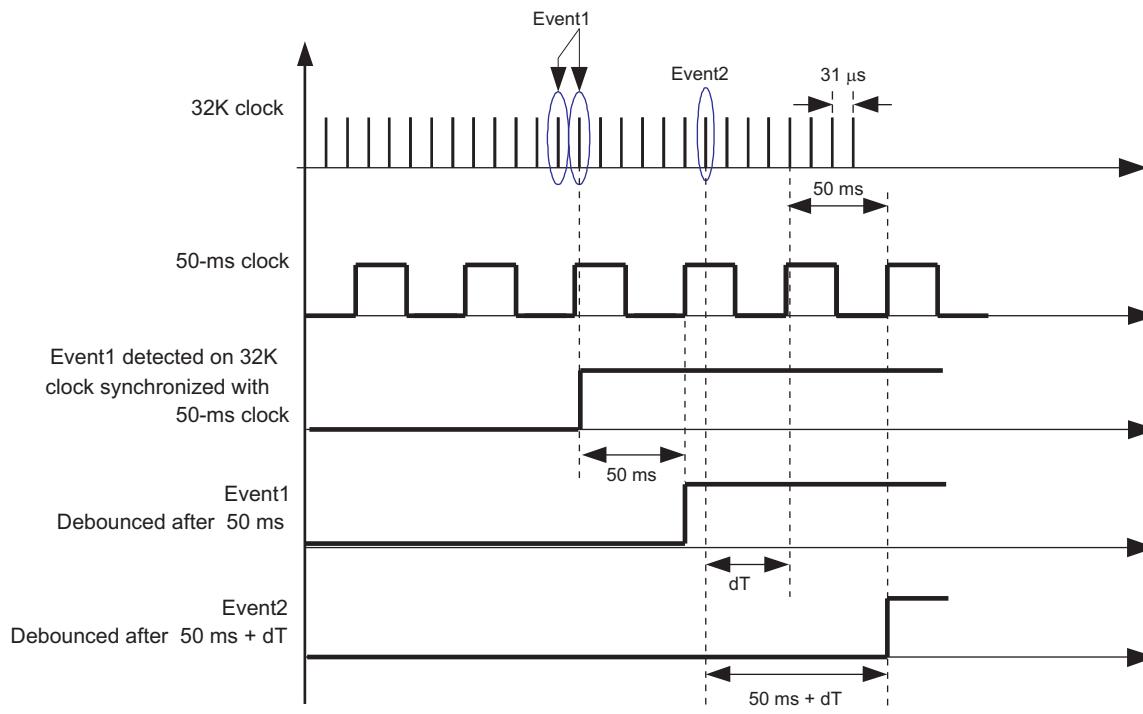
- (1) According to the capture of the event, debouncing time can vary between 50 ms and 50 ms + dT (dT included in 0 < dT > 50 ms). [Figure 14-1](#) shows and explains this possible variation of the debouncing time.

(2) Programmable in the VBUS\_DEBOUNCE register

(3) Programmable in the ID\_DEBOUNCE register

(4) Programmable in the RESERVED\_E[2:0] CFG\_VBUSDEB register

(5) The PWRON signal is debounced 1024 × CLK32K (maximum 1026 × CLK32K) falling edge in master mode.



032-084

**Figure 14-1. Debouncing Sequence Chronogram Example**

Event 1 is correctly debounced after 50 ms. Event 2 is debounced after 50 ms +  $dT$  because the capture of the event is considered after the next rising edge of the 50-ms clock.

## 15 External Components

Table 15-1 lists the external components of the TPS65950.

**Table 15-1. TPS65950 External Components**

| Function              | Component | Reference                   | Value | Note   | Link   |
|-----------------------|-----------|-----------------------------|-------|--|--|
| <b>Power Supplies</b> |           |                             |       |  |  |
| VDD1                  | Capacitor | C <sub>VDD1.IN</sub>        | 10 µF | Range ± 50%<br>ESR minimum = 1 mΩ<br>ESR maximum = 20 mΩ<br>Taiyo Yuden: JMK212BJ106KD | <a href="#">Figure 4-1</a>                               |
|                       | Capacitor | C <sub>VDD1.OUT</sub>       | 10 µF | Range ± 50%<br>ESR minimum = 1 mΩ<br>ESR maximum = 20 mΩ<br>Taiyo Yuden: JMK212BJ106KD |  |
|                       | Inductor  | L <sub>VDD1</sub>           | 1 µH  | Range ± 30%<br>DCR maximum = 100 mΩ  |  |
| VDD2                  | Capacitor | C <sub>VDD2.IN</sub>        | 10 µF | Range ± 50%<br>ESR minimum = 1 mΩ<br>ESR maximum = 20 mΩ<br>Taiyo Yuden: JMK212BJ106KD | <a href="#">Figure 4-1</a>                               |
|                       | Capacitor | C <sub>VDD2.OUT</sub>       | 10 µF | Range ± 50%<br>ESR minimum = 1 mΩ<br>ESR maximum = 20 mΩ<br>Taiyo Yuden: JMK212BJ106KD |  |
|                       | Inductor  | L <sub>VDD2</sub>           | 1 µH  | Range ± 30%<br>DCR maximum = 100 mΩ  |  |
| VIO                   | Capacitor | C <sub>VIO.IN</sub>         | 10 µF | Range ± 50%<br>ESR minimum = 1 mΩ<br>ESR maximum = 20 mΩ<br>Taiyo Yuden: JMK212BJ106KD | <a href="#">Figure 4-1</a>                               |
|                       | Capacitor | C <sub>VIO.OUT</sub>        | 10 µF | Range ± 50%<br>ESR minimum = 1 mΩ<br>ESR maximum = 20 mΩ<br>Taiyo Yuden: JMK212BJ106KD |  |
|                       | Inductor  | L <sub>VVIO</sub>           | 1 µH  | Range ± 30%<br>DCR maximum = 100 mΩ  |  |
| VRUSB_3V              | Capacitor | C <sub>VUSB.3P1</sub>       | 1 µF  | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 300 mΩ                    | <a href="#">Figure 4-1</a><br><a href="#">Figure 7-2</a> |
| VRUSB_1V5             | Capacitor | C <sub>VINTUSB1P5.OUT</sub> | 1 µF  | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ                    | <a href="#">Figure 4-1</a><br><a href="#">Figure 7-2</a> |
| VRUSB_1V8             | Capacitor | C <sub>VINTUSB1P8.OUT</sub> | 1 µF  | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ                    | <a href="#">Figure 4-1</a><br><a href="#">Figure 7-2</a> |
| VDAC                  | Capacitor | C <sub>VDAC.IN</sub>        | 1 µF  | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ                    | <a href="#">Figure 4-1</a>                               |
|                       | Capacitor | C <sub>VDAC.OUT</sub>       | 1 µF  | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ                    |  |
| VPILLA3R              | Capacitor | C <sub>VPILLA3R.IN</sub>    | 1 µF  | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ                    | <a href="#">Figure 4-1</a>                               |
| VPPLL1                | Capacitor | C <sub>VPPLL1.OUT</sub>     | 1 µF  | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ                    | <a href="#">Figure 4-1</a>                               |
| VPPLL2/VDSI.CSI       | Capacitor | C <sub>VPPLL2.OUT</sub>     | 1 µF  | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ                    | <a href="#">Figure 4-1</a>                               |

**Table 15-1. TPS65950 External Components (continued)**

| Function | Component | Reference                 | Value       | Note  | Link                       |
|----------|-----------|---------------------------|-------------|---|----------------------------|
| VMMC1    | Capacitor | C <sub>VMMC1.IN</sub>     | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 4-1</a> |
|          | Capacitor | C <sub>VMMC1.OUT</sub>    | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ |                            |
| VMMC2    | Capacitor | C <sub>VMMC2.IN</sub>     | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 4-1</a> |
|          | Capacitor | C <sub>VMMC2.OUT</sub>    | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ |                            |
| VSIM     | Capacitor | C <sub>VSIM.OUT</sub>     | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 4-1</a> |
| VAUX12S  | Capacitor | C <sub>VAUX12S.IN</sub>   | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 4-1</a> |
| VAUX1    | Capacitor | C <sub>VAUX1.OUT</sub>    | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 4-1</a> |
| VAUX2    | Capacitor | C <sub>VAUX2.OUT</sub>    | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 4-1</a> |
| VAUX3    | Capacitor | C <sub>VAUX3.OUT</sub>    | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 4-1</a> |
| VAUX4    | Capacitor | C <sub>VAUX4.IN</sub>     | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 4-1</a> |
|          | Capacitor | C <sub>VAUX4.OUT</sub>    | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ |                            |
| VINT     | Capacitor | C <sub>VINT.IN</sub>      | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 4-1</a> |
| VINTANA1 | Capacitor | C <sub>VINTANA1.OUT</sub> | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 4-1</a> |
| VINTANA2 | Capacitor | C <sub>VINTANA2.OUT</sub> | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 4-1</a> |
| VINTDIG  | Capacitor | C <sub>VINTDIG.OUT</sub>  | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 4-1</a> |
| VBAT.USB | Capacitor | C <sub>VBAT.USB</sub>     | 1 µF        | Range: 0.3 to 2.7 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ | <a href="#">Figure 7-2</a> |
| USB CP   | Capacitor | C <sub>VBUS.FC</sub>      | 2.2 µF ±40% | ESR maximum = 20 mΩ   | <a href="#">Figure 7-2</a> |
|          | Capacitor | C <sub>VBUS.IN</sub>      | 10 µF       |   |                            |
|          | Capacitor | C <sub>VBUS</sub>         | 4.7 µF ±40% | ESR maximum = 20 mΩ   |                            |

**Table 15-1. TPS65950 External Components (continued)**

| Function                        | Component    | Reference              | Value                          | Note  | Link                                 |
|---------------------------------|--------------|------------------------|--------------------------------|---|--------------------------------------|
| <b>MCPC</b>                     |              |                        |                                |   |                                      |
|                                 | Capacitor    | $C_{TXAF}$             | 0.1 $\mu$ F                    |   | Figure 7-2                           |
|                                 | Capacitor    | $C_{RXAF}$             | 1 $\mu$ F                      |   |                                      |
|                                 | Resistor     | $R_{RTSO}$             | 22 $\Omega$ /100 $\Omega$      |   |                                      |
|                                 | Diode        | $D_{CTS1}$             |                                | NNCD5.6J  |                                      |
|                                 | Diode        | $D_{CTS2}$             |                                | NNCD5.6J  |                                      |
|                                 | Diode        | $D_{RTSO1}$            |                                | NNCD5.6J  |                                      |
|                                 | Diode        | $D_{RTSO2}$            |                                | NNCD5.6J  |                                      |
| <b>32.768 kHz</b>               |              |                        |                                |   |                                      |
|                                 | Capacitor    | $C_{XIN}$              | 10 pF                          | Range: 9 to 12.5 pF   | Figure 12-5                          |
|                                 | Capacitor    | $C_{XOUT}$             | 10 pF                          |   |                                      |
|                                 | Quartz       | $X_{32.768\text{kHz}}$ | 32.768 kHz                     | $\pm 30 \text{ ppm}$ (at 25°C)<br>$\pm 200 \text{ ppm}$ (-40°C to 85°C)   |                                      |
| <b>Audio</b>                    |              |                        |                                |   |                                      |
| Earpiece                        | Capacitor    | $C_{EAR}$              | 100 pF                         |   | Figure 6-3                           |
| 8- $\Omega$ hands-free right    | Ferrite bead | $L_{HFR.M}$            |                                | NEC: N2012ZPS121  | Figure 6-5                           |
|                                 | Ferrite bead | $L_{HFR.P}$            |                                | NEC: N2012ZPS121  |                                      |
|                                 | Capacitor    | $C_{HFR}$              | 1 $\mu$ F                      |   |                                      |
|                                 | Capacitor    | $C_{HFR.M}$            | 1 nF                           |   |                                      |
|                                 | Capacitor    | $C_{HFR.P}$            | 1 nF                           |   |                                      |
| 8- $\Omega$ hands-free left     | Ferrite bead | $L_{HFL.M}$            |                                | NEC: N2012ZPS121  | Figure 6-5                           |
|                                 | Ferrite bead | $L_{HFL.P}$            |                                | NEC: N2012ZPS121  |                                      |
|                                 | Capacitor    | $C_{HFL}$              | 1 $\mu$ F                      |   |                                      |
|                                 | Capacitor    | $C_{HFL.M}$            | 1 nF                           |   |                                      |
|                                 | Capacitor    | $C_{HFL.P}$            | 1 nF                           |   |                                      |
| Headset left                    | Capacitor    | $C_S$                  | 22 $\mu$ F/47 $\mu$ F          |   | Figure 6-7<br>through<br>Figure 6-10 |
|                                 | Resistor     | $R_S$                  | 0 to 33 $\Omega$               |   |                                      |
|                                 | Capacitor    | $C_I$                  | 47 pF                          |   |                                      |
| Headset right                   | Capacitor    | $C_S$                  | 22 $\mu$ F/47 $\mu$ F          |   | Figure 6-7<br>through<br>Figure 6-10 |
|                                 | Resistor     | $R_S$                  | 0 to 33 $\Omega$               |   |                                      |
|                                 | Capacitor    | $C_I$                  | 47 pF                          |   |                                      |
| Headset microphone              | Capacitor    | $C_{HM.M}$             | 100 nF                         |   | Figure 6-7<br>through<br>Figure 6-10 |
|                                 | Capacitor    | $C_{HM.P}$             | 100 nF                         |   |                                      |
|                                 | Capacitor    | $C_{HM.O}$             | 47 pF                          |   |                                      |
|                                 | Resistor     | $R_B + R_{SB}$         | 2.2 k $\Omega$ /2.7 k $\Omega$ |   |                                      |
|                                 | Capacitor    | $C_B$                  | 0 to 200 pF                    | If greater than 200 pF, a serial resistor is required for bias stability. |                                      |
| External class-D predriver left | Capacitor    | $C_{PL.O}$             | 50 pF                          |   | Figure 6-12                          |
|                                 | Capacitor    | $C_{PL}$               | 1 $\mu$ F                      |   |                                      |
|                                 | Resistor     | $R_{PL}$               | >15 k $\Omega$                 |   |                                      |
|                                 | Resistor     | $R_{PL.M}$             | >15 k $\Omega$                 |   |                                      |
|                                 | Resistor     | $R_{PL.O}$             | 10 k $\Omega$                  |   |                                      |
|                                 | Capacitor    | $C_{PL.M}$             | 1 $\mu$ F                      |   |                                      |

Table 15-1. TPS65950 External Components (continued)

| Function                                  | Component    | Reference       | Value           | Note   | Link        |
|---|--------------|-----------------|-----------------|--|-------------|
| External class-D predriver right          | Capacitor    | $C_{PR,O}$      | 50 pF           |  | Figure 6-12 |
|   | Capacitor    | $C_{PR}$        | 1 $\mu$ F       |  |             |
|   | Resistor     | $R_{PR}$        | >15 k $\Omega$  |  |             |
|   | Resistor     | $R_{PR,M}$      | >15 k $\Omega$  |  |             |
|   | Resistor     | $R_{PR,O}$      | 10 k $\Omega$   |  |             |
|   | Capacitor    | $C_{PR,M}$      | 1 $\mu$ F       |  |             |
| Vibrator H-bridge                         | Ferrite bead | $L_{V,M}$       |                 | BLM18BD221S1N  | Figure 6-13 |
|   | Ferrite bead | $L_{V,P}$       |                 | BLM18BD221S1N  |             |
|   | Capacitor    | $C_{V,V}$       | 1 $\mu$ F       |  |             |
|   | Capacitor    | $C_{V,M}$       | 1 nF            |  |             |
|   | Capacitor    | $C_{V,P}$       | 1 nF            |  |             |
| Main microphone (pseudodifferential mode) | Capacitor    | $C_{MM,M}$      | 100 nF          |  | Figure 6-20 |
|   | Capacitor    | $C_{MM,P}$      | 100 nF          |  |             |
|   | Capacitor    | $C_{MM,O}$      | 47 pF           |  |             |
|   | Resistor     | $R_{MM,O}$      | ~500 $\Omega$   |  |             |
|   | Resistor     | $R_{MM,MP}$     | ~1.7 k $\Omega$ |  |             |
|   | Capacitor    | $C_{MM,B}$      | 0 to 200 pF     | If greater than 200 pF, a serial resistor is required for bias stability.                |             |
| Submicrophone (pseudodifferential mode)   | Capacitor    | $C_{MS,M}$      | 100 nF          |  | Figure 6-20 |
|   | Capacitor    | $C_{MS,P}$      | 100 nF          |  |             |
|   | Capacitor    | $C_{MS,O}$      | 47 pF           |  |             |
|   | Resistor     | $R_{MS,O}$      | ~500 $\Omega$   |  |             |
|   | Resistor     | $R_{MS,MP}$     | ~1.7 k $\Omega$ |  |             |
|   | Capacitor    | $C_{MS,B}$      | 0 to 200 pF     | If greater than 200 pF, a serial resistor is required for bias stability.                |             |
| Main microphone (differential mode)       | Capacitor    | $C_{MM,M}$      | 100 nF          |  | Figure 6-21 |
|   | Capacitor    | $C_{MM,P}$      | 100 nF          |  |             |
|   | Capacitor    | $C_{MM,PM}$     | 47 pF           |  |             |
|   | Capacitor    | $C_{MM,O}$      | 47 pF           |  |             |
|   | Capacitor    | $C_{MM,GM}$     | 47 pF           |  |             |
|   | Capacitor    | $C_{MM,GP}$     | 47 pF           |  |             |
|   | Resistor     | $R_{MM,BP}$     | 1 k $\Omega$    |  |             |
|   | Resistor     | $R_{MM,GM}$     | 1 k $\Omega$    |  |             |
|   | Capacitor    | $C_{MM,B}$      | 0 to 200 pF     | If greater than 200 pF, a serial resistor is required for bias stability.                |             |
| Submicrophone (differential mode)         | Capacitor    | $C_{MS,M}$      | 100 nF          |  | Figure 6-21 |
|   | Capacitor    | $C_{MS,P}$      | 100 nF          |  |             |
|   | Capacitor    | $C_{MS,PM}$     | 47 pF           |  |             |
|   | Capacitor    | $C_{MS,O}$      | 47 pF           |  |             |
|   | Capacitor    | $C_{MS,GM}$     | 47 pF           |  |             |
|   | Capacitor    | $C_{MS,GP}$     | 47 pF           |  |             |
|   | Resistor     | $R_{MS,BP}$     | 1 k $\Omega$    |  |             |
|   | Resistor     | $R_{MS,GM}$     | 1 k $\Omega$    |  |             |
|   | Capacitor    | $C_{MS,B}$      | 0 to 200 pF     | If greater than 200 pF, a serial resistor is required for bias stability.                |             |
| VMIC1                                     | Capacitor    | $C_{VMIC1,OUT}$ | 1 $\mu$ F       | Range: 0.3 to 3.3 $\mu$ F<br>ESR minimum = 20 m $\Omega$<br>ESR maximum = 600 m $\Omega$ |             |

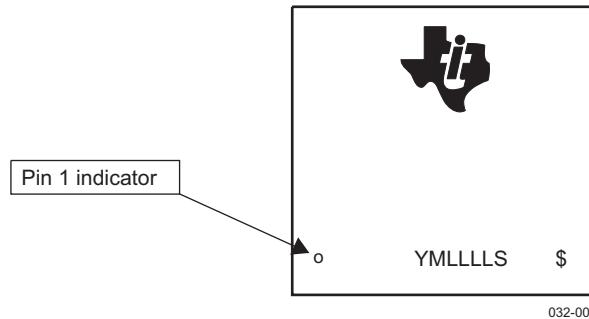
**Table 15-1. TPS65950 External Components (continued)**

| Function                                  | Component | Reference              | Value  | Note  | Link                     |  |
|---|-----------|------------------------|--|---|--------------------------|--|
| VMIC2                                     | Capacitor | C <sub>VMIC2.OUT</sub> | 1 µF   | Range: 0.3 to 3.3 µF<br>ESR minimum = 20 mΩ<br>ESR maximum = 600 mΩ |                          |  |
| Silicon microphone                        | Capacitor | C <sub>SM</sub>        | 1 µF   |   | Figure 6-24              |  |
|   | Capacitor | C <sub>SM.P</sub>      | 100 nF   |   |                          |  |
|   | Capacitor | C <sub>SM.M</sub>      | 100 nF   |   |                          |  |
|   | Capacitor | C <sub>SM.PG</sub>     | 47 nF  |   |                          |  |
|   | Resistor  | R <sub>SM</sub>        | >500 Ω   |   |                          |  |
| Auxiliary left                            | Capacitor | C <sub>AUXL</sub>      | 100 nF   |   | Figure 6-25              |  |
|   | Capacitor | C <sub>AUXL.M</sub>    | 47 pF  |   |                          |  |
| Auxiliary right                           | Capacitor | C <sub>AUXR</sub>      | 100 nF   |   |                          |  |
|   | Capacitor | C <sub>AUXR.M</sub>    | 47 pF  |   |                          |  |
| <b>LED Driver</b>                         |           |                        |  |   |                          |  |
|   | Resistor  | R <sub>LED.A</sub>     | 120 Ω  | Required for each LED   | Figure 10-1              |  |
|   | Resistor  | R <sub>LED.B</sub>     | 160 kΩ   | Required for each LED   |                          |  |
| <b>Battery Charger</b>                    |           |                        |  |   |                          |  |
| ICTLAC1                                   | Capacitor | C <sub>COMPAC</sub>    | 100 nF   |   | Figure 8-1<br>Figure 8-2 |  |
|   | Resistor  | R <sub>SCOMPAC</sub>   | 51 Ω   |   | Figure 8-1<br>Figure 8-2 |  |
|   | FET       | T <sub>AC</sub>        | FDJ1027P   | Fairchild   | Figure 8-1<br>Figure 8-2 |  |
|   | Resistor  | R <sub>LimitAC</sub>   | 700 kΩ   |   | Figure 8-1<br>Figure 8-2 |  |
|   | FET       | T <sub>3</sub>         | FDY100PZ   |   | Figure 8-2               |  |
|   | Capacitor | C <sub>3</sub>         | 1 nF   |   | Figure 8-2               |  |
|   | Resistor  | R <sub>3</sub>         | 100 kΩ   |   | Figure 8-2               |  |
| ICTLUSB1                                  | Capacitor | C <sub>COMPUSB</sub>   | 100 nF   |   | Figure 8-1               |  |
|   | Resistor  | R <sub>SCOMPUSB</sub>  | 51 Ω   |   |                          |  |
|   | FET       | T <sub>USB</sub>       | FDJ1027P   | Fairchild   |                          |  |
|   | Resistor  | R <sub>LimitUSB</sub>  | 500 kΩ   |   |                          |  |
| VPRECH                                    | Capacitor | C <sub>PRECH</sub>     | 1 µF   |   | Figure 8-1               |  |
| VCCS                                      | Resistor  | R <sub>S</sub>         | 220 mΩ   |   | Figure 8-1               |  |
| BCI AUTO                                  | Resistor  | R <sub>BCI.AUTO</sub>  | <10 kΩ<br>>140 kΩ  | For more information, see<br><a href="#">Table 8-2</a> .            | Figure 8-3               |  |
| VBAT                                      | Capacitor | C <sub>CV</sub>        | 80 µF  |   | Figure 8-1               |  |
| <b>I<sup>2</sup>C Bus—External Pullup</b> |           |                        |  |   |                          |  |
| I <sup>2</sup> C SmartReflex              | Resistor  | R <sub>PSR.SDA</sub>   | Pullups for various bus capacitances (C <sub>L</sub> ) and I <sup>2</sup> C speeds (standard, fast, and HS)<br>If C <sub>L</sub> = 10 pF: Standard = 118 kΩ, Fast = 35.4 kΩ, HS = 4.7 kΩ   |   | Section 13.3             |  |
|   | Resistor  | R <sub>PSR.SCL</sub>   | If C <sub>L</sub> = 12 pF: Standard = 98.3 kΩ, Fast = 29.5 kΩ, HS = 3.9 kΩ<br>If C <sub>L</sub> = 50 pF: Standard = 23.6 kΩ, Fast = 7.1 kΩ, HS = 940 Ω<br>If C <sub>L</sub> = 100 pF: Standard = 11.8 kΩ, Fast = 3.54 kΩ, HS = 470 Ω<br>If C <sub>L</sub> ≤ 12 pF, there is no need for an external pullup; the internal 3-kΩ pullup can be used.<br>If an external pullup is used, disable the internal 3-kΩ pullup (reference the GPPUPDCTR1 register; see the TRM). |   |                          |  |
| I <sup>2</sup> C control                  | Resistor  | R                      |  |   |                          |  |
|   | Resistor  | R <sub>CNTL.SCL</sub>  |  |   |                          |  |

## 16 TPS65950 Package

### 16.1 TPS65950 Standard Package Symbols

Table 15-1 shows the TPS65950 printed device reference.



**Figure 16-1. Printed Device Reference**

Table 16-1 lists the symbols used in the TPS65950 nomenclature.

**Table 16-1. TPS65950 Nomenclature Description**

| Field | Meaning   |
|-------|---|
| P     | Prototype (X), preproduction (P), or qualified/production device (blank) <sup>(1)</sup>   |
| A     | Mask set version descriptor (initial silicon = blank, first silicon revision = A, second silicon revision = B,...) <sup>(2)</sup> |
| YM    | Year month  |
| LLLLS | Lot code  |
| \$    | Fab planning code   |

(1) A blank in the symbol or part number is collapsed so there are no gaps between characters.

(2) Initial silicon version is ES1.0; first revision can be named ES2.0, ES1.1 or ES1.01, depending on the level of change.  
Note: Device name is a maximum of 10 characters.

### 16.2 Package Thermal Resistance Characteristics

Table 16-2 lists the thermal resistance characteristics for the recommended package types used for the TPS65950.

**Table 16-2. TPS65950 Thermal Resistance Characteristics**

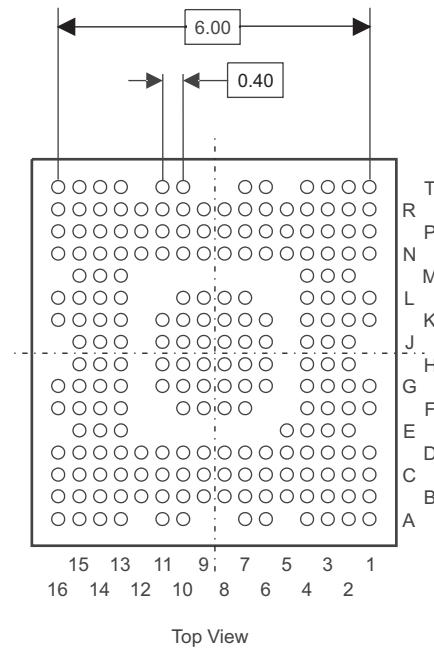
| Package  | R <sub>θJA</sub> (°C/W) | R <sub>θJB</sub> (°C/W) | R <sub>θJC</sub> (°C/W) | Board Type          |
|----------|-------------------------|-------------------------|-------------------------|---------------------|
| TPS65950 | 38.4                    | 15.2                    | 19.2 <sup>(1)</sup>     | 1S2P <sup>(2)</sup> |
| TPS65950 | 56.5                    | 15.5                    | 19.2 <sup>(1)</sup>     | 1S0P <sup>(2)</sup> |

(1) Not applicable. Because the POP package has a memory package on top, no heat sink can be used.

(2) The board types are defined by JEDEC (reference JEDEC standard JESD51-9, Test Board for Area Array Surface Mount Package Thermal Measurements).

## 16.3 Mechanical Data

Figure 16-2 is the top view of the TPS65950 mechanical package.

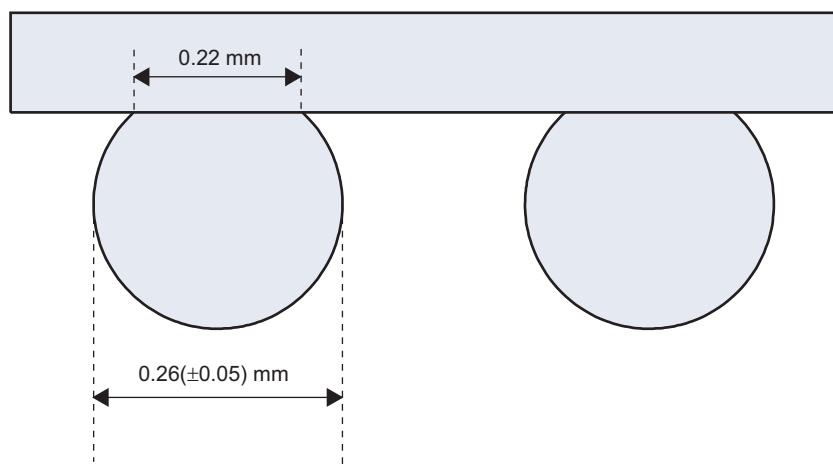


Top View

032-086

**Figure 16-2. TPS65950 Mechanical Package Top View**

Figure 16-3 shows the ball size.



032-087

**Figure 16-3. Ball Size**

## 16.4 ESD Specifications

The device has built-in ESD protection to the limits specified below. It is recommended that the leads are shorted together, or the device placed in conductive foam, during storage or handling to prevent electrostatic damage.

| ESD Method                | Standard Reference | Performance   |
|---------------------------|--------------------|---|
| Human Body Model (HBM)    | EIA / JESD22-A114D | 1000V for internal pins<br>2000V for external pins <sup>(1)</sup> |
| Charge Device Model (CDM) | EIA / JESD22-C101C | 500V  |

(1) List of external pins: VAC, VBUS, DP/UART3.RXD, DN/UART3.TXD, ID, VPLL1.OUT, VMMC1.OUT, VMMC2.OUT, VSIM.OUT.

## 17 Glossary

|                  |  |
|------------------|--|
| ADC              | Analog-to-digital converter                    |
| ALC              | Automatic level control                        |
| ARIB             | Association of Radio Industries and Businesses |
| ASIC             | Application-specific integrated circuit        |
| BCI              | Battery charger interface                      |
| BGA              | Ball grid array                                |
| BT               | Bluetooth                                      |
| BW               | Signal bandwidth                               |
| CMOS             | Complementary metal oxide semiconductor        |
| Codec            | Coder/decoder                                  |
| CMT              | Cellular mobile telephone                      |
| CPU              | Central processing unit                        |
| DAC              | Digital-to-analog converter                    |
| DBB              | Digital baseband                               |
| DCR              | Direct current (dc) resistance                 |
| DM               | Data manual                                    |
| DSP              | Digital signal processor                       |
| DVFS             | Dynamic voltage and frequency scaling          |
| ESD              | Electrostatic discharge                        |
| ESR              | Equivalent series resistance                   |
| FET              | Field effect transistor                        |
| FSR              | Full-scale range                               |
| GP               | General-purpose                                |
| GPIO             | General-purpose input/output                   |
| hiZ              | High impedance                                 |
| HS               | High speed or high security                    |
| HW               | Hardware                                       |
| I <sup>2</sup> C | Inter-integrated circuit                       |
| I2S              | Inter-IC sound                                 |
| IC               | Integrated circuit                             |
| ICN              | Idle channel noise                             |
| ID               | Identification                                 |
| IDDQ             | Direct drain quiescent current                 |
| IF               | Interface                                      |
| IO or I/O        | Input/output                                   |
| JTAG             | Joint Test Action Group, IEEE 1149.1 standard  |
| LED              | Light emitting diode                           |
| LDO              | Low-dropout regulator                          |
| LJF              | Left-justified format                          |

|              |  |
|--------------|--|
| LS           | Low speed                              |
| MADC         | Monitoring analog-to-digital converter |
| MCPC         | Mobile Computing Promotion Consortium  |
| MEMS         | Micro-electrical-mechanical system     |
| NA, N/A      | Not applicable                         |
| NRZI         | Nonreturn to zero inverted             |
| OCP          | Open-core protocol                     |
| OTG          | On-the-go                              |
| PBGA         | Plastic ball grid array                |
| PCB          | Printed circuit board                  |
| PCM          | Pulse-code modulation                  |
| PD           | Pulldown                               |
| PDM          | Pulse density modulated                |
| PFM          | Pulse frequency modulation             |
| PLL          | Phase-locked loop                      |
| PMOS         | Portable media operating system        |
| POL          | Polarity                               |
| POR          | Power-on reset                         |
| PSRR         | Power supply ripple rejection          |
| PU           | Pullup                                 |
| PWL          | Pulse-width length                     |
| PWT          | Pulse-width time                       |
| PWM          | Pulse-width modulation                 |
| RFID         | Radio frequency identification         |
| RJF          | Right-justified format                 |
| RTC          | Real-time clock                        |
| RX           | Receive                                |
| SDI          | Serial display Interface               |
| SMPS         | Switch-mode power supply               |
| SNR          | Signal-to-noise ratio                  |
| SRP          | Secure remote password                 |
| SW           | Software                               |
| SYNC/SYNCHRO | Synchronization                        |
| SYS          | System                                 |
| TAP          | Test access port                       |
| TBD          | To be defined                          |
| TDM          | Time division multiplexing             |
| THRU         | Feed through                           |
| TRM          | Technical reference manual             |
| TX           | Transmit                               |

|      |   |
|------|---|
| UART | Universal asynchronous receiver/transmitter |
| ULPI | UTMI+ low pin interface                     |
| UPR  | Uninterrupted power rail                    |
| USB  | Universal serial bus                        |
| UTMI | USB transceiver macrocell interface         |

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples (Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|--------------------------|
| TPS65950A2ZXN    | ACTIVE                | NFBGA        | ZXN             | 209  | 260         | Green (RoHS & no Sb/Br) | SNAGCU           | Level-3-260C-168 HR          |                          |
| TPS65950A2ZXNR   | ACTIVE                | NFBGA        | ZXN             | 209  | 2000        | Green (RoHS & no Sb/Br) | SNAGCU           | Level-3-260C-168 HR          |                          |
| TPS65950A3ZXN    | ACTIVE                | NFBGA        | ZXN             | 209  | 260         | Green (RoHS & no Sb/Br) | SNAGCU           | Level-3-260C-168 HR          |                          |
| TPS65950A3ZXNR   | ACTIVE                | NFBGA        | ZXN             | 209  | 2000        | Green (RoHS & no Sb/Br) | SNAGCU           | Level-3-260C-168 HR          |                          |
| TPS65950BZXN     | OBSOLETE              | NFBGA        | ZXN             | 209  |             | TBD                     | Call TI          | Call TI                      |                          |
| TPS65950BZXNR    | OBSOLETE              | NFBGA        | ZXN             | 209  |             | TBD                     | Call TI          | Call TI                      |                          |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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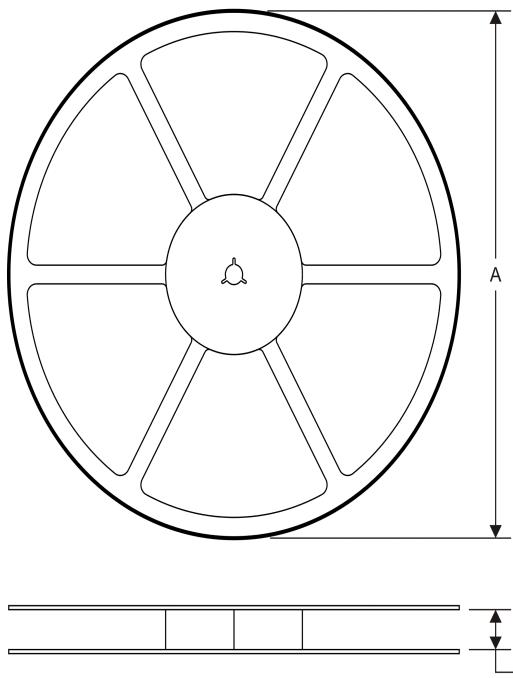
## PACKAGE OPTION ADDENDUM

14-Nov-2011

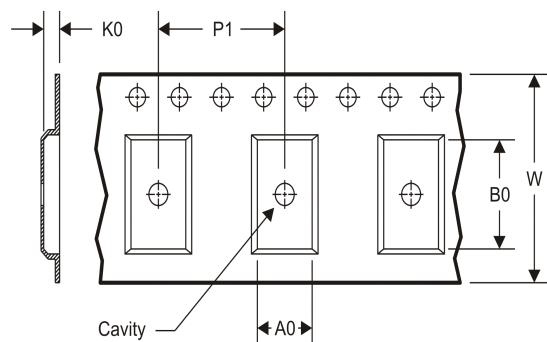
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## TAPE AND REEL INFORMATION

### REEL DIMENSIONS



### TAPE DIMENSIONS

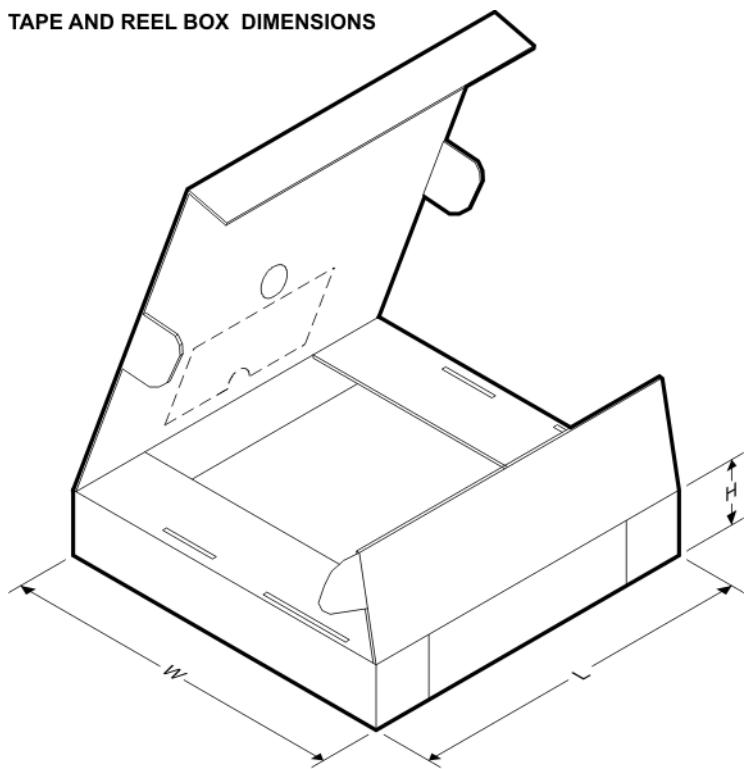


|    |   |
|----|---|
| A0 | Dimension designed to accommodate the component width     |
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

### TAPE AND REEL INFORMATION

\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS65950A2ZXNR | NFBGA        | ZXN             | 209  | 2000 | 330.0              | 16.4               | 7.3     | 7.3     | 1.5     | 12.0    | 16.0   | Q1            |
| TPS65950A3ZXNR | NFBGA        | ZXN             | 209  | 2000 | 330.0              | 16.4               | 7.3     | 7.3     | 1.5     | 12.0    | 16.0   | Q1            |

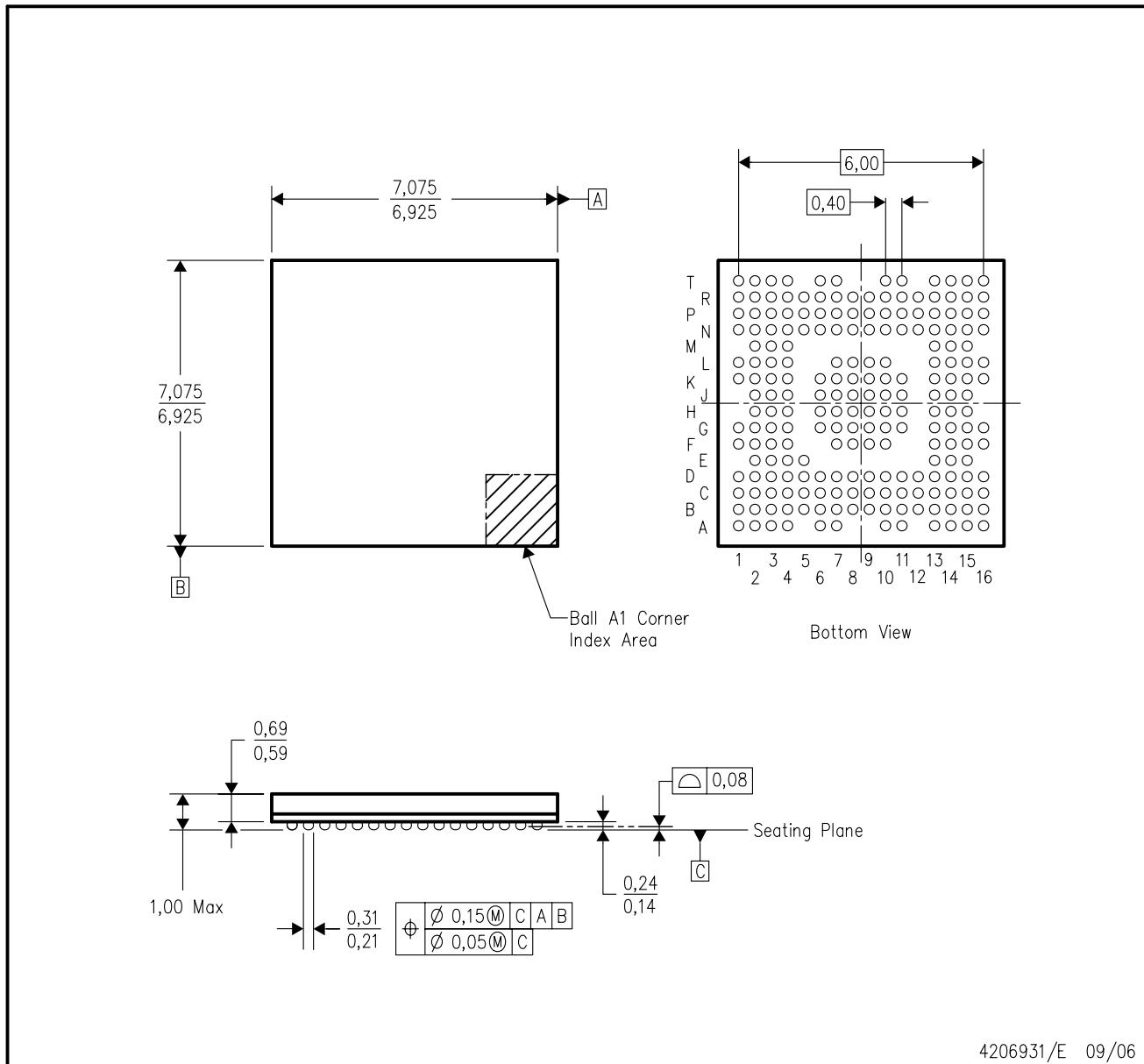
**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS65950A2ZXNR | NFBGA        | ZXN             | 209  | 2000 | 336.6       | 336.6      | 31.8        |
| TPS65950A3ZXNR | NFBGA        | ZXN             | 209  | 2000 | 336.6       | 336.6      | 31.8        |

## ZXN (S-PBGA-N209)

## PLASTIC BALL GRID ARRAY



4206931/E 09/06

- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - This drawing is subject to change without notice.
  - This is a lead-free solder ball design.

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